

16**H8/38704 Group, H8/38702S Group
Hardware Manual**

Renesas 16-Bit Single-Chip Microcomputer
H8 Family / H8/300H Super Low Power Series

| | |
|-----------------|-----------|
| H8/38704 Group | H8/38704 |
| | H8/38703 |
| | H8/38702 |
| H8/38702S Group | H8/38702S |
| | H8/38701S |
| | H8/38700S |

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

How to Use This Manual

1. Objective and Target Users

This manual was written to explain the hardware functions and electrical characteristics of this LSI to the target users, i.e. those who will be using this LSI in the design of application systems. Target users are expected to understand the fundamentals of electrical circuits, logic circuits, and microcomputers.

This manual is organized in the following items: an overview of the product, descriptions of the CPU, system control functions, and peripheral functions, electrical characteristics of the device, and usage notes.

When designing an application system that includes this LSI, take all points to note into account. Points to note are given in their contexts and at the final part of each section, and in the section giving usage notes.

The list of revisions is a summary of major points of revision or addition for earlier versions. It does not cover all revised items. For details on the revised points, see the actual locations in the manual.

The following documents have been prepared for the H8/38704 Group and the H8/38702S Group. Before using any of the documents, please visit our web site to verify that you have the most up-to-date available version of the document.

| Document Type | Contents | Document Title | Document No. |
|--------------------------|--|--|--------------|
| Data Sheet | Overview of hardware and electrical characteristics | — | — |
| Hardware Manual | Hardware specifications (pin assignments, memory maps, peripheral specifications, electrical characteristics, and timing charts) and descriptions of operation | H8/38704, H8/38702S Group Hardware Manual | This manual |
| Software Manual | Detailed descriptions of the CPU and instruction set | H8/300H Series Software Manual | REJ09B0213 |
| Application Note | Examples of applications and sample programs | The latest versions are available from our web site. | |
| Renesas Technical Update | Preliminary report on the specifications of a product, document, etc. | | |

2. Description of Numbers and Symbols

Aspects of the notations for register names, bit names, numbers, and symbolic names in this manual are explained below.

(1) Overall notation

In descriptions involving the names of bits and bit fields within this manual, the modules and registers to which the bits belong may be clarified by giving the names in the forms "module name"."register name"."bit name" or "register name"."bit name".

(2) Register notation

The style "register name"_"instance number" is used in cases where there is more than one instance of the same function or similar functions.

[Example] CMCSR_0: Indicates the CMCSR register for the compare-match timer of channel 0.

(3) Number notation

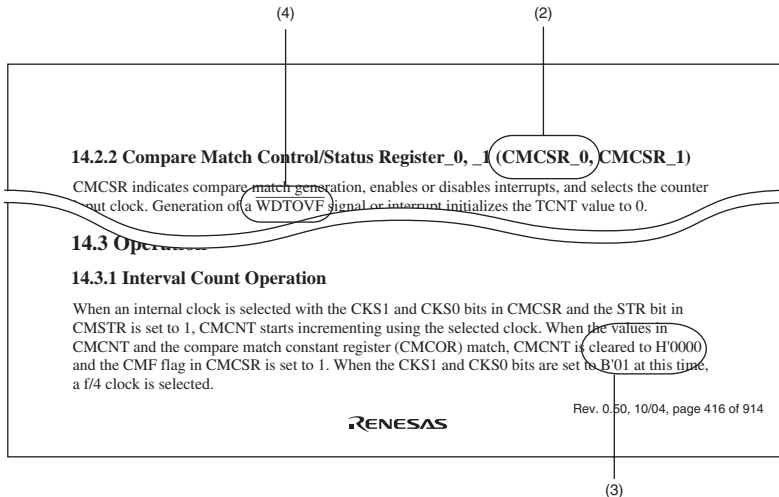
Binary numbers are given as B'nnnn (B' may be omitted if the number is obviously binary), hexadecimal numbers are given as H'nnnn or 0xnnnn, and decimal numbers are given as nnnn.

[Examples] Binary: B'11 or 11
Hexadecimal: H'EFA0 or 0xEFA0
Decimal: 1234

(4) Notation for active-low

An overbar on the name indicates that a signal or pin is active-low.

[Example] $\overline{\text{WDTOVF}}$



Note: The bit names and sentences in the above figure are examples and have nothing to do with the contents of this manual.

3. Description of Registers

Each register description includes a bit chart, illustrating the arrangement of bits, and a table of bits, describing the meanings of the bit settings. The standard format and notation for bit charts and tables are described below.

[Table of Bits]

| (1) Bit | (2) Bit Name | (3) Initial Value | (4) R/W | (5) Description |
|------------|-----------------|----------------------|------------|--|
| 15 | - | 0 | R | Reserved |
| 14 | - | 0 | R | These bits are always read as 0. |
| 13 to 11 | ASID2 to ASID0 | All 0 | R/W | Address Identifier These bits enable or disable the pin function. |
| 10 | - | 0 | R | Reserved This bit is always read as 0. |
| 9 | - | 1 | R | Reserved This bit is always read as 1. |
| - | - | 0 | - | - |

Note: The bit names and sentences in the above figure are examples, and have nothing to do with the contents of this manual.

- (1) Bit
Indicates the bit number or numbers.
In the case of a 32-bit register, the bits are arranged in order from 31 to 0. In the case of a 16-bit register, the bits are arranged in order from 15 to 0.
- (2) Bit name
Indicates the name of the bit or bit field.
When the number of bits has to be clearly indicated in the field, appropriate notation is included (e.g., ASID[3:0]).
A reserved bit is indicated by "-".
Certain kinds of bits, such as those of timer counters, are not assigned bit names. In such cases, the entry under Bit Name is blank.
- (3) Initial value
Indicates the value of each bit immediately after a power-on reset, i.e., the initial value.
0: The initial value is 0
1: The initial value is 1
-: The initial value is undefined
- (4) R/W
For each bit and bit field, this entry indicates whether the bit or field is readable or writable, or both writing to and reading from the bit or field are impossible.
The notation is as follows:
R/W: The bit or field is readable and writable.
R/(W): The bit or field is readable and writable.
However, writing is only performed to flag clearing.
R: The bit or field is readable.
"R" is indicated for all reserved bits. When writing to the register, write the value under Initial Value in the bit chart to reserved bits or fields.
W: The bit or field is writable.
- (5) Description
Describes the function of the bit or field and specifies the values for writing.

4. Description of Abbreviations

The abbreviations used in this manual are listed below.

- Abbreviations used in this manual

| Abbreviation | Description |
|---------------------|--|
| ACIA | Asynchronous communication interface adapter |
| bps | Bits per second |
| CRC | Cyclic redundancy check |
| DMA | Direct memory access |
| DMAC | Direct memory access controller |
| GSM | Global System for Mobile Communications |
| Hi-Z | High impedance |
| IEBus | Inter Equipment Bus (IEBus is a trademark of NEC Electronics Corporation.) |
| I/O | Input/output |
| IrDA | Infrared Data Association |
| LSB | Least significant bit |
| MSB | Most significant bit |
| NC | No connection |
| PLL | Phase-locked loop |
| PWM | Pulse width modulation |
| SFR | Special function register |
| SIM | Subscriber Identity Module |
| UART | Universal asynchronous receiver/transmitter |
| VCO | Voltage-controlled oscillator |

5. List of Product Specifications

Below is a table listing the product specifications for each group.

| Item | | H8/38704 Group | | H8/38702S Group |
|---|----------------------|--|-----------------------|----------------------|
| | | Flash Memory | Mask ROM | Mask ROM |
| Memory | ROM | 16 k, 32 kbytes | 16 k, 24 k, 32 kbytes | 8 k, 12 k, 16 kbytes |
| | RAM | 1 kbyte | 1 kbyte | 512 bytes |
| Operating voltage and operating frequency | 4.5 to 5.5 V | — | 16 MHz | — |
| | 2.7 to 5.5 V | — | 16 MHz | — |
| | 1.8 to 5.5 V | — | — | — |
| | 2.7 to 3.6 V | 10 MHz | — | 10 MHz |
| | 1.8 to 3.6 V | 4 MHz (2.2 V or more) | — | 4 MHz |
| I/O ports | Input | 9 | 9 | 9 |
| | Output | 6 | 5 | 6 |
| | I/O | 39 | 39 | 39 |
| Timers | Clock (timer A) | 1 | 1 | 1 |
| | Compare (timer F) | 1 | 1 | 1 |
| | AEC | 1 | 1 | 1 |
| | WDT | 1 | 1 | 1 |
| | WDT (discrete) | — | — | — |
| SCI | UART/Clock frequency | 1 ch | 1 ch | 1 ch |
| A-D (resolution × input channels) | | 10 bit × 4 ch | 10 bit × 4 ch | 10 bit × 4 ch |
| External interrupt (internal wakeup) | | 11(8) | 11(8) | 11(8) |
| Package | | FP-64A | FP-64A | FP-64A |
| | | FP-64E | FP-64E | FP-64K |
| | | TNP-64B | TNP-64B | — |
| Operating temperature | | Standard specifications: –20 to 75°C, WTR: –40 to 85°C | | |

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Contents

| | | |
|-----------|---|----|
| Section 1 | Overview | 1 |
| 1.1 | Features..... | 1 |
| 1.1.1 | Application | 1 |
| 1.1.2 | Overview of Specifications..... | 2 |
| 1.2 | List of Products..... | 5 |
| 1.3 | Block Diagram..... | 7 |
| 1.4 | Pin Assignment..... | 8 |
| 1.5 | Pin Functions | 9 |
| Section 2 | CPU | 13 |
| 2.1 | Address Space and Memory Map..... | 15 |
| 2.2 | Register Configuration..... | 21 |
| 2.2.1 | General Registers..... | 22 |
| 2.2.2 | Program Counter (PC)..... | 23 |
| 2.2.3 | Condition-Code Register (CCR)..... | 23 |
| 2.3 | Data Formats..... | 25 |
| 2.3.1 | General Register Data Formats..... | 25 |
| 2.3.2 | Memory Data Formats..... | 27 |
| 2.4 | Instruction Set..... | 28 |
| 2.4.1 | Table of Instructions Classified by Function | 28 |
| 2.4.2 | Basic Instruction Formats | 38 |
| 2.5 | Addressing Modes and Effective Address Calculation..... | 39 |
| 2.5.1 | Addressing Modes | 39 |
| 2.5.2 | Effective Address Calculation | 43 |
| 2.6 | Basic Bus Cycle..... | 45 |
| 2.6.1 | Access to On-Chip Memory (RAM, ROM)..... | 45 |
| 2.6.2 | On-Chip Peripheral Modules | 46 |
| 2.7 | CPU States | 47 |
| 2.8 | Usage Notes | 48 |
| 2.8.1 | Notes on Data Access to Empty Areas | 48 |
| 2.8.2 | EPMOV Instruction..... | 48 |
| 2.8.3 | Bit-Manipulation Instruction | 49 |
| Section 3 | Exception Handling..... | 55 |
| 3.1 | Exception Sources and Vector Address | 58 |
| 3.2 | Register Descriptions..... | 59 |

| | | |
|---------------------------------------|---|----|
| 3.2.1 | Interrupt Edge Select Register (IEGR) | 59 |
| 3.2.2 | Interrupt Enable Register 1 (IENR1) | 60 |
| 3.2.3 | Interrupt Enable Register 2 (IENR2) | 61 |
| 3.2.4 | Interrupt Request Register 1 (IRR1) | 62 |
| 3.2.5 | Interrupt Request Register 2 (IRR2) | 63 |
| 3.2.6 | Wakeup Interrupt Request Register (IWPR)..... | 64 |
| 3.2.7 | Wakeup Edge Select Register (WEGR)..... | 65 |
| 3.3 | Reset Exception Handling..... | 65 |
| 3.4 | Interrupt Exception Handling | 66 |
| 3.4.1 | External Interrupts | 66 |
| 3.4.2 | Internal Interrupts | 67 |
| 3.4.3 | Interrupt Handling Sequence | 68 |
| 3.4.4 | Interrupt Response Time..... | 69 |
| 3.5 | Usage Notes | 71 |
| 3.5.1 | Interrupts after Reset..... | 71 |
| 3.5.2 | Notes on Stack Area Use | 71 |
| 3.5.3 | Interrupt Request Flag Clearing Method..... | 71 |
| 3.5.4 | Notes on Rewriting Port Mode Registers..... | 72 |
| Section 4 Clock Pulse Generators..... | | 75 |
| 4.1 | Features..... | 75 |
| 4.2 | System Clock Generator | 76 |
| 4.2.1 | Connecting Crystal Resonator | 76 |
| 4.2.2 | Connecting Ceramic Resonator | 77 |
| 4.2.3 | External Clock Input Method..... | 77 |
| 4.3 | Subclock Generator..... | 78 |
| 4.3.1 | Connecting 32.768-kHz/38.4-kHz Crystal Resonator..... | 78 |
| 4.3.2 | Pin Connection when Not Using Subclock..... | 79 |
| 4.3.3 | External Clock Input | 80 |
| 4.4 | Prescalers | 80 |
| 4.4.1 | Prescaler S | 80 |
| 4.4.2 | Prescaler W | 80 |
| 4.5 | Usage Notes | 81 |
| 4.5.1 | Note on Resonators | 81 |
| 4.5.2 | Notes on Board Design | 82 |
| 4.5.3 | Definition of Oscillation Stabilization Standby Time..... | 83 |
| 4.5.4 | Notes on Use of Resonator | 85 |

| | | |
|-----------|--|-----|
| Section 5 | Power-Down Modes | 87 |
| 5.1 | Register Descriptions | 88 |
| 5.1.1 | System Control Register 1 (SYSCR1) | 88 |
| 5.1.2 | System Control Register 2 (SYSCR2) | 90 |
| 5.1.3 | Clock Halt Registers 1 and 2 (CKSTPR1 and CKSTPR2) | 91 |
| 5.2 | Mode Transitions and States of LSI | 92 |
| 5.2.1 | Sleep Mode | 98 |
| 5.2.2 | Standby Mode | 99 |
| 5.2.3 | Watch Mode | 99 |
| 5.2.4 | Subsleep Mode | 100 |
| 5.2.5 | Subactive Mode | 100 |
| 5.2.6 | Active (Medium-Speed) Mode | 101 |
| 5.3 | Direct Transition | 102 |
| 5.3.1 | Direct Transition from Active (High-Speed) Mode to Active (Medium-Speed) Mode | 103 |
| 5.3.2 | Direct Transition from Active (Medium-Speed) Mode to Active (High-Speed) Mode | 104 |
| 5.3.3 | Direct Transition from Subactive Mode to Active (High-Speed) Mode | 104 |
| 5.3.4 | Direct Transition from Subactive Mode to Active (Medium-Speed) Mode | 105 |
| 5.3.5 | Notes on External Input Signal Changes before/after Direct Transition | 105 |
| 5.4 | Module Standby Function | 106 |
| 5.5 | Usage Notes | 106 |
| 5.5.1 | Standby Mode Transition and Pin States | 106 |
| 5.5.2 | Notes on External Input Signal Changes before/after Standby Mode | 107 |
| Section 6 | ROM | 109 |
| 6.1 | Block Diagram | 109 |
| 6.2 | Overview of Flash Memory | 110 |
| 6.2.1 | Features | 110 |
| 6.2.2 | Block Diagram | 111 |
| 6.2.3 | Block Configuration | 112 |
| 6.3 | Register Descriptions | 113 |
| 6.3.1 | Flash Memory Control Register 1 (FLMCR1) | 114 |
| 6.3.2 | Flash Memory Control Register 2 (FLMCR2) | 115 |
| 6.3.3 | Erase Block Register (EBR) | 115 |
| 6.3.4 | Flash Memory Power Control Register (FLPWCR) | 116 |
| 6.3.5 | Flash Memory Enable Register (FENR) | 116 |
| 6.4 | On-Board Programming Modes | 117 |
| 6.4.1 | Boot Mode | 117 |

| | | |
|---------------------------|---|-----|
| 6.4.2 | Programming/Erasing in User Program Mode..... | 120 |
| 6.5 | Flash Memory Programming/Erasing | 121 |
| 6.5.1 | Program/Program-Verify | 122 |
| 6.5.2 | Erase/Erase-Verify | 125 |
| 6.5.3 | Interrupt Handling when Programming/Erasing Flash Memory..... | 125 |
| 6.6 | Program/Erase Protection | 127 |
| 6.6.1 | Hardware Protection | 127 |
| 6.6.2 | Software Protection..... | 127 |
| 6.6.3 | Error Protection..... | 127 |
| 6.7 | Programmer Mode | 128 |
| 6.7.1 | Socket Adapter..... | 128 |
| 6.7.2 | Programmer Mode Commands | 128 |
| 6.7.3 | Memory Read Mode | 131 |
| 6.7.4 | Auto-Program Mode | 134 |
| 6.7.5 | Auto-Erase Mode | 136 |
| 6.7.6 | Status Read Mode | 137 |
| 6.7.7 | Status Polling | 139 |
| 6.7.8 | Programmer Mode Transition Time | 140 |
| 6.7.9 | Notes on Memory Programming..... | 140 |
| 6.8 | Power-Down States for Flash Memory..... | 141 |
| Section 7 RAM | | 143 |
| 7.1 | Block Diagram..... | 144 |
| Section 8 I/O Ports | | 145 |
| 8.1 | Port 3..... | 147 |
| 8.1.1 | Port Data Register 3 (PDR3)..... | 148 |
| 8.1.2 | Port Control Register 3 (PCR3) | 148 |
| 8.1.3 | Port Pull-Up Control Register 3 (PUCR3)..... | 149 |
| 8.1.4 | Port Mode Register 3 (PMR3) | 150 |
| 8.1.5 | Port Mode Register 2 (PMR2) | 151 |
| 8.1.6 | Pin Functions | 152 |
| 8.1.7 | Input Pull-Up MOS..... | 153 |
| 8.2 | Port 4..... | 154 |
| 8.2.1 | Port Data Register 4 (PDR4)..... | 154 |
| 8.2.2 | Port Control Register 4 (PCR4) | 155 |
| 8.2.3 | Serial Port Control Register (SPCR)..... | 155 |
| 8.2.4 | Pin Functions | 157 |
| 8.3 | Port 5..... | 158 |
| 8.3.1 | Port Data Register 5 (PDR5)..... | 159 |

| | | |
|-----------------------|--|-----|
| 8.3.2 | Port Control Register 5 (PCR5) | 159 |
| 8.3.3 | Port Pull-Up Control Register 5 (PUCR5)..... | 160 |
| 8.3.4 | Port Mode Register 5 (PMR5) | 160 |
| 8.3.5 | Pin Functions | 161 |
| 8.3.6 | Input Pull-Up MOS..... | 162 |
| 8.4 | Port 6..... | 162 |
| 8.4.1 | Port Data Register 6 (PDR6) | 163 |
| 8.4.2 | Port Control Register 6 (PCR6) | 163 |
| 8.4.3 | Port Pull-Up Control Register 6 (PUCR6)..... | 164 |
| 8.4.4 | Pin Functions | 164 |
| 8.4.5 | Input Pull-Up MOS..... | 165 |
| 8.5 | Port 7..... | 165 |
| 8.5.1 | Port Data Register 7 (PDR7) | 166 |
| 8.5.2 | Port Control Register 7 (PCR7) | 166 |
| 8.5.3 | Pin Functions | 167 |
| 8.6 | Port 8..... | 167 |
| 8.6.1 | Port Data Register 8 (PDR8) | 168 |
| 8.6.2 | Port Control Register 8 (PCR8) | 168 |
| 8.6.3 | Pin Functions | 168 |
| 8.7 | Port 9..... | 169 |
| 8.7.1 | Port Data Register 9 (PDR9) | 169 |
| 8.7.2 | Port Mode Register 9 (PMR9) | 170 |
| 8.7.3 | Pin Functions | 170 |
| 8.8 | Port A..... | 171 |
| 8.8.1 | Port Data Register A (PDRA)..... | 171 |
| 8.8.2 | Port Control Register A (PCRA) | 172 |
| 8.8.3 | Pin Functions | 172 |
| 8.9 | Port B..... | 173 |
| 8.9.1 | Port Data Register B (PDRB) | 174 |
| 8.9.2 | Port Mode Register B (PMRB)..... | 174 |
| 8.9.3 | Pin Functions | 175 |
| 8.10 | Usage Notes..... | 176 |
| 8.10.1 | How to Handle Unused Pin | 176 |
| Section 9 Timers..... | | 177 |
| 9.1 | Overview | 177 |
| 9.2 | Timer A..... | 178 |
| 9.2.1 | Features..... | 178 |
| 9.2.2 | Register Descriptions..... | 179 |
| 9.2.3 | Operation | 181 |

| | | |
|---|---|------------|
| 9.2.4 | Timer A Operating States | 182 |
| 9.3 | Timer F | 182 |
| 9.3.1 | Features..... | 182 |
| 9.3.2 | Input/Output Pins | 184 |
| 9.3.3 | Register Descriptions | 184 |
| 9.3.4 | CPU Interface | 188 |
| 9.3.5 | Operation | 191 |
| 9.3.6 | Timer F Operating States | 193 |
| 9.3.7 | Usage Notes | 194 |
| 9.4 | Asynchronous Event Counter (AEC)..... | 198 |
| 9.4.1 | Features..... | 198 |
| 9.4.2 | Input/Output Pins | 200 |
| 9.4.3 | Register Descriptions | 200 |
| 9.4.4 | Operation | 207 |
| 9.4.5 | Operating States of Asynchronous Event Counter..... | 212 |
| 9.4.6 | Usage Notes | 213 |
| 9.5 | Watchdog Timer | 214 |
| 9.5.1 | Features..... | 214 |
| 9.5.2 | Register Descriptions | 215 |
| 9.5.3 | Operation | 217 |
| 9.5.4 | Operating States of Watchdog Timer..... | 218 |
| Section 10 Serial Communication Interface 3 (SCI3) | | 219 |
| 10.1 | Features..... | 219 |
| 10.2 | Input/Output Pins | 221 |
| 10.3 | Register Descriptions | 221 |
| 10.3.1 | Receive Shift Register (RSR) | 221 |
| 10.3.2 | Receive Data Register (RDR)..... | 222 |
| 10.3.3 | Transmit Shift Register (TSR)..... | 222 |
| 10.3.4 | Transmit Data Register (TDR)..... | 222 |
| 10.3.5 | Serial Mode Register (SMR) | 223 |
| 10.3.6 | Serial Control Register 3 (SCR3)..... | 226 |
| 10.3.7 | Serial Status Register (SSR) | 228 |
| 10.3.8 | Bit Rate Register (BRR) | 231 |
| 10.3.9 | Serial Port Control Register (SPCR)..... | 237 |
| 10.4 | Operation in Asynchronous Mode | 238 |
| 10.4.1 | Clock..... | 239 |
| 10.4.2 | SCI3 Initialization..... | 243 |
| 10.4.3 | Data Transmission | 244 |
| 10.4.4 | Serial Data Reception | 246 |

| | | |
|--------------------------------|--|-----|
| 10.5 | Operation in Clocked Synchronous Mode | 250 |
| 10.5.1 | Clock | 250 |
| 10.5.2 | SCI3 Initialization | 250 |
| 10.5.3 | Serial Data Transmission | 251 |
| 10.5.4 | Serial Data Reception | 254 |
| 10.5.5 | Simultaneous Serial Data Transmission and Reception | 256 |
| 10.6 | Interrupts | 258 |
| 10.7 | Usage Notes | 261 |
| 10.7.1 | Break Detection and Processing | 261 |
| 10.7.2 | Mark State and Break Sending | 261 |
| 10.7.3 | Receive Error Flags and Transmit Operations (Clocked Synchronous Mode Only) | 261 |
| 10.7.4 | Receive Data Sampling Timing and Reception Margin in Asynchronous Mode | 261 |
| 10.7.5 | Note on Switching SCK32 Function | 263 |
| 10.7.6 | Relation between Writing to TDR and Bit TDRE | 263 |
| 10.7.7 | Relation between RDR Reading and bit RDRF | 264 |
| 10.7.8 | Transmit and Receive Operations when Making State Transition | 264 |
| 10.7.9 | Setting in Subactive or Subsleep Mode | 265 |
| Section 11 10-Bit PWM | | 267 |
| 11.1 | Features | 267 |
| 11.2 | Input/Output Pins | 268 |
| 11.3 | Register Descriptions | 269 |
| 11.3.1 | PWM Control Register (PWCR) | 269 |
| 11.3.2 | PWM Data Registers U and L (PWDRU, PWDRL) | 270 |
| 11.4 | Operation | 271 |
| 11.4.1 | Operation | 271 |
| 11.4.2 | PWM Operating States | 272 |
| Section 12 A/D Converter | | 273 |
| 12.1 | Features | 273 |
| 12.2 | Input/Output Pins | 275 |
| 12.3 | Register Descriptions | 275 |
| 12.3.1 | A/D Result Registers H and L (ADRRH and ADDRRL) | 275 |
| 12.3.2 | A/D Mode Register (AMR) | 276 |
| 12.3.3 | A/D Start Register (ADSR) | 277 |
| 12.4 | Operation | 277 |
| 12.4.1 | A/D Conversion | 277 |
| 12.4.2 | Operating States of A/D Converter | 278 |

| | | |
|--|---|------------|
| 12.5 | Example of Use..... | 278 |
| 12.6 | A/D Conversion Accuracy Definitions | 281 |
| 12.7 | Usage Notes | 283 |
| 12.7.1 | Permissible Signal Source Impedance | 283 |
| 12.7.2 | Influences on Absolute Accuracy | 283 |
| 12.7.3 | Additional Usage Notes | 284 |
| Section 13 List of Registers | | 285 |
| 13.1 | Register Addresses (Address Order)..... | 286 |
| 13.2 | Register Bits..... | 289 |
| 13.3 | Register States in Each Operating Mode | 292 |
| Section 14 Electrical Characteristics | | 295 |
| 14.1 | Absolute Maximum Ratings of H8/38704 Group (Flash Memory Version, Mask ROM Version), H8/38702S Group (Mask ROM Version) | 295 |
| 14.2 | Electrical Characteristics of H8/38704 Group (Flash Memory Version, Mask ROM Version), H8/38702S Group (Mask ROM Version) | 296 |
| 14.2.1 | Power Supply Voltage and Operating Ranges | 296 |
| 14.2.2 | DC Characteristics | 301 |
| 14.2.3 | AC Characteristics | 311 |
| 14.2.4 | A/D Converter Characteristics | 315 |
| 14.2.5 | Flash Memory Characteristics | 317 |
| 14.3 | Operation Timing..... | 319 |
| 14.4 | Output Load Condition | 321 |
| 14.5 | Resonator Equivalent Circuit..... | 321 |
| 14.6 | Usage Note..... | 322 |
| Appendix..... | | 323 |
| A. | Instruction Set..... | 323 |
| A.1 | Instruction List..... | 323 |
| A.2 | Operation Code Map..... | 338 |
| A.3 | Number of Execution States | 341 |
| A.4 | Combinations of Instructions and Addressing Modes | 352 |
| B. | I/O Port Block Diagrams | 353 |
| B.1 | Port 3 Block Diagrams..... | 353 |
| B.2 | Port 4 Block Diagrams..... | 357 |
| B.3 | Port 5 Block Diagram | 361 |
| B.4 | Port 6 Block Diagram | 362 |

| | | |
|-------------|---|-----|
| B.5 | Port 7 Block Diagram | 363 |
| B.6 | Port 8 Block Diagram | 364 |
| B.7 | Port 9 Block Diagrams..... | 365 |
| B.8 | Port A Block Diagram | 366 |
| B.9 | Port B Block Diagrams..... | 367 |
| C. | Port States in Each Operating State | 368 |
| D. | Product Code Lineup | 369 |
| E. | Package Dimensions | 372 |
| Index | | 377 |

Section 1 Overview

1.1 Features

Microcontrollers of the H8/38704 Group and the H8/38702S Group are CISC (complex instruction set computer) microcontrollers whose core is an H8/300H CPU, which has an internal 32-bit architecture. The H8/300H CPU provides upward compatibility with the H8/300 CPUs of other Renesas Technology-original microcontrollers.

As peripheral functions, each LSI of these Groups includes various timer functions that realize low-cost configurations for end systems. The power consumption of these modules can be kept down dynamically by power-down mode.

1.1.1 Application

Examples of the applications of this LSI include motor control, power meter, and health equipment.

1.1.2 Overview of Specifications

Table 1.1 lists the functions of H8/38704, H8/38702S Group products in outline.

Table 1.1 Overview of Functions

| Classification | Module/ Function | Description | |
|--------------------|-----------------------------|--|---|
| Memory | — | <ul style="list-style-type: none"> ROM lineup: Flash memory version and mask Rom version ROM capacity: 8 k, 12 k, 16 k, 24 k, and 32 kbytes | |
| | RAM | <ul style="list-style-type: none"> RAM capacity: 512 and 1024 bytes | |
| CPU | CPU | <ul style="list-style-type: none"> H8/300H CPU (CISC type) Upward compatibility for H8/300 CPU at object level Sixteen 16-bit general registers Eight addressing modes 64-Kbyte address space Program: 64 Kbytes available Data: 64 Kbytes available 62 basic instructions, classifiable as bit arithmetic and logic instructions, multiply and divide instructions, bit manipulation instructions, and others Minimum instruction execution time: 400 ns (for an ADD instruction while system clock $\phi = 5$ MHz and $V_{cc} = 2.7$ to 3.6 V) On-chip multiplier ($16 \times 16 \rightarrow 32$ bits) | |
| | | Operating mode | <ul style="list-style-type: none"> Normal mode |
| | | MCU operating mode | Mode: Single-chip mode <ul style="list-style-type: none"> Low power consumption state (transition driven by the SLEEP instruction) |
| Interrupt (source) | Interrupt controller (INTC) | <ul style="list-style-type: none"> Eleven external interrupt pins ($\overline{\text{IRQAEC}}$, $\overline{\text{IRQ1}}$, $\overline{\text{IRQ0}}$, $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$) Seven internal interrupt sources Independent vector addresses | |

| Classification | Module/ Function | Description |
|----------------|----------------------------------|---|
| Clock | Clock pulse generator (CPG) | <ul style="list-style-type: none"> • Two clock generation circuits available • Separate clock signals are provided for each of functional modules • Includes frequency division circuit, so the operating frequency is selectable • Seven low-power-consumption modes: Active (medium speed) mode, sleep (high speed or medium speed) mode, subactive mode, subsleep mode, standby mode, and watch mode |
| A/D converter | A/D converter (ADC) | <ul style="list-style-type: none"> • 10-bit resolution × four input channels • Sample and hold function included • Conversion time: 12.4 μs per channel (with φ at 5-MHz operation) • Method of starting A/D conversion: software |
| Timer | 10-bit PWM | <ul style="list-style-type: none"> • 10 bits × two channels • Four conversion periods selectable • Pulse division method for less ripple |
| | Timer A | <ul style="list-style-type: none"> • 8-bit timer • Interval timer functionality: Eight interrupt periods are selectable • Clock time base functionality: Four overflow periods are selectable • Generates an interrupt upon overflow |
| | Timer F | <ul style="list-style-type: none"> • 16-bit timer (also can be used as two independent 8-bit timers) • Four counter input clocks • Output compare function supported • Toggle output function supported • two interrupt sources: Compare match and overflow |
| | Asynchronous event counter (AEC) | <ul style="list-style-type: none"> • 16-bit pulse timer (also can be used as two 8 bits × two channels) • Can count asynchronously-input external events |
| Watchdog timer | Watchdog timer (WDT) | 8 bits × one channel (selectable from two counter input clocks) |

| Classification | Module/ Function | Description |
|--|--|--|
| Serial interface | Serial communications interface 3 (SCI3) | <ul style="list-style-type: none"> • For both asynchronous and clock synchronous serial communications • Full-duplex communications capability • Select the desired bit rate • Six interrupt sources |
| I/O ports | | <ul style="list-style-type: none"> • Five CMOS input-only pins • 39 CMOS input/output pins • Six large-current-drive pins (port 9) • 23 pull-up resistors • Six open drains |
| Package | | <ul style="list-style-type: none"> • QFP-64: package code: FP-64A (package dimensions: 14 × 14 mm, pin pitch: 0.8 mm) • LQFP-64: package code: FP-64E (package dimensions: 10 × 10 mm, pin pitch: 0.5 mm) • LQFP-64: package code FP-64K (package dimensions: 10 × 10 mm, pin pitch: 0.5 mm) • P-VQFN-64: package code TNP-64B (package dimensions: 8 × 8 mm, pin pitch: 0.4 mm) <p>Packages FP-64E and FP-64K have different package dimensions. For details, see appendix E, Package Dimensions.</p> |
| Operating frequency/ Power supply voltage | | <ul style="list-style-type: none"> • Operating frequency: 2 to 10 MHz • Power supply voltage: <ul style="list-style-type: none"> Flash memory version: $V_{cc} = 2.2$ to 3.6 V, $AV_{cc} = 2.2$ to 3.6 V Mask ROM version: $V_{cc} = 1.8$ to 3.6 V, $AV_{cc} = 1.8$ to 3.6 V • Supply current: <ul style="list-style-type: none"> Flash memory version: 3.6 mA (typ.) ($V_{cc} = 3.0$ V, $AV_{cc} = 3.0$ V, $\phi = 10$ MHz) Mask ROM version: 3.1 mA (typ.) ($V_{cc} = 3.0$ V, $AV_{cc} = 3.0$ V, $\phi = 10$ MHz) |
| Operating peripheral temperature (°C) | | <ul style="list-style-type: none"> • -20 to +75°C (regular specifications) • -40 to +85°C (wide-range specifications) |

1.2 List of Products

Table 1.2 and figure 1.1 show the list of products and the structure of a product number, respectively.

Table 1.2 List of Products

| Group | Product Type | ROM Size | RAM Size | Package | Remarks |
|-----------------|--------------|-----------|-----------|-----------------------------------|----------------------|
| H8/38704 Group | HD64F38704 | 32 kbytes | 1 kbyte | FP-64A, FP-64E* ¹ , | Flash memory version |
| | HD64338704 | 32 kbytes | 1 kbyte | TNP-64B | Mask ROM version |
| | HD64338703 | 24 kbytes | 1 kbyte | | Mask ROM version |
| | HD64F38702 | 16 kbytes | 1 kbyte | | Flash memory version |
| | HD64338702 | 16 kbytes | 1 kbyte | | Mask ROM version |
| H8/38702S Group | HD64338702S | 16 kbytes | 512 bytes | FP-64A, FP-64K* ² , | Mask ROM version |
| | HD64338701S | 12 kbytes | 512 bytes | TNP-64B | Mask ROM version |
| | HD64338700S | 8 kbytes | 512 bytes | | Mask ROM version |

Notes: 1. FP-64E package is only available as an H8/38704 Group microcontroller.
2. FP-64K package is only available as an H8/38702S Group microcontroller.

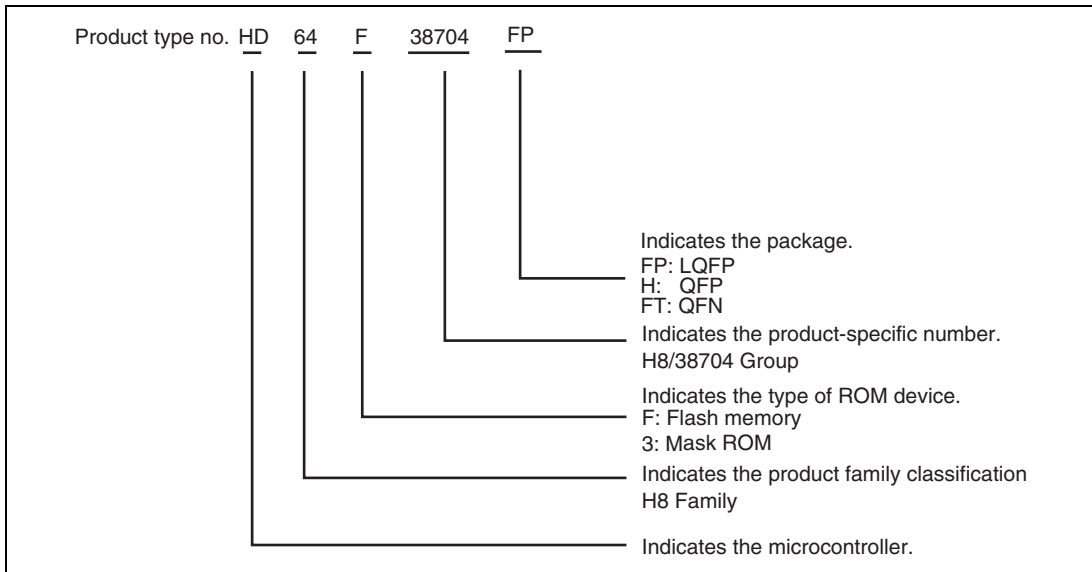


Figure 1.1 How to Read the Product Name Code

1.3 Block Diagram

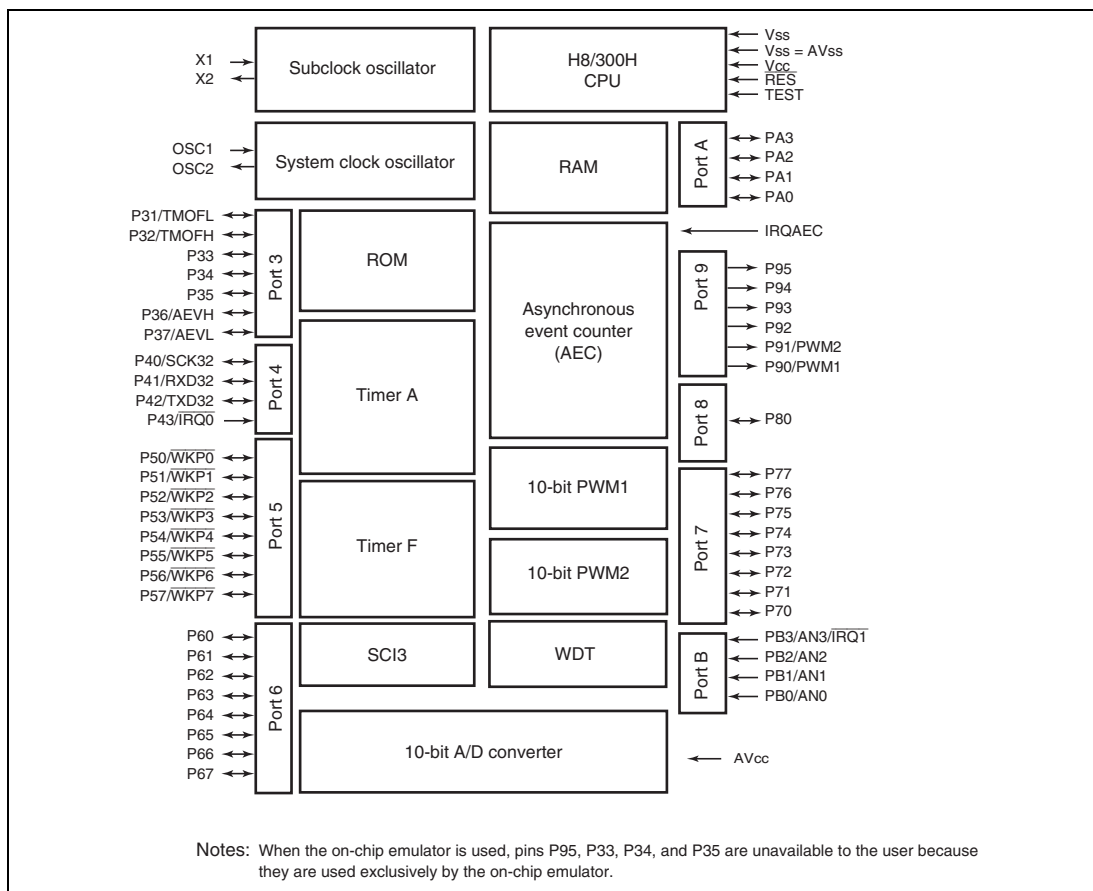
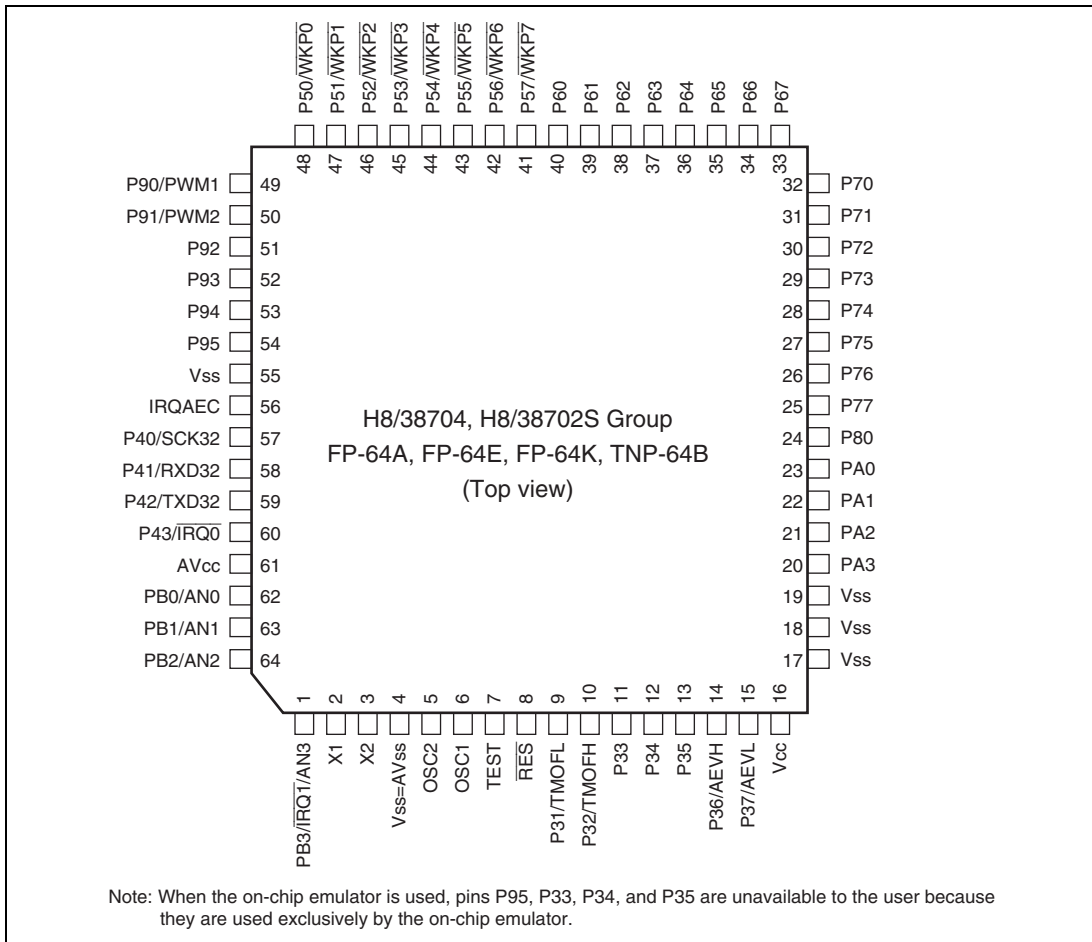


Figure 1.2 Block Diagram of H8/38704, H8/38702S Group

1.4 Pin Assignment



**Figure 1.3 Pin Assignment of H8/38704, H8/38702S Group
 (FP-64A, FP-64E, FP-64K, and TNP-64B)**

1.5 Pin Functions

Table 1.3 Pin Functions

| Type | Symbol | Pin No. | | Functions |
|-------------------|------------------|--|--------|--|
| | | FP-64A, FP-64E* ¹ , FP-64K* ² , TNP-64B | I/O | |
| Power source pins | V _{CC} | 16 | Input | Power supply pin. Connect this pin to the system power supply. |
| | V _{SS} | 4 (= AV _{SS}) 17, 18, 19, 55 | Input | Ground pin. Connect this pin to the system power supply (0V). |
| | AV _{CC} | 61 | Input | Analog power supply pin for the A/D converter. When the A/D converter is not used, connect this pin to the system power supply. |
| | AV _{SS} | 4 (= V _{SS}) | Input | Ground pin for the A/D converter. Connect this pin to the system power supply (0 V). |
| Clock pins | OSC1 | 6 | Input | These pins connect to a crystal or ceramic resonator for system clocks, or can be used to input an external clock. See section 4, Clock Pulse Generators, for a typical connection. |
| | OSC2 | 5 | Output | |
| | X1 | 2 | Input | These pins connect to a 32.768- or 38.4-kHz crystal resonator for subclocks. See section 4, Clock Pulse Generators, for a typical connection. |
| | X2 | 3 | Output | |
| System control | RES | 8 | Input | Reset pin. When this driven low, the chip is reset. |
| | TEST | 7 | Input | Test pin. Connect this pin to V _{SS} . Users cannot use this pin. |

| Type | Symbol | Pin No. | | Functions |
|----------------|---|--|--------|---|
| | | FP-64A, FP-64E* ¹ , FP-64K* ² , TNP-64B | I/O | |
| Interrupt pins | $\overline{\text{IRQ0}}$ | 60 | Input | External interrupt request input pins. Can select the rising or falling edge. |
| | $\overline{\text{IRQ1}}$ | 1 | | |
| | IRQAEC | 56 | Input | Asynchronous event counter interrupt input pin. Enables asynchronous event input. |
| | $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$ | 41 to 48 | Input | Wakeup interrupt request input pins. Can select the rising or falling edge. |
| Timer | AEVL | 15 | Input | This is an event input pin for input to the asynchronous event counter. |
| | AEVH | 14 | | |
| | TMOFL | 9 | Output | This is an output pin for waveforms generated by the timer FL output compare function. |
| | TMOFH | 10 | Output | This is an output pin for waveforms generated by the timer FH output compare function. |
| 10-bit PWM | PWM1 | 49 | Output | These are output pins for waveforms generated by the channel 1 and 2 10-bit PWMs. |
| | PWM2 | 50 | | |
| I/O ports | P37 to P31 | 15 to 9 | I/O | 7-bit I/O port. Input or output can be designated for each bit by means of the port control register 3 (PCR3). When the on-chip emulator is used, pins P33, P34, and P35 are unavailable to the user because they are used exclusively by the on-chip emulator. |
| | P43 | 60 | Input | 1-bit input port. |
| | P42 to P40 | 59 to 57 | I/O | 3-bit I/O port. Input or output can be designated for each bit by means of the port control register 4 (PCR4). |
| | P57 to P50 | 41 to 48 | I/O | 8-bit I/O port. Input or output can be designated for each bit by means of the port control register 5 (PCR5). |

| Type | Symbol | Pin No. | | Functions |
|---------------|---------------------------------------|--|--------|---|
| | | FP-64A, FP-64E* ¹ , FP-64K* ² , TNP-64B | I/O | |
| I/O ports | P67 to P60 | 33 to 40 | I/O | 8-bit I/O port. Input or output can be designated for each bit by means of the port control register 6 (PCR6). |
| | P77 to P70 | 25 to 32 | I/O | 8-bit I/O port. Input or output can be designated for each bit by means of the port control register 7 (PCR7). |
| | P80 | 24 | I/O | 1-bit I/O port. Input or output can be designated for each bit by means of the port control register 8 (PCR8). |
| | P95 to P90 | 54 to 49 | Output | 6-bit output port. When the on-chip emulator is used, pin P95 is unavailable to the user because it is used exclusively by the on-chip emulator. In the flash memory version, pin P95 should not be open but pulled up to go high in user mode. |
| | PA3 to PA0 | 20 to 23 | I/O | 4-bit I/O port. Input or output can be designated for each bit by means of the port control register A (PCRA). |
| | PB3 to PB0 | 1, 64 to 62 | Input | 4-bit input port. |
| | Serial communications interface (SCI) | RXD32 | 58 | Input |
| TXD32 | | 59 | Output | Transmit data output pin. |
| SCK32 | | 57 | I/O | Clock I/O pin. |
| A/D converter | AN3 to AN0 | 1, 64 to 62 | Input | Analog data input pins. |

- Notes: 1. FP-64E package is only available as an H8/38704 Group microcontroller.
2. FP-64K package is only available as an H8/38702S Group microcontroller.

Section 2 CPU

This LSI has an H8/300H CPU with an internal 32-bit architecture that is upward-compatible with the H8/300 CPU, and supports only normal mode, which has a 64-kbyte address space.

- Upward-compatible with H8/300 CPUs
 - Can execute H8/300 CPUs object programs
 - Additional eight 16-bit extended registers
 - 32-bit transfer and arithmetic and logic instructions are added
 - Signed multiply and divide instructions are added.
- General-register architecture
 - Sixteen 16-bit general registers also usable as sixteen 8-bit registers and eight 16-bit registers, or eight 32-bit registers
- Sixty-two basic instructions
 - 8/16/32-bit data transfer and arithmetic and logic instructions
 - Multiply and divide instructions
 - Powerful bit-manipulation instructions
- Eight addressing modes
 - Register direct [Rn]
 - Register indirect [@ERn]
 - Register indirect with displacement [@(d:16,ERn) or @(d:24,ERn)]
 - Register indirect with post-increment or pre-decrement [@ERn+ or @-ERn]
 - Absolute address [@aa:8, @aa:16, @aa:24]
 - Immediate [#xx:8, #xx:16, or #xx:32]
 - Program-counter relative [@(d:8,PC) or @(d:16,PC)]
 - Memory indirect [@@aa:8]
- 64-kbyte address space

- High-speed operation

All frequently-used instructions execute in one or two states

8/16/32-bit register-register add/subtract : 2 states

8 × 8-bit register-register multiply : 14 states

16 ÷ 8-bit register-register divide : 14 states

16 × 16-bit register-register multiply : 22 states

32 ÷ 16-bit register-register divide : 22 states

- Power-down state

Transition to power-down state by SLEEP instruction

2.1 Address Space and Memory Map

The address space of this LSI is 64 kbytes, which includes the program area and the data area.

Figures 2.1 show the memory map.

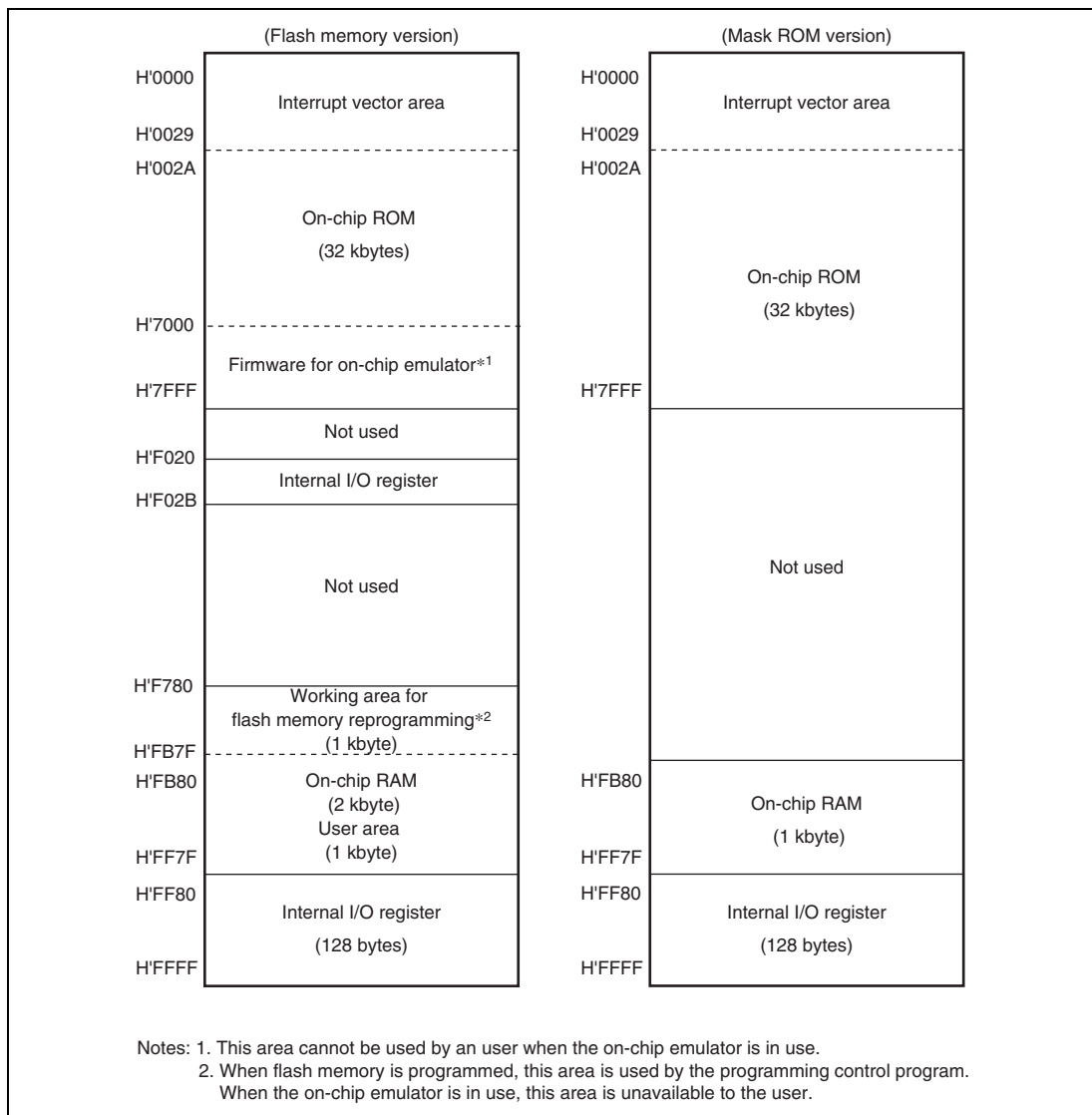


Figure 2.1(1) H8/38704 Memory Map

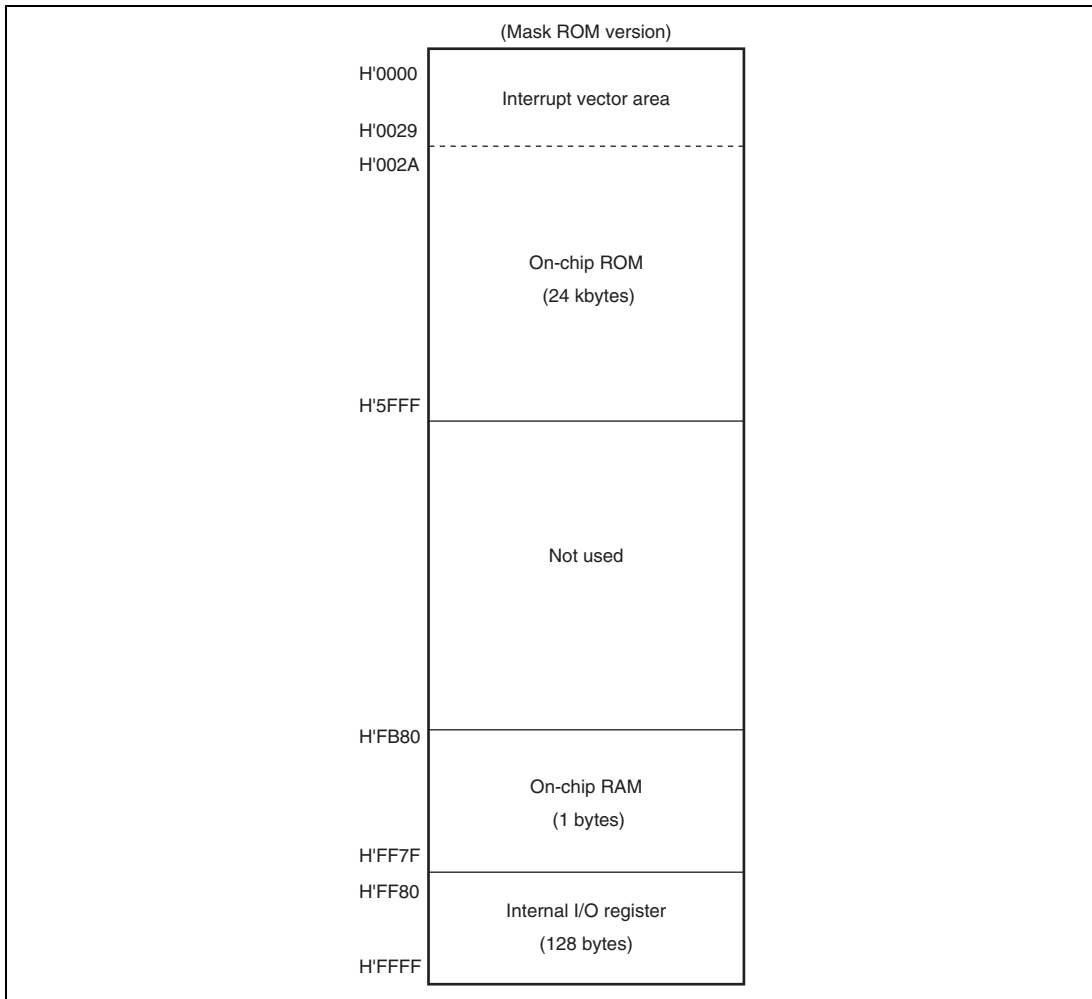


Figure 2.1(2) H8/38703 Memory Map

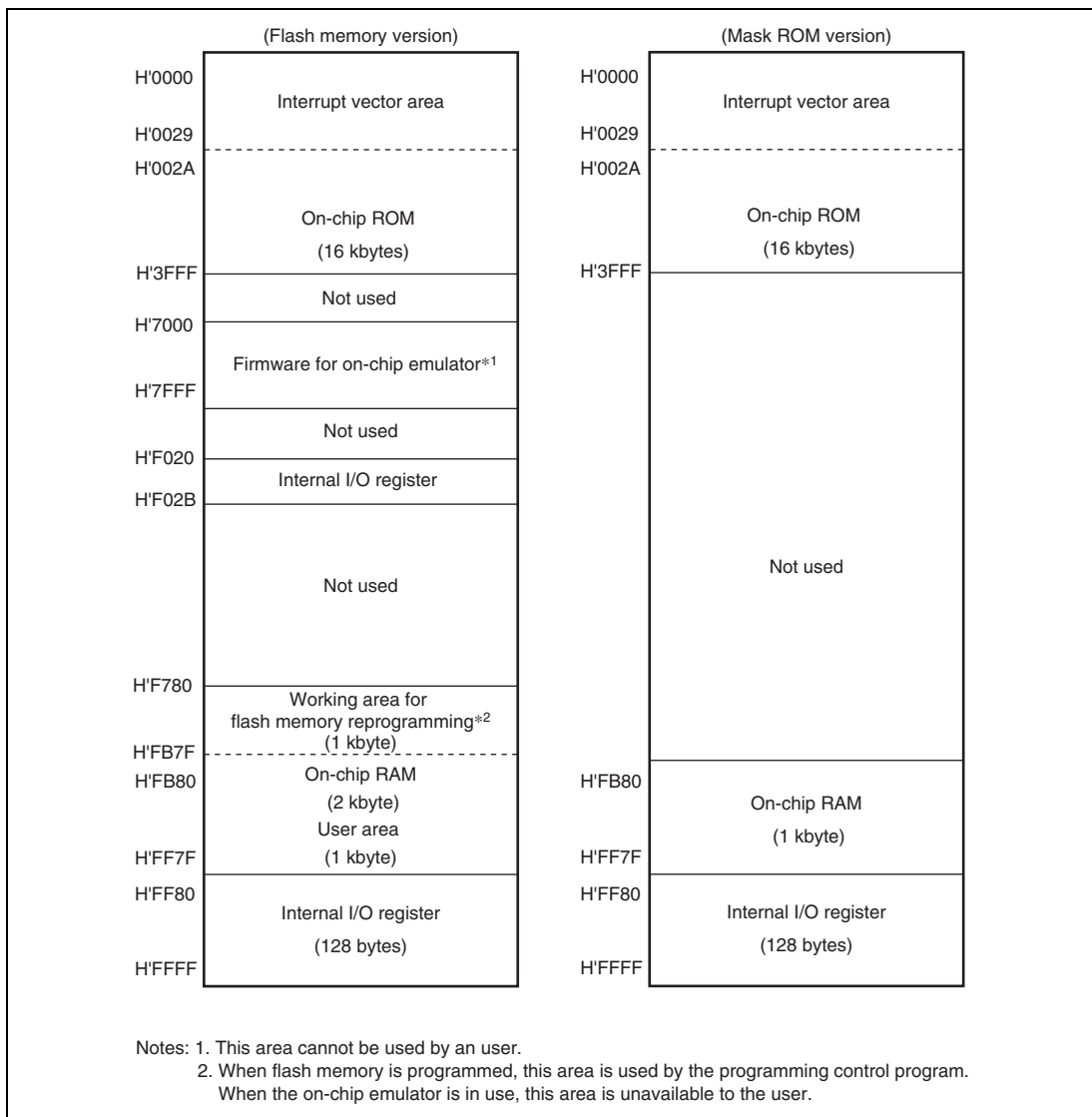


Figure 2.1(3) H8/38702 Memory Map

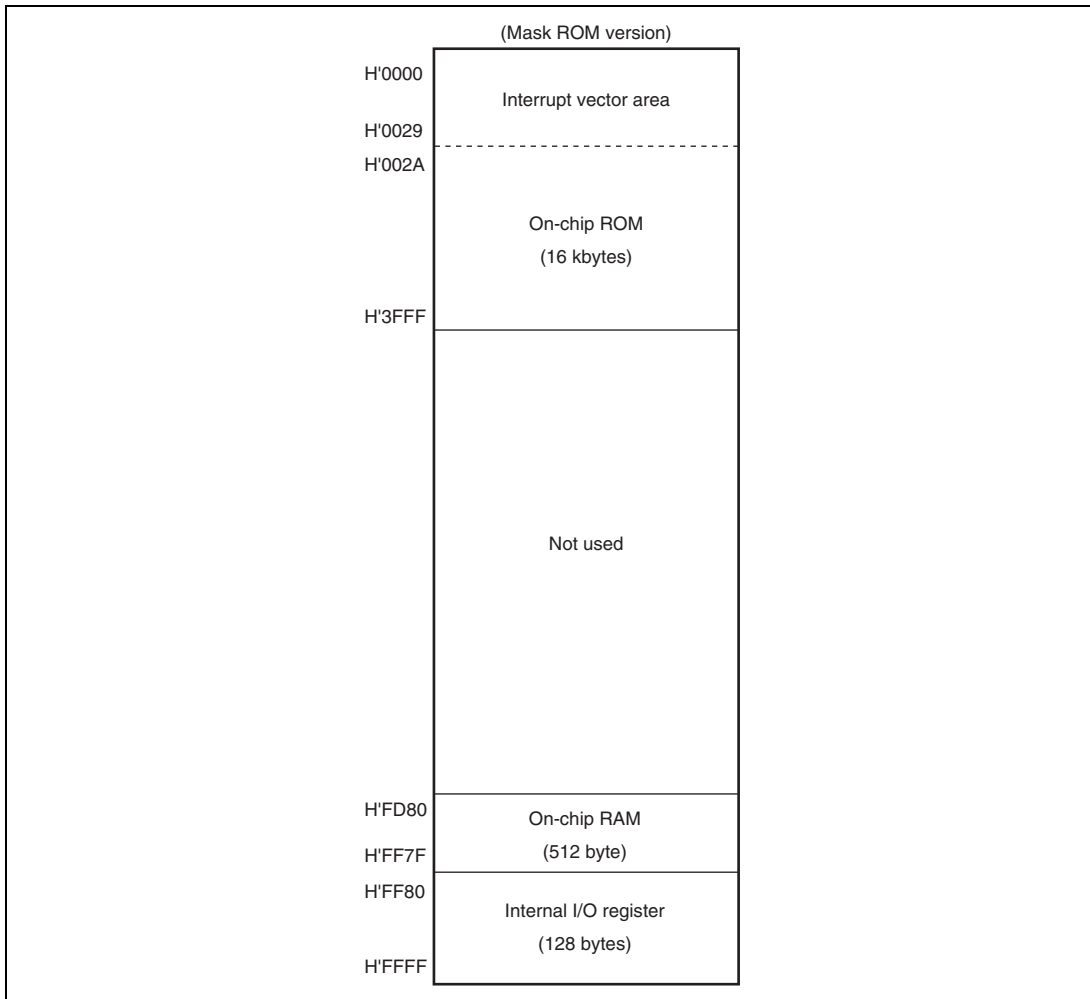
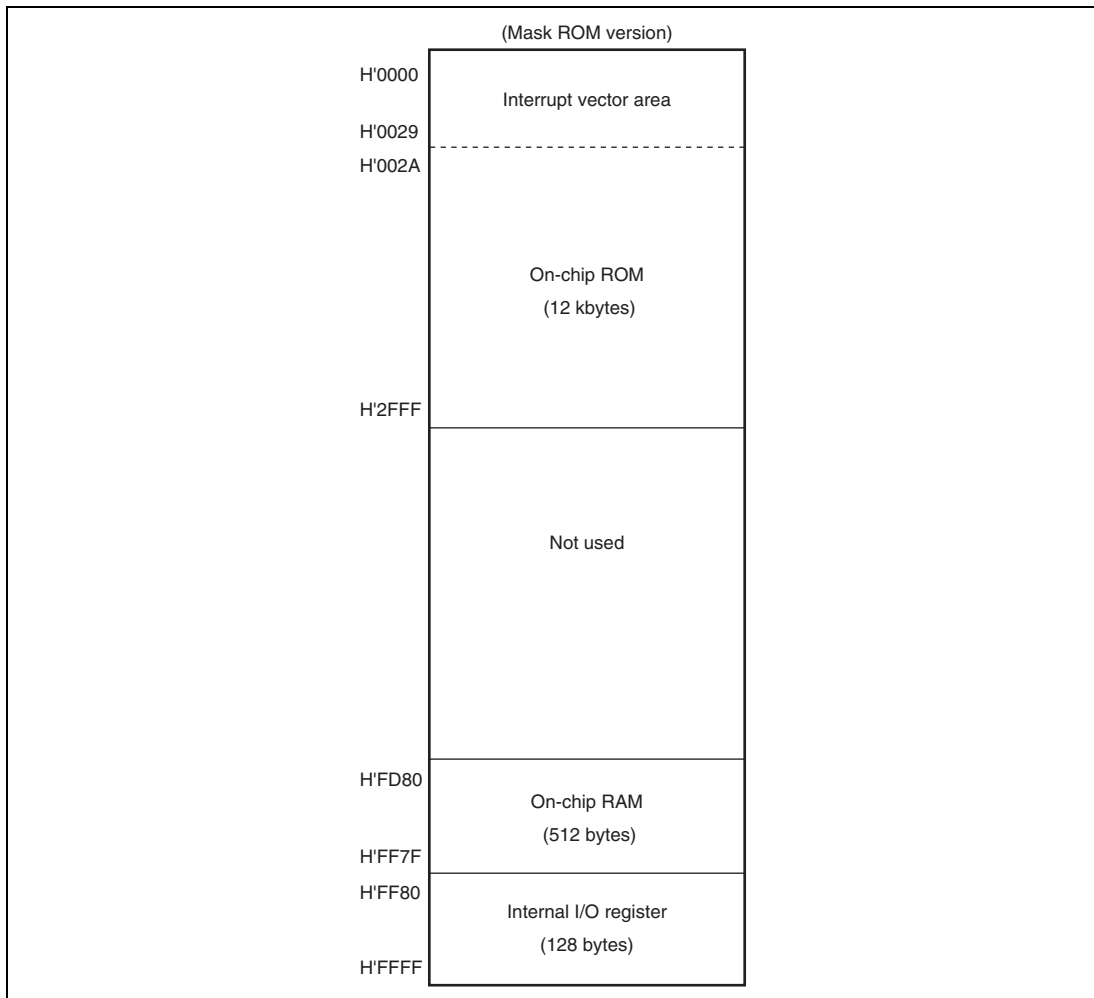


Figure 2.1(4) H8/38702S Memory Map

**Figure 2.1(5) H8/38701S Memory Map**

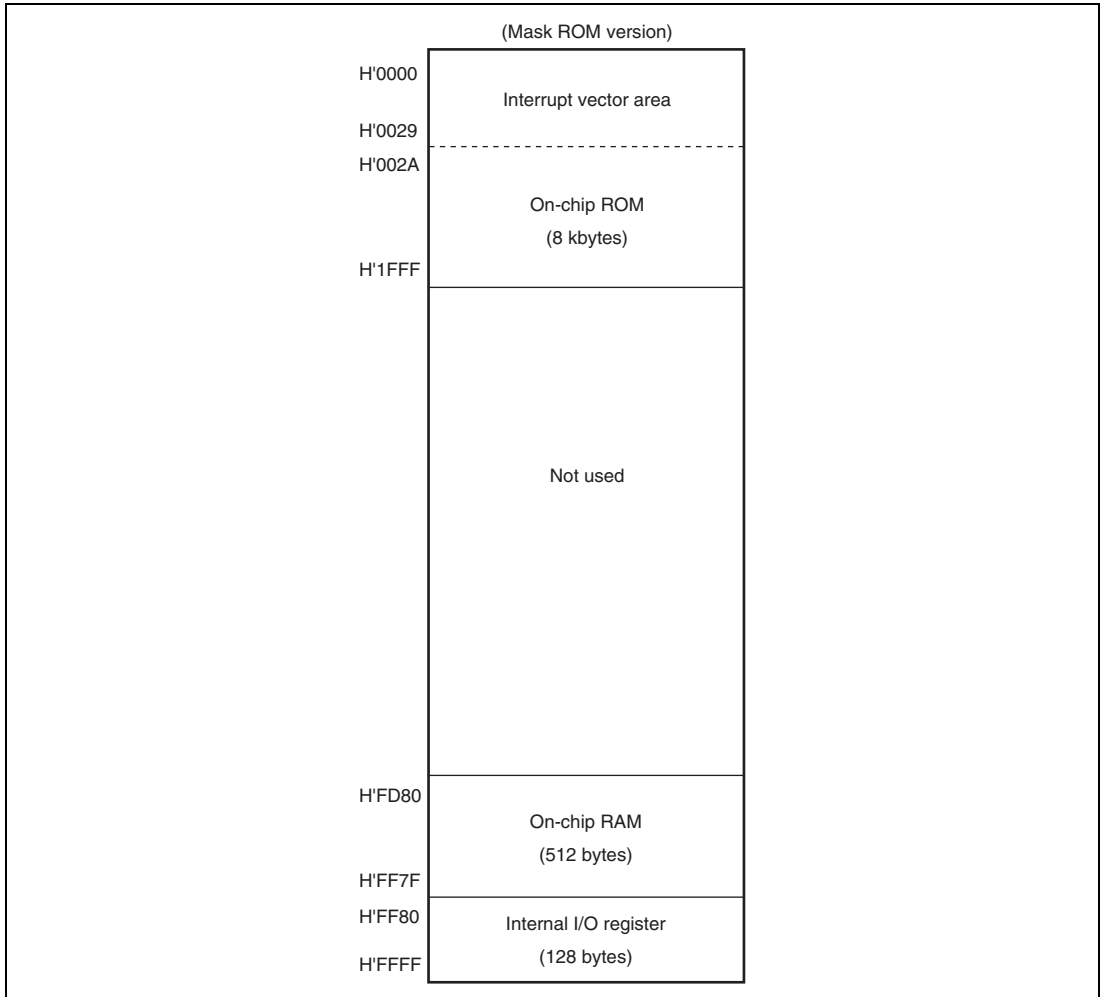


Figure 2.1(6) H8/38700S Memory Map

2.2 Register Configuration

The H8/300H CPU has the internal registers shown in figure 2.2. There are two types of registers; general registers and control registers. The control registers are a 24-bit program counter (PC), and an 8-bit condition-code register (CCR).

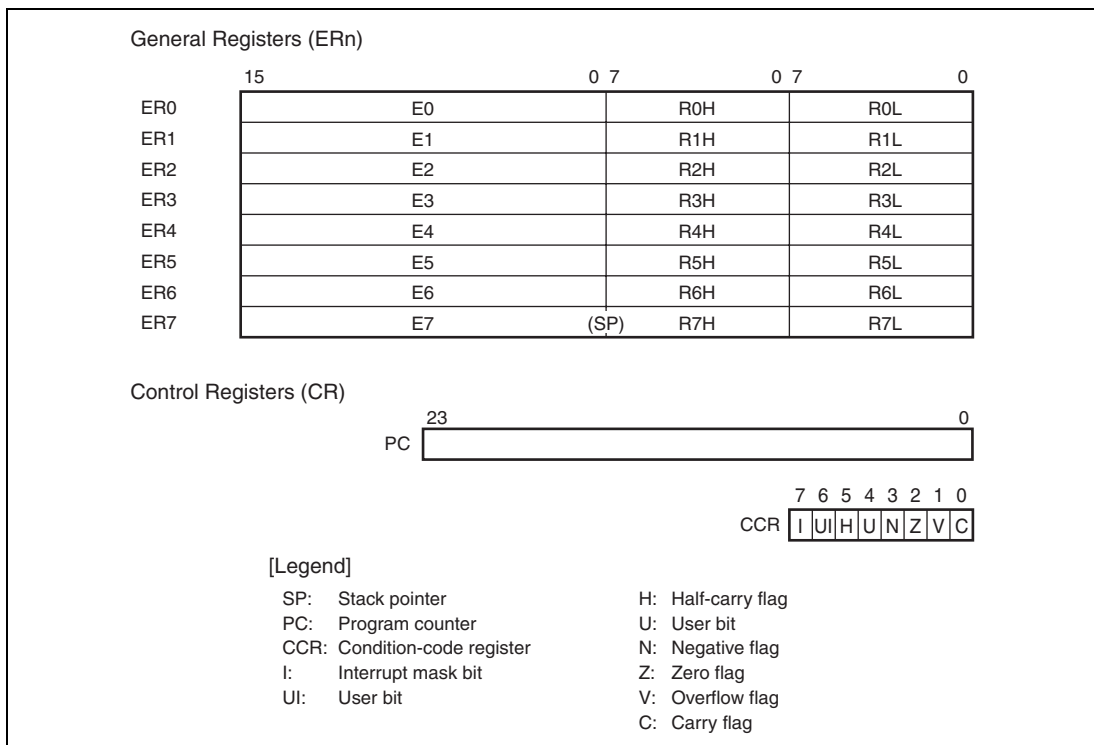


Figure 2.2 CPU Registers

2.2.1 General Registers

The H8/300H CPU has eight 32-bit general registers. These general registers are all functionally identical and can be used as both address registers and data registers. When a general register is used as a data register, it can be accessed as a 32-bit, 16-bit, or 8-bit register. Figure 2.3 illustrates the usage of the general registers. When the general registers are used as 32-bit registers or address registers, they are designated by the letters ER (ER0 to ER7).

The ER registers divide into 16-bit general registers designated by the letters E (E0 to E7) and R (R0 to R7). These registers are functionally equivalent, providing a maximum of sixteen 16-bit registers. The E registers (E0 to E7) are also referred to as extended registers.

The R registers divide into 8-bit registers designated by the letters RH (R0H to R7H) and RL (R0L to R7L). These registers are functionally equivalent, providing a maximum of sixteen 8-bit registers.

The usage of each register can be selected independently.

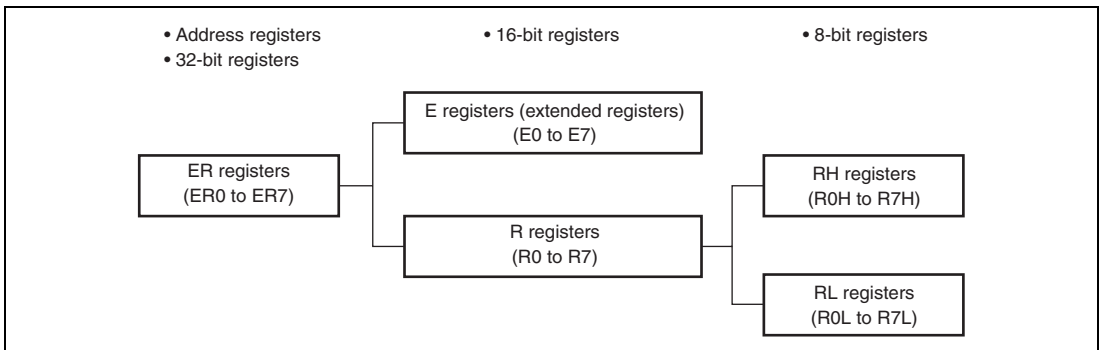


Figure 2.3 Usage of General Registers

General register ER7 has the function of the stack pointer (SP) in addition to its general-register function, and is used implicitly in exception handling and subroutine calls. Figure 2.4 shows the relationship between the stack pointer and the stack area.

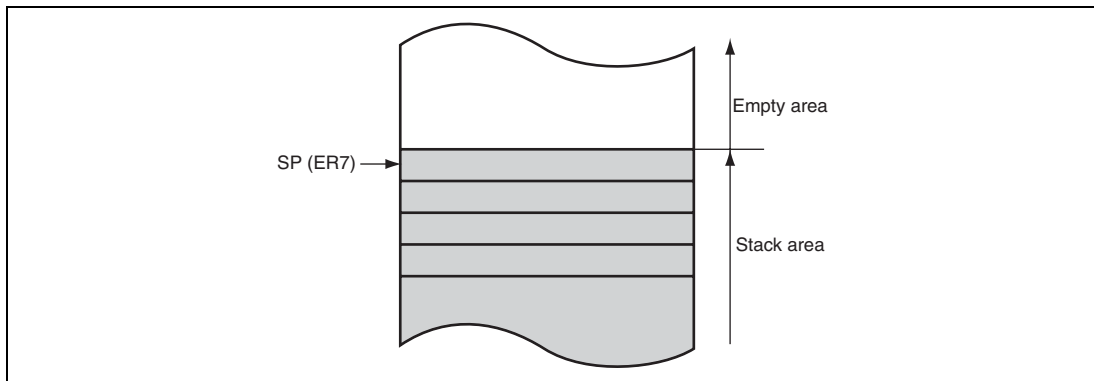


Figure 2.4 Relationship between Stack Pointer and Stack Area

2.2.2 Program Counter (PC)

This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. (When an instruction is fetched, the least significant PC bit is regarded as 0). The PC is initialized when the start address is loaded by the vector address generated during reset exception-handling sequence.

2.2.3 Condition-Code Register (CCR)

This 8-bit register contains internal CPU status information, including an interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags. The I bit is initialized to 1 by reset exception-handling sequence, but other bits are not initialized.

Some instructions leave flag bits unchanged. Operations can be performed on the CCR bits by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used as branching conditions for conditional branch (Bcc) instructions.

For the action of each instruction on the flag bits, see appendix A.1, Instruction List.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | I | 1 | R/W | <p>Interrupt Mask Bit</p> <p>Masks interrupts other than NMI when set to 1. NMI is accepted regardless of the I bit setting. The I bit is set to 1 at the start of an exception-handling sequence.</p> |
| 6 | UI | Undefined | R/W | <p>User Bit</p> <p>Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.</p> |
| 5 | H | Undefined | R/W | <p>Half-Carry Flag</p> <p>When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise.</p> |
| 4 | U | Undefined | R/W | <p>User Bit</p> <p>Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.</p> |
| 3 | N | Undefined | R/W | <p>Negative Flag</p> <p>Stores the value of the most significant bit of data as a sign bit.</p> |
| 2 | Z | Undefined | R/W | <p>Zero Flag</p> <p>Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data.</p> |
| 1 | V | Undefined | R/W | <p>Overflow Flag</p> <p>Set to 1 when an arithmetic overflow occurs, and cleared to 0 at other times.</p> |
| 0 | C | Undefined | R/W | <p>Carry Flag</p> <p>Set to 1 when a carry occurs, and cleared to 0 otherwise. Used by:</p> <ul style="list-style-type: none"> • Add instructions, to indicate a carry • Subtract instructions, to indicate a borrow • Shift and rotate instructions, to indicate a carry <p>The carry flag is also used as a bit accumulator by bit manipulation instructions.</p> |

2.3 Data Formats

The H8/300H CPU can process 1-bit, 4-bit (BCD), 8-bit (byte), 16-bit (word), and 32-bit (longword) data. Bit-manipulation instructions operate on 1-bit data by accessing bit n ($n = 0, 1, 2, \dots, 7$) of byte operand data. The DAA and DAS decimal-adjust instructions treat byte data as two digits of 4-bit BCD data.

2.3.1 General Register Data Formats

Figure 2.5 shows the data formats in general registers.

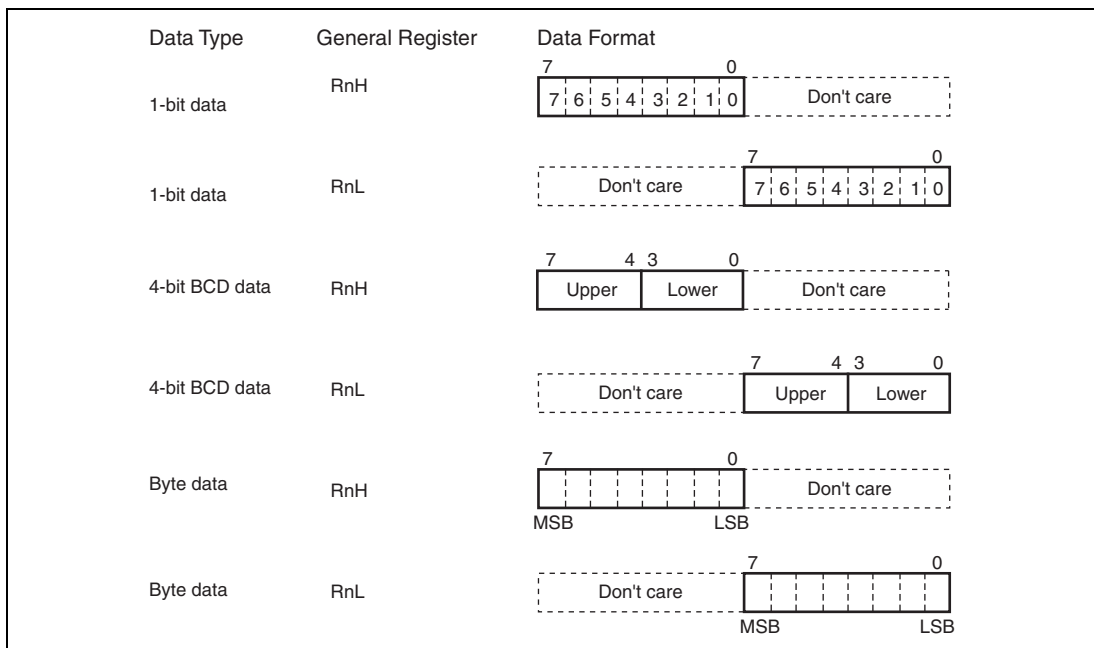


Figure 2.5 General Register Data Formats (1)

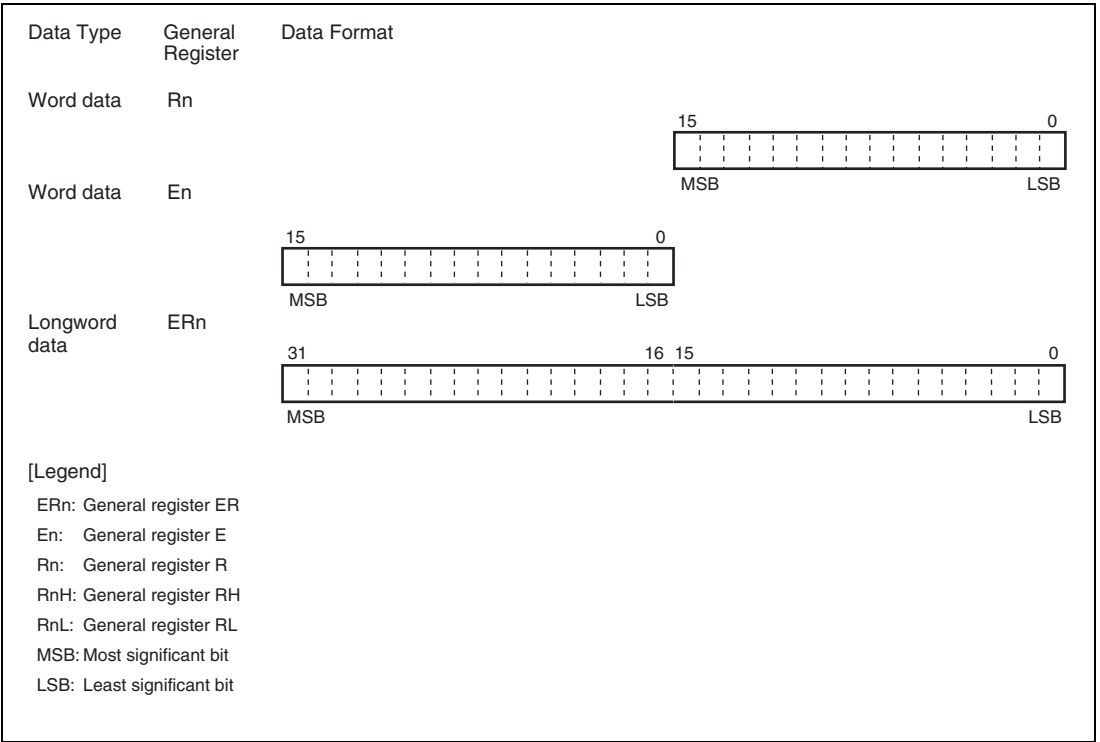


Figure 2.5 General Register Data Formats (2)

2.3.2 Memory Data Formats

Figure 2.6 shows the data formats in memory. The H8/300H CPU can access word data and longword data in memory, however word or longword data must begin at an even address. If an attempt is made to access word or longword data at an odd address, an address error does not occur, however the least significant bit of the address is regarded as 0, so access begins the preceding address. This also applies to instruction fetches.

When ER7 (SP) is used as an address register to access the stack area, the operand size should be word or longword.

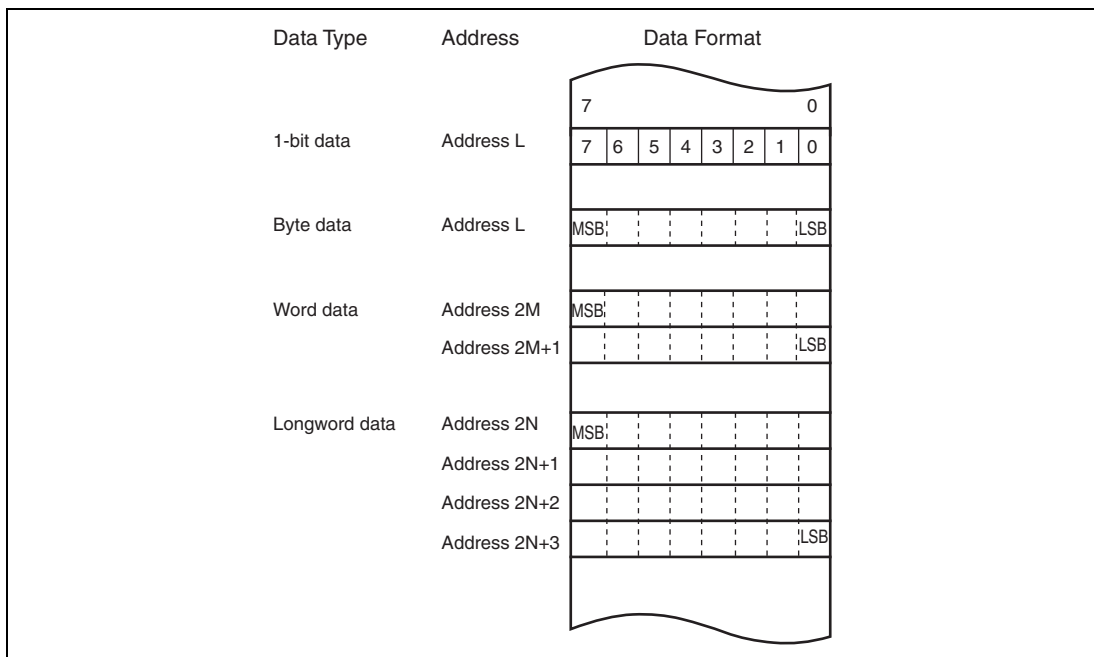


Figure 2.6 Memory Data Formats

2.4 Instruction Set

2.4.1 Table of Instructions Classified by Function

The H8/300H CPU has 62 instructions. Tables 2.2 to 2.9 summarize the instructions in each functional category. The notation used in tables 2.2 to 2.9 is defined in table 2.1.

Table 2.1 Operation Notation

| Symbol | Description |
|--------|--|
| Rd | General register (destination)* |
| Rs | General register (source)* |
| Rn | General register* |
| ERn | General register (32-bit register or address register) |
| (EAd) | Destination operand |
| (EAs) | Source operand |
| CCR | Condition-code register |
| N | N (negative) flag in CCR |
| Z | Z (zero) flag in CCR |
| V | V (overflow) flag in CCR |
| C | C (carry) flag in CCR |
| PC | Program counter |
| SP | Stack pointer |
| #IMM | Immediate data |
| disp | Displacement |
| + | Addition |
| − | Subtraction |
| × | Multiplication |
| ÷ | Division |
| ^ | Logical AND |
| ∨ | Logical OR |
| ⊕ | Logical XOR |
| → | Move |
| ¬ | NOT (logical complement) |

| Symbol | Description |
|---------------|-------------------------------|
| :3/:8/:16/:24 | 3-, 8-, 16-, or 24-bit length |

Note: * General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit registers/address register (ER0 to ER7).

Table 2.2 Data Transfer Instructions

| Instruction | Size* | Function |
|-------------|-------|---|
| MOV | B/W/L | (EAs) → Rd, Rs → (EAd) Moves data between two general registers or between a general register and memory, or moves immediate data to a general register. |
| MOVFP | B | (EAs) → Rd Cannot be used in this LSI. |
| MOVTP | B | Rs → (EAs) Cannot be used in this LSI. |
| POP | W/L | @SP+ → Rn Pops a general register from the stack. POP.W Rn is identical to MOV.W @SP+, Rn. POP.L ERn is identical to MOV.L @SP+, ERn. |
| PUSH | W/L | Rn → @-SP Pushes a general register onto the stack. PUSH.W Rn is identical to MOV.W Rn, @-SP. PUSH.L ERn is identical to MOV.L ERn, @-SP. |

Note: * Refers to the operand size.
B: Byte
W: Word
L: Longword

Table 2.3 Arithmetic Operations Instructions (1)

| Instruction | Size* | Function |
|--------------------|--------------|--|
| ADD SUB | B/W/L | $Rd \pm Rs \rightarrow Rd$, $Rd \pm \#IMM \rightarrow Rd$ Performs addition or subtraction on data in two general registers, or on immediate data and data in a general register (immediate byte data cannot be subtracted from byte data in a general register. Use the SUBX or ADD instruction.) |
| ADDX SUBX | B | $Rd \pm Rs \pm C \rightarrow Rd$, $Rd \pm \#IMM \pm C \rightarrow Rd$ Performs addition or subtraction with carry on byte data in two general registers, or on immediate data and data in a general register. |
| INC DEC | B/W/L | $Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$ Increments or decrements a general register by 1 or 2. (Byte operands can be incremented or decremented by 1 only.) |
| ADDS SUBS | L | $Rd \pm 1 \rightarrow Rd$, $Rd \pm 2 \rightarrow Rd$, $Rd \pm 4 \rightarrow Rd$ Adds or subtracts the value 1, 2, or 4 to or from data in a 32-bit register. |
| DAA DAS | B | Rd (decimal adjust) $\rightarrow Rd$ Decimal-adjusts an addition or subtraction result in a general register by referring to the CCR to produce 4-bit BCD data. |
| MULXU | B/W | $Rd \times Rs \rightarrow Rd$ Performs unsigned multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. |
| MULXS | B/W | $Rd \times Rs \rightarrow Rd$ Performs signed multiplication on data in two general registers: either 8 bits \times 8 bits \rightarrow 16 bits or 16 bits \times 16 bits \rightarrow 32 bits. |
| DIVXU | B/W | $Rd \div Rs \rightarrow Rd$ Performs unsigned division on data in two general registers: either 16 bits \div 8 bits \rightarrow 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \rightarrow 16-bit quotient and 16-bit remainder. |

Note: * Refers to the operand size.

B: Byte

W: Word

L: Longword

Table 2.3 Arithmetic Operations Instructions (2)

| Instruction | Size* | Function |
|--------------------|--------------|---|
| DIVXS | B/W | $Rd \div Rs \rightarrow Rd$ Performs signed division on data in two general registers: either 16 bits \div 8 bits \rightarrow 8-bit quotient and 8-bit remainder or 32 bits \div 16 bits \rightarrow 16-bit quotient and 16-bit remainder. |
| CMP | B/W/L | $Rd - Rs, Rd - \#IMM$ Compares data in a general register with data in another general register or with immediate data, and sets CCR bits according to the result. |
| NEG | B/W/L | $0 - Rd \rightarrow Rd$ Takes the two's complement (arithmetic complement) of data in a general register. |
| EXTU | W/L | Rd (zero extension) $\rightarrow Rd$ Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by padding with zeros on the left. |
| EXTS | W/L | Rd (sign extension) $\rightarrow Rd$ Extends the lower 8 bits of a 16-bit register to word size, or the lower 16 bits of a 32-bit register to longword size, by extending the sign bit. |

Note: * Refers to the operand size.

B: Byte

W: Word

L: Longword

Table 2.4 Logic Operations Instructions

| Instruction | Size* | Function |
|--------------------|--------------|---|
| AND | B/W/L | $Rd \wedge Rs \rightarrow Rd$, $Rd \wedge \#IMM \rightarrow Rd$ Performs a logical AND operation on a general register and another general register or immediate data. |
| OR | B/W/L | $Rd \vee Rs \rightarrow Rd$, $Rd \vee \#IMM \rightarrow Rd$ Performs a logical OR operation on a general register and another general register or immediate data. |
| XOR | B/W/L | $Rd \oplus Rs \rightarrow Rd$, $Rd \oplus \#IMM \rightarrow Rd$ Performs a logical exclusive OR operation on a general register and another general register or immediate data. |
| NOT | B/W/L | $\neg (Rd) \rightarrow (Rd)$ Takes the one's complement (logical complement) of general register contents. |

Note: * Refers to the operand size.

B: Byte

W: Word

L: Longword

Table 2.5 Shift Instructions

| Instruction | Size* | Function |
|--------------------|--------------|---|
| SHAL SHAR | B/W/L | $Rd \text{ (shift)} \rightarrow Rd$ Performs an arithmetic shift on general register contents. |
| SHLL SHLR | B/W/L | $Rd \text{ (shift)} \rightarrow Rd$ Performs a logical shift on general register contents. |
| ROTL ROTR | B/W/L | $Rd \text{ (rotate)} \rightarrow Rd$ Rotates general register contents. |
| ROTXL ROTXR | B/W/L | $Rd \text{ (rotate)} \rightarrow Rd$ Rotates general register contents through the carry flag. |

Note: * Refers to the operand size.

B: Byte

W: Word

L: Longword

Table 2.6 Bit Manipulation Instructions

| Instruction | Size* | Function |
|-------------|-------|---|
| BSET | B | $1 \rightarrow \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle$ Sets a specified bit in a general register or memory operand to 1. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BCLR | B | $0 \rightarrow \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle$ Clears a specified bit in a general register or memory operand to 0. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BNOT | B | $\neg \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle$ Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BTST | B | $\neg \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow Z$ Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower three bits of a general register. |
| BAND | B | $C \wedge \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ ANDs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| BIAND | B | $C \wedge \neg \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ ANDs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |
| BOR | B | $C \vee \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| BIOR | B | $C \vee \neg \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |
| BXOR | B | $C \oplus \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ XORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag. |
| BIXOR | B | $C \oplus \neg \langle \text{bit-No.} \rangle \text{ of } \langle \text{EAd} \rangle \rightarrow C$ XORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data. |

| Instruction | Size* | Function |
|--------------------|--------------|--|
| BLD | B | (<bit-No.> of <EAd>) → C Transfers a specified bit in a general register or memory operand to the carry flag. |
| BILD | B | \neg (<bit-No.> of <EAd>) → C Transfers the inverse of a specified bit in a general register or memory operand to the carry flag. The bit number is specified by 3-bit immediate data. |
| BST | B | C → (<bit-No.> of <EAd>) Transfers the carry flag value to a specified bit in a general register or memory operand. |
| BIST | B | \neg C → (<bit-No.> of <EAd>) Transfers the inverse of the carry flag value to a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data. |

Note: * Refers to the operand size.

B: Byte

Table 2.7 Branch Instructions

| Instruction | Size | Function | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|-------------|-------------------------------|--|----------|-------------|-----------|---------|---------------|--------|---------|---------------|-------|-----|------|----------------|-----|-------------|----------------|----------|-------------------------------|---------|----------|-----------------|---------|-----|-----------|---------|-----|-------|---------|-----|----------------|---------|-----|--------------|---------|-----|------|---------|-----|-------|---------|-----|------------------|------------------|-----|-----------|------------------|-----|--------------|---------------------------|-----|---------------|---------------------------|
| Bcc* | — | Branches to a specified address if a specified condition is true. The branching conditions are listed below. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Mnemonic</th> <th>Description</th> <th>Condition</th> </tr> </thead> <tbody> <tr> <td>BRA(BT)</td> <td>Always (true)</td> <td>Always</td> </tr> <tr> <td>BRN(BF)</td> <td>Never (false)</td> <td>Never</td> </tr> <tr> <td>BHI</td> <td>High</td> <td>$C \vee Z = 0$</td> </tr> <tr> <td>BLS</td> <td>Low or same</td> <td>$C \vee Z = 1$</td> </tr> <tr> <td>BCC(BHS)</td> <td>Carry clear (high or same)</td> <td>$C = 0$</td> </tr> <tr> <td>BCS(BLO)</td> <td>Carry set (low)</td> <td>$C = 1$</td> </tr> <tr> <td>BNE</td> <td>Not equal</td> <td>$Z = 0$</td> </tr> <tr> <td>BEQ</td> <td>Equal</td> <td>$Z = 1$</td> </tr> <tr> <td>BVC</td> <td>Overflow clear</td> <td>$V = 0$</td> </tr> <tr> <td>BVS</td> <td>Overflow set</td> <td>$V = 1$</td> </tr> <tr> <td>BPL</td> <td>Plus</td> <td>$N = 0$</td> </tr> <tr> <td>BMI</td> <td>Minus</td> <td>$N = 1$</td> </tr> <tr> <td>BGE</td> <td>Greater or equal</td> <td>$N \oplus V = 0$</td> </tr> <tr> <td>BLT</td> <td>Less than</td> <td>$N \oplus V = 1$</td> </tr> <tr> <td>BGT</td> <td>Greater than</td> <td>$Z \vee (N \oplus V) = 0$</td> </tr> <tr> <td>BLE</td> <td>Less or equal</td> <td>$Z \vee (N \oplus V) = 1$</td> </tr> </tbody> </table> | Mnemonic | Description | Condition | BRA(BT) | Always (true) | Always | BRN(BF) | Never (false) | Never | BHI | High | $C \vee Z = 0$ | BLS | Low or same | $C \vee Z = 1$ | BCC(BHS) | Carry clear (high or same) | $C = 0$ | BCS(BLO) | Carry set (low) | $C = 1$ | BNE | Not equal | $Z = 0$ | BEQ | Equal | $Z = 1$ | BVC | Overflow clear | $V = 0$ | BVS | Overflow set | $V = 1$ | BPL | Plus | $N = 0$ | BMI | Minus | $N = 1$ | BGE | Greater or equal | $N \oplus V = 0$ | BLT | Less than | $N \oplus V = 1$ | BGT | Greater than | $Z \vee (N \oplus V) = 0$ | BLE | Less or equal | $Z \vee (N \oplus V) = 1$ |
| Mnemonic | Description | Condition | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BRA(BT) | Always (true) | Always | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BRN(BF) | Never (false) | Never | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BHI | High | $C \vee Z = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BLS | Low or same | $C \vee Z = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BCC(BHS) | Carry clear (high or same) | $C = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BCS(BLO) | Carry set (low) | $C = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BNE | Not equal | $Z = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BEQ | Equal | $Z = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BVC | Overflow clear | $V = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BVS | Overflow set | $V = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BPL | Plus | $N = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BMI | Minus | $N = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BGE | Greater or equal | $N \oplus V = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BLT | Less than | $N \oplus V = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BGT | Greater than | $Z \vee (N \oplus V) = 0$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BLE | Less or equal | $Z \vee (N \oplus V) = 1$ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| JMP | — | Branches unconditionally to a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BSR | — | Branches to a subroutine at a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| JSR | — | Branches to a subroutine at a specified address. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RTS | — | Returns from a subroutine | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

Note: * Bcc is the general name for conditional branch instructions.

Table 2.8 System Control Instructions

| Instruction | Size* | Function |
|--------------------|--------------|---|
| RTE | — | Returns from an exception-handling routine. |
| SLEEP | — | Causes a transition to a power-down state. |
| LDC | B/W | (EAs) → CCR Moves the source operand contents to the CCR. The CCR size is one byte, but in transfer from memory, data is read by word access. |
| STC | B/W | CCR → (EAd) Transfers the CCR contents to a destination location. The condition code register size is one byte, but in transfer to memory, data is written by word access. |
| ANDC | B | CCR ∧ #IMM → CCR Logically ANDs the CCR with immediate data. |
| ORC | B | CCR ∨ #IMM → CCR Logically ORs the CCR with immediate data. |
| XORC | B | CCR ⊕ #IMM → CCR Logically XORs the CCR with immediate data. |
| NOP | — | PC + 2 → PC Only increments the program counter. |

Note: * Refers to the operand size.

B: Byte

W: Word

Table 2.9 Block Data Transfer Instructions

| Instruction | Size | Function |
|--------------------|-------------|--|
| EEPMOV.B | — | if R4L \neq 0 then Repeat @ER5+ \rightarrow @ER6+, R4L-1 \rightarrow R4L Until R4L = 0 else next; |
| EEPMOV.W | — | if R4 \neq 0 then Repeat @ER5+ \rightarrow @ER6+, R4-1 \rightarrow R4 Until R4 = 0 else next; Transfers a data block. Starting from the address set in ER5, transfers data for the number of bytes set in R4L or R4 to the address location set in ER6. Execution of the next instruction begins as soon as the transfer is completed. |

2.4.2 Basic Instruction Formats

H8/300H CPU instructions consist of 2-byte (1-word) units. An instruction consists of an operation field (op), a register field (r), an effective address extension (EA), and a condition field (cc).

Figure 2.7 shows examples of instruction formats.

(1) Operation Field

Indicates the function of the instruction, the addressing mode, and the operation to be carried out on the operand. The operation field always includes the first four bits of the instruction. Some instructions have two operation fields.

(2) Register Field

Specifies a general register. Address registers are specified by 3 bits, and data registers by 3 bits or 4 bits. Some instructions have two register fields. Some have no register field.

(3) Effective Address Extension

8, 16, or 32 bits specifying immediate data, an absolute address, or a displacement. A24-bit address or displacement is treated as a 32-bit data in which the first 8 bits are 0 (H'00).

(4) Condition Field

Specifies the branching condition of Bcc instructions.

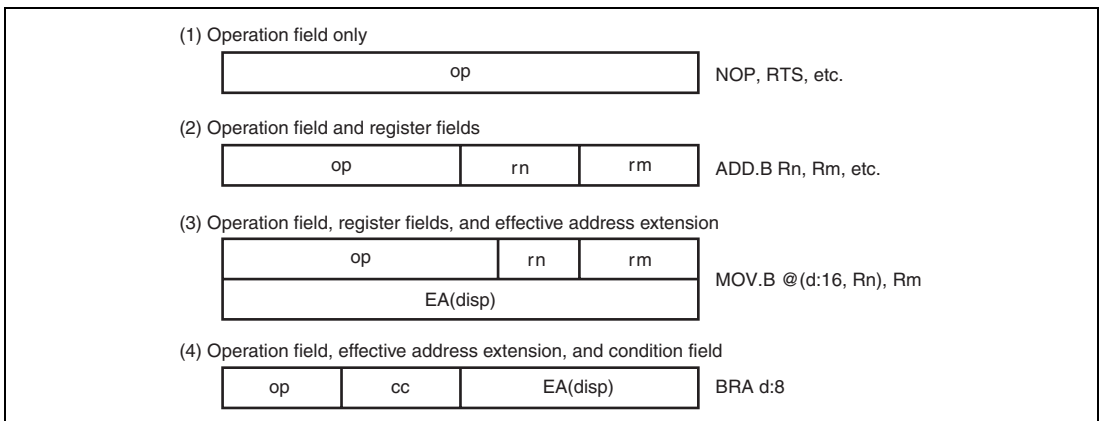


Figure 2.7 Instruction Formats

2.5 Addressing Modes and Effective Address Calculation

The following describes the H8/300H CPU. In this LSI, the upper eight bits are ignored in the generated 24-bit address, so the effective address is 16 bits.

2.5.1 Addressing Modes

The H8/300H CPU supports the eight addressing modes listed in table 2.10. Each instruction uses a subset of these addressing modes. Addressing modes that can be used differ depending on the instruction. For details, refer to appendix A.4, Combinations of Instructions and Addressing Modes.

Arithmetic and logic instructions can use the register direct and immediate modes. Data transfer instructions can use all addressing modes except program-counter relative and memory indirect. Bit-manipulation instructions use register direct, register indirect, or the absolute addressing mode (@aa:8) to specify an operand, and register direct (BSET, BCLR, BNOT, and BTST instructions) or immediate (3-bit) addressing mode to specify a bit number in the operand.

Table 2.10 Addressing Modes

| No. | Addressing Mode | Symbol |
|-----|---|-------------------------|
| 1 | Register direct | Rn |
| 2 | Register indirect | @ERn |
| 3 | Register indirect with displacement | @(d:16,ERn)/@(d:24,ERn) |
| 4 | Register indirect with post-increment Register indirect with pre-decrement | @ERn+ @-ERn |
| 5 | Absolute address | @aa:8/@aa:16/@aa:24 |
| 6 | Immediate | #xx:8/#xx:16/#xx:32 |
| 7 | Program-counter relative | @(d:8,PC)/@(d:16,PC) |
| 8 | Memory indirect | @ @aa:8 |

(1) Register Direct—Rn

The register field of the instruction specifies an 8-, 16-, or 32-bit general register containing the operand. R0H to R7H and R0L to R7L can be specified as 8-bit registers. R0 to R7 and E0 to E7 can be specified as 16-bit registers. ER0 to ER7 can be specified as 32-bit registers.

(2) Register Indirect—@ERn

The register field of the instruction code specifies an address register (ERn), the lower 24 bits of which contain the address of the operand on memory.

(3) Register Indirect with Displacement—@(d:16, ERn) or @(d:24, ERn)

A 16-bit or 24-bit displacement contained in the instruction is added to an address register (ERn) specified by the register field of the instruction, and the lower 24 bits of the sum the address of a memory operand. A 16-bit displacement is sign-extended when added.

(4) Register Indirect with Post-Increment or Pre-Decrement—@ERn+ or @-ERn

- Register indirect with post-increment—@ERn+

The register field of the instruction code specifies an address register (ERn) the lower 24 bits of which contains the address of a memory operand. After the operand is accessed, 1, 2, or 4 is added to the address register contents (32 bits) and the sum is stored in the address register. The value added is 1 for byte access, 2 for word access, or 4 for longword access. For the word or longword access, the register value should be even.

- Register indirect with pre-decrement—@-ERn

The value 1, 2, or 4 is subtracted from an address register (ERn) specified by the register field in the instruction code, and the lower 24 bits of the result is the address of a memory operand. The result is also stored in the address register. The value subtracted is 1 for byte access, 2 for word access, or 4 for longword access. For the word or longword access, the register value should be even.

(5) Absolute Address—@aa:8, @aa:16, @aa:24

The instruction code contains the absolute address of a memory operand. The absolute address may be 8 bits long (@aa:8), 16 bits long (@aa:16), 24 bits long (@aa:24)

For an 8-bit absolute address, the upper 16 bits are all assumed to be 1 (H'FFFF). For a 16-bit absolute address the upper 8 bits are a sign extension. A 24-bit absolute address can access the entire address space.

The access ranges of absolute addresses for this LSI are those shown in table 2.11, because the upper 8 bits are ignored.

Table 2.11 Absolute Address Access Ranges

| Absolute Address | Access Range |
|-------------------------|---------------------|
| 8 bits (@aa:8) | H'FF00 to H'FFFF |
| 16 bits (@aa:16) | H'0000 to H'FFFF |
| 24 bits (@aa:24) | H'0000 to H'FFFF |

(6) Immediate—#xx:8, #xx:16, or #xx:32

The instruction contains 8-bit (#xx:8), 16-bit (#xx:16), or 32-bit (#xx:32) immediate data as an operand.

The ADDS, SUBS, INC, and DEC instructions contain immediate data implicitly. Some bit manipulation instructions contain 3-bit immediate data in the instruction code, specifying a bit number.

(7) Program-Counter Relative—@(d:8, PC) or @(d:16, PC)

This mode is used in the BSR instruction. An 8-bit or 16-bit displacement contained in the instruction is sign-extended and added to the 24-bit PC contents to generate a branch address. The PC value to which the displacement is added is the address of the first byte of the next instruction, so the possible branching range is -126 to +128 bytes (-63 to +64 words) or -32766 to +32768 bytes (-16383 to +16384 words) from the branch instruction. The resulting value should be an even number.

(8) Memory Indirect—@@aa:8

This mode can be used by the JMP and JSR instructions. The instruction code contains an 8-bit absolute address specifying a memory operand. This memory operand contains a branch address. The memory operand is accessed in words, generating a 16-bit branch address. Figure 2.8 shows how to specify branch address for in memory indirect mode. The upper bits of the absolute address are all assumed to be 0, so the address range is 0 to 255 (H'0000 to H'00FF).

Note that the first part of the address range is also the exception vector area.

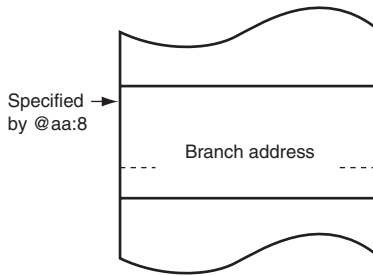


Figure 2.8 Branch Address Specification in Memory Indirect Mode

2.5.2 Effective Address Calculation

Table 2.12 indicates how effective addresses are calculated in each addressing mode. In this LSI, the upper 8 bits of the effective address are ignored in order to generate a 16-bit effective address.

Table 2.12 Effective Address Calculation (1)

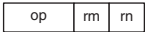

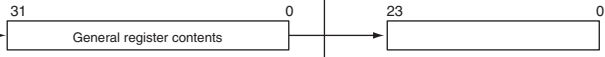
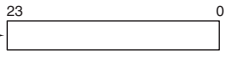
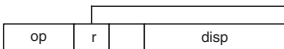
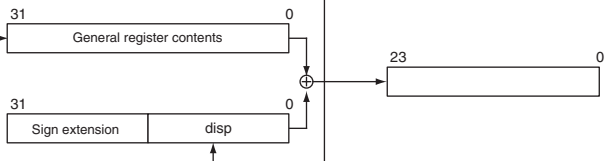

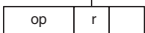
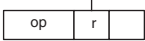
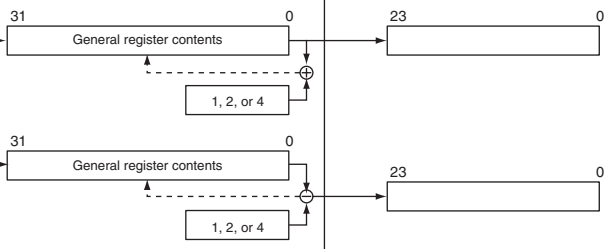


| No | Addressing Mode and Instruction Format | Effective Address Calculation | Effective Address (EA) |
|----|--|--|--|
| 1 | Register direct(Rn)  | | Operand is general register contents. |
| 2 | Register indirect(@ERn)  |  |  |
| 3 | Register indirect with displacement @d:16,ERn) or @(d:24,ERn)  |  |  |
| 4 | Register indirect with post-increment or pre-decrement •Register indirect with post-increment @ERn+  •Register indirect with pre-decrement @-ERn  |  <p>The value to be added or subtracted is 1 when the operand is byte size, 2 for word size, and 4 for longword size.</p> |   |

Table 2.12 Effective Address Calculation (2)

| No | Addressing Mode and Instruction Format | Effective Address Calculation | Effective Address (EA) |
|----|--|-------------------------------|----------------------------|
| 5 | Absolute address @aa:8 | | |
| | @aa:16 | | |
| | @aa:24 | | |
| 6 | Immediate #xx:8/#xx:16/#xx:32 | | Operand is immediate data. |
| 7 | Program-counter relative @(d:8,PC)/@(d:16,PC) | | |
| 8 | Memory indirect @aa:8 | | |

[Legend]

r, rm, rn : Register field
op : Operation field
disp : Displacement
IMM : Immediate data
abs : Absolute address

2.6 Basic Bus Cycle

CPU operation is synchronized by a system clock (ϕ) or a subclock (ϕ_{SUB}). The period from a rising edge of ϕ or ϕ_{SUB} to the next rising edge is called one state. A bus cycle consists of two states or three states. The cycle differs depending on whether access is to on-chip memory or to on-chip peripheral modules.

2.6.1 Access to On-Chip Memory (RAM, ROM)

Access to on-chip memory takes place in two states. The data bus width is 16 bits, allowing access in byte or word size. Figure 2.9 shows the on-chip memory access cycle.

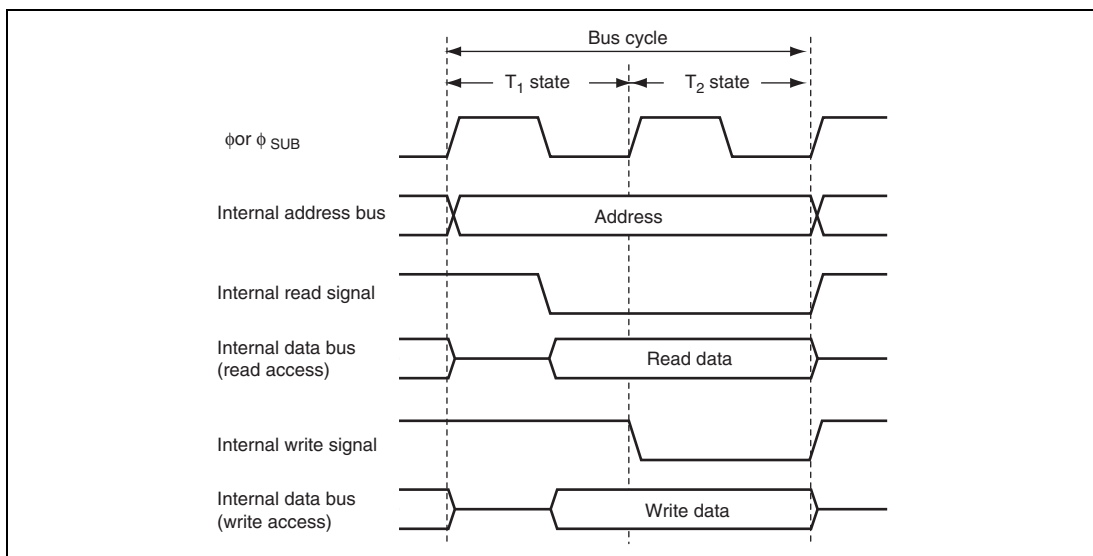


Figure 2.9 On-Chip Memory Access Cycle

2.6.2 On-Chip Peripheral Modules

On-chip peripheral modules are accessed in two states or three states. The data bus width is 8 bits or 16 bits depending on the register. For description on the data bus width and number of accessing states of each register, refer to section 13.1, Register Addresses (Address Order). Registers with 16-bit data bus width can be accessed by word size only. Registers with 8-bit data bus width can be accessed by byte or word size. When a register with 8-bit data bus width is accessed by word size, a bus cycle occurs twice. In two-state access, the operation timing is the same as that for on-chip memory.

Figure 2.10 shows the operation timing in the case of three-state access to an on-chip peripheral module.

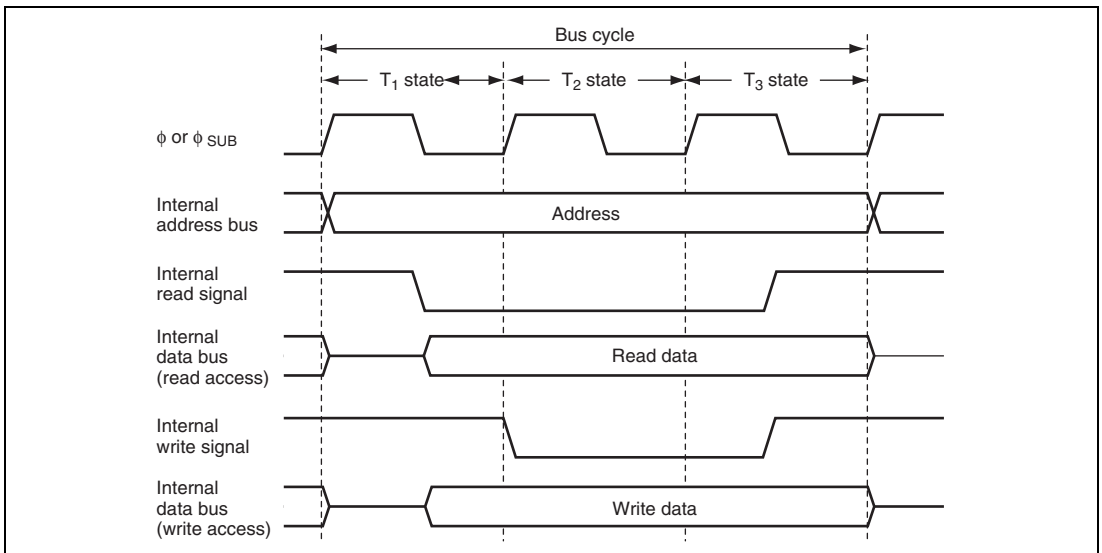


Figure 2.10 On-Chip Peripheral Module Access Cycle (3-State Access)

2.7 CPU States

There are four CPU states: the reset state, program execution state, program halt state, and exception-handling state. The program execution state includes active (high-speed or medium-speed) mode and subactive mode. For the program halt state, there are sleep (high-speed or medium-speed) mode, standby mode, watch mode, and subsleep mode. These states are shown in figure 2.11. Figure 2.12 shows the state transitions. For details on program execution state and program halt state, refer to section 5, Power-Down Modes. For details on exception handling, refer to section 3, Exception Handling.

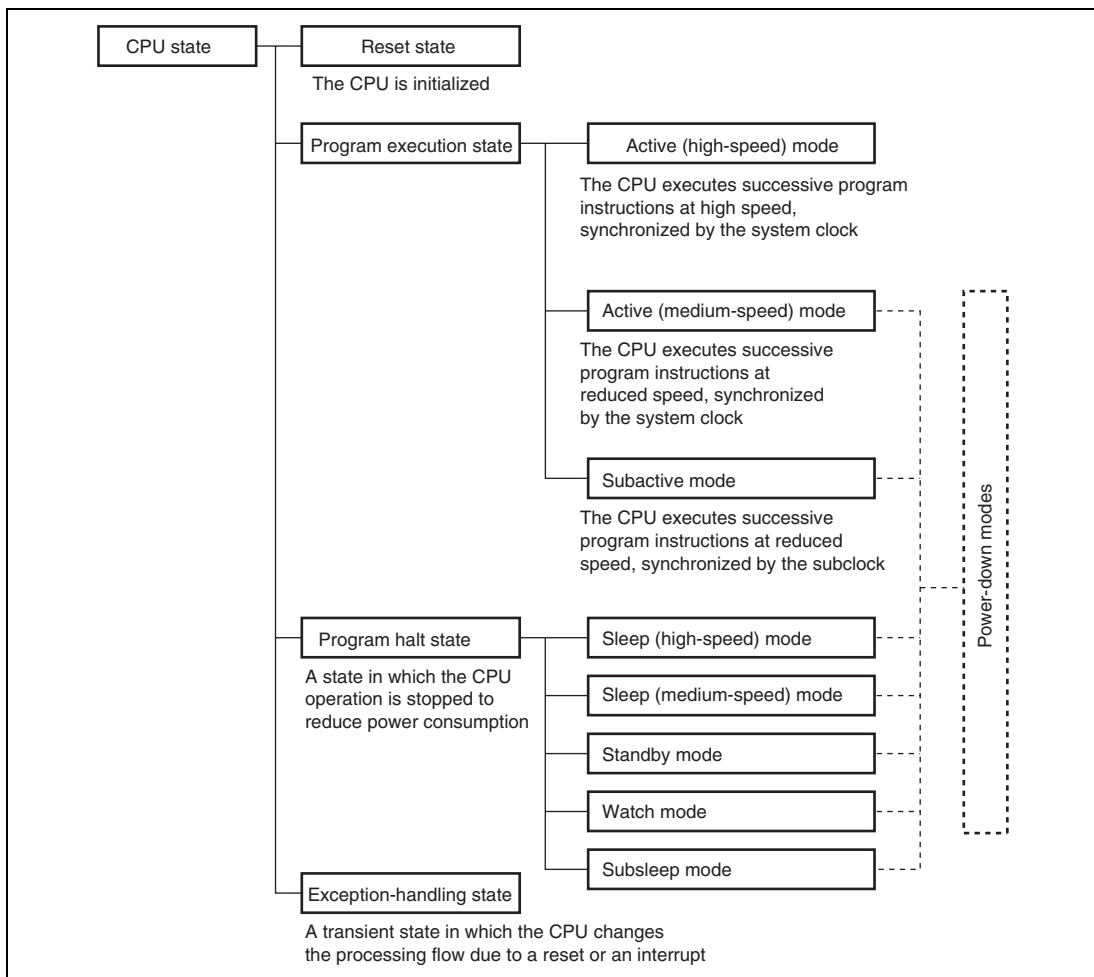


Figure 2.11 CPU Operating States

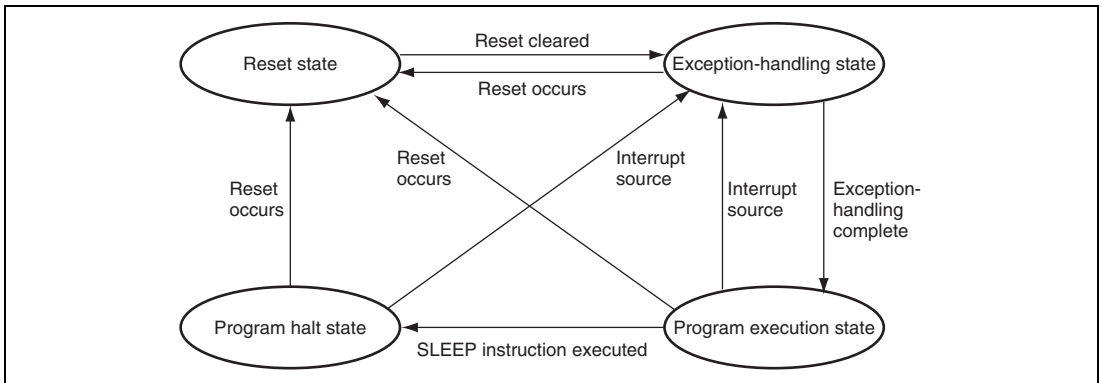


Figure 2.12 State Transitions

2.8 Usage Notes

2.8.1 Notes on Data Access to Empty Areas

The address space of this LSI includes empty areas in addition to the ROM, RAM, and on-chip I/O registers areas available to the user. When data is transferred from CPU to empty areas, the transferred data will be lost. This action may also cause the CPU to malfunction. When data is transferred from an empty area to CPU, the contents of the data cannot be guaranteed.

2.8.2 EEPMOV Instruction

EEPMOV is a block-transfer instruction and transfers the byte size of data indicated by R4L, which starts from the address indicated by R5, to the address indicated by R6. Set R4L and R6 so that the end address of the destination address (value of R6 + R4L) does not exceed H'FFFF (the value of R6 must not change from H'FFFF to H'0000 during execution).

2.8.3 Bit-Manipulation Instruction

The BSET, BCLR, BNOT, BST, and BIST instructions read data from the specified address in byte units, manipulate the data of the target bit, and write data to the same address again in byte units. Special care is required when using these instructions in cases where two registers are assigned to the same address, or when a bit is directly manipulated for a port or a register containing a write-only bit, because this may rewrite data of a bit other than the bit to be manipulated.

(1) Bit manipulation for two registers assigned to the same address

Example 1: Bit manipulation for the timer load register and timer counter

Figure 2.13 shows an example of a timer in which two timer registers are assigned to the same address. When a bit-manipulation instruction accesses the timer load register and timer counter of a reloadable timer, since these two registers share the same address, the following operations takes place.

1. Data is read in byte units.
2. The CPU sets or resets the bit to be manipulated with the bit-manipulation instruction.
3. The written data is written again in byte units to the timer load register.

The timer is counting, so the value read is not necessarily the same as the value in the timer load register. As a result, bits other than the intended bit in the timer counter may be modified and the modified value may be written to the timer load register.

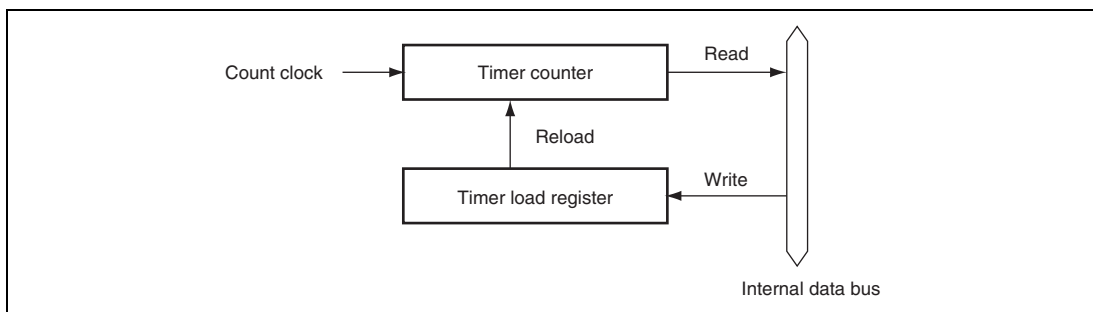


Figure 2.13 Example of Timer Configuration with Two Registers Allocated to Same Address

Example 2: When the BSET instruction is executed for port 5

P57 and P56 are input pins, with a low-level signal input at P57 and a high-level signal input at P56. P55 to P50 are output pins and output low-level signals. An example to output a high-level signal at P50 with a BSET instruction is shown below.

- Prior to executing BSET instruction

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|------------|------------|------------|------------|------------|------------|------------|------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

- BSET instruction executed

```
BSET #0, @PDR5
```

The BSET instruction is executed for port 5.

- After executing BSET instruction

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|------------|------------|------------|------------|------------|------------|------------|------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 |

- Description on operation

- When the BSET instruction is executed, first the CPU reads port 5.

Since P57 and P56 are input pins, the CPU reads the pin states (low-level and high-level input).

P55 to P50 are output pins, so the CPU reads the value in PDR5. In this example PDR5 has a value of H'80, but the value read by the CPU is H'40.

- Next, the CPU sets bit 0 of the read data to 1, changing the PDR5 data to H'41.

3. Finally, the CPU writes H'41 to PDR5, completing execution of BSET instruction.

As a result of the BSET instruction, bit 0 in PDR5 becomes 1, and P50 outputs a high-level signal. However, bits 7 and 6 of PDR5 end up with different values. To prevent this problem, store a copy of the PDR5 data in a work area in memory. Perform the bit manipulation on the data in the work area, then write this data to PDR5.

- Prior to executing BSET instruction

```
MOV.B #H'80, R0L
MOV.B R0L, @RAM0
MOV.B R0L, @PDR5
```

The PDR5 value (H'80) is written to a work area in memory (RAM0) as well as to PDR5.

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

- BSET instruction executed

```
BSET #0, @RAM0
```

The BSET instruction is executed designating the PDR5 work area (RAM0).

- After executing BSET instruction

```
MOV.B @RAM0, R0L
MOV.B R0L, @PDR5
```

The work area (RAM0) value is written to PDR5.

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| RAM0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

(2) Bit Manipulation in a Register Containing a Write-Only Bit

Example 3: BCLR instruction executed designating port 5 control register PCR5

P57 and P56 are input pins, with a low-level signal input at P57 and a high-level signal input at P56. P55 to P50 are output pins that output low-level signals. An example of setting the P50 pin as an input pin by the BCLR instruction is shown below. It is assumed that a high-level signal will be input to this input pin.

- Prior to executing BCLR instruction

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

- BCLR instruction executed

```
BCLR #0, @PCR5
```

The BCLR instruction is executed for PCR5.

- After executing BCLR instruction

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|------------|
| Input/output | Output | Output | Output | Output | Output | Output | Output | Input |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR5 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

- Description on operation

- When the BCLR instruction is executed, first the CPU reads PCR5. Since PCR5 is a write-only register, the CPU reads a value of H'FF, even though the PCR5 value is actually H'3F.
- Next, the CPU clears bit 0 in the read data to 0, changing the data to H'FE.
- Finally, H'FE is written to PCR5 and BCLR instruction execution ends.

As a result of this operation, bit 0 in PCR5 becomes 0, making P50 an input port. However, bits 7 and 6 in PCR5 change to 1, so that P57 and P56 change from input pins to output pins. To prevent this problem, store a copy of the PDR5 data in a work area in memory and manipulate data of the bit in the work area, then write this data to PDR5.

- Prior to executing BCLR instruction

```
MOV.B #H'3F, R0L
MOV.B R0L, @RAM0
MOV.B R0L, @PCR5
```

The PCR5 value (H'3F) is written to a work area in memory (RAM0) as well as to PCR5.

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | Low level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |

- BCLR instruction executed

```
BCLR #0, @RAM0
```

The BCLR instructions executed for the PCR5 work area (RAM0).

- After executing BCLR instruction

```
MOV.B @RAM0, R0L
MOV.B R0L, @PCR5
```

The work area (RAM0) value is written to PCR5.

| | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 |
|--------------|-----------|------------|-----------|-----------|-----------|-----------|-----------|------------|
| Input/output | Input | Input | Output | Output | Output | Output | Output | Output |
| Pin state | Low level | High level | Low level | Low level | Low level | Low level | Low level | High level |
| PCR5 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| PDR5 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| RAM0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |

Section 3 Exception Handling

Exception handling may be caused by a reset or interrupts.

- Reset

A reset has the highest exception priority. Exception handling starts as soon as the reset is cleared by the $\overline{\text{RES}}$ pin. The chip is also reset when the watchdog timer overflows, and exception handling starts. Exception handling is the same as exception handling by the $\overline{\text{RES}}$ pin.

- Interrupts

External interrupts and internal interrupts are masked by the I bit in CCR, and kept masked while the I bit is set to 1. Exception handling starts when the current instruction or exception handling ends, if an interrupt request has been issued.

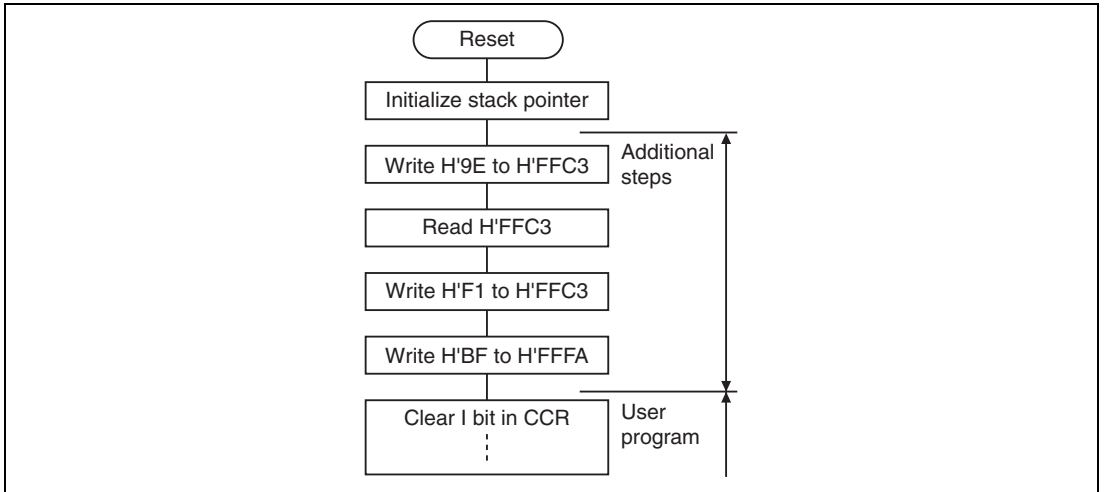
The following notes apply to the HD64F38704 and HD64F38702.

- Issue

Depending on the circuitry status at power-on, a vector 17 (system reservation) interrupt request may be generated. If bit I in CCR is cleared to 0, this interrupt will be accepted just like any other internal interrupt. This can cause processing exceptions to occur, and program execution will eventually halt since there is no procedure for clearing the interrupt request flag in question.

- Countermeasure

To prevent the above issue from occurring, it is recommended that the following steps be added to programs written for the product.



The following is an example in assembler.

```
.ORG H'0000
.DATA.W      INIT
.ORG H'0100
INIT:
MOV.W  #H'FF80:16,SP

MOV.B  #H'9E:8,R0L
MOV.B  R0L,@H'FFC3:8
MOV.B  @H'FFC3:8,R0L
MOV.B  #H'F1:8,R0L
MOV.B  R0L,@H'FFC3:8
MOV.B  #H'BF:8,R0L
MOV.B  R0L,@H'FFFA:8
ANDC.B #H'7F:8,CCR      ; user program
```

The following is an example in C.

```
void powerON_Reset(void)
{
// -----
    unsigned char dummy;
    *((volatile unsigned char *)0xffc3)= 0x9e;
    dummy = *((volatile unsigned char *)0xffc3);
    *((volatile unsigned char *)0xffc3)= 0xf1;
    *((volatile unsigned char *)0xfffa)= 0xbf;
// -----
    set_imask_ccr(0);      // clear I bit
                          // user program
}
```

On the mask ROM version of the product, user programs may be used as is (including the additional steps described above) or without the additional steps.

3.1 Exception Sources and Vector Address

Table 3.1 shows the vector addresses and priority of each exception handling. When more than one interrupt is requested, handling is performed from the interrupt with the highest priority.

Table 3.1 Exception Sources and Vector Address

| Relative Module | Exception Sources | Vector Number | Vector Address | Priority |
|----------------------------|--|---------------|------------------|----------|
| RES pin, WDT | Reset | 0 | H'0000 to H'0001 | High |
| — | Reserved for system use | 1 to 3 | H'0002 to H'0007 | |
| External interrupt pin | IRQ0 | 4 | H'0008 to H'0009 | |
| | IRQ1 | 5 | H'000A to H'000B | |
| | IRQAEC | 6 | H'000C to H'000D | |
| — | Reserved for system use | 7, 8 | H'000E to H'0011 | |
| External interrupt pin | WKP0 | 9 | H'0012 to H'0013 | |
| | WKP1 | | | |
| | WKP2 | | | |
| | WKP3 | | | |
| | WKP4 | | | |
| | WKP5 | | | |
| | WKP6 | | | |
| | WKP7 | | | |
| — | Reserved for system use | 10 | H'0014 to H'0015 | |
| Timer A | Timer A overflow | 11 | H'0016 to H'0017 | |
| Asynchronous event counter | Asynchronous event counter overflow | 12 | H'0018 to H'0019 | |
| — | Reserved for system use | 13 | H'001A to H'001B | |
| Timer F | Timer FL compare match | 14 | H'001C to H'001D | |
| | Timer FL overflow | | | |
| | Timer FH compare match | 15 | H'001E to H'001F | |
| | Timer FH overflow | | | |
| — | Reserved for system use | 16, 17 | H'0020 to H'0023 | |
| SCI3 | Transmit end | 18 | H'0024 to H'0025 | |
| | Transmit data empty | | | |
| | Transmit data full | | | |
| | Receive error | | | |
| A/D converter | A/D conversion end | 19 | H'0026 to H'0027 | |
| CPU | Direct transition by SLEEP instruction | 20 | H'0028 to H'0029 | Low |

3.2 Register Descriptions

Interrupts are controlled by the following registers.

- Interrupt edge select register (IEGR)
- Interrupt enable register 1 (IENR1)
- Interrupt enable register 2 (IENR2)
- Interrupt request register 1 (IRR1)
- Interrupt request register 2 (IRR2)
- Wakeup interrupt request register (IWPR)
- Wakeup edge select register (WEGR)

3.2.1 Interrupt Edge Select Register (IEGR)

IEGR selects the direction of an edge that generates interrupt requests of pins and $\overline{\text{IRQ1}}$ and $\overline{\text{IRQ0}}$.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 5 | — | All 1 | — | Reserved These bits are always read as 1. |
| 4 to 2 | — | — | W | Reserved The write value should always be 0. |
| 1 | IEG1 | 0 | R/W | IRQ1 and IRQ0 Edge Select |
| 0 | IEG0 | 0 | R/W | 0: Falling edge of $\overline{\text{IRQn}}$ pin input is detected 1: Rising edge of $\overline{\text{IRQn}}$ pin input is detected (n = 1 or 0) |

3.2.2 Interrupt Enable Register 1 (IENR1)

IENR1 enables timers and external pin interrupts.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|--|
| 7 | IENTA | 0 | R/W | Timer A interrupt enable Enables or disables timer A overflow interrupt requests. 0: Disables timer A interrupt requests 1: Enables timer A interrupt requests |
| 6 | — | — | W | Reserved The write value should always be 0. |
| 5 | IENWP | 0 | R/W | Wakeup Interrupt Enable Enables or disables WKP7 to WKP0 interrupt requests. 0: Disables $\overline{WKP7}$ to $\overline{WKP0}$ interrupt requests 1: Enables $\overline{WKP7}$ to $\overline{WKP0}$ interrupt requests |
| 4, 3 | — | — | W | Reserved The write value should always be 0. |
| 2 | IENEC2 | 0 | R/W | IRQAEC Interrupt Enable Enables or disables IRQAEC interrupt requests. 0: Disables IRQAEC interrupt requests 1: Enables IRQAEC interrupt requests |
| 1 | IEN1 | 0 | R/W | IRQ1 and IRQ0 Interrupt Enable |
| 0 | IEN0 | 0 | R/W | Enables or disables IRQ1 and IRQ0 interrupt requests. 0: Disables \overline{IRQn} interrupt requests 1: Enables \overline{IRQn} interrupt requests (n = 1, 0) |

3.2.3 Interrupt Enable Register 2 (IENR2)

IENR2 enables direct transition, A/D converter, and timer interrupts.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|--|
| 7 | IENDT | 0 | R/W | Direct Transition Interrupt enable Enables or disables direct transition interrupt requests. 0: Disables direct transition interrupt requests 1: Enables direct transition interrupt requests |
| 6 | IENAD | 0 | R/W | A/D Converter Interrupt enable Enables or disables A/D conversion end interrupt requests. 0: Disables A/D converter interrupt requests 1: Enables A/D converter interrupt requests |
| 5, 4 | — | — | W | Reserved The write value should always be 0. |
| 3 | IENTFH | 0 | R/W | Timer FH Interrupt Enable Enables or disables timer FH compare match or overflow interrupt requests. 0: Disables timer FH interrupt requests 1: Enables timer FH interrupt requests |
| 2 | IENTFL | 0 | R/W | Timer FL Interrupt Enable Enables or disables timer FL compare match or overflow interrupt requests. 0: Disables timer FL interrupt requests 1: Enables timer FL interrupt requests |
| 1 | — | — | W | Reserved The write value should always be 0. |
| 0 | IENEC | 0 | R/W | Asynchronous Event Counter Interrupt Enable Enables or disables asynchronous event counter interrupt requests. 0: Disables asynchronous event counter interrupt requests 1: Enables asynchronous event counter interrupt requests |

For details on SCI3 interrupt control, refer to section 10.3.6, Serial Control Register 3 (SCR3).

3.2.4 Interrupt Request Register 1 (IRRI1)

IRRI1 is a status flag register for timer A, IRQAEC, IRQ1, and IRQ0 interrupt requests. The corresponding flag is set to 1 when an interrupt request occurs. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

| Bit | Bit Name | Initial Value | R/W | Description |
|---------|----------|---------------|------|---|
| 7 | IRRTA | 0 | R/W* | Timer A Interrupt Request Flag [Setting condition] When the timer A counter value overflows [Clearing condition] When IRRTA = 1, it is cleared by writing 0 |
| 6, 4, 3 | — | — | W | Reserved The write value should always be 0. |
| 5 | — | 1 | — | Reserved This bit is always read as 1 and cannot be modified. |
| 2 | IRREC2 | 0 | R/W* | IRQAEC Interrupt Request Flag [Setting condition] When pin IRQAEC is designated for interrupt input and the designated signal edge is detected [Clearing condition] When IRREC2 = 1, it is cleared by writing 0 |
| 1 | IRRI1 | 0 | R/W* | IRQ1 and IRQ0 Interrupt Request Flag |
| 0 | IRRI0 | 0 | R/W* | [Setting condition] When pin \overline{IRQn} is designated for interrupt input and the designated signal edge is detected (n = 1, 0) [Clearing condition] When IRRI1 and IRRI0 = 1, they are cleared by writing 0 |

Note: * Only 0 can be written for flag clearing.

3.2.5 Interrupt Request Register 2 (IRR2)

IRR2 is a status flag register for direct transition, A/D converter, timer FH, timer FL, and asynchronous event counter interrupt requests. The corresponding flag is set to 1 when an interrupt request occurs. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|------|---|
| 7 | IRRDT | 0 | R/W* | Direct Transition Interrupt Request Flag [Setting condition] When a direct transition is made by executing a SLEEP instruction while the DTON bit = 1 [Clearing condition] When IRRDT = 1, it is cleared by writing 0 |
| 6 | IRRAD | 0 | R/W* | A/D Converter Interrupt Request Flag [Setting condition] When A/D conversion is completed and the ADSF bit is cleared to 0 [Clearing condition] When IRRAD = 1, it is cleared by writing 0 |
| 5, 4 | — | — | W | Reserved The write value should always be 0. |
| 3 | IRRTFH | 0 | R/W* | Timer FH Interrupt Request Flag [Setting condition] When TCFH and OCRFH match in 8-bit timer mode, or when TCF (TCFL, TCFH) and OCRF (OCRFL, OCRFH) match in 16-bit timer mode [Clearing condition] When IRRTFH = 1, it is cleared by writing 0 |
| 2 | IRRTFL | 0 | R/W* | Timer FL Interrupt Request Flag [Setting condition] When TCFL and OCRFL match in 8-bit timer mode [Clearing condition] When IRRTFL = 1, it is cleared by writing 0 |
| 1 | — | — | W | Reserved The write value should always be 0. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 0 | IRREC | 0 | R/W* | Asynchronous Event Counter Interrupt Request Flag [Setting condition] When ECH overflows in 16-bit counter mode, or ECH or ECL overflows in 8-bit counter mode [Clearing condition] When IRREC = 1, it is cleared by writing 0 |

Note: * Only 0 can be written for flag clearing.

3.2.6 Wakeup Interrupt Request Register (IWPR)

IWPR is a status flag register for $\overline{WKP7}$ to $\overline{WKP0}$ interrupt requests. The flags are not cleared automatically when an interrupt is accepted. It is necessary to write 0 to clear each flag.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|---|
| 7 | IWPF7 | 0 | R/W* | Wakeup Interrupt Request Flag 7 to 0 |
| 6 | IWPF6 | 0 | R/W* | [Setting condition] |
| 5 | IWPF5 | 0 | R/W* | When pin \overline{WKPn} is designated for wakeup input and the designated edge is detected (n = 7 to 0) |
| 4 | IWPF4 | 0 | R/W* | |
| 3 | IWPF3 | 0 | R/W* | [Clearing condition] |
| 2 | IWPF2 | 0 | R/W* | When IWPFn = 1, it is cleared by writing 0 |
| 1 | IWPF1 | 0 | R/W* | |
| 0 | IWPF0 | 0 | R/W* | |

Note: * Only 0 can be written for flag clearing.

3.2.7 Wakeup Edge Select Register (WEGR)

WEGR specifies rising or falling edge sensing for pins \overline{WKPn} .

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | WKEGS7 | 0 | R/W | WKPn Edge Select 7 to 0 |
| 6 | WKEGS6 | 0 | R/W | Selects \overline{WKPn} pin input sensing. |
| 5 | WKEGS5 | 0 | R/W | 0: \overline{WKPn} pin falling edge is detected |
| 4 | WKEGS4 | 0 | R/W | 1: \overline{WKPn} pin rising edge is detected |
| 3 | WKEGS3 | 0 | R/W | (n = 7 to 0) |
| 2 | WKEGS2 | 0 | R/W | |
| 1 | WKEGS1 | 0 | R/W | |
| 0 | WKEGS0 | 0 | R/W | |

3.3 Reset Exception Handling

When the \overline{RES} pin goes low, all processing halts and this LSI enters the reset. The internal state of the CPU and the registers of the on-chip peripheral modules are initialized by the reset. To ensure that this LSI is reset at power-on, hold the \overline{RES} pin low until the clock pulse generator output stabilizes. To reset the chip during operation, hold the \overline{RES} pin low for at least 10 system clock cycles. When the \overline{RES} pin goes high after being held low for the necessary time, this LSI starts reset exception handling. The reset exception handling sequence is shown in figure 3.1. The reset exception handling sequence is as follows.

1. Set the I bit in the condition code register (CCR) to 1.
2. The CPU generates a reset exception handling vector address (from H'0000 to H'0001), the data in that address is sent to the program counter (PC) as the start address, and program execution starts from that address.

3.4 Interrupt Exception Handling

3.4.1 External Interrupts

There are external interrupts, WKP7 to WKP0, IRQ1, IRQ0, and IRQAEC.

(1) WKP7 to WKP0 Interrupts

WKP7 to WKP0 interrupts are requested by input signals to pins $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$. These interrupts have the same vector addresses, and are detected individually by either rising edge sensing or falling edge sensing, depending on the settings of bits WKEGS7 to WKEGS0 in WEGR.

When pins $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$ are designated for interrupt input in PMR5 and the designated signal edge is input, the corresponding bit in IWPR is set to 1, requesting the CPU of an interrupt. These interrupts can be masked by setting bit IENWP in IENR1.

(2) IRQ1 and IRQ0 Interrupts

IRQ1 and IRQ0 interrupts are requested by input signals to pins $\overline{\text{IRQ1}}$ and $\overline{\text{IRQ0}}$. These interrupts are given different vector addresses, and are detected individually by either rising edge sensing or falling edge sensing, depending on the settings of bits IEG1 and IEG0 in IEGR.

When pins $\overline{\text{IRQ1}}$ and $\overline{\text{IRQ0}}$ are designated for interrupt input by PMRB and PMR2 and the designated signal edge is input, the corresponding bit in IRR1 is set to 1, requesting the CPU of an interrupt. These interrupts can be masked by setting bits IEN1 and IEN0 in IENR1.

(3) IRQAEC Interrupt

The IRQAEC interrupt is requested by an input signal to pin IRQAEC. This interrupt is detected by either rising edge sensing or falling edge sensing, depending on the settings of bits AIEGS1 and AIEGS0 in AEGSR.

When bit IENEC2 in IENR1 is designated for interrupt input and the designated signal edge is input, the corresponding bit in IRR1 is set to 1, requesting the CPU of an interrupt.

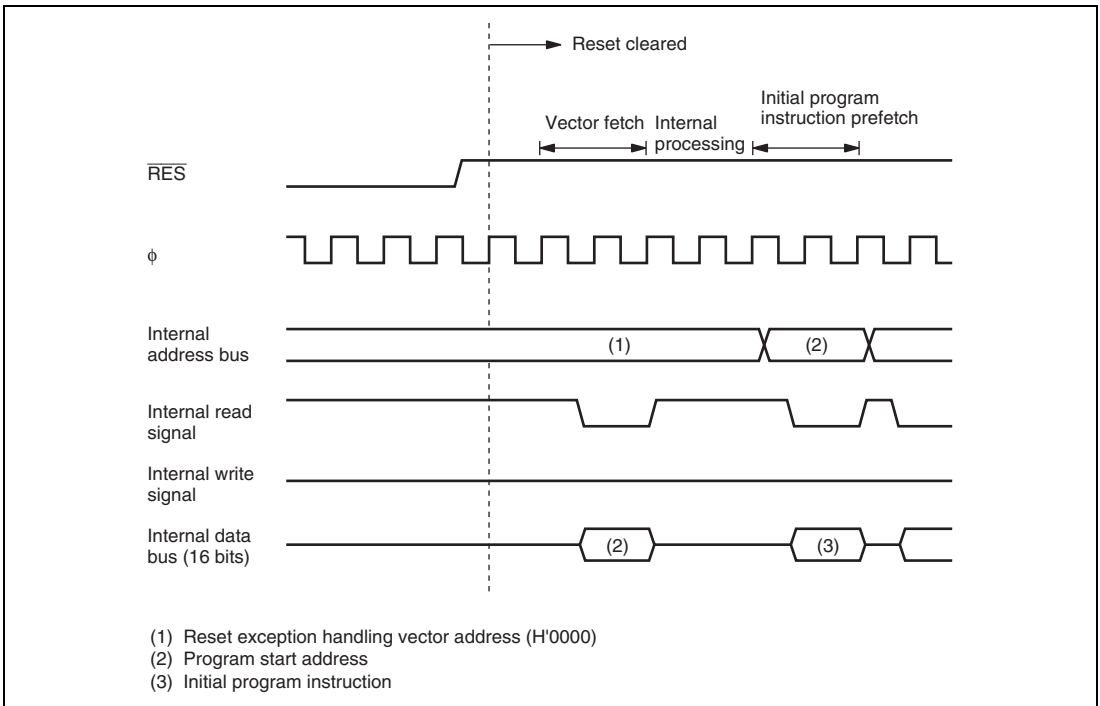


Figure 3.1 Reset Sequence

3.4.2 Internal Interrupts

Each on-chip peripheral module has a flag to show the interrupt request status and the enable bit to enable or disable the interrupt. For direct transition interrupt requests generated by execution of a SLEEP instruction, this function is included in IRR1 and IRR2.

When an on-chip peripheral module requests an interrupt, the corresponding interrupt request status flag is set to 1, requesting the CPU of an interrupt. When this interrupt is accepted, the I bit is set to 1 in CCR. These interrupts can be masked by writing 0 to clear the corresponding enable bit.

3.4.3 Interrupt Handling Sequence

Interrupts are controlled by an interrupt controller.

Interrupt operation is described as follows.

1. If an interrupt occurs while the interrupt enable bit is set to 1, an interrupt request signal is sent to the interrupt controller.
2. When multiple interrupt requests are generated, the interrupt controller requests to the CPU for the interrupt handling with the highest priority at that time according to table 3.1. Other interrupt requests are held pending.
3. Interrupt requests are accepted, if the I bit is cleared to 0 in CCR; if the I bit is set to 1, the interrupt request is held pending.
4. If the CPU accepts the interrupt after processing of the current instruction is completed, interrupt exception handling will begin. First, both PC and CCR are pushed onto the stack. The state of the stack at this time is shown in figure 3.2. The PC value pushed onto the stack is the address of the first instruction to be executed upon return from interrupt handling.
5. Then, the I bit in CCR is set to 1, masking further interrupts. Upon return from interrupt handling, the values of I bit and other bits in CCR will be restored and returned to the values prior to the start of interrupt exception handling.
6. Next, the CPU generates the vector address corresponding to the accepted interrupt, and transfers the address to PC as a start address of the interrupt handling-routine. Then a program starts executing from the address indicated in PC.

Figure 3.3 shows a typical interrupt sequence where the program area is in the on-chip ROM and the stack area is in the on-chip RAM.

- Notes:
1. When disabling interrupts by clearing bits in the interrupt enable register, or when clearing bits in the interrupt request register, always do so while interrupts are masked ($I = 1$).
 2. If the above clear operations are performed while $I = 0$, and as a result a conflict arises between the clear instruction and an interrupt request, exception processing for the interrupt will be executed after the clear instruction has been executed.

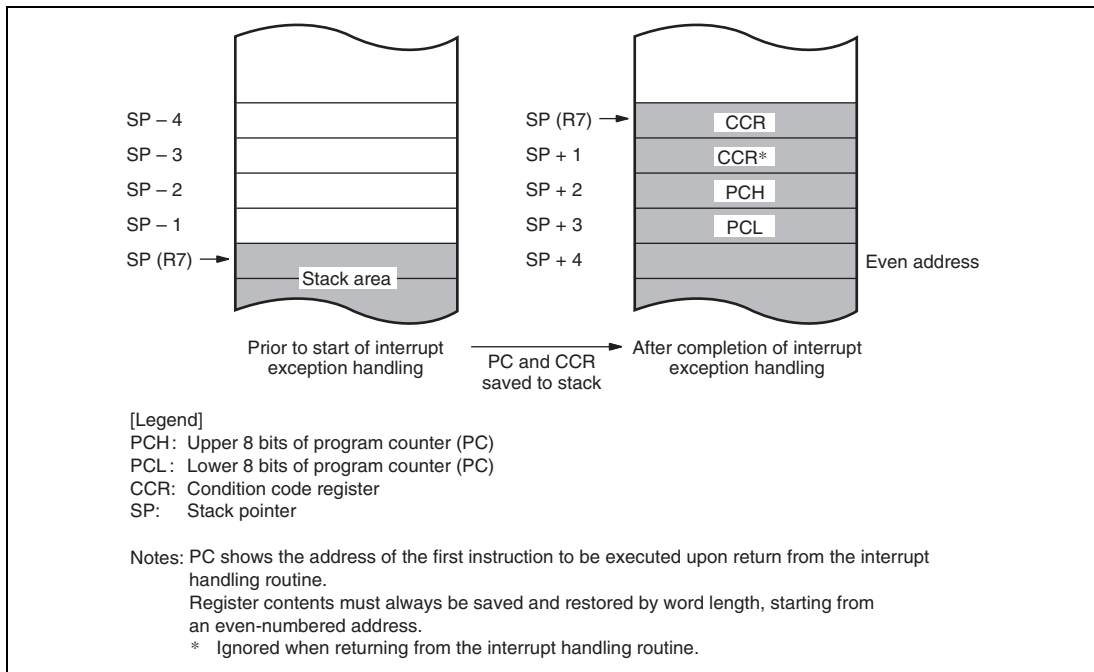


Figure 3.2 Stack Status after Exception Handling

3.4.4 Interrupt Response Time

Table 3.2 shows the number of wait states after an interrupt request flag is set until the first instruction of the interrupt handling-routine is executed.

Table 3.2 Interrupt Wait States

| Item | States | Total |
|---|---------|----------|
| Waiting time for completion of executing instruction* | 1 to 13 | 15 to 27 |
| Saving of PC and CCR to stack | 4 | |
| Vector fetch | 2 | |
| Instruction fetch | 4 | |
| Internal processing | 4 | |

Note: * Not including EEPMOV instruction.

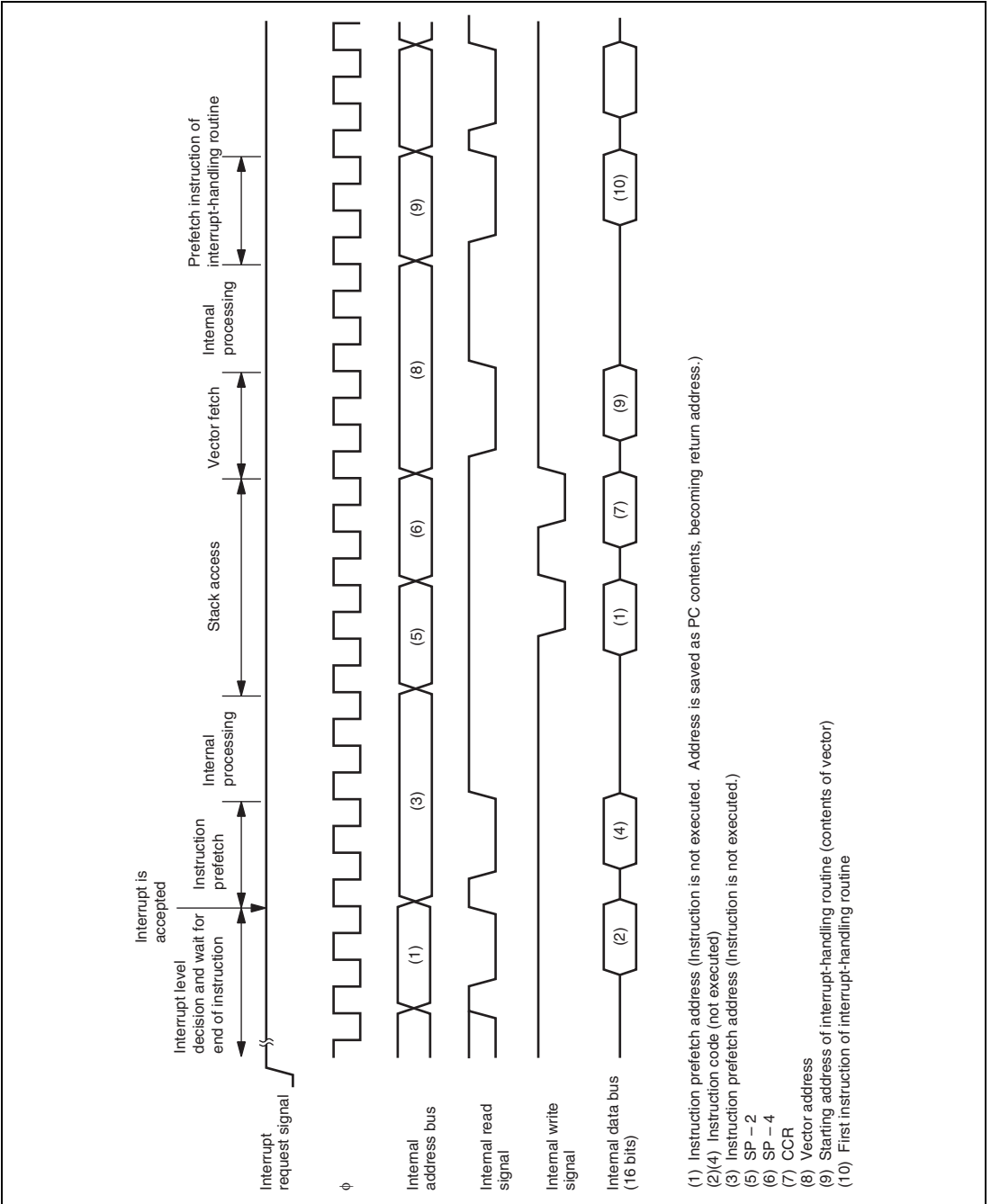


Figure 3.3 Interrupt Sequence

3.5 Usage Notes

3.5.1 Interrupts after Reset

If an interrupt is accepted after a reset and before the stack pointer (SP) is initialized, the PC and CCR will not be saved correctly, leading to a program crash. To prevent this, all interrupt requests are disabled immediately after a reset. Since the first instruction of a program is always executed immediately after the reset state ends, make sure that this instruction initializes the stack pointer (example: `MOV.W #xx: 16, SP`).

3.5.2 Notes on Stack Area Use

When word data is accessed, the least significant bit of the address is regarded as 0. Access to the stack always takes place in word size, so the stack pointer (SP: R7) should never indicate an odd address. Use `PUSH Rn (MOV.W Rn, @-SP)` or `POP Rn (MOV.W @SP+, Rn)` to save or restore register values.

3.5.3 Interrupt Request Flag Clearing Method

Use the following recommended method for flag clearing in the interrupt request registers (IRR1, IRR2, and IWPR).

Recommended Method: Perform flag clearing with only one instruction. Either a bit manipulation instruction or a data transfer instruction in bytes can be used. Two examples of coding for clearing IRR1 (bit 1 in IRR1) are shown below:

- `BCR #1,@IRR1:8`
- `MOV.B R1L,@IRR1:8` (Set B'11111101 to R1L in advance)

Malfunction Example: When flag clearing is performed with several instructions, a flag, other than the intended one, which was set while executing one of those instructions may be accidentally cleared, and thus cause incorrect operations to occur.

An example of coding for clearing IRR1 (bit 1 in IRR1), in which IRR10 is also cleared and the interrupt becomes invalid is shown below.

| | |
|------------------------------------|----------------------------|
| <code>MOV.B @IRR1:8,R1L</code> | At this point, IRR10 is 0. |
| <code>AND.B #B'11111101,R1L</code> | IRR10 becomes 1 here. |
| <code>MOV.B R1L,@IRR1:8</code> | IRR10 is cleared to 0. |

In the above example, an IRQ0 interrupt occurs while the AND.B instruction is executed. Since not only the original target IRR11, but also IRR10 is cleared to 0, the IRQ0 interrupt becomes invalid.

3.5.4 Notes on Rewriting Port Mode Registers

When a port mode register is rewritten to switch the functions of external interrupt pins, IRQAEC, $\overline{\text{IRQ1}}$, $\overline{\text{IRQ0}}$, and $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$, the interrupt request flag may be set to 1.

When switching a pin function, mask the interrupt before setting the bit in the port mode register. After accessing the port mode register, execute at least one instruction (e.g., NOP), then clear the interrupt request flag from 1 to 0.

Table 3.3 lists the interrupt request flags which are set to 1 and the conditions.

Table 3.3 Conditions under which Interrupt Request Flag is Set to 1

| Interrupt Request Flags Set to 1 | | Conditions |
|----------------------------------|--------|--|
| IRR1 | IRREC2 | When the edge designated by AIEGS1 and AIEGS0 in AEGSR is input while IENEC2 in IENRI is set to 1. |
| | IRRI1 | When IRQ1 bit in PMRB is changed from 0 to 1 while pin $\overline{\text{IRQ1}}$ is low and IEG1 bit in IEGR = 0. When IRQ1 bit in PMRB is changed from 1 to 0 while pin $\overline{\text{IRQ1}}$ is low and IEG1 bit in IEGR = 1. |
| | IRRI0 | When IRQ0 bit in PMR2 is changed from 0 to 1 while pin $\overline{\text{IRQ0}}$ is low and IEG0 bit in IEGR = 0. When IRQ0 bit in PMR2 is changed from 1 to 0 while pin $\overline{\text{IRQ0}}$ is low and IEG0 bit in IEGR = 1. |

Interrupt Request Flags**Set to 1****Conditions**

| | | |
|------|-------|---|
| IWPR | IWPF7 | When PMR5 bit WKP7 is changed from 0 to 1 while pin $\overline{WKP7}$ is low and WEGR bit WKEGS7 = 0. |
| | | When PMR5 bit WKP7 is changed from 1 to 0 while pin $\overline{WKP7}$ is low and WEGR bit WKEGS7 = 1. |
| | IWPF6 | When PMR5 bit WKP6 is changed from 0 to 1 while pin $\overline{WKP6}$ is low and WEGR bit WKEGS6 = 0. |
| | | When PMR5 bit WKP6 is changed from 1 to 0 while pin $\overline{WKP6}$ is low and WEGR bit WKEGS6 = 1. |
| | IWPF5 | When PMR5 bit WKP5 is changed from 0 to 1 while pin $\overline{WKP5}$ is low and WEGR bit WKEGS5 = 0. |
| | | When PMR5 bit WKP5 is changed from 1 to 0 while pin $\overline{WKP5}$ is low and WEGR bit WKEGS5 = 1. |
| | IWPF4 | When PMR5 bit WKP4 is changed from 0 to 1 while pin $\overline{WKP4}$ is low and WEGR bit WKEGS4 = 0. |
| | | When PMR5 bit WKP4 is changed from 1 to 0 while pin $\overline{WKP4}$ is low and WEGR bit WKEGS4 = 1. |
| | IWPF3 | When PMR5 bit WKP3 is changed from 0 to 1 while pin $\overline{WKP3}$ is low and WEGR bit WKEGS3 = 0. |
| | | When PMR5 bit WKP3 is changed from 1 to 0 while pin $\overline{WKP3}$ is low and WEGR bit WKEGS3 = 1. |
| | IWPF2 | When PMR5 bit WKP2 is changed from 0 to 1 while pin $\overline{WKP2}$ is low and WEGR bit WKEGS2 = 0. |
| | | When PMR5 bit WKP2 is changed from 1 to 0 while pin $\overline{WKP2}$ is low and WEGR bit WKEGS2 = 1. |
| | IWPF1 | When PMR5 bit WKP1 is changed from 0 to 1 while pin $\overline{WKP1}$ is low and WEGR bit WKEGS1 = 0. |
| | | When PMR5 bit WKP1 is changed from 1 to 0 while pin $\overline{WKP1}$ is low and WEGR bit WKEGS1 = 1. |
| | IWPF0 | When PMR5 bit WKP0 is changed from 0 to 1 while pin $\overline{WKP0}$ is low and WEGR bit WKEGS0 = 0. |
| | | When PMR5 bit WKP0 is changed from 1 to 0 while pin $\overline{WKP0}$ is low and WEGR bit WKEGS0 = 1. |

Figure 3.4 shows a port mode register setting and interrupt request flag clearing procedure.

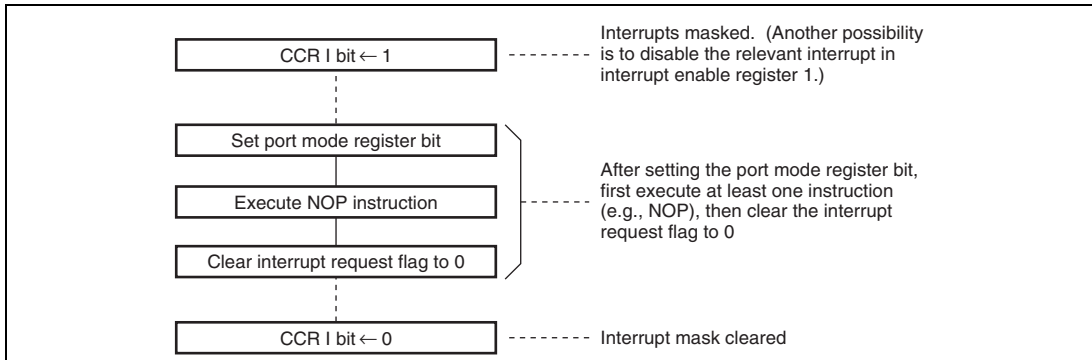


Figure 3.4 Port Mode Register Setting and Interrupt Request Flag Clearing Procedure

Section 4 Clock Pulse Generators

4.1 Features

Clock oscillator circuitry (CPG: clock pulse generator) is provided on-chip, including both a system clock pulse generator and a subclock pulse generator. The system clock pulse generator consists of a system clock oscillator and system clock dividers. The subclock pulse generator consists of a subclock oscillator and a subclock divider.

Figure 4.1 shows a block diagram of the clock pulse generators.

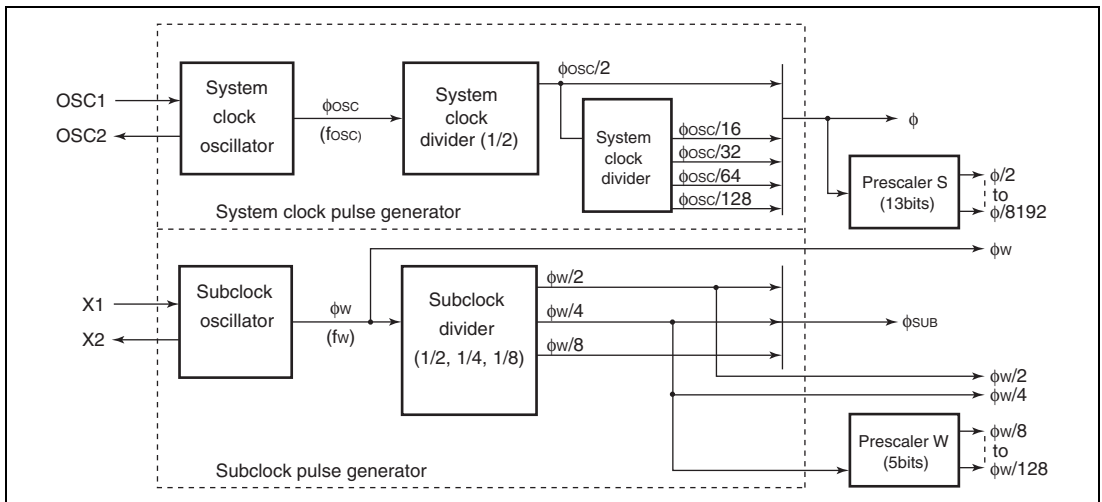


Figure 4.1 Block Diagram of Clock Pulse Generators

4.2 System Clock Generator

Clock pulses can be supplied to the system clock divider either by connecting a crystal or ceramic resonator, or by providing external clock input. Figure 4.2 shows a block diagram of the system clock generator.

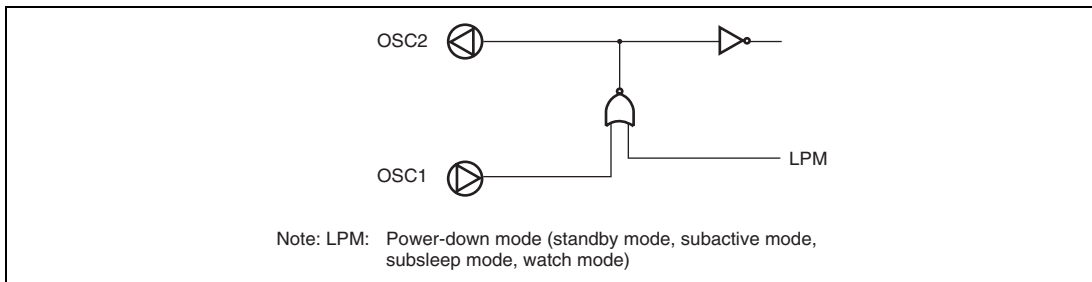


Figure 4.2 Block Diagram of System Clock Generator

4.2.1 Connecting Crystal Resonator

Figure 4.3 shows a typical method of connecting a crystal oscillator to the H8/38704, H8/38702S Group. Figure 4.4 shows the equivalent circuit of a crystal resonator. A resonator having the characteristics given in table 4.1 should be used.

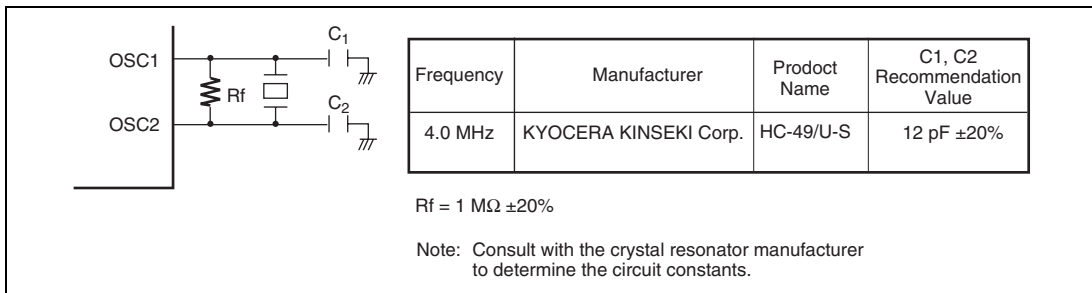


Figure 4.3 Typical Connection to Crystal Resonator (H8/38704, H8/38702S Group)

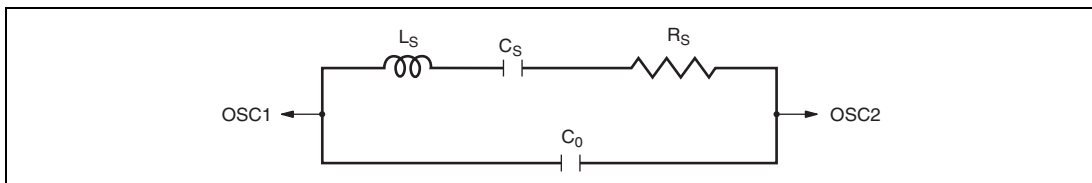


Figure 4.4 Equivalent Circuit of Crystal Resonator

Table 4.1 Crystal Resonator Parameters

| | | |
|-----------------|--------------|-------|
| Frequency (MHz) | 4.10 | 4.193 |
| R_s (max) | 150 Ω | |
| C_o (max) | 1.4 pF | |

4.2.2 Connecting Ceramic Resonator

Figure 4.5 shows a typical method of connecting a ceramic oscillator to the H8/38704, H8/38702S Group.

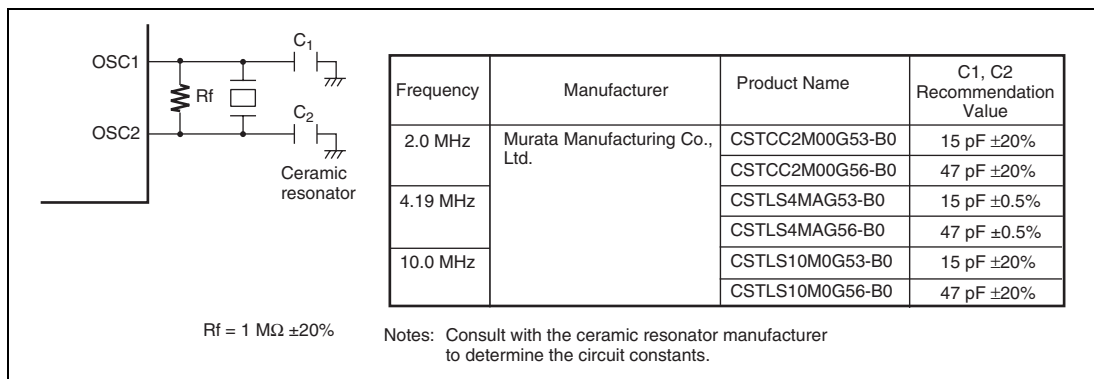


Figure 4.5 Typical Connection to Ceramic Resonator (H8/38704, H8/38702S Group)

4.2.3 External Clock Input Method

Connect an external clock signal to pin OSC1, and leave pin OSC2 open. Figure 4.6 shows a typical connection. The duty cycle of the external clock signal must be 45 to 55%.

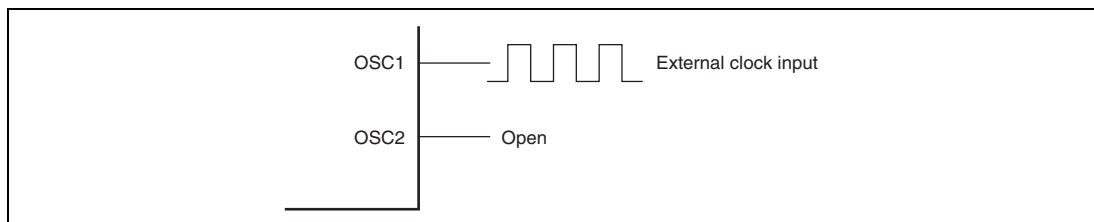


Figure 4.6 Example of External Clock Input

4.3 Subclock Generator

Figure 4.7 shows a block diagram of the subclock generator.

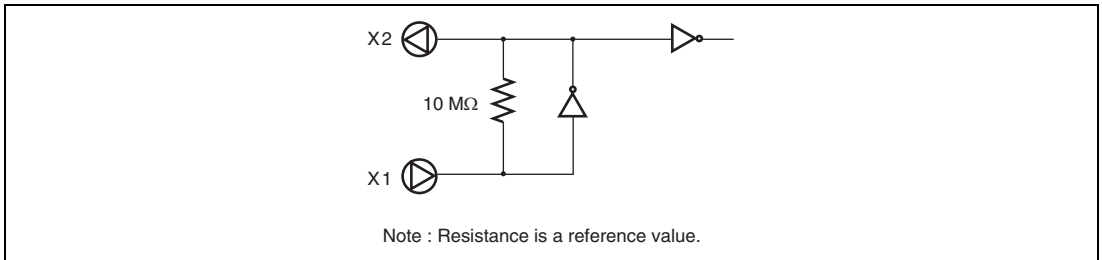


Figure 4.7 Block Diagram of Subclock Generator

4.3.1 Connecting 32.768-kHz/38.4-kHz Crystal Resonator

Clock pulses can be supplied to the subclock divider by connecting a 32.768-kHz or 38.4-kHz crystal resonator, as shown in figure 4.8. Figure 4.9 shows the equivalent circuit of the 32.768-kHz or 38.4-kHz crystal resonator.

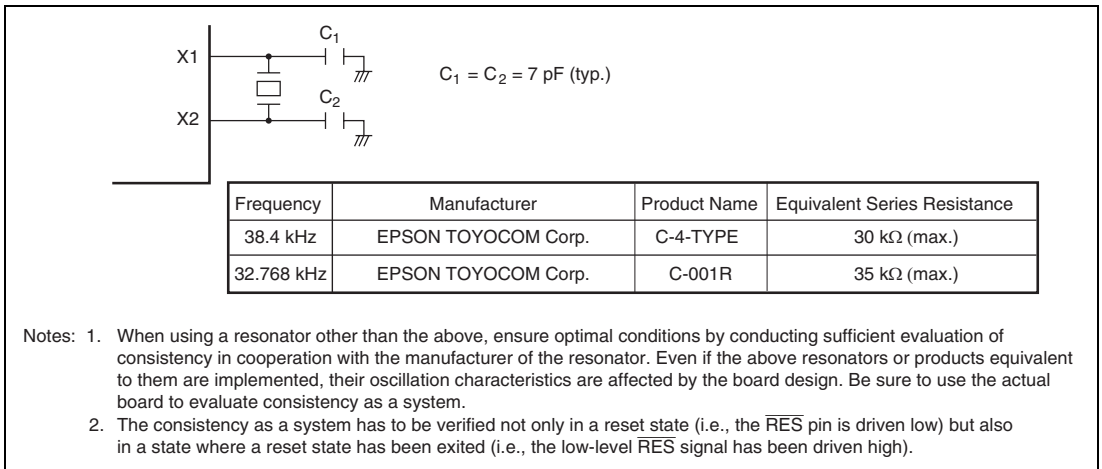


Figure 4.8 Typical Connection to 32.768-kHz/38.4-kHz Crystal Resonator

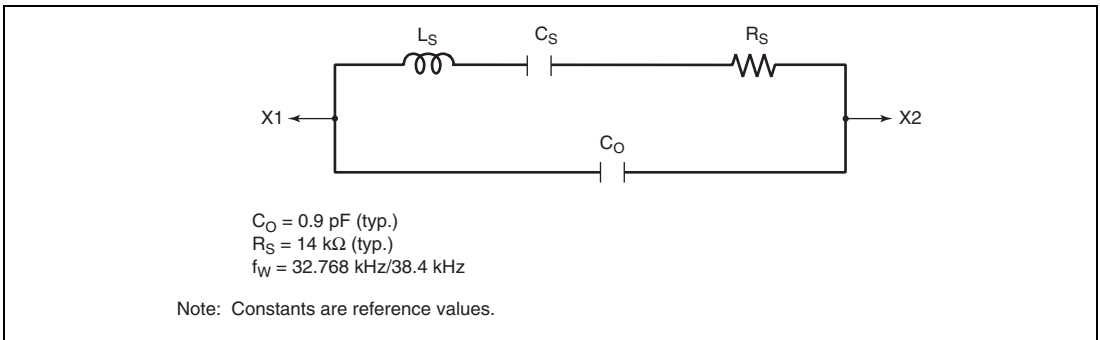


Figure 4.9 Equivalent Circuit of 32.768-kHz/38.4-kHz Crystal Resonator

4.3.2 Pin Connection when Not Using Subclock

When the subclock is not used, connect pin X1 to GND and leave pin X2 open, as shown in figure 4.10.

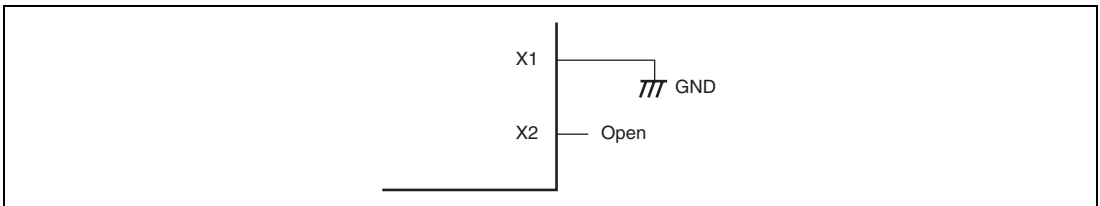


Figure 4.10 Pin Connection when Not Using Subclock

4.3.3 External Clock Input

Connect the external clock to pin X1 and leave pin X2 open, as shown in figure 4.11.

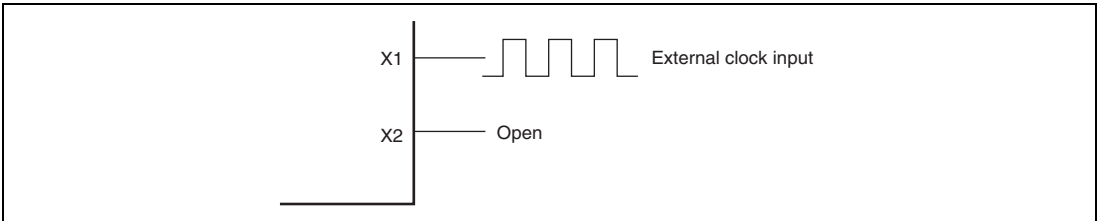


Figure 4.11 Pin Connection when Inputting External Clock

| Frequency | Subclock (ϕ_w) |
|-----------|-----------------------|
| Duty | 45% to 55% |

4.4 Prescalers

4.4.1 Prescaler S

Prescaler S is a 13-bit counter using the system clock (ϕ) as its input clock. It is incremented once per clock period. Prescaler S is initialized to H'0000 by a reset, and starts counting on exit from the reset state. In standby mode, watch mode, subactive mode, and subsleep mode, the system clock pulse generator stops. Prescaler S also stops and is initialized to H'0000. The CPU cannot read or write prescaler S. The output from prescaler S is shared by the on-chip peripheral modules. The division ratio can be set separately for each on-chip peripheral function. In active (medium-speed) mode and sleep mode, the clock input to prescaler S is determined by the division ratio designated by the MA1 and MA0 bits in SYSCR2.

4.4.2 Prescaler W

Prescaler W is a 5-bit counter using a 32.768 kHz or 38.4 kHz signal divided by 4 ($\phi_w/4$) as its input clock. The divided output is used for clock time base operation of timer A. Prescaler W is initialized to H'00 by a reset, and starts counting on exit from the reset state. Even in standby mode, watch mode, subactive mode, or subsleep mode, prescaler W continues functioning. Prescaler W can be reset by setting 1s in bits TMA3 and TMA2 in TMA.

4.5 Usage Notes

4.5.1 Note on Resonators

Resonator characteristics are closely related to board design and should be carefully evaluated by the user, referring to the examples shown in this section. Resonator circuit constants will differ depending on the resonator element, stray capacitance in its interconnecting circuit, and other factors. Suitable constants should be determined in consultation with the resonator manufacturer. Design the circuit so that the resonator never receives voltages exceeding its maximum rating.

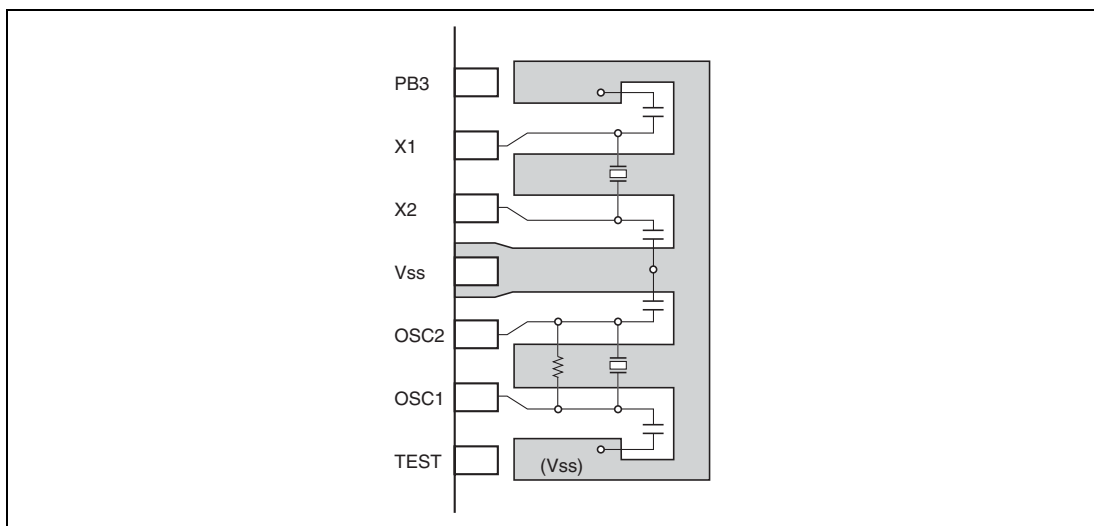


Figure 4.12 Example of Crystal and Ceramic Resonator Arrangement

Figure 4.13 (1) shows an example of the measurement circuit for the negative resistor which is recommended by the resonator manufacturer. Note that if the negative resistor in this circuit does not reach the level which is recommended by the resonator manufacturer, the main oscillator may be hard to start oscillation.

If the negative resistor does not reach the level which is recommended by the resonator manufacturer and oscillation is not started, changes as shown in figure 4.13 (2) to (4) should be made. The proposed change and capacitor size to be applied should be determined according to the evaluation result of the negative resistor and frequency deviation, etc.

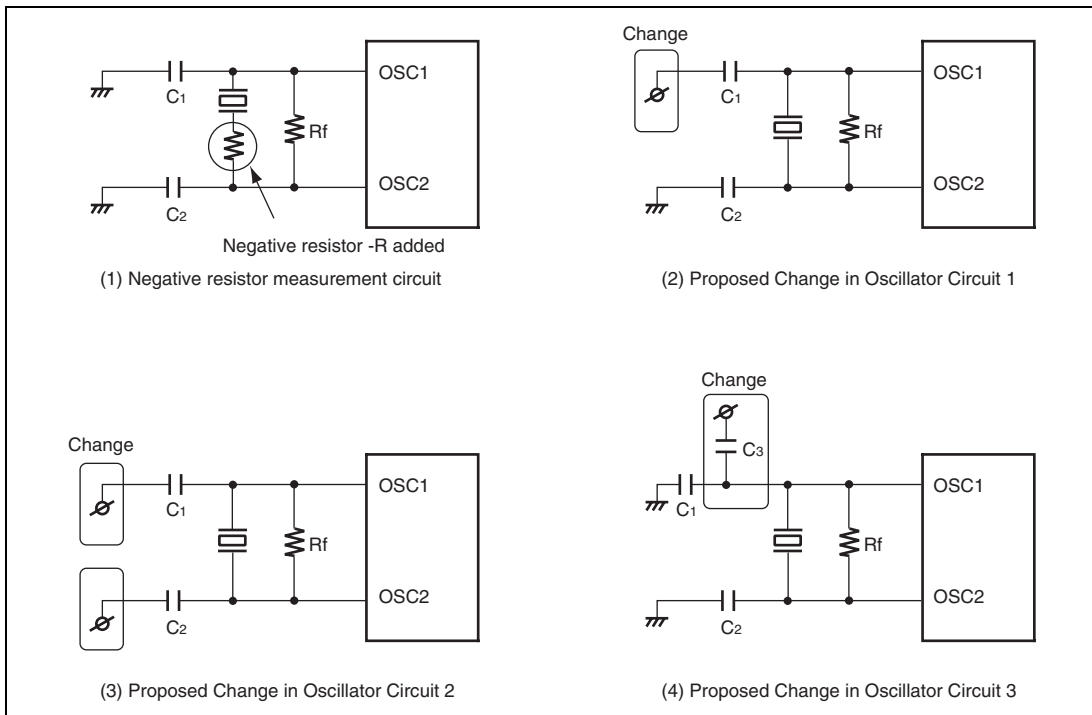


Figure 4.13 Negative Resistor Measurement and Proposed Changes in Circuit

4.5.2 Notes on Board Design

When using a crystal resonator (ceramic resonator), place the resonator and its load capacitors as close as possible to the OSC1 and OSC2 pins. Other signal lines should be routed away from the resonator circuit to prevent induction from interfering with correct oscillation (see figure 4.14).

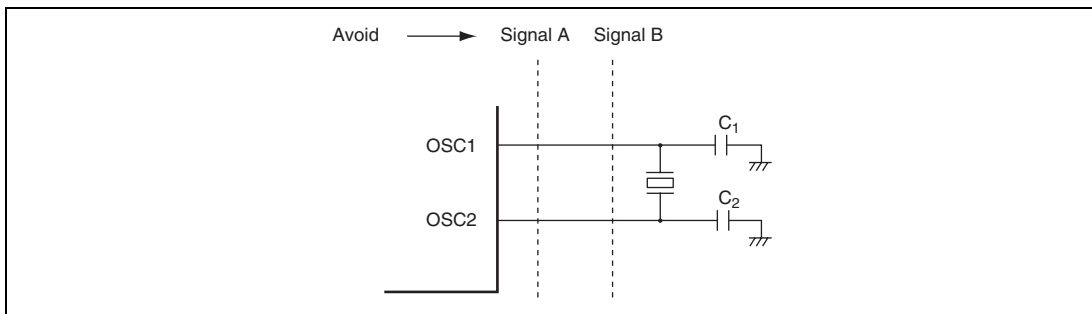


Figure 4.14 Example of Incorrect Board Design

4.5.3 Definition of Oscillation Stabilization Standby Time

Figure 4.15 shows the oscillation waveform (OSC2), system clock (ϕ), and microcomputer operating mode when a transition is made from standby mode, watch mode, or subactive mode, to active (high-speed/medium-speed) mode, with a resonator connected to the system clock oscillator.

As shown in figure 4.15, as the system clock oscillator is halted in standby mode, watch mode, and subactive mode, when a transition is made to active (high-speed/medium-speed) mode, the sum of the following two times (oscillation stabilization time and standby time) is required.

1. Oscillation start time

The time from the point at which the oscillation waveform of the system clock oscillator starts to change when an interrupt is generated, until generation of the system clock is started.

2. Standby time

The time required for the CPU and peripheral functions to begin operating after generation of the system clock has been started.

The standby time setting is selected with standby timer select bits 2 to 0 (STS2 to STS0) (bits 6 to 4 in the system control register 1 (SYSCR1)).

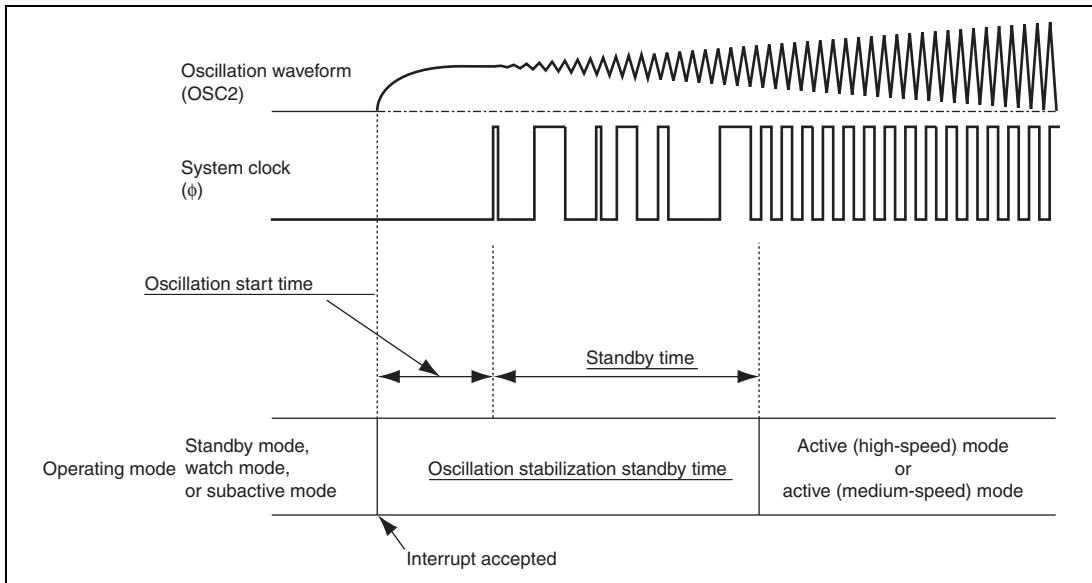


Figure 4.15 Oscillation Stabilization Standby Time

The required oscillation stabilization time is identical with the oscillation stabilization time (t_{ic}) when power as specified by the AC characteristics is supplied. The setting must be such that the time specified by the STS2 to STS0 bits in SYSCR is not less than t_{ic} . Consequently, when a resonator is connected as the system clock oscillator and a transition is made from the standby, watch, or subactive mode to the active (high- or medium-speed) mode, be sure to sufficiently test behavior on the actual circuit. Waiting time must be enough for the amplitudes of OSC1 and OSC2 to become sufficiently large.

Since the oscillation start time varies with the constant of the actual circuit and stray capacitance, determine the oscillation stabilization waiting time in close cooperation with the manufacturer of the resonator.

4.5.4 Notes on Use of Resonator

When a microcomputer operates, the internal power supply potential fluctuates slightly in synchronization with the system clock. Depending on the individual resonator characteristics, the oscillation waveform amplitude may not be sufficiently large immediately after the oscillation stabilization standby time, making the oscillation waveform susceptible to influence by fluctuations in the power supply potential. In this state, the oscillation waveform may be disrupted, leading to an unstable system clock and erroneous operation of the microcomputer.

If erroneous operation occurs, change the setting of standby timer select bits 2 to 0 (STS2 to STS0) (bits 6 to 4 in system control register 1 (SYSCR1)) to give a longer standby time.

For example, if erroneous operation occurs with a standby time setting of 1,024 states, check the operation with a standby time setting of 2,048 states or more.

If the same kind of erroneous operation occurs after a reset as after a state transition, hold the $\overline{\text{RES}}$ pin low for a longer period.

Section 5 Power-Down Modes

This LSI has eight modes of operation after a reset. These include a normal active (high-speed) mode and seven power-down modes, in which power consumption is significantly reduced. The module standby function reduces power consumption by selectively halting on-chip module functions.

- Active (medium-speed) mode
The CPU and all on-chip peripheral modules are operable on the system clock. The system clock frequency can be selected from $\phi_{osc}/16$, $\phi_{osc}/32$, $\phi_{osc}/64$, and $\phi_{osc}/128$.
- Subactive mode
The CPU and all on-chip peripheral modules are operable on the subclock. The subclock frequency can be selected from $\phi_w/2$, $\phi_w/4$, and $\phi_w/8$.
- Sleep (high-speed) mode
The CPU halts. On-chip peripheral modules are operable on the system clock.
- Sleep (medium-speed) mode
The CPU halts. On-chip peripheral modules are operable on the system clock. The system clock frequency can be selected from $\phi_{osc}/16$, $\phi_{osc}/32$, $\phi_{osc}/64$, and $\phi_{osc}/128$.
- Subsleep mode
The CPU halts. The timer A, timer F, SCI3, and AEC are operable on the subclock. The subclock frequency can be selected from $\phi_w/2$, $\phi_w/4$, and $\phi_w/8$.
- Watch mode
The CPU halts. Timer A's timekeeping function, timer F, and AEC are operable on the subclock.
- Standby mode
The CPU and all on-chip peripheral modules halt.
- Module standby function
Independent of the above modes, power consumption can be reduced by halting on-chip peripheral modules that are not used in module units.

Note: In this manual, active (high-speed) mode and active (medium-speed) mode are collectively called active mode.

5.1 Register Descriptions

The registers related to power-down modes are as follows.

- System control register 1 (SYSCR1)
- System control register 2 (SYSCR2)
- Clock halt registers 1 and 2 (CKSTPR1 and CKSTPR2)

5.1.1 System Control Register 1 (SYSCR1)

SYSCR1 controls the power-down modes, as well as SYSCR2.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | SSBY | 0 | R/W | <p>Software Standby</p> <p>Selects the mode to transit after the execution of the SLEEP instruction.</p> <p>0: A transition is made to sleep mode or subsleep mode. 1: A transition is made to standby mode or watch mode.</p> <p>For details, see table 5.2.</p> |
| 6 | STS2 | 0 | R/W | Standby Timer Select 2 to 0 |
| 5 | STS1 | 0 | R/W | <p>Designate the time the CPU and peripheral modules wait for stable clock operation after exiting from standby mode, subactive mode, subsleep mode, or watch mode to active mode or sleep mode due to an interrupt. The designation should be made according to the operating frequency so that the waiting time is at least equal to the oscillation stabilization time. The relationship between the specified value and the number of wait states is shown in table 5.1.</p> <p>When an external clock is to be used, the minimum value (STS2 = 1, STS1 = 0, STS0 = 1) is recommended. If the setting other than the recommended value is made, operation may start before the end of the waiting time.</p> |
| 4 | STS0 | 0 | R/W | |
| 3 | LSON | 0 | R/W | <p>Selects the system clock (ϕ) or subclock (ϕ_{SUB}) as the CPU operating clock when watch mode is cleared.</p> <p>0: The CPU operates on the system clock (ϕ) 1: The CPU operates on the subclock (ϕ_{SUB})</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 2 | — | 1 | — | Reserved This bit is always read as 1 and cannot be modified. |
| 1 | MA1 | 1 | R/W | Active Mode Clock Select 1 and 0 |
| 0 | MA0 | 1 | R/W | Select $\phi_{osc}/16$, $\phi_{osc}/32$, $\phi_{osc}/64$, or $\phi_{osc}/128$ as the operating clock in active (medium-speed) mode and sleep (medium-speed) mode. The MA1 and MA0 bits should be written to in active (high-speed) mode or subactive mode. 00: $\phi_{osc}/16$ 01: $\phi_{osc}/32$ 10: $\phi_{osc}/64$ 11: $\phi_{osc}/128$ |

Table 5.1 Operating Frequency and Waiting Time

| Bit | | | Operating Frequency | | |
|------|------|------|---------------------------------|--------|-------|
| STS2 | STS1 | STS0 | Waiting Time | 5 MHz | 2 MHz |
| 0 | 0 | 0 | 8,192 states | 1.638 | 4.1 |
| | | 1 | 16,384 states | 3.277 | 8.2 |
| | 1 | 0 | 1,024 states | 0.205 | 0.512 |
| | | 1 | 2,048 states | 0.410 | 1.024 |
| 1 | 0 | 0 | 4,096 states | 0.819 | 2.048 |
| | | 1 | 2 states (external clock input) | 0.0004 | 0.001 |
| | 1 | 0 | 8 states | 0.002 | 0.004 |
| | | 1 | 16 states | 0.003 | 0.008 |

Note: The time unit is ms.

If external clock input is used, STS2 to STS0 should be set to the external clock input mode before the mode transition is executed. In addition, STS2 to STS0 should not be set to the external clock input mode if external clock input is not used.

5.1.2 System Control Register 2 (SYSCR2)

SYSCR2 controls the power-down modes, as well as SYSCR1.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 5 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 4 | NESEL | 1 | R/W | Noise Elimination Sampling Frequency Select Selects the frequency at which the watch clock signal (ϕ_w) generated by the subclock pulse generator is sampled, in relation to the oscillator clock (ϕ_{osc}) generated by the system clock pulse generator. When $\phi_{osc} = 2$ to 16 MHz, clear this bit to 0. 0: Sampling rate is $\phi_{osc}/16$. 1: Sampling rate is $\phi_{osc}/4$. |
| 3 | DTON | 0 | R/W | Direct Transfer on Flag Selects the mode to which the transition is made after the SLEEP instruction is executed with bits SSBY and LSON in SYSCR1, bit MSON in SYSCR2, and bit TMA3 in TMA. For details, see table 5.2. |
| 2 | MSON | 0 | R/W | Medium Speed on Flag After standby, watch, or sleep mode is cleared, this bit selects active (high-speed) or active (medium-speed) mode. 0: Operation in active (high-speed) mode 1: Operation in active (medium-speed) mode |
| 1 | SA1 | 0 | R/W | Subactive Mode Clock Select 1 and 0 |
| 0 | SA0 | 0 | R/W | Select the operating clock frequency in subactive and subsleep modes. The operating clock frequency changes to the set frequency after the SLEEP instruction is executed. 00: $\phi_w/8$ 01: $\phi_w/4$ 1x: $\phi_w/2$ |

[Legend] x: Don't care.

5.1.3 Clock Halt Registers 1 and 2 (CKSTPR1 and CKSTPR2)

CKSTPR1 and CKSTPR2 allow the on-chip peripheral modules to enter a standby state in module units.

- CKSTPR1

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|--|
| 7, 6 | — | All 1 | — | Reserved |
| 5 | S32CKSTP | 1 | R/W | SCI Module Standby SCI3 enters standby mode when this bit is cleared to 0.*1 |
| 4 | ADCKSTP | 1 | R/W | A/D Converter Module Standby A/D converter enters standby mode when this bit is cleared to 0. |
| 3 | — | 1 | — | Reserved |
| 2 | TFCKSTP | 1 | R/W | Timer F Module Standby Timer F enters standby mode when this bit is cleared to 0. |
| 1 | — | 1 | — | Reserved |
| 0 | TACKSTP | 1 | R/W | Timer A Module Standby*2 Timer A enters standby mode when this bit is cleared to 0. |

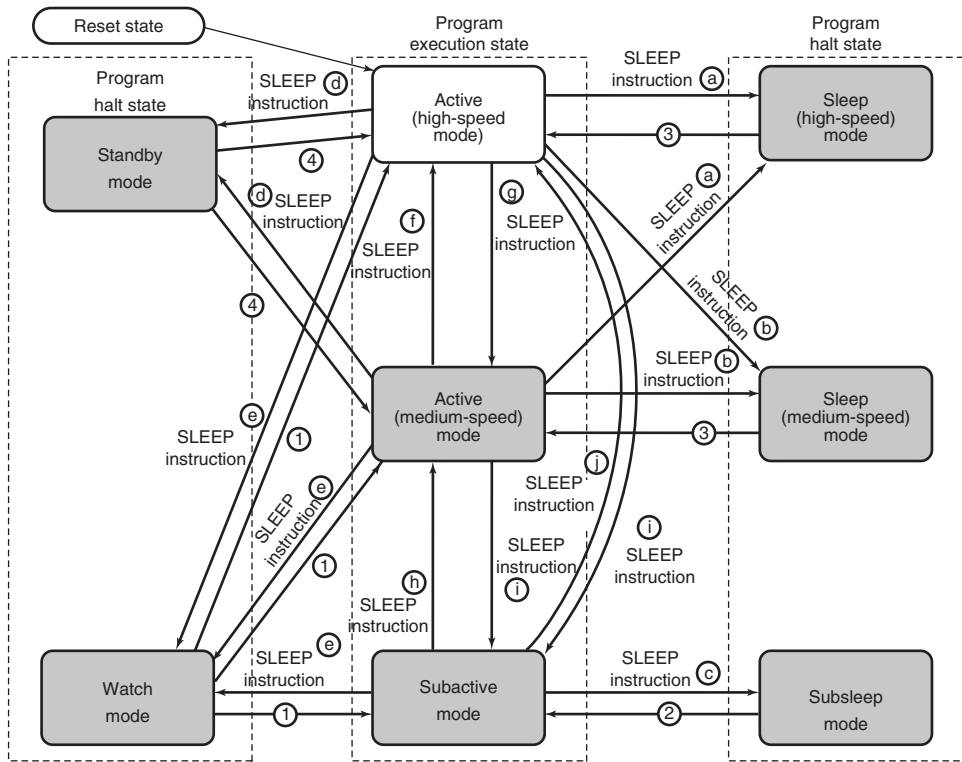
- CKSTPR2

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-------------------|---|
| 7 | — | 1 | R/W | Reserved |
| 6, 5 | — | All 1 | — | Reserved |
| 4 | PW2CKSTP | 1 | R/W ^{*3} | PWM2 Module Standby PWM2 enters standby mode when this bit is cleared to 0. |
| 3 | AECKSTP | 1 | R/W | Asynchronous Event Counter Module Standby Asynchronous event counter enters standby mode when this bit is cleared to 0 |
| 2 | WDCKSTP | 1 | R/W ^{*4} | Watchdog Timer Module Standby Watchdog timer enters standby mode when this bit is cleared to 0 |
| 1 | PW1CKSTP | 1 | R/W | PWM1 Module Standby PWM1 enters standby mode when this bit is cleared to 0 |
| 0 | — | 1 | — | Reserved |

Notes: 1. When the SCI module standby is set, all registers in the SCI3 enter the reset state.
 2. When the timer A module standby is set, the TMA3 bit in TMA cannot be rewritten. When the TMA3 bit is rewritten, the TACKSTP bit in CKSTPR1 should be set to 1 in advance.

5.2 Mode Transitions and States of LSI

Figure 5.1 shows the possible transitions among these operating modes. A transition is made from the program execution state to the program halt state of the program by executing a SLEEP instruction. Interrupts allow for returning from the program halt state to the program execution state of the program. A direct transition between active mode and subactive mode, which are both program execution states, can be made without halting the program. The operating frequency can also be changed in the same modes by making a transition directly from active mode to active mode, and from subactive mode to subactive mode. \overline{RES} input enables transitions from a mode to the reset state. Table 5.2 shows the transition conditions of each mode after the SLEEP instruction is executed and a mode to return by an interrupt. Table 5.3 shows the internal states of the LSI in each mode.



→ : Transition is made after exception handling is executed.

Power-down modes

Mode Transition Conditions (1)

| | LSON | MSON | SSBY | TMA3 | DTON |
|-----|------|------|------|------|------|
| (a) | 0 | 0 | 0 | * | 0 |
| (b) | 0 | 1 | 0 | * | 0 |
| (c) | 1 | * | 0 | 1 | 0 |
| (d) | 0 | * | 1 | 0 | 0 |
| (e) | * | * | 1 | 1 | 0 |
| (f) | 0 | 0 | 0 | * | 1 |
| (g) | 0 | 1 | 0 | * | 1 |
| (h) | 0 | 1 | 1 | 1 | 1 |
| (i) | 1 | * | 1 | 1 | 1 |
| (j) | 0 | 0 | 1 | 1 | 1 |

[Legend] * Don't care

Mode Transition Conditions (2)

| | Interrupt Sources |
|---|---|
| ① | Timer A, Timer F, IRQ0 interrupt, WKP7 to WKP0 interrupts |
| ② | Timer A, Timer F, SCI3 interrupt, IRQ1 and IRQ0, IRQAEC interrupts, WKP7 o WKP0 interrupts, AEC |
| ③ | All interrupts |
| ④ | IRQ1 or IRQ0, WKP7 to WKP0 interrupts |

Note: A transition between different modes cannot be made to occur simply because an interrupt request is generated. Make sure that interrupts are enabled.

Figure 5.1 Mode Transition Diagram

Table 5.2 Transition Mode after SLEEP Instruction Execution and Interrupt Handling

| State Before Transition | LSON | MSON | SSBY | TMA3 | DTON | Transition Mode after SLEEP Instruction Execution | Transition Mode due to Interrupt | Symbol in Figure 5.1 |
|--------------------------|------|------|------|------|------|---|----------------------------------|----------------------|
| Active (high-speed) mode | 0 | 0 | 0 | x | 0 | Sleep (high-speed) mode | Active (high-speed) mode | a |
| | 0 | 1 | 0 | x | 0 | Sleep (medium-speed) mode | Active (medium-speed) mode | b |
| | 0 | 0 | 1 | 0 | 0 | Standby mode | Active (high-speed) mode | d |
| | 0 | 1 | 1 | 0 | 0 | Standby mode | Active (medium-speed) mode | d |
| | 0 | 0 | 1 | 1 | 0 | Watch mode | Active (high-speed) mode | e |
| | 0 | 1 | 1 | 1 | 0 | Watch mode | Active (medium-speed) mode | e |
| | 1 | x | 1 | 1 | 0 | Watch mode | Subactive mode | e |
| | 0 | 0 | 0 | x | 1 | Active (high-speed) mode (direct transition) | — | — |
| | 0 | 1 | 0 | x | 1 | Active (medium-speed) mode (direct transition) | — | g |
| | 1 | x | 1 | 1 | 1 | Subactive mode (direct transition) | — | i |

| State Before Transition | LSON | MSON | SSBY | TMA3 | DTON | Transition Mode after SLEEP Instruction Execution | Transition Mode due to Interrupt | Symbol in Figure 6.1 |
|----------------------------|------|------|------|------|------|---|----------------------------------|----------------------|
| Active (medium-speed) mode | 0 | 0 | 0 | x | 0 | Sleep (high-speed) mode | Active (high-speed) mode | a |
| | 0 | 1 | 0 | x | 0 | Sleep (medium-speed) mode | Active (medium-speed) mode | b |
| | 0 | 0 | 1 | 0 | 0 | Standby mode | Active (high-speed) mode | d |
| | 0 | 1 | 1 | 0 | 0 | Standby mode | Active (medium-speed) mode | d |
| | 0 | 0 | 1 | 1 | 0 | Watch mode | Active (high-speed) mode | e |
| | 0 | 1 | 1 | 1 | 0 | Watch mode | Active (medium-speed) mode | e |
| | 1 | 1 | 1 | 1 | 0 | Watch mode | Subactive mode | e |
| | 0 | 0 | 0 | x | 1 | Active (high-speed) mode (direct transition) | — | f |
| | 0 | 1 | 0 | x | 1 | Active (medium-speed) mode (direct transition) | — | — |
| | 1 | x | 1 | 1 | 1 | Subactive mode (direct transition) | — | i |

| State Before Transition | LSON | MSON | SSBY | TMA3 | DTON | Transition Mode after SLEEP | Transition Mode due to Interrupt | Symbol in Figure 6.1 |
|-------------------------------|------|------|------|------|------|--|--|-------------------------|
| | | | | | | Instruction Execution | | |
| Subactive mode | 1 | x | 0 | 1 | 0 | Subsleep mode | Subactive mode | c |
| | 0 | 0 | 1 | 1 | 0 | Watch mode | Active (high- speed) mode | e |
| | 0 | 1 | 1 | 1 | 0 | Watch mode | Active (medium- speed) mode | e |
| | 1 | x | 1 | 1 | 0 | Watch mode | Subactive mode | e |
| | 0 | 0 | 1 | 1 | 1 | Active (high- speed) mode (direct transition) | — | j |
| | 0 | 1 | 1 | 1 | 1 | Active (medium- speed) mode (direct transition) | — | h |
| | 1 | x | 1 | 1 | 1 | Subactive mode (direct transition) | — | — |

[Legend]

x: Don't care

Table 5.3 Internal State in Each Operating Mode

| Function | Active Mode | | Sleep Mode | | Watch Mode | Subactive Mode | Subsleep Mode | Stand-by Mode | |
|-------------------------|----------------------|--------------|-------------|--------------|-------------|--|--|---|--|
| | High-speed | Medium-speed | High-speed | Medium-speed | | | | | |
| System clock oscillator | Functioning | Functioning | Functioning | Functioning | Halted | Halted | Halted | Halted | |
| Subclock oscillator | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | |
| CPU | Instructions | Functioning | Functioning | Halted | Halted | Halted | Functioning | Halted | Halted |
| | RAM | | | Retained | Retained | Retained | | Retained | Retained |
| | Registers | | | | | | | | |
| | I/O | | | | | | | | Retained ^{*1} |
| External interrupts | IRQ0 | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning | Functioning |
| | IRQ1 | | | | | Retained ^{*4} | | | |
| | IRQAEC | | | | | | | | Retained ^{*4} |
| | WKP7 to WKP0 | | | | | Functioning | | | Functioning |
| Peripheral modules | Timer A | Functioning | Functioning | Functioning | Functioning | Functioning ^{*3} | Functioning ^{*3} | Functioning ^{*3} | Retained |
| | Asynchronous counter | | | | | Functioning ^{*5} | Functioning | Functioning | Functioning ^{*5} |
| | Timer F | | | | | Functioning/ retained ^{*6} | Functioning/ retained ^{*6} | Functioning/ retained ^{*6*} | Retained |
| | WDT | | | | | Functioning/ retained ^{*8} | Functioning/ retained ^{*7} | Functioning/ retained ^{*8} | Functioning/ retained ^{*8} |
| | SCI3 | Functioning | Functioning | Functioning | Functioning | Reset | Functioning/ retained ^{*2} | Functioning/ retained ^{*2} | Reset |
| PWM | Functioning | Functioning | Functioning | Functioning | Retained | Retained | Retained | Retained | |
| Peripheral modules | A/D converter | Functioning | Functioning | Functioning | Functioning | Retained | Retained | Retained | Retained |

- Notes:
1. Register contents are retained. Output is the high-impedance state.
 2. Functioning if $\phi_w/2$ is selected as an internal clock, or halted and retained otherwise.
 3. Functioning if the timekeeping time-base function is selected.
 4. An external interrupt request is ignored. Contents of the interrupt request register are not affected.
 5. The counter can be incremented. An interrupt cannot occur.
 6. Functioning if $\phi_w/4$ is selected as an internal clock. Halted and retained otherwise.
 7. Operates when $\phi_w/32$ is selected as the internal clock; otherwise stops and stands by.
 8. Stops and stands by.

5.2.1 Sleep Mode

In sleep mode, CPU operation is halted but the system clock oscillator, subclock oscillator, and on-chip peripheral modules function. In sleep (medium-speed) mode, the on-chip peripheral modules function at the clock frequency set by the MA1 and MA0 bits in SYSCR1. CPU register contents are retained.

Sleep mode is cleared by an interrupt. When an interrupt is requested, sleep mode is cleared and interrupt exception handling starts. Sleep mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled by the interrupt enable bit. After sleep mode is cleared, a transition is made from sleep (high-speed) mode to active (high-speed) mode or from sleep (medium-speed) mode to active (medium-speed) mode.

When the $\overline{\text{RES}}$ pin goes low, the CPU goes into the reset state and sleep mode is cleared. Since an interrupt request signal is synchronous with the system clock, the maximum time of $2/\phi$ (s) may be delayed from the point at which an interrupt request signal occurs until the interrupt exception handling is started.

Furthermore, it sometimes operates with half state early timing at the time of transition to sleep (medium-speed) mode.

5.2.2 Standby Mode

In standby mode, the clock pulse generator stops, so the CPU and on-chip peripheral modules stop functioning. However, as long as the rated voltage is supplied, the contents of CPU registers, on-chip RAM, and some on-chip peripheral module registers are retained. On-chip RAM contents will be retained as long as the voltage set by the RAM data retention voltage is provided. The I/O ports go to the high-impedance state.

Standby mode is cleared by an interrupt. When an interrupt is requested, the system clock pulse generator starts. After the time set in bits STS2 to STS0 in SYSCR1 has elapsed, standby mode is cleared and interrupt exception handling starts. After standby mode is cleared, a transition is made to active (high-speed) or active (medium-speed) mode according to the MSON bit in SYSCR2. Standby mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled by the interrupt enable bit.

When the $\overline{\text{RES}}$ pin goes low, the system clock pulse generator starts. Since system clock signals are supplied to the entire chip as soon as the system clock pulse generator starts functioning, the $\overline{\text{RES}}$ pin must be kept low until the pulse generator output stabilizes. After the pulse generator output has stabilized, the CPU starts reset exception handling if the $\overline{\text{RES}}$ pin is driven high.

5.2.3 Watch Mode

In watch mode, the system clock oscillator and CPU operation stop and on-chip peripheral modules stop functioning except for the timer A, timer F, and asynchronous event counter. However, as long as the rated voltage is supplied, the contents of CPU registers, some on-chip peripheral module registers, and on-chip RAM are retained. The I/O ports retain their state before the transition.

Watch mode is cleared by an interrupt. When an interrupt is requested, watch mode is cleared and interrupt exception handling starts. When watch mode is cleared by an interrupt, a transition is made to active (high-speed) mode, active (medium-speed) mode, or subactive mode depending on the settings of the LSON bit in SYSCR1 and the MSON bit in SYSCR2. When the transition is made to active mode, after the time set in bits STS2 to STS0 in SYSCR1 has elapsed, interrupt exception handling starts. Watch mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled by the interrupt enable bit.

When the $\overline{\text{RES}}$ pin goes low, the system clock pulse generator starts. Since system clock signals are supplied to the entire chip as soon as the system clock pulse generator starts functioning, the $\overline{\text{RES}}$ pin must be kept low until the pulse generator output stabilizes. After the pulse generator output has stabilized, the CPU starts reset exception handling if the $\overline{\text{RES}}$ pin is driven high.

5.2.4 Subsleep Mode

In subsleep mode, the CPU operation stops but on-chip peripheral modules other than the A/D converter and PWM function. As long as a required voltage is applied, the contents of CPU registers, the on-chip RAM, and some registers of the on-chip peripheral modules are retained. I/O ports keep the same states as before the transition.

Subsleep mode is cleared by an interrupt. When an interrupt is requested, subsleep mode is cleared and interrupt exception handling starts. After subsleep mode is cleared, a transition is made to subactive mode. Subsleep mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled in the interrupt enable register.

When the $\overline{\text{RES}}$ pin goes low, the system clock pulse generator starts. Since system clock signals are supplied to the entire chip as soon as the system clock pulse generator starts functioning, the $\overline{\text{RES}}$ pin must be kept low until the pulse generator output stabilizes. After the pulse generator output has stabilized, the CPU starts reset exception handling if the $\overline{\text{RES}}$ pin is driven high.

5.2.5 Subactive Mode

In subactive mode, the system clock oscillator stops but on-chip peripheral modules other than the A/D converter and PWM function. As long as a required voltage is applied, the contents of some registers of the on-chip peripheral modules are retained.

Subactive mode is cleared by the SLEEP instruction. When subactive mode is cleared, a transition to subsleep mode, active mode, or watch mode is made, depending on the combination of bits SSBY and LSON in SYSCR1, bits MSON and DTON in SYSCR2, and bit TMA3 in TMA. Subactive mode is not cleared if the I bit in CCR is set to 1 or the requested interrupt is disabled in the interrupt enable register.

When the $\overline{\text{RES}}$ pin goes low, the system clock pulse generator starts. Since system clock signals are supplied to the entire chip as soon as the system clock pulse generator starts functioning, the $\overline{\text{RES}}$ pin must be kept low until the pulse generator output stabilizes. After the pulse generator output has stabilized, the CPU starts reset exception handling if the $\overline{\text{RES}}$ pin is driven high.

The operating frequency of subactive mode is selected from $\phi_w/2$, $\phi_w/4$, and $\phi_w/8$ by the SA1 and SA0 bits in SYSCR2. After the SLEEP instruction is executed, the operating frequency changes to the frequency which is set before the execution.

5.2.6 Active (Medium-Speed) Mode

In active (medium-speed) mode, the system clock oscillator, subclock oscillator, CPU, and on-chip peripheral modules function.

Active (medium-speed) mode is cleared by the SLEEP instruction. When active (medium-speed) mode is cleared, a transition to standby mode is made depending on the combination of bits SSBY and LSON in SYSCR1 and bit TMA3 in TMA, a transition to watch mode is made depending on the combination of bit SSBY in SYSCR1 and bit TMA3 in TMA, or a transition to sleep mode is made depending on the combination of bits SSBY and LSON in SYSCR1. Moreover, a transition to active (high-speed) mode or subactive mode is made by a direct transition. Active (medium-sleep) mode is not entered if the I bit in CCR is set to 1 or the requested interrupt is disabled in the interrupt enable register. When the $\overline{\text{RES}}$ pin goes low, the CPU goes into the reset state and active (medium-sleep) mode is cleared.

Furthermore, it sometimes operates with half state early timing at the time of transition to active (medium-speed) mode.

In active (medium-speed) mode, the on-chip peripheral modules function at the clock frequency set by the MA1 and MA0 bits in SYSCR1.

5.3 Direct Transition

The CPU can execute programs in two modes: active and subactive mode. A direct transition is a transition between these two modes without stopping program execution. A direct transition can be made by executing a SLEEP instruction while the DTON bit in SYSCR2 is set to 1. The direct transition also enables operating frequency modification in active or subactive mode. After the mode transition, direct transition interrupt exception handling starts.

If the direct transition interrupt is disabled in interrupt permission register 2, a transition is made instead to sleep or watch mode. Note that if a direct transition is attempted while the I bit in CCR is set to 1, sleep or watch mode will be entered, and the resulting mode cannot be cleared by means of an interrupt.

- Direct transfer from active (high-speed) mode to active (medium-speed) mode
When a SLEEP instruction is executed in active (high-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is set to 1, and the DTON bit in SYSCR2 is set to 1, a transition is made to active (medium-speed) mode via sleep mode.
- Direct transfer from active (medium-speed) mode to active (high-speed) mode
When a SLEEP instruction is executed in active (medium-speed) mode while the SSBY and LSON bits in SYSCR1 are cleared to 0, the MSON bit in SYSCR2 is cleared to 0, and the DTON bit in SYSCR2 is set to 1, a transition is made to active (high-speed) mode via sleep mode.
- Direct transfer from active (high-speed) mode to subactive mode
When a SLEEP instruction is executed in active (high-speed) mode while the SSBY and LSON bits in SYSCR1 are set to 1, the DTON bit in SYSCR2 is set to 1, and the TMA3 bit in TMA is set to 1, a transition is made to subactive mode via watch mode.
- Direct transfer from subactive mode to active (high-speed) mode
When a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON bit in SYSCR2 is cleared to 0, the DTON bit in SYSCR2 is set to 1, and the TMA3 bit in TMA is set to 1, a transition is made directly to active (high-speed) mode via watch mode after the waiting time set in bits STS2 to STS0 in SYSCR1 has elapsed.
- Direct transfer from active (medium-speed) mode to subactive mode
When a SLEEP instruction is executed in active (medium-speed) while the SSBY and LSON bits in SYSCR1 are set to 1, the DTON bit in SYSCR2 is set to 1, and the TMA3 bit in TMA is set to 1, a transition is made to subactive mode via watch mode.

- Direct transfer from subactive mode to active (medium-speed) mode

When a SLEEP instruction is executed in subactive mode while the SSBY bit in SYSCR1 is set to 1, the LSON bit in SYSCR1 is cleared to 0, the MSON bit in SYSCR2 is set to 1, the DTON bit in SYSCR2 is set to 1, and the TMA3 bit in TMA is set to 1, a transition is made directly to active (medium-speed) mode via watch mode after the waiting time set in bits STS2 to STS0 in SYSCR1 has elapsed.

5.3.1 Direct Transition from Active (High-Speed) Mode to Active (Medium-Speed) Mode

The time from the start of SLEEP instruction execution to the end of interrupt exception handling (the direct transition time) is calculated by equation (1).

$$\text{Direct transition time} = \{(\text{Number of SLEEP instruction execution states}) + (\text{Number of internal processing states})\} \times (\text{tcyc before transition}) + (\text{Number of interrupt exception handling execution states}) \times (\text{tcyc after transition}) \dots\dots\dots(1)$$

Example: Direct transition time = $(2 + 1) \times 2t_{osc} + 14 \times 16t_{osc} = 230t_{osc}$ (when $\phi/8$ is selected as the CPU operating clock)

Legend:

tosc: OSC clock cycle time

tcyc: System clock (ϕ) cycle time

5.3.2 Direct Transition from Active (Medium-Speed) Mode to Active (High-Speed) Mode

The time from the start of SLEEP instruction execution to the end of interrupt exception handling (the direct transition time) is calculated by equation (2).

$$\text{Direct transition time} = \{(\text{Number of SLEEP instruction execution states}) + (\text{Number of internal processing states})\} \times (\text{tcyc before transition}) + (\text{Number of interrupt exception handling execution states}) \times (\text{tcyc after transition}) \dots\dots\dots(2)$$

Example: Direct transition time = $(2 + 1) \times 16\text{tosc} + 14 \times 2\text{tosc} = 76\text{tosc}$ (when $\phi/8$ is selected as the CPU operating clock)

Legend:

tosc: OSC clock cycle time

tcyc: System clock (ϕ) cycle time

5.3.3 Direct Transition from Subactive Mode to Active (High-Speed) Mode

The time from the start of SLEEP instruction execution to the end of interrupt exception handling (the direct transition time) is calculated by equation (3).

$$\text{Direct transition time} = \{(\text{Number of SLEEP instruction execution states}) + (\text{Number of internal processing states})\} \times (\text{tsubcyc before transition}) + \{(\text{Wait time set in bits STS2 to STS0}) + (\text{Number of interrupt exception handling execution states})\} \times (\text{tcyc after transition}) \dots\dots\dots(3)$$

Example: Direct transition time = $(2 + 1) \times 8\text{tw} + (8192 + 14) \times 2\text{tosc} = 24\text{tw} + 16412\text{tosc}$ (when $\phi_w/8$ is selected as the CPU operating clock and wait time = 8192 states)

Legend:

tosc: OSC clock cycle time

tw: Watch clock cycle time

tcyc: System clock (ϕ) cycle time

tsubcyc: Subclock (ϕ_{SUB}) cycle time

5.3.4 Direct Transition from Subactive Mode to Active (Medium-Speed) Mode

The time from the start of SLEEP instruction execution to the end of interrupt exception handling (the direct transition time) is calculated by equation (4).

$$\text{Direct transition time} = \{(\text{Number of SLEEP instruction execution states}) + (\text{Number of internal processing states})\} \times (\text{tsubcyc before transition}) + \{(\text{Wait time set in bits STS2 to STS0}) + (\text{Number of interrupt exception handling execution states})\} \times (\text{tcyc after transition}) \dots\dots\dots(4)$$

Example: Direct transition time = $(2 + 1) \times 8tw + (8192 + 14) \times 16tosc = 24tw + 131296tosc$ (when $\phi w/8$ or $\phi/8$ is selected as the CPU operating clock and wait time = 8192 states)

Legend:

- tosc: OSC clock cycle time
- tw: Watch clock cycle time
- tcyc: System clock (ϕ) cycle time
- tsubcyc: Subclock (ϕ_{SUB}) cycle time

5.3.5 Notes on External Input Signal Changes before/after Direct Transition

- Direct transition from active (high-speed) mode to subactive mode
Since the mode transition is performed via watch mode, see section 5.5.2, Notes on External Input Signal Changes before/after Standby Mode.
- Direct transition from active (medium-speed) mode to subactive mode
Since the mode transition is performed via watch mode, see section 5.5.2, Notes on External Input Signal Changes before/after Standby Mode.
- Direct transition from subactive mode to active (high-speed) mode
Since the mode transition is performed via watch mode, see section 5.5.2, Notes on External Input Signal Changes before/after Standby Mode.
- Direct transition from subactive mode to active (medium-speed) mode
Since the mode transition is performed via watch mode, see section 5.5.2, Notes on External Input Signal Changes before/after Standby Mode.

5.4 Module Standby Function

The module-standby function can be set to any peripheral module. In module standby mode, the clock supply to modules stops to enter the power-down mode. Module standby mode enables each on-chip peripheral module to enter the standby state by clearing a bit that corresponds to each module in CKSTPR1 and CKSTPR2 to 0 and cancels the mode by setting the bit to 1. (See section 5.1.3, Clock Halt Registers 1 and 2 (CKSTPR1 and CKSTPR2).)

5.5 Usage Notes

5.5.1 Standby Mode Transition and Pin States

When a SLEEP instruction is executed in active (high-speed) mode or active (medium-speed) mode while bit SSBY is set to 1 and bit LSON is cleared to 0 in SYSCR1, and bit TMA3 is cleared to 0 in TMA, a transition is made to standby mode. At the same time, pins go to the high-impedance state (except pins for which the pull-up MOS is designated as on). Figure 5.2 shows the timing in this case.

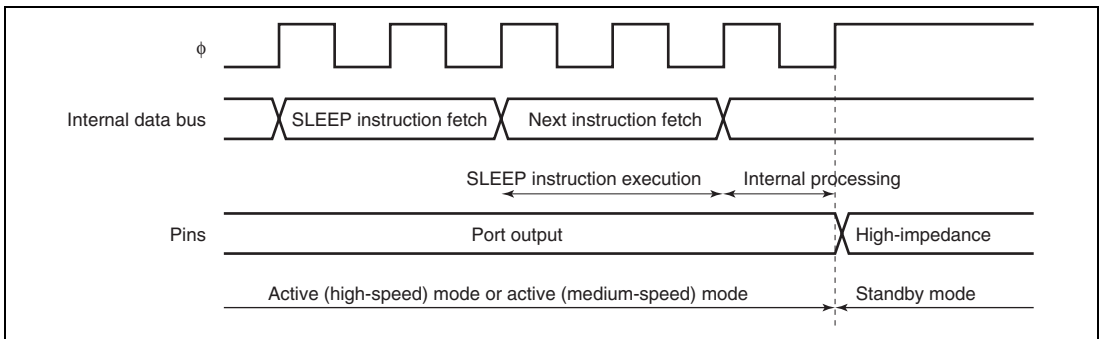


Figure 5.2 Standby Mode Transition and Pin States

5.5.2 Notes on External Input Signal Changes before/after Standby Mode

- When external input signal changes before/after standby mode or watch mode

When an external input signal such as $\overline{\text{IRQ}}$, $\overline{\text{WKP}}$, or IRQAEC is input, both the high- and low-level widths of the signal must be at least two cycles of system clock ϕ or subclock ϕ_{SUB} (referred to together in this section as the internal clock). As the internal clock stops in standby mode and watch mode, the width of external input signals requires careful attention when a transition is made via these operating modes. Ensure that external input signals conform to the conditions stated in 3, Recommended timing of external input signals, below.

- When external input signals cannot be captured because internal clock stops

The case of falling edge capture is shown in figure 5.3.

As shown in the case marked "Capture not possible," when an external input signal falls immediately after a transition to active (high-speed or medium-speed) mode or subactive mode, after oscillation is started by an interrupt via a different signal, the external input signal cannot be captured if the high-level width at that point is less than $2 t_{\text{cyc}}$ or $2 t_{\text{subcyc}}$.

- Recommended timing of external input signals

To ensure dependable capture of an external input signal, high- and low-level signal widths of at least $2 t_{\text{cyc}}$ or $2 t_{\text{subcyc}}$ are necessary before a transition is made to standby mode or watch mode, as shown in "Capture possible: case 1."

External input signal capture is also possible with the timing shown in "Capture possible: case 2" and "Capture possible: case 3," in which a $2 t_{\text{cyc}}$ or $2 t_{\text{subcyc}}$ level width is secured.

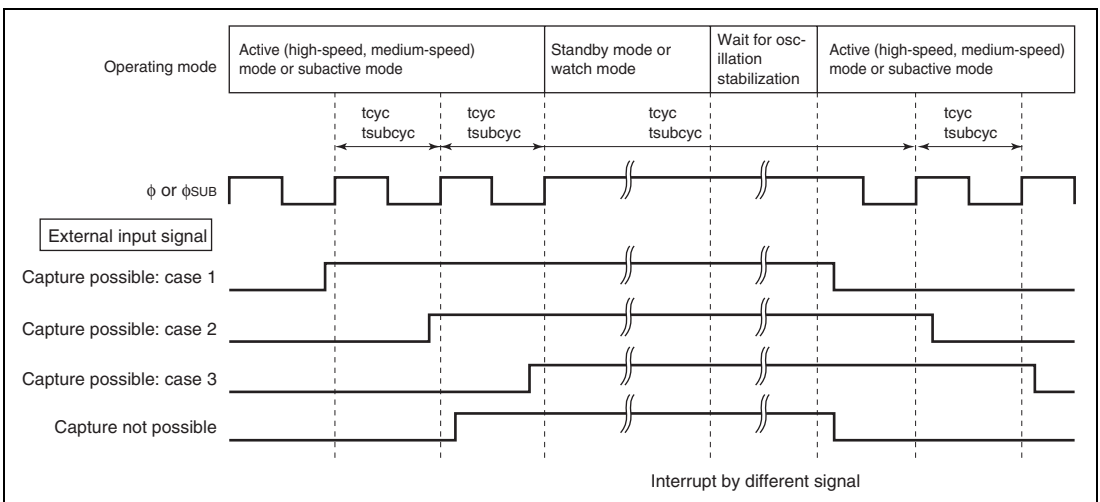


Figure 5.3 External Input Signal Capture when Signal Changes before/after Standby Mode or Watch Mode

4. Input pins to which these notes apply:

$\overline{\text{IRQ1}}$, $\overline{\text{IRQ0}}$, $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$, and $\overline{\text{IRQAEC}}$

Section 6 ROM

The H8/38704 has 32 kbytes of the on-chip mask ROM, the H8/38703 has 24 kbytes, the H8/38702 and H8/38702S have 16 kbytes, the H8/38701S has 12 kbytes, and the H8/38700S has 8 kbytes. The ROM is connected to the CPU by a 16-bit data bus, allowing high-speed two-state access for both byte data and word data. The H8/38704 and H8/38702 have flash ROM versions with 32-kbyte flash memory and 16-kbyte flash memory, respectively.

6.1 Block Diagram

Figure 6.1 shows a block diagram of the on-chip ROM.

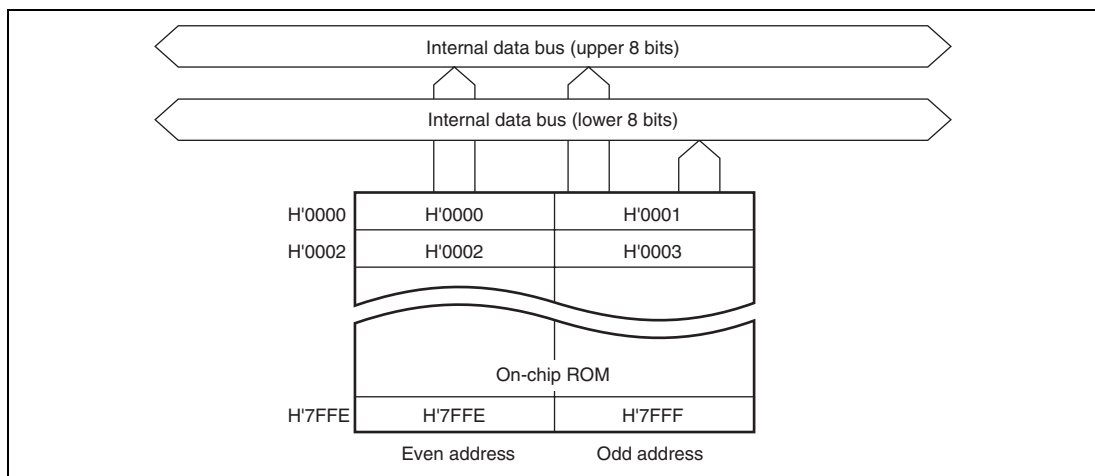


Figure 6.1 Block Diagram of ROM

6.2 Overview of Flash Memory

6.2.1 Features

The features of the 32-kbyte or 16-kbyte flash memory built into the flash memory version are summarized below.

- Programming/erase methods
 - The flash memory is programmed 128 bytes at a time. Erase is performed in single-block units. The 32-kbyte flash memory are configured as 1 kbyte \times 4 blocks and 28 kbytes \times 1 block. The 16-kbyte flash memory is configured as 1 kbyte \times 4 blocks and 12 kbytes \times 1 block. To erase the entire flash memory, each block must be erased in turn.
- On-board programming
 - On-board programming/erasing can be done in boot mode, in which the boot program built into the chip is started to erase or program of the entire flash memory. In normal user program mode, individual blocks can be erased or programmed.
- Programmer mode
 - Flash memory can be programmed/erased in programmer mode using a PROM programmer, as well as in on-board programming mode.
- Automatic bit rate adjustment
 - For data transfer in boot mode, this LSI's bit rate can be automatically adjusted to match the transfer bit rate of the host.
- Programming/erasing protection
 - Sets software protection against flash memory programming/erasing.
- Power-down mode
 - Operation of the power supply circuit can be partly halted in subactive mode. As a result, flash memory can be read with low power consumption.

6.2.2 Block Diagram

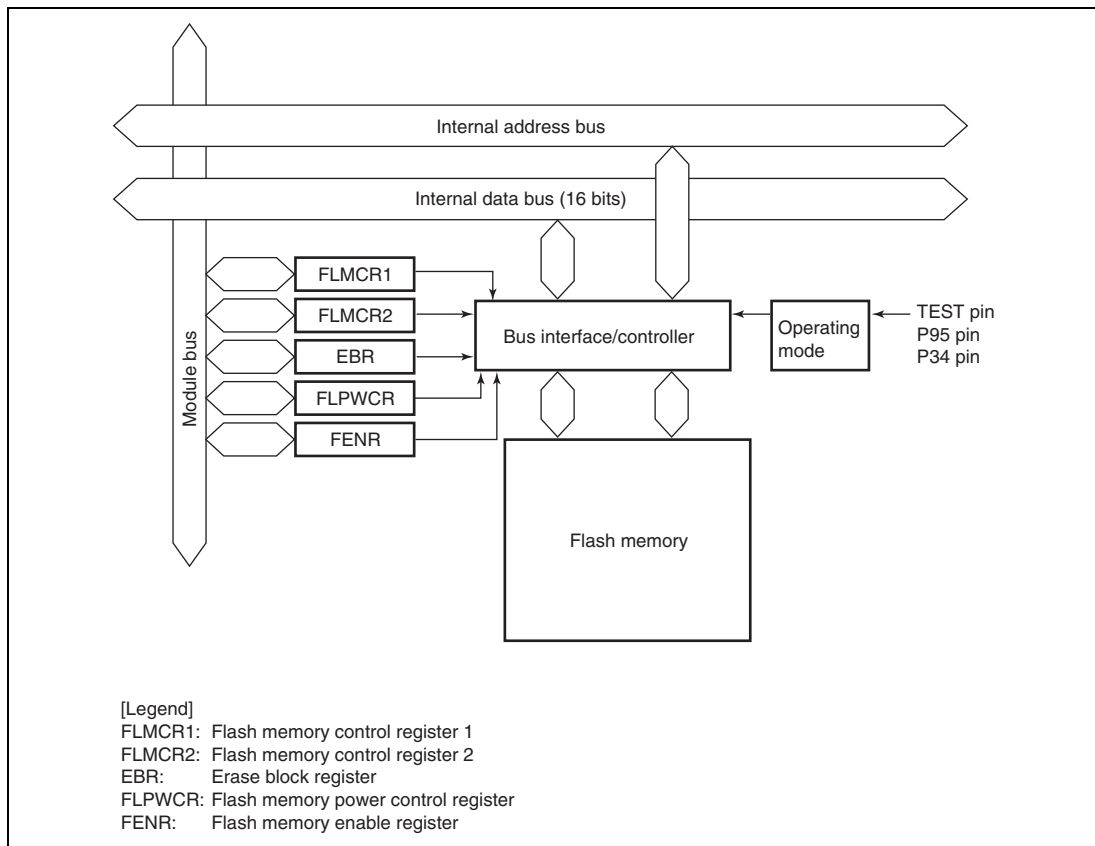


Figure 6.2 Block Diagram of Flash Memory

6.2.3 Block Configuration

Figure 6.3 shows the block configuration of 32-kbyte flash memory. The thick lines indicate erasing units, the narrow lines indicate programming units, and the values are addresses. The 32-kbyte flash memory is divided into 1 kbyte \times 4 blocks and 28 kbytes \times 1 block. Erasing is performed in these units. The 16-kbyte flash memory is divided into 1 kbyte \times 4 blocks and 12 kbytes \times 1 block. Programming is performed in 128-byte units starting from an address with lower eight bits H'00 or H'80.

| | | | | | |
|-------------------------|--------|--------|--------|---------------------------------|--------|
| Erase unit 1 kbyte | H'0000 | H'0001 | H'0002 | ← Programming unit: 128 bytes → | H'007F |
| | H'0080 | H'0081 | H'0082 | | H'00FF |
| Erase unit 1 kbyte | H'0380 | H'0381 | H'0382 | | H'03FF |
| | H'0400 | H'0401 | H'0402 | ← Programming unit: 128 bytes → | H'047F |
| Erase unit 1 kbyte | H'0480 | H'0481 | H'0482 | | H'04FF |
| | H'0780 | H'0781 | H'0782 | | H'07FF |
| Erase unit 1 kbyte | H'0800 | H'0801 | H'0802 | ← Programming unit: 128 bytes → | H'087F |
| | H'0880 | H'0881 | H'0882 | | H'08FF |
| Erase unit 1 kbyte | H'0B80 | H'0B81 | H'0B82 | | H'0BFF |
| | H'0C00 | H'0C01 | H'0C02 | ← Programming unit: 128 bytes → | H'0C7F |
| Erase unit 1 kbyte | H'0C80 | H'0C81 | H'0C82 | | H'0CFF |
| | H'0F80 | H'0F81 | H'0F82 | | H'0FFF |
| Erase unit 28 kbytes | H'1000 | H'1001 | H'1002 | ← Programming unit: 128 bytes → | H'107F |
| | H'1080 | H'1081 | H'1082 | | H'10FF |
| | H'7F80 | H'7F81 | H'7F82 | | H'7FFF |

Figure 6.3(1) Block Configuration of 32-kbyte Flash Memory

| | | | | | |
|-------------------------|--------|--------|--------|---------------------------------|--------|
| Erase unit 1 kbyte | H'0000 | H'0001 | H'0002 | ← Programming unit: 128 bytes → | H'007F |
| | H'0080 | H'0081 | H'0082 | | H'00FF |
| Erase unit 1 kbyte | H'0380 | H'0381 | H'0382 | | H'03FF |
| | H'0400 | H'0401 | H'0402 | ← Programming unit: 128 bytes → | H'047F |
| Erase unit 1 kbyte | H'0480 | H'0481 | H'0482 | | H'04FF |
| | H'0780 | H'0781 | H'0782 | | H'07FF |
| Erase unit 1 kbyte | H'0800 | H'0801 | H'0802 | ← Programming unit: 128 bytes → | H'087F |
| | H'0880 | H'0881 | H'0882 | | H'08FF |
| Erase unit 1 kbyte | H'0B80 | H'0B81 | H'0B82 | | H'0BFF |
| | H'0C00 | H'0C01 | H'0C02 | ← Programming unit: 128 bytes → | H'0C7F |
| Erase unit 1 kbyte | H'0C80 | H'0C81 | H'0C82 | | H'0CFF |
| | H'0F80 | H'0F81 | H'0F82 | | H'0FFF |
| Erase unit 12 kbytes | H'1000 | H'1001 | H'1002 | ← Programming unit: 128 bytes → | H'107F |
| | H'1080 | H'1081 | H'1082 | | H'10FF |
| | H'3F80 | H'3F81 | H'3F82 | | H'3FFF |

Figure 6.3(2) Block Configuration of 16-kbyte Flash Memory

6.3 Register Descriptions

The flash memory has the following registers.

- Flash memory control register 1 (FLMCR1)
- Flash memory control register 2 (FLMCR2)
- Erase block register (EBR)
- Flash memory power control register (FLPWCR)
- Flash memory enable register (FENR)

6.3.1 Flash Memory Control Register 1 (FLMCR1)

FLMCR1 is a register that makes the flash memory change to program mode, program-verify mode, erase mode, or erase-verify mode. For details on register setting, refer to section 6.5, Flash Memory Programming/Erasing.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | — | 0 | — | Reserved This bit is always read as 0. |
| 6 | SWE | 0 | R/W | Software Write Enable When this bit is set to 1, flash memory programming/erasing is enabled. When this bit is cleared to 0, flash memory programming/erasing is invalid. Other FLMCR1 bits and all EBR bits cannot be set. |
| 5 | ESU | 0 | R/W | Erase Setup When this bit is set to 1, the flash memory changes to the erase setup state. When it is cleared to 0, the erase setup state is cancelled. Set this bit to 1 before setting the E bit to 1 in FLMCR1. |
| 4 | PSU | 0 | R/W | Program Setup When this bit is set to 1, the flash memory changes to the program setup state. When it is cleared to 0, the program setup state is cancelled. Set this bit to 1 before setting the P bit in FLMCR1. |
| 3 | EV | 0 | R/W | Erase-Verify When this bit is set to 1, the flash memory changes to erase-verify mode. When it is cleared to 0, erase-verify mode is cancelled. |
| 2 | PV | 0 | R/W | Program-Verify When this bit is set to 1, the flash memory changes to program-verify mode. When it is cleared to 0, program-verify mode is cancelled. |
| 1 | E | 0 | R/W | Erase When this bit is set to 1, and while the SWE = 1 and ESU = 1 bits are 1, the flash memory changes to erase mode. When it is cleared to 0, erase mode is cancelled. |
| 0 | P | 0 | R/W | Program When this bit is set to 1, and while the SWE = 1 and PSU = 1 bits are 1, the flash memory changes to program mode. When it is cleared to 0, program mode is cancelled. |

Note: Bits SWE, PSU, EV, PV, E, and P should not be set at the same time.

6.3.2 Flash Memory Control Register 2 (FLMCR2)

FLMCR2 is a register that displays the state of flash memory programming/erasing. FLMCR2 is a read-only register, and should not be written to.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 | FLER | 0 | R | Flash Memory Error Indicates that an error has occurred during an operation on flash memory (programming or erasing). When flash memory goes to the error-protection state, this bit is set to 1. See section 6.6.3, Error Protection, for details. |
| 6 to 0 | — | All 0 | — | Reserved These bits are always read as 0. |

6.3.3 Erase Block Register (EBR)

EBR specifies the flash memory erase area block. EBR is initialized to H'00 when the SWE bit in FLMCR1 is 0. Do not set more than one bit at a time, as this will cause all the bits in EBR to be automatically cleared to 0.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 5 | — | All 0 | — | Reserved These bits are always read as 0. |
| 4 | EB4 | 0 | R/W | H8/38704F: When this bit is set to 1, 28 kbytes of H'1000 to H'7FFF will be erased. H8/38702F: When this bit is set to 1, 12 kbytes of H'1000 to H'3FFF will be erased. |
| 3 | EB3 | 0 | R/W | When this bit is set to 1, 1 kbyte of H'0C00 to H'0FFF will be erased. |
| 2 | EB2 | 0 | R/W | When this bit is set to 1, 1 kbyte of H'0800 to H'0BFF will be erased. |
| 1 | EB1 | 0 | R/W | When this bit is set to 1, 1 kbyte of H'0400 to H'07FF will be erased. |
| 0 | EB0 | 0 | R/W | When this bit is set to 1, 1 kbyte of H'0000 to H'03FF will be erased. |

6.3.4 Flash Memory Power Control Register (FLPWCR)

FLPWCR enables or disables a transition to the flash memory power-down mode when the LSI switches to subactive mode. There are two modes: mode in which operation of the power supply circuit of flash memory is partly halted in power-down mode and flash memory can be read, and mode in which even if a transition is made to subactive mode, operation of the power supply circuit of flash memory is retained and flash memory can be read.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 | PDWND | 0 | R/W | Power-Down Disable When this bit is 0 and a transition is made to subactive mode, the flash memory enters the power-down mode. When this bit is 1, the flash memory remains in the normal mode even after a transition is made to subactive mode. |
| 6 to 0 | — | All 0 | — | Reserved These bits are always read as 0. |

6.3.5 Flash Memory Enable Register (FENR)

Bit 7 (FLSHE) in FENR enables or disables the CPU access to the flash memory control registers, FLMCR1, FLMCR2, EBR, and FLPWCR.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 | FLSHE | 0 | R/W | Flash Memory Control Register Enable Flash memory control registers can be accessed when this bit is set to 1. Flash memory control registers cannot be accessed when this bit is set to 0. |
| 6 to 0 | — | All 0 | — | Reserved These bits are always read as 0. |

6.4 On-Board Programming Modes

There are two modes for programming/erasing of the flash memory; boot mode, which enables on-board programming/erasing, and programmer mode, in which programming/erasing is performed with a PROM programmer. On-board programming/erasing can also be performed in user program mode. At reset-start in reset mode, this LSI changes to a mode depending on the TEST pin settings, P95 pin settings, and input level of each port, as shown in table 6.1. The input level of each pin must be defined four states before the reset ends.

When changing to boot mode, the boot program built into this LSI is initiated. The boot program transfers the programming control program from the externally-connected host to on-chip RAM via SCI3. After erasing the entire flash memory, the programming control program is executed. This can be used for programming initial values in the on-board state or for a forcible return when programming/erasing can no longer be done in user program mode. In user program mode, individual blocks can be erased and programmed by branching to the user program/erase control program prepared by the user.

Table 6.1 Setting Programming Modes

| TEST | P95 | P34 | PB0 | PB1 | PB2 | LSI State after Reset End |
|------|-----|-----|-----|-----|-----|---------------------------|
| 0 | 1 | x | x | x | x | User Mode |
| 0 | 0 | 1 | x | x | x | Boot Mode |
| 1 | x | x | 0 | 0 | 0 | Programmer Mode |

[Legend]

x: Don't care.

6.4.1 Boot Mode

Table 6.2 shows the boot mode operations between reset end and branching to the programming control program.

1. When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. Prepare a programming control program in accordance with the description in section 6.5, Flash Memory Programming/Erasing.
2. The SCI3 should be set to asynchronous mode, and the transfer format as follows: 8-bit data, 1 stop bit, and no parity. Since the inversion function of SPCR is configured not to inverse data of the TXD pin and RXD pin, do not place an inversion circuit between the host and this LSI.

3. When the boot program is initiated, the chip measures the low-level period of asynchronous SCI communication data (H'00) transmitted continuously from the host. The chip then calculates the bit rate of transmission from the host, and adjusts the SCI3 bit rate to match that of the host. The reset should end with the RXD pin high. The RXD and TXD pins should be pulled up on the board if necessary. After the reset is complete, it takes approximately 100 states before the chip is ready to measure the low-level period.
4. After matching the bit rates, the chip transmits one H'00 byte to the host to indicate the completion of bit rate adjustment. The host should confirm that this adjustment end indication (H'00) has been received normally, and transmit one H'55 byte to the chip. If reception could not be performed normally, initiate boot mode again by a reset. Depending on the host's transfer bit rate and system clock frequency of this LSI, there will be a discrepancy between the bit rates of the host and the chip. To operate the SCI properly, set the host's transfer bit rate and system clock frequency of this LSI within the ranges listed in table 6.3.
5. In boot mode, a part of the on-chip RAM area is used by the boot program. The area H'F780 to H'FEFF is the area to which the programming control program is transferred from the host. The boot program area cannot be used until the execution state in boot mode switches to the programming control program.
6. Before branching to the programming control program, the chip terminates transfer operations by SCI3 (by clearing the RE and TE bits in SCR to 0), however the adjusted bit rate value remains set in BRR. Therefore, the programming control program can still use it for transfer of write data or verify data with the host. The TXD pin is high (PCR42 = 1, P42 = 1). The contents of the CPU general registers are undefined immediately after branching to the programming control program. These registers must be initialized at the beginning of the programming control program, as the stack pointer (SP), in particular, is used implicitly in subroutine calls, etc.
7. Boot mode can be cleared by a reset. End the reset after driving the reset pin low, waiting at least 20 states, and then setting the TEST pin and P95 pin. Boot mode is also cleared when a WDT overflow occurs.
8. Do not change the TEST pin and P95 pin input levels in boot mode.

Table 6.2 Boot Mode Operation

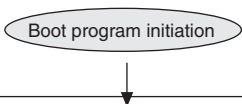
| Item | Host Operation | Communication Contents | LSI Operation |
|--|--|--|---|
| | Processing Contents | | Processing Contents |
| Boot mode initiation | | | Branches to boot program at reset-start.  |
| Bit rate adjustment | Continuously transmits data H'00 at specified bit rate. ↓ Transmits data H'55 when data H'00 is received error-free. | H'00, H'00 ... H'00 ← H'00 → H'55 | <ul style="list-style-type: none"> Measures low-level period of receive data H'00. Calculates bit rate and sets BRR in SCI3. Transmits data H'00 to host as adjustment end indication. |
| Flash memory erase | ↓ H'AA reception ← | ← H'FF ← H'AA | Checks flash memory data, erases all flash memory blocks in case of written data existing, and transmits data H'AA to host. (If erase could not be done, transmits data H'FF to host and aborts operation.) |
| Transfer of number of bytes of programming control program | Transmits number of bytes (N) of programming control program to be transferred as 2-byte data (low-order byte following high-order byte) ↓ Transmits 1-byte of programming control program (repeated for N times) ↓ H'AA reception ← | → Upper bytes, lower bytes ← Echoback → H'XX ← Echoback ← H'AA | Echobacks the 2-byte data received to host. ↓ Echobacks received data to host and also transfers it to RAM. (repeated for N times) ↓ Transmits data H'AA to host. |
| | | | Branches to programming control program transferred to on-chip RAM and starts execution. |

Table 6.3 Oscillation Frequencies for which Automatic Adjustment of LSI Bit Rate is Possible (f_{osc})

| Host Bit Rate | Oscillation Frequency Range of LSI (f_{osc}) |
|----------------------|--|
| 4,800 bps | 8 to 10 MHz |
| 2,400 bps | 4 to 10 MHz |
| 1,200 bps | 2 to 10 MHz |

6.4.2 Programming/Erasing in User Program Mode

User program mode means the execution state of the user program. On-board programming/erasing of an individual flash memory block can also be performed in user program mode by branching to a user program/erase control program. The user must set branching conditions and provide on-board means of supplying programming data. The flash memory must contain the user program/erase control program or a program that provides the user program/erase control program from external memory. As the flash memory itself cannot be read during programming/erasing, transfer the user program/erase control program to on-chip RAM, as in boot mode. Figure 6.4 shows a sample procedure for programming/erasing in user program mode. Prepare a user program/erase control program in accordance with the description in section 6.5, Flash Memory Programming/Erasing.

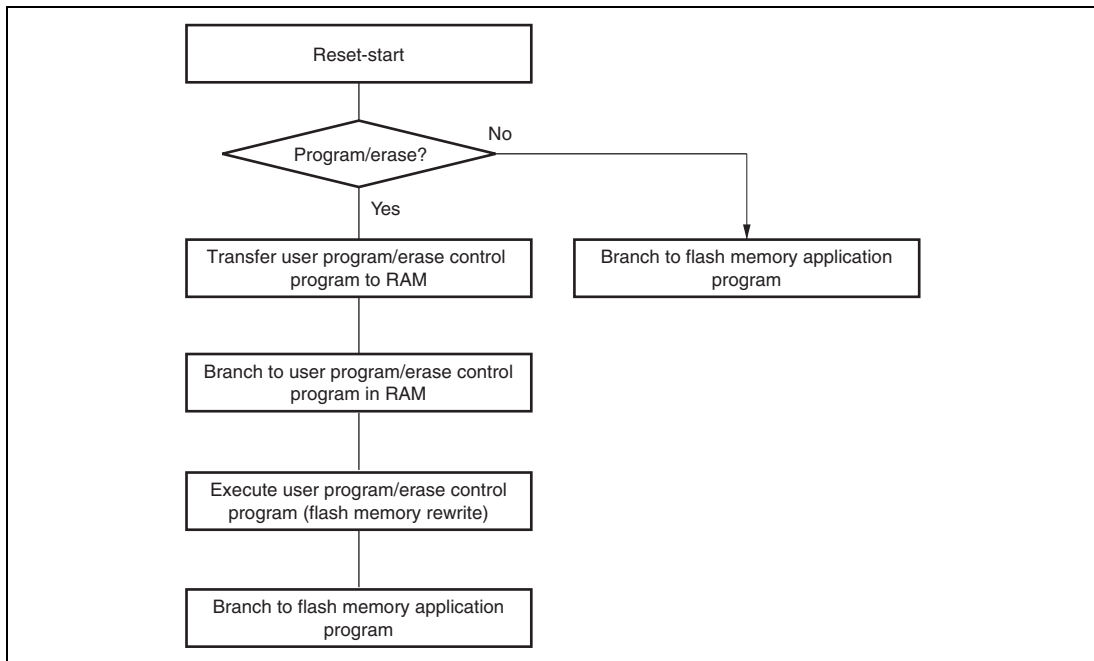


Figure 6.4 Programming/Erasing Flowchart Example in User Program Mode

6.5 Flash Memory Programming/Erasing

A software method using the CPU is employed to program and erase flash memory in the on-board programming modes. Depending on the FLMCR1 setting, the flash memory operates in one of the following four modes: Program mode, program-verify mode, erase mode, and erase-verify mode. The programming control program in boot mode and the user program/erase control program in user program mode use these operating modes in combination to perform programming/erasing. Flash memory programming and erasing should be performed in accordance with the descriptions in section 6.5.1, Program/Program-Verify and section 6.5.2, Erase/Erase-Verify, respectively.

6.5.1 Program/Program-Verify

When writing data or programs to the flash memory, the program/program-verify flowchart shown in figure 6.5 should be followed. Performing programming operations according to this flowchart will enable data or programs to be written to the flash memory without subjecting the chip to voltage stress or sacrificing program data reliability.

1. Programming must be done to an empty address. Do not reprogram an address to which programming has already been performed.
2. Programming should be carried out 128 bytes at a time. A 128-byte data transfer must be performed even if writing fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
3. Prepare the following data storage areas in RAM: A 128-byte programming data area, a 128-byte reprogramming data area, and a 128-byte additional-programming data area. Perform reprogramming data computation according to table 6.4, and additional programming data computation according to table 6.5.
4. Consecutively transfer 128 bytes of data in byte units from the reprogramming data area or additional-programming data area to the flash memory. The program address and 128-byte data are latched in the flash memory. The lower 8 bits of the start address in the flash memory destination area must be H'00 or H'80.
5. The time during which the P bit is set to 1 is the programming time. Table 6.6 shows the allowable programming times.
6. The watchdog timer (WDT) is set to prevent overprogramming due to program runaway, etc. An overflow cycle of approximately 6.6 ms is allowed.
7. For a dummy write to a verify address, write 1-byte data H'FF to an address whose lower one bit is B'0. Verify data can be read in word or longword units from the address to which a dummy write was performed.
8. The maximum number of repetitions of the program/program-verify sequence of the same bit is 1,000.

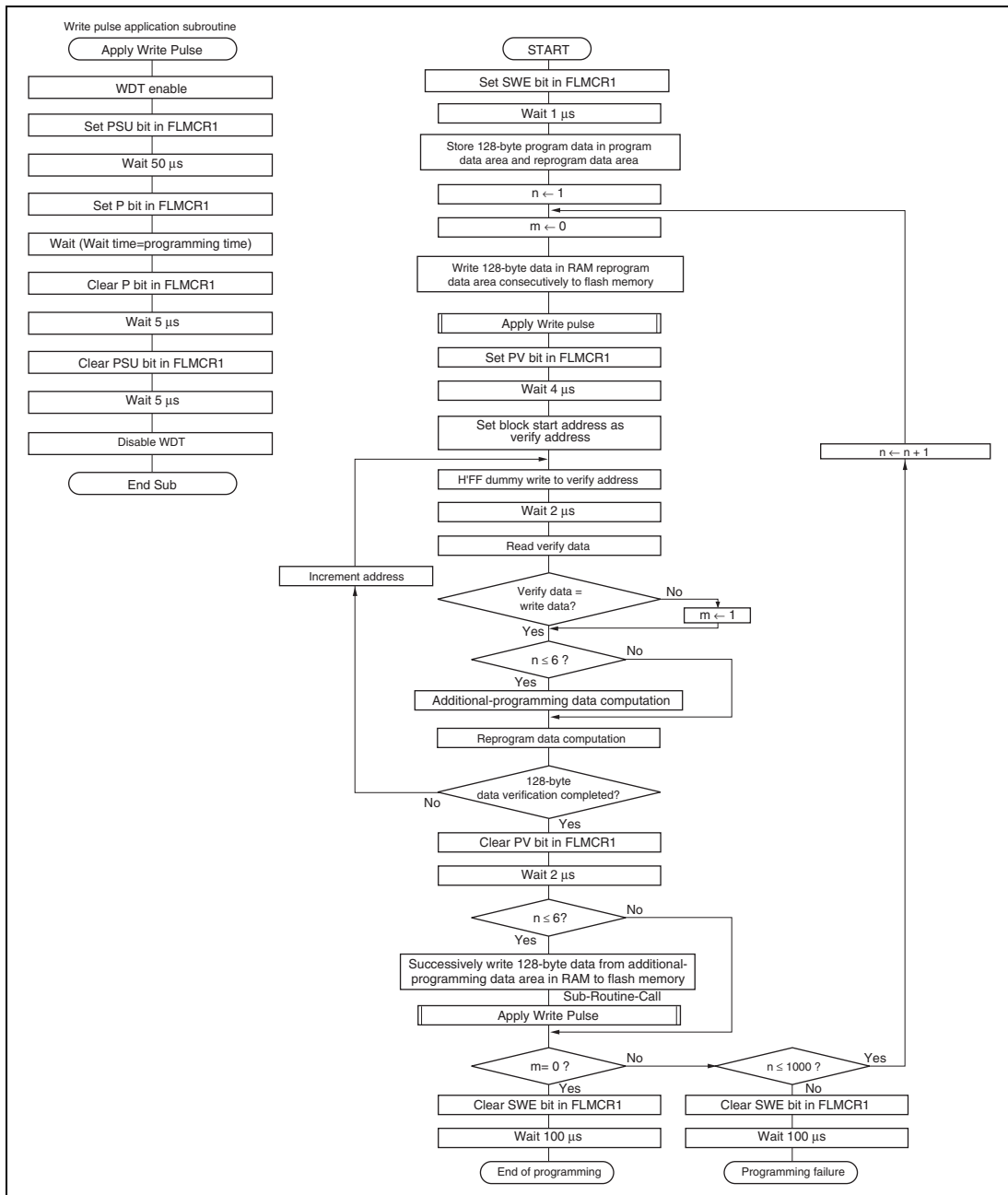


Figure 6.5 Program/Program-Verify Flowchart

Table 6.4 Reprogram Data Computation Table

| Program Data | Verify Data | Reprogram Data | Comments |
|--------------|-------------|----------------|-------------------------|
| 0 | 0 | 1 | Programming completed |
| 0 | 1 | 0 | Reprogram bit |
| 1 | 0 | 1 | — |
| 1 | 1 | 1 | Remains in erased state |

Table 6.5 Additional-Program Data Computation Table

| Reprogram Data | Verify Data | Additional-Program Data | Comments |
|----------------|-------------|-------------------------|---------------------------|
| 0 | 0 | 0 | Additional-program bit |
| 0 | 1 | 1 | No additional programming |
| 1 | 0 | 1 | No additional programming |
| 1 | 1 | 1 | No additional programming |

Table 6.6 Programming Time

| n (Number of Writes) | Programming Time | In Additional Programming | Comments |
|-------------------------|------------------|---------------------------|----------|
| 1 to 6 | 30 | 10 | |
| 7 to 1,000 | 200 | — | |

Note: Time shown in μ s.

6.5.2 Erase/Erase-Verify

When erasing flash memory, the erase/erase-verify flowchart shown in figure 6.6 should be followed.

1. Prewriting (setting erase block data to all 0s) is not necessary.
2. Erasing is performed in block units. Make only a single-bit specification in the erase block register (EBR). To erase multiple blocks, each block must be erased in turn.
3. The time during which the E bit is set to 1 is the flash memory erase time.
4. The watchdog timer (WDT) is set to prevent overerasing due to program runaway, etc. An overflow cycle of approximately 19.8 ms is allowed.
5. For a dummy write to a verify address, write 1-byte data H'FF to an address whose lower 1 bit is B'0. Verify data can be read in word or longword units from the address to which a dummy write was performed.
6. If the read data is not erased successfully, set erase mode again, and repeat the erase/erase-verify sequence as before. The maximum number of repetitions of the erase/erase-verify sequence is 100.

6.5.3 Interrupt Handling when Programming/Erasing Flash Memory

All interrupts are disabled while flash memory is being programmed or erased, or while the boot program is executing, for the following three reasons:

1. Interrupt during programming/erasing may cause a violation of the programming or erasing algorithm, with the result that normal operation cannot be assured.
2. If interrupt exception handling starts before the vector address is written or during programming/erasing, a correct vector cannot be fetched and the CPU malfunctions.
3. If an interrupt occurs during boot program execution, normal boot mode sequence cannot be carried out.

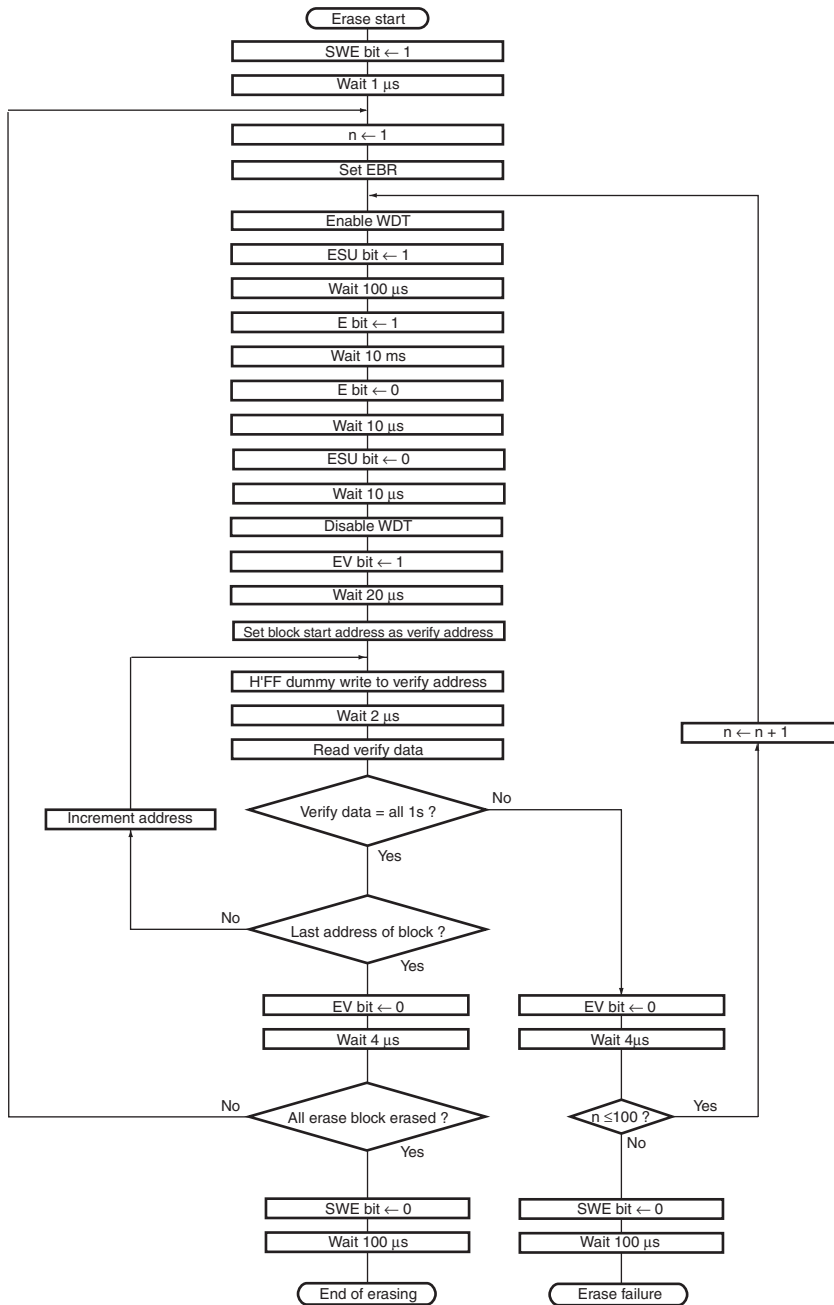


Figure 6.6 Erase/Erase-Verify Flowchart

6.6 Program/Erase Protection

There are three kinds of flash memory program/erase protection; hardware protection, software protection, and error protection.

6.6.1 Hardware Protection

Hardware protection refers to a state in which programming/erasing of flash memory is forcibly disabled or aborted because of a transition to reset, subactive mode, subsleep mode, watch mode, or standby mode. Flash memory control register 1 (FLMCR1), flash memory control register 2 (FLMCR2), and erase block register (EBR) are initialized. In a reset via the $\overline{\text{RES}}$ pin, the reset state is not entered unless the $\overline{\text{RES}}$ pin is held low until oscillation stabilizes after powering on. In the case of a reset during operation, hold the $\overline{\text{RES}}$ pin low for the $\overline{\text{RES}}$ pulse width specified in the AC Characteristics section.

6.6.2 Software Protection

Software protection can be implemented against programming/erasing of all flash memory blocks by clearing the SWE bit in FLMCR1. When software protection is in effect, setting the P or E bit in FLMCR1 does not cause a transition to program mode or erase mode. By setting the erase block register (EBR), erase protection can be set for individual blocks. When EBR is set to H'00, erase protection is set for all blocks.

6.6.3 Error Protection

In error protection, an error is detected when CPU runaway occurs during flash memory programming/erasing, or operation is not performed in accordance with the program/erase algorithm, and the program/erase operation is aborted. Aborting the program/erase operation prevents damage to the flash memory due to overprogramming or overerasing.

When the following errors are detected during programming/erasing of flash memory, the FLER bit in FLMCR2 is set to 1, and the error protection state is entered.

- When the flash memory of the relevant address area is read during programming/erasing (including vector read and instruction fetch)
- Immediately after exception handling excluding a reset during programming/erasing
- When a SLEEP instruction is executed during programming/erasing

The FLMCR1, FLMCR2, and EBR settings are retained, however program mode or erase mode is aborted at the point at which the error occurred. Program mode or erase mode cannot be re-entered by re-setting the P or E bit. However, PV and EV bit setting is enabled, and a transition can be made to verify mode. Error protection can be cleared only by a power-on reset.

6.7 Programmer Mode

In programmer mode, a PROM programmer can be used to perform programming/erasing via a socket adapter, just as a discrete flash memory. Use a PROM programmer that supports the MCU device type with the on-chip Renesas Technology (former Hitachi Ltd.) 64-kbyte flash memory (FZTAT64V3). A 10-MHz input clock is required. For the conditions for transition to programmer mode, see table 6.1.

6.7.1 Socket Adapter

The socket adapter converts the pin allocation of the HD64F38704 and HD64F38702 to that of the discrete flash memory HN28F101. The address of the on-chip flash memory is H'0000 to H'7FFF. Figure 6.7 shows a socket-adapter-pin correspondence diagram.

6.7.2 Programmer Mode Commands

The following commands are supported in programmer mode.

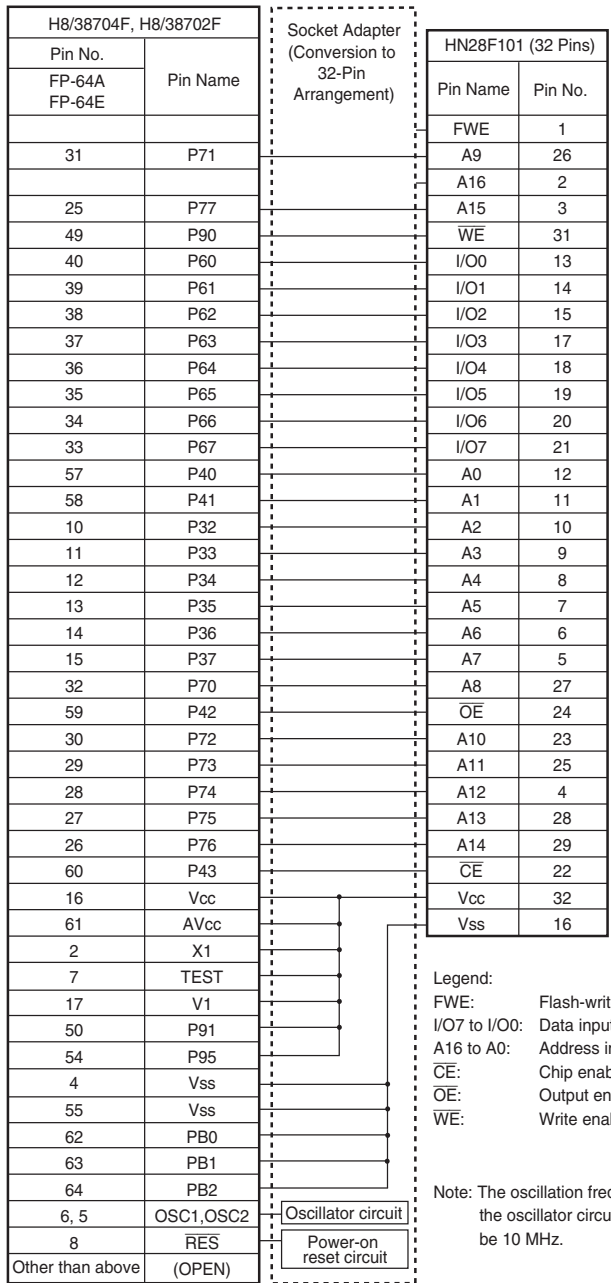
- Memory Read Mode
- Auto-Program Mode
- Auto-Erase Mode
- Status Read Mode

Status polling is used for auto-programming, auto-erasing, and status read modes. In status read mode, detailed internal information is output after the execution of auto-programming or auto-erasing. Table 6.7 shows the sequence of each command. In auto-programming mode, 129 cycles are required since 128 bytes are written at the same time. In memory read mode, the number of cycles depends on the number of address write cycles (n).

Table 6.7 Command Sequence in Programmer Mode

| Command Name | Number of Cycles | 1st Cycle | | | 2nd Cycle | | |
|--------------|------------------|-----------|---------|------|-----------|---------|------|
| | | Mode | Address | Data | Mode | Address | Data |
| Memory read | 1 + n | Write | X | H'00 | Read | RA | Dout |
| Auto-program | 129 | Write | X | H'40 | Write | WA | Din |
| Auto-erase | 2 | Write | X | H'20 | Write | X | H'20 |
| Status read | 2 | Write | X | H'71 | Write | X | H'71 |

[Legend] n: Number of address write cycles



Legend:
 FWE: Flash-write enable
 I/O7 to I/O0: Data input/output
 A16 to A0: Address input
 CE: Chip enable
 OE: Output enable
 WE: Write enable

Note: The oscillation frequency of the oscillator circuit should be 10 MHz.

Figure 6.7 Socket Adapter Pin Correspondence Diagram (H8/38704F, H8/38702F)

6.7.3 Memory Read Mode

After completion of auto-program/auto-erase/status read operations, a transition is made to the command wait state. When reading memory contents, a transition to memory read mode must first be made with a command write, after which the memory contents are read. Once memory read mode has been entered, consecutive reads can be performed.

1. In memory read mode, command writes can be performed in the same way as in the command wait state.
2. After powering on, memory read mode is entered.
3. Tables 6.8 to 6.10 show the AC characteristics.

Table 6.8 AC Characteristics in Transition to Memory Read Mode

(Conditions: $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$)

| Item | Symbol | Min | Max | Unit | Test Condition |
|-----------------------------------|------------|-----|-----|---------------|----------------|
| Command write cycle | t_{nxtc} | 20 | — | μs | Figure 6.8 |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns | |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns | |
| Data hold time | t_{dh} | 50 | — | ns | |
| Data setup time | t_{ds} | 50 | — | ns | |
| Write pulse width | t_{wep} | 70 | — | ns | |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns | |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns | |

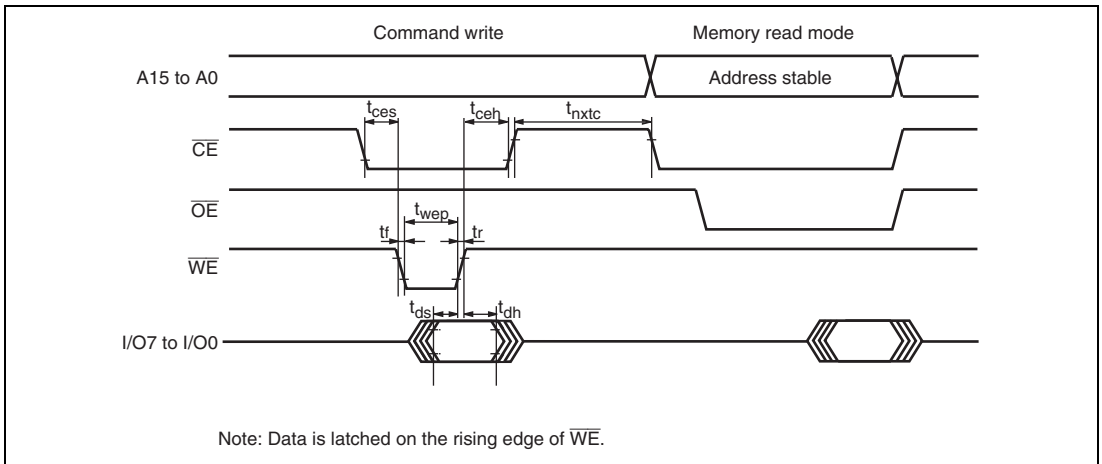


Figure 6.8 Timing Waveforms for Memory Read after Command Write

Table 6.9 AC Characteristics in Transition from Memory Read Mode to Another Mode

(Conditions: $V_{cc} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{ss} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$)

| Item | Symbol | Min | Max | Unit | Test Condition |
|----------------------------|------------|-----|-----|---------------|----------------|
| Command write cycle | t_{nxtc} | 20 | — | μs | Figure 6.9 |
| \overline{CE} hold time | t_{ceh} | 0 | — | ns | |
| \overline{CE} setup time | t_{ces} | 0 | — | ns | |
| Data hold time | t_{dh} | 50 | — | ns | |
| Data setup time | t_{ds} | 50 | — | ns | |
| Write pulse width | t_{wep} | 70 | — | ns | |
| \overline{WE} rise time | t_r | — | 30 | ns | |
| \overline{WE} fall time | t_f | — | 30 | ns | |

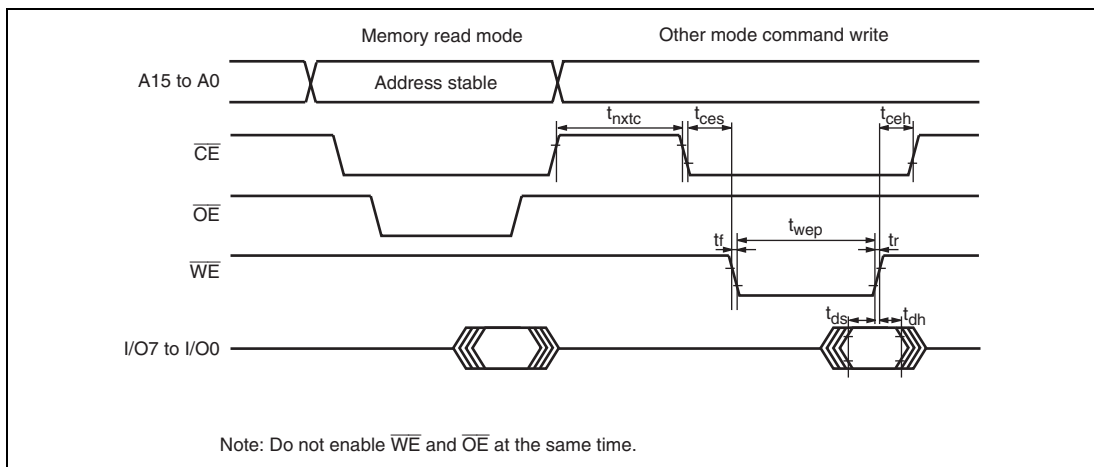


Figure 6.9 Timing Waveforms in Transition from Memory Read Mode to Another Mode

Table 6.10 AC Characteristics in Memory Read Mode

(Conditions: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$)

| Item | Symbol | Min | Max | Unit | Test Condition |
|-----------------------------------|-----------|-----|-----|---------------|-----------------------|
| Access time | t_{acc} | — | 20 | μs | Figures 6.10 and 6.11 |
| \overline{CE} output delay time | t_{ce} | — | 150 | ns | |
| \overline{OE} output delay time | t_{oe} | — | 150 | ns | |
| Output disable delay time | t_{df} | — | 100 | ns | |
| Data output hold time | t_{oh} | 5 | — | ns | |

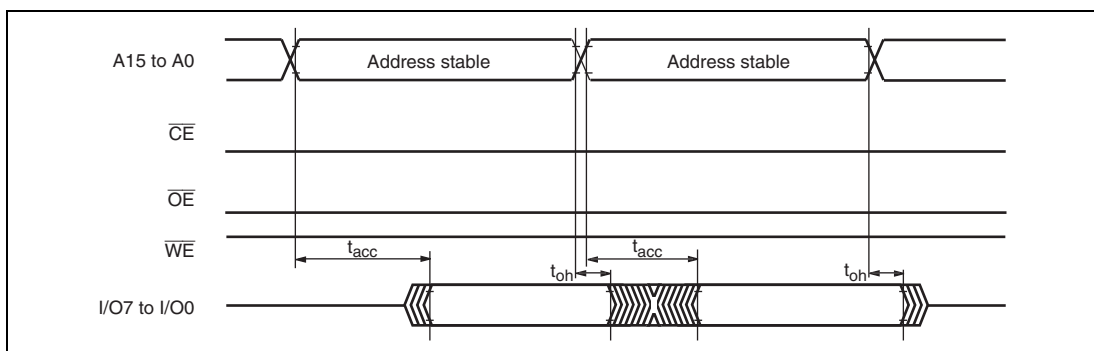


Figure 6.10 Timing Waveforms in \overline{CE} and \overline{OE} Enable State Read

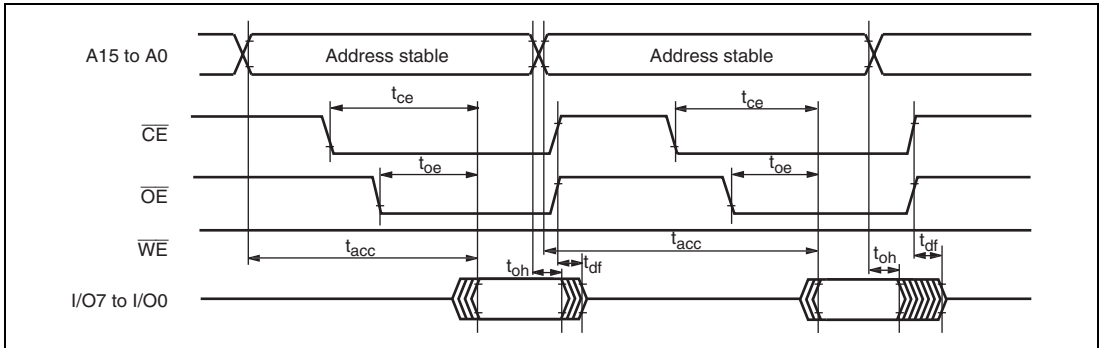


Figure 6.11 Timing Waveforms in \overline{CE} and \overline{OE} Clock System Read

6.7.4 Auto-Program Mode

1. When reprogramming previously programmed addresses, perform auto-erasing before auto-programming.
2. Perform auto-programming once only on the same address block. It is not possible to program an address block that has already been programmed.
3. In auto-program mode, 128 bytes are programmed simultaneously. This should be carried out by executing 128 consecutive byte transfers. A 128-byte data transfer is necessary even when programming fewer than 128 bytes. In this case, H'FF data must be written to the extra addresses.
4. The lower 7 bits of the transfer address must be low. If a value other than an effective address is input, processing will switch to a memory write operation but a write error will be flagged.
5. Memory address transfer is performed in the second cycle (figure 6.12). Do not perform transfer after the third cycle.
6. Do not perform a command write during a programming operation.
7. Perform one auto-program operation for a 128-byte block for each address. Two or more additional programming operations cannot be performed on a previously programmed address block.
8. Confirm normal end of auto-programming by checking I/O6. Alternatively, status read mode can also be used for this purpose (I/O7 status polling uses the auto-program operation end decision pin).
9. Status polling I/O6 and I/O7 pin information is retained until the next command write. As long as the next command write has not been performed, reading is possible by enabling \overline{CE} and \overline{OE} .
10. Table 6.11 shows the AC characteristics.

6.7.5 Auto-Erase Mode

1. Auto-erase mode supports only entire memory erasing.
2. Do not perform a command write during auto-erasing.
3. Confirm normal end of auto-erasing by checking I/O6. Alternatively, status read mode can also be used for this purpose (I/O7 status polling uses the auto-erase operation end decision pin).
4. Status polling I/O6 and I/O7 pin information is retained until the next command write. As long as the next command write has not been performed, reading is possible by enabling $\overline{\text{CE}}$ and $\overline{\text{OE}}$.
5. Table 6.12 shows the AC characteristics.

Table 6.12 AC Characteristics in Auto-Erase Mode

(Conditions: $V_{\text{CC}} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{\text{SS}} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$)

| Item | Symbol | Min | Max | Unit | Test Condition |
|-----------------------------------|--------------------|-----|-------|---------------|----------------|
| Command write cycle | t_{rxtc} | 20 | — | μs | Figure 6.13 |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns | |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns | |
| Data hold time | t_{dh} | 50 | — | ns | |
| Data setup time | t_{ds} | 50 | — | ns | |
| Write pulse width | t_{wep} | 70 | — | ns | |
| Status polling start time | t_{ests} | 1 | — | ms | |
| Status polling access time | t_{spsa} | — | 150 | ns | |
| Memory erase time | t_{erase} | 100 | 40000 | ms | |
| $\overline{\text{WE}}$ rise time | t_{r} | — | 30 | ns | |
| $\overline{\text{WE}}$ fall time | t_{f} | — | 30 | ns | |

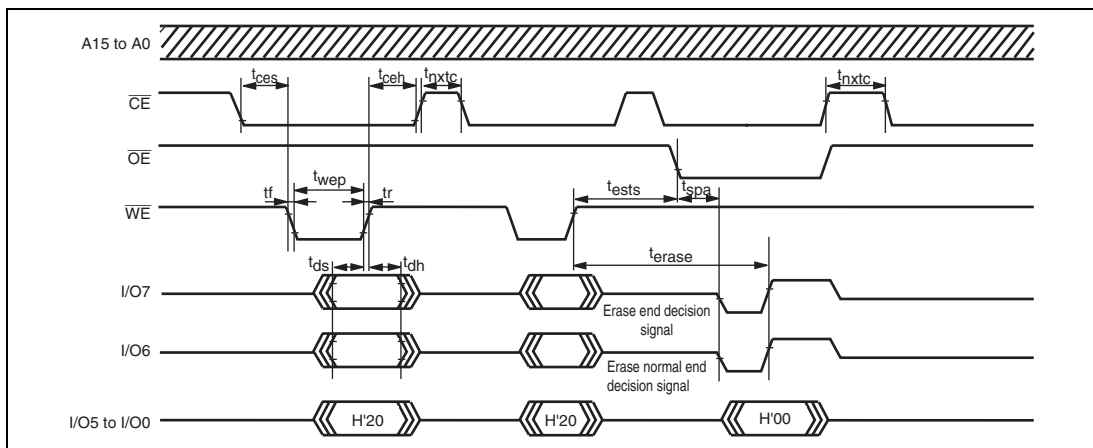


Figure 6.13 Timing Waveforms in Auto-Erase Mode

6.7.6 Status Read Mode

1. Status read mode is provided to identify the kind of abnormal end. Use this mode when an abnormal end occurs in auto-program mode or auto-erase mode.
2. The return code is retained until a command write other than command write in status read mode is executed.
3. Table 6.13 shows the AC characteristics and table 6.14 shows the return codes.

Table 6.13 AC Characteristics in Status Read Mode(Conditions: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C} \pm 5^\circ\text{C}$)

| Item | Symbol | Min | Max | Unit | Test Condition |
|--|------------|-----|-----|---------------|----------------|
| Read time after command write | t_{nxtc} | 20 | — | μs | Figure 6.14 |
| $\overline{\text{CE}}$ hold time | t_{ceh} | 0 | — | ns | |
| $\overline{\text{CE}}$ setup time | t_{ces} | 0 | — | ns | |
| Data hold time | t_{dh} | 50 | — | ns | |
| Data setup time | t_{ds} | 50 | — | ns | |
| Write pulse width | t_{wep} | 70 | — | ns | |
| $\overline{\text{OE}}$ output delay time | t_{oe} | — | 150 | ns | |
| Disable delay time | t_{df} | — | 100 | ns | |
| $\overline{\text{CE}}$ output delay time | t_{ce} | — | 150 | ns | |
| $\overline{\text{WE}}$ rise time | t_r | — | 30 | ns | |
| $\overline{\text{WE}}$ fall time | t_f | — | 30 | ns | |

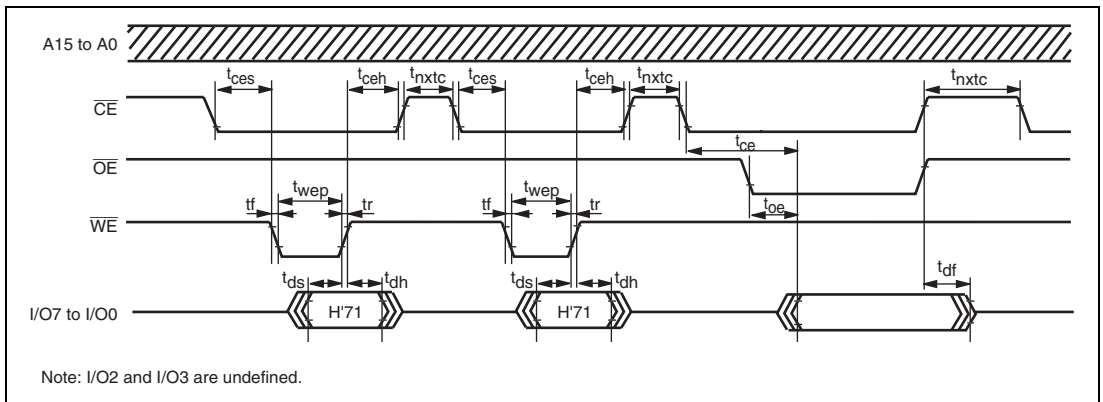
**Figure 6.14 Timing Waveforms in Status Read Mode**

Table 6.14 Return Codes in Status Read Mode

| Pin Name | Initial Value | Description |
|----------|---------------|--|
| I/O7 | 0 | 1: Abnormal end 0: Normal end |
| I/O6 | 0 | 1: Command error 0: Otherwise |
| I/O5 | 0 | 1: Programming error 0: Otherwise |
| I/O4 | 0 | 1: Erasing error 0: Otherwise |
| I/O3 | 0 | Undefined |
| I/O2 | 0 | Undefined |
| I/O1 | 0 | 1: Over counting of writing or erasing 0: Otherwise |
| I/O0 | 0 | 1: Effective address error 0: Otherwise |

6.7.7 Status Polling

1. The I/O7 status polling flag indicates the operating status in auto-program/auto-erase mode.
2. The I/O6 status polling flag indicates a normal or abnormal end in auto-program/auto-erase mode.

Table 6.15 Status Polling Output

| I/O7 | I/O6 | I/O0 to I/O5 | Status |
|------|------|--------------|---------------------------|
| 0 | 0 | 0 | During internal operation |
| 1 | 0 | 0 | Abnormal end |
| 1 | 1 | 0 | Normal end |
| 0 | 1 | 0 | — |

6.7.8 Programmer Mode Transition Time

Commands cannot be accepted during the oscillation stabilization period or the programmer mode setup period. After the programmer mode setup time, a transition is made to memory read mode.

Table 6.16 Stipulated Transition Times to Command Wait State

| Item | Symbol | Min | Max | Unit | Test Condition |
|--|------------|-----|-----|------|----------------|
| Oscillation stabilization time (crystal resonator) | t_{osc1} | 10 | — | ms | Figure 6.15 |
| Oscillation stabilization time (ceramic resonator) | | 5 | — | ms | |
| Programmer mode setup time | t_{bmv} | 10 | — | ms | |
| V_{CC} hold time | t_{dwn} | 0 | — | ms | |

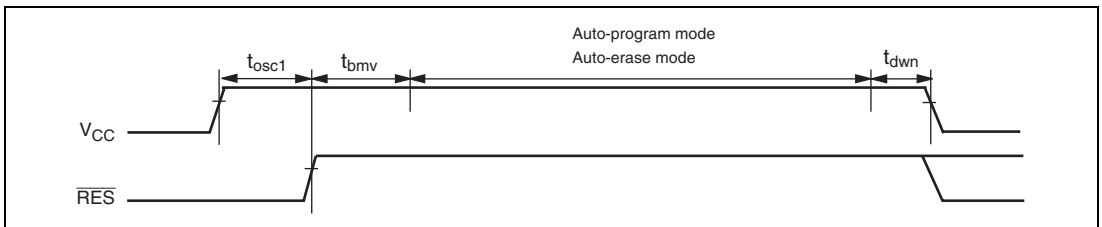


Figure 6.15 Oscillation Stabilization Time, Boot Program Transfer Time, and Power-Down Sequence

6.7.9 Notes on Memory Programming

1. When performing programming using programmer mode on a chip that has been programmed/erased in on-board programming mode, auto-erasing is recommended before carrying out auto-programming.
2. The flash memory is initially in the erased state when the device is shipped by Renesas. For other chips for which the erasure history is unknown, it is recommended that auto-erasing be executed to check and supplement the initialization (erase) level.

6.8 Power-Down States for Flash Memory

In user mode, the flash memory will operate in either of the following states:

- Normal operating mode
The flash memory can be read and written to at high speed.
- Power-down operating mode
The power supply circuit of flash memory can be partly halted. As a result, flash memory can be read with low power consumption.
- Standby mode
All flash memory circuits are halted.

Table 6.17 shows the correspondence between the operating modes of this LSI and the flash memory. In subactive mode, the flash memory can be set to operate in power-down mode with the PDWND bit in FLPWCR. When the flash memory returns to its normal operating state from power-down mode or standby mode, a period to stabilize operation of the power supply circuits that were stopped is needed. When the flash memory returns to its normal operating state, bits STS2 to STS0 in SYSCR1 must be set to provide a wait time of at least 20 μ s, even when the external clock is being used.

Table 6.17 Flash Memory Operating States

| LSI Operating State | Flash Memory Operating State | |
|---------------------|------------------------------|-----------------------|
| | PDWND = 0 (Initial value) | PDWND = 1 |
| Active mode | Normal operating mode | Normal operating mode |
| Subactive mode | Power-down mode | Normal operating mode |
| Sleep mode | Normal operating mode | Normal operating mode |
| Subsleep mode | Standby mode | Standby mode |
| Standby mode | Standby mode | Standby mode |
| Watch mode | Standby mode | Standby mode |

Section 7 RAM

This LSI has an on-chip high-speed static RAM. The RAM is connected to the CPU by a 16-bit data bus, enabling two-state access by the CPU to both byte data and word data.

| Product Classification | | RAM Size | RAM Address |
|-------------------------------|-----------|-----------------|--------------------|
| Flash memory version | H8/38704F | 1 kbyte | H'FB80 to H'FF7F |
| | H8/38702F | 1 kbyte | H'FB80 to H'FF7F |
| Mask ROM version | H8/38704 | 1 kbyte | H'FB80 to H'FF7F |
| | H8/38703 | 1 kbyte | H'FB80 to H'FF7F |
| | H8/38702 | 1 kbyte | H'FB80 to H'FF7F |
| | H8/38702S | 512 bytes | H'FD80 to H'FF7F |
| | H8/38701S | 512 bytes | H'FD80 to H'FF7F |
| | H8/38700S | 512 bytes | H'FD80 to H'FF7F |

7.1 Block Diagram

Figure 7.1 shows a block diagram of the on-chip RAM.

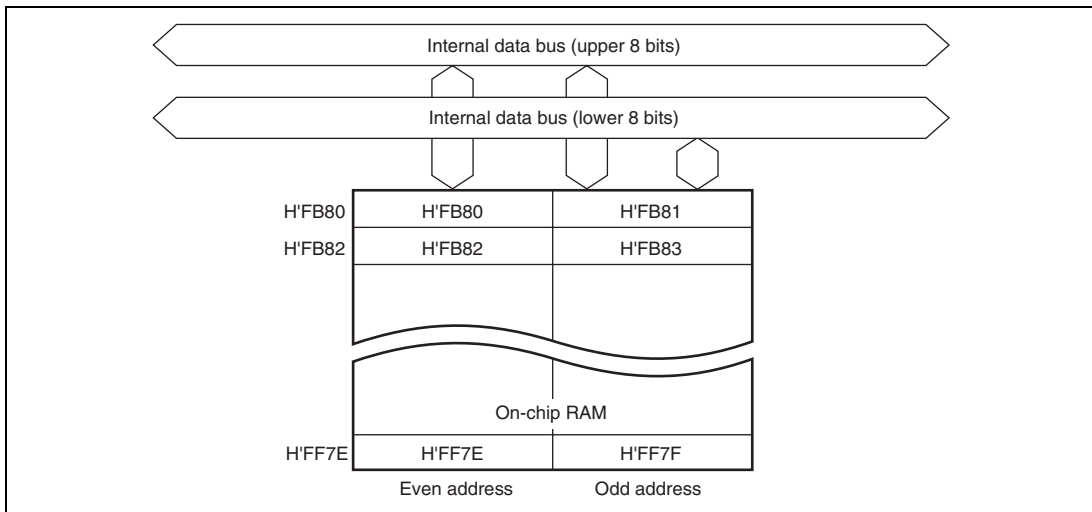


Figure 7.1 Block Diagram of RAM

Section 8 I/O Ports

This LSI is provided with three 8-bit I/O ports, one 7-bit I/O port, one 4-bit I/O port, one 3-bit I/O port, one 1-bit I/O port, one 4-bit input-only port, one 1-bit input-only port, and one 6-bit output-only port.

Each port is configured by the port control register (PCR) that controls input and output, and the port data register (PDR) that stores output data. Input or output can be assigned to individual bits.

See section 2.8.3, Bit-Manipulation Instructions, for information on executing bit-manipulation instructions to write data in PCR or PDR. Block diagrams of each port are given in appendix B, I/O Port Block Diagrams. Table 8.1 lists the functions of each port.

Table 8.1 Port Functions

| Port | Description | Pins | Other Functions | Function Switching Registers |
|--------|--|--|--|------------------------------|
| Port 3 | <ul style="list-style-type: none"> 7-bit I/O port Input pull-up MOS option | P37/AEVL P36/AEVH P35 P34 P33 | Asynchronous event counter event inputs AEVL, AEVH | PMR3 |
| | | P32/TMOFH P31/TMOFL | Timer F output compare output | PMR3 |
| Port 4 | <ul style="list-style-type: none"> 1-bit input-only port 3-bit I/O port | P43/ $\overline{\text{IRQ0}}$ | External interrupt 0 | PMR2 |
| | | P42/TXD32 P41/RXD32 P40/SCK32 | SCI3 data output (TXD32), data input (RXD32), clock input/output (SCK32) | SCR3 SMR |
| Port 5 | <ul style="list-style-type: none"> 8-bit I/O port Input pull-up MOS option | P57 to P50/ $\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$ | Wakeup input ($\overline{\text{WKP7}}$ to $\overline{\text{WKP0}}$) | PMR5 |
| Port 6 | <ul style="list-style-type: none"> 8-bit I/O port Input pull-up MOS option | P67 to P60 | None | — |
| Port 7 | <ul style="list-style-type: none"> 8-bit I/O port | P77 to P70 | None | — |
| Port 8 | <ul style="list-style-type: none"> 1-bit I/O port | P80 | None | — |
| Port 9 | <ul style="list-style-type: none"> 6-bit output-only port | P95 to P92 | None | — |
| | | P91, P90/ PWM2, PWM1 | 10-bit PWM output | PMR9 |
| Port A | <ul style="list-style-type: none"> 4-bit I/O port | PA3 to PA0 | None | — |
| Port B | <ul style="list-style-type: none"> 4-bit input-only port | PB3/AN3/ $\overline{\text{IRQ1}}$ | A/D converter analog input External interrupt 1 | AMR PMRB |
| | | PB2/AN2 | A/D converter analog input | AMR |
| | | PB1/AN1 PB0/AN0 | A/D converter analog input | AMR |

8.1 Port 3

Port 3 is an I/O port also functioning as an asynchronous event counter input pin and timer F output pin. Figure 8.1 shows its pin configuration.

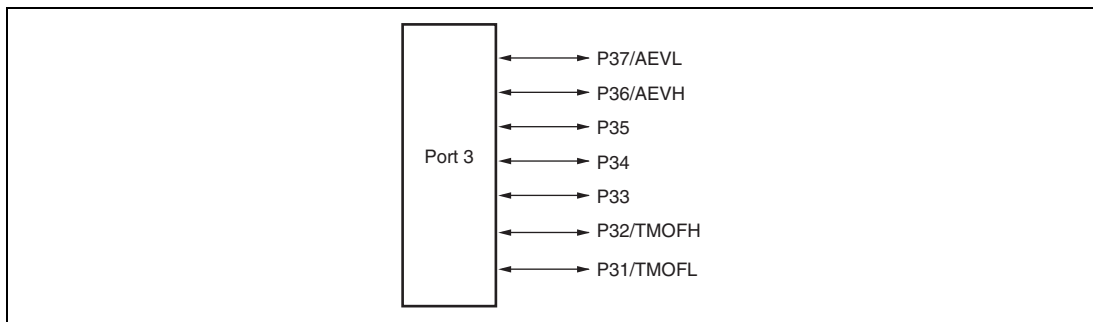


Figure 8.1 Port 3 Pin Configuration

Port 3 has the following registers.

- Port data register 3 (PDR3)
- Port control register 3 (PCR3)
- Port pull-up control register 3 (PUCR3)
- Port mode register 3 (PMR3)
- Port mode register 2 (PMR2)

8.1.1 Port Data Register 3 (PDR3)

PDR3 is a register that stores data of port 3.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P37 | 0 | R/W | If port 3 is read while PCR3 bits are set to 1, the values stored in PDR3 are read, regardless of the actual pin states. If port 3 is read while PCR3 bits are cleared to 0, the pin states are read. |
| 6 | P36 | 0 | R/W | |
| 5 | P35 | 0 | R/W | |
| 4 | P34 | 0 | R/W | |
| 3 | P33 | 0 | R/W | |
| 2 | P32 | 0 | R/W | |
| 1 | P31 | 0 | R/W | |
| 0 | — | — | — | Reserved |

8.1.2 Port Control Register 3 (PCR3)

PCR3 controls whether each of the port 3 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description | |
|-----|----------|---------------|-----|---|--|
| 7 | PCR37 | 0 | W | Setting a PCR3 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR3 and in PDR3 are valid only when the corresponding pin is designated in PMR3 as a general I/O pin. | |
| 6 | PCR36 | 0 | W | | |
| 5 | PCR35 | 0 | W | | |
| 4 | PCR34 | 0 | W | | |
| 3 | PCR33 | 0 | W | | PCR3 is a write-only register. Bits 7 to 1 are always read as 1. |
| 2 | PCR32 | 0 | W | | |
| 1 | PCR31 | 0 | W | | |
| 0 | — | — | W | Reserved The write value should always be 0. | |

8.1.3 Port Pull-Up Control Register 3 (PUCR3)

PUCR3 controls whether the pull-up MOS of each of the port 3 pins is on or off.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PUCR37 | 0 | R/W | When a PCR3 bit is cleared to 0, setting the corresponding PUCR3 bit to 1 turns on the pull-up MOS for the corresponding pin, while clearing the bit to 0 turns off the pull-up MOS. |
| 6 | PUCR36 | 0 | R/W | |
| 5 | PUCR35 | 0 | R/W | |
| 4 | PUCR34 | 0 | R/W | |
| 3 | PUCR33 | 0 | R/W | |
| 2 | PUCR32 | 0 | R/W | |
| 1 | PUCR31 | 0 | R/W | |
| 0 | — | — | W | Reserved The write value should always be 0. |

8.1.4 Port Mode Register 3 (PMR3)

PMR3 controls the selection of pin functions for port 3 pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 | AEVL | 0 | R/W | P37/AEVL Pin Function Switch This bit selects whether pin P37/AEVL is used as P37 or as AEVL. 0: P37 I/O pin 1: AEVL input pin |
| 6 | AEVH | 0 | R/W | P36/AEVH Pin Function Switch This bit selects whether pin P36/AEVH is used as P36 or as AEVH. 0: P36 I/O pin 1: AEVH input pin |
| 5 to 3 | — | — | W | Reserved The write value should always be 0. |
| 2 | TMOFH | 0 | R/W | P32/TMOFH Pin Function Switch This bit selects whether pin P32/TMOFH is used as P32 or as TMOFH. 0: P32 I/O pin 1: TMOFH output pin |
| 1 | TMOFL | 0 | R/W | P31/TMOFL Pin Function Switch This bit selects whether pin P31/TMOFL is used as P31 or as TMOFL. 0: P31 I/O pin 1: TMOFL output pin |
| 0 | — | — | W | Reserved The write value should always be 0. |

8.1.5 Port Mode Register 2 (PMR2)

PMR2 controls the PMOS on/off state for the P35 pin, selects a pin function for the P43/ $\overline{\text{IRQ0}}$ pin, and selects a clock of the watchdog timer.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|--|
| 7, 6 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 5 | POF1 | 0 | R/W | P35 Pin PMOS Control This bit controls the on/off state of the PMOS of the P35 pin output buffer. 0: CMOS output 1: NMOS open-drain output |
| 4, 3 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 2 | WDCKS | 0 | R/W | Watchdog Timer Source Clock Select This bit selects the input clock for the watchdog timer. 0: $\phi/8, 192$ 1: $\phi_w/32$ |
| 1 | — | — | W | Reserved The write value should always be 0. |
| 0 | IRQ0 | 0 | R/W | P43/ $\overline{\text{IRQ0}}$ Pin Function Switch This bit selects whether pin P43/ $\overline{\text{IRQ0}}$ is used as P43 or as $\overline{\text{IRQ0}}$. 0: P43 input pin 1: $\overline{\text{IRQ0}}$ input pin |

8.1.6 Pin Functions

The port 3 pin functions are shown below.

- P37/AEVL pin

The pin function depends on the combination of bit AEVL in PMR3 and bit PCR37 in PCR3.

| | | | |
|--------------|---------------|----------------|----------------|
| AEVL | 0 | | 1 |
| PCR37 | 0 | 1 | x |
| Pin Function | P37 input pin | P37 output pin | AEVL input pin |

[Legend]

x: Don't care.

- P36/AEVH pin

The pin function depends on the combination of bit AEVH in PMR3 and bit PCR36 in PCR3.

| | | | |
|--------------|---------------|----------------|----------------|
| AEVH | 0 | | 1 |
| PCR36 | 0 | 1 | x |
| Pin Function | P36 input pin | P36 output pin | AEVH input pin |

[Legend]

x: Don't care.

- P35 to P33 pins

The pin function depends on the corresponding bit in PCR3.

(n = 5 to 3)

| | | |
|--------------|---------------|----------------|
| PCR3n | 0 | 1 |
| Pin Function | P3n input pin | P3n output pin |

- P32/TMOFH pin

The pin function depends on the combination of bit TMOFH in PMR3 and bit PCR32 in PCR3.

| | | | |
|--------------|---------------|----------------|------------------|
| TMOFH | 0 | | 1 |
| PCR32 | 0 | 1 | x |
| Pin Function | P32 input pin | P32 output pin | TMOFH output pin |

[Legend]

x: Don't care.

- P31/TMOFL pin

The pin function depends on the combination of bit TMOFL in PMR3 and bit PCR31 in PCR3.

| | | | |
|--------------|---------------|----------------|------------------|
| TMOFL | 0 | | 1 |
| PCR31 | 0 | 1 | x |
| Pin Function | P31 input pin | P31 output pin | TMOFL output pin |

[Legend]

x: Don't care.

8.1.7 Input Pull-Up MOS

Port 3 has an on-chip input pull-up MOS function that can be controlled by software. When the PCR3 bit is cleared to 0, setting the corresponding PUCR3 bit to 1 turns on the input pull-up MOS for that pin. The input pull-up MOS function is in the off state after a reset.

(n = 7 to 1)

| | | | |
|-------------------|-----|----|-----|
| PCR3n | 0 | | 1 |
| PUCR3n | 0 | 1 | x |
| Input Pull-Up MOS | Off | On | Off |

[Legend]

x: Don't care.

8.2 Port 4

Port 4 is an I/O port also functioning as an interrupt input pin and SCI I/O pin. Figure 8.2 shows its pin configuration.

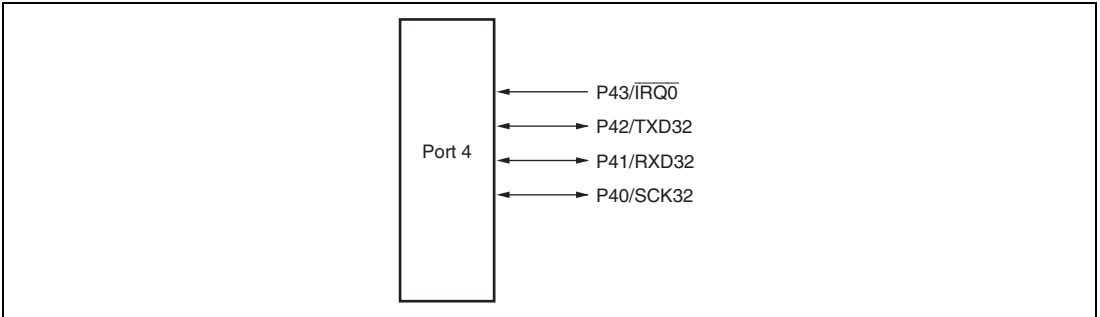


Figure 8.2 Port 4 Pin Configuration

Port 4 has the following registers.

- Port data register 4 (PDR4)
- Port control register 4 (PCR4)
- Serial port control register (SPCR)

8.2.1 Port Data Register 4 (PDR4)

PDR4 is a register that stores data of port 4.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 4 | — | 1 | — | Reserved These bits are always read as 1. |
| 3 | P43 | 1 | R | If port 4 is read while PCR4 bits are set to 1, the values stored in PDR4 are read, regardless of the actual pin states. If port 4 is read while PCR4 bits are cleared to 0, the pin states are read. |
| 2 | P42 | 0 | R/W | |
| 1 | P41 | 0 | R/W | |
| 0 | P40 | 0 | R/W | |

8.2.2 Port Control Register 4 (PCR4)

PCR4 controls whether each of the port 4 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 3 | — | All 1 | — | Reserved These bits are always read as 1. |
| 2 | PCR42 | 0 | W | Setting a PCR4 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR4 and in PDR4 are valid only when the corresponding pin is designated in SCR3 and SCR2 as a general I/O pin. PCR4 is a write-only register. Bits 2 to 0 are always read as 1. |
| 1 | PCR41 | 0 | W | |
| 0 | PCR40 | 0 | W | |

8.2.3 Serial Port Control Register (SPCR)

SPCR performs input/output data inversion switching of the RXD32 and TXD32 pins. Figure 8.3 shows the configuration.

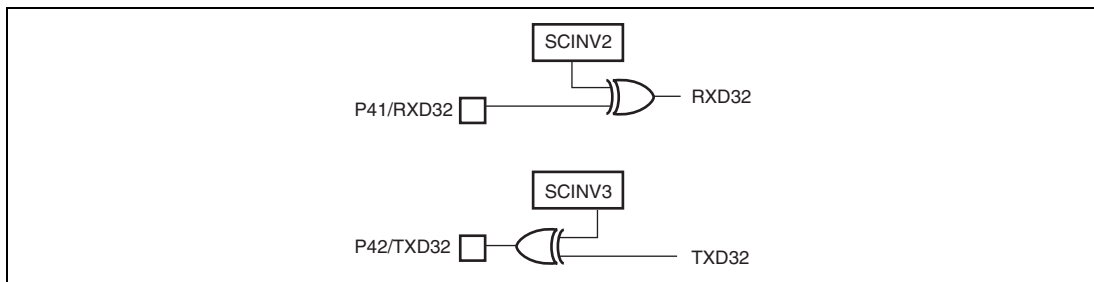


Figure 8.3 Input/Output Data Inversion Function

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|---|
| 7, 6 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 5 | SPC32 | 0 | R/W | P42/TXD32 Pin Function Switch This bit selects whether pin P42/TXD32 is used as P42 or as TXD32. 0: P42 I/O pin 1: TXD32 output pin* Note: * Set the TE bit in SCR3 after setting this bit to 1. |
| 4 | — | — | W | Reserved The write value should always be 0. |
| 3 | SCINV3 | 0 | R/W | TXD32 Pin Output Data Inversion Switch This bit selects whether or not the logic level of the TXD32 pin output data is inverted. 0: TXD32 output data is not inverted 1: TXD32 output data is inverted |
| 2 | SCINV2 | 0 | R/W | RXD32 Pin Input Data Inversion Switch This bit selects whether or not the logic level of the RXD32 pin input data is inverted. 0: RXD32 input data is not inverted 1: RXD32 input data is inverted |
| 1, 0 | — | — | W | Reserved The write value should always be 0. |

Note: When the serial port control register is modified, the data being input or output up to that point is inverted immediately after the modification, and an invalid data change is input or output. When modifying the serial port control register, modification must be made in a state in which data changes are invalidated.

8.2.4 Pin Functions

The port 4 pin functions are shown below.

- P43/ $\overline{\text{IRQ0}}$ pin

The pin function depends on the IRQ0 bit in PMR2.

| IRQ0 | 0 | 1 |
|--------------|---------------|------------------------------------|
| Pin Function | P43 input pin | $\overline{\text{IRQ0}}$ input pin |

- P42/TXD32 pin

The pin function depends on the combination of bit TE in SCR3, bit SPC32 in SPCR, and bit PCR42 in PCR4.

| SPC32 | 0 | | 1 |
|--------------|---------------|----------------|------------------|
| TE | 0 | | x |
| PCR42 | 0 | 1 | x |
| Pin Function | P42 input pin | P42 output pin | TXD32 output pin |

[Legend]

x: Don't care.

- P41/RXD32 pin

The pin function depends on the combination of bit RE in SCR3 and bit PCR41 in PCR4.

| RE | 0 | | 1 |
|--------------|---------------|----------------|-----------------|
| PCR41 | 0 | 1 | x |
| Pin Function | P41 input pin | P41 output pin | RXD32 input pin |

[Legend]

x: Don't care.

- P40/SCK32 pin

The pin function depends on the combination of bits CKE1 and CKE0 in SCR3, bit COM in SMR, and bit PCR40 in PCR4.

| | | | | |
|--------------|---------------|----------------|------------------|-----------------|
| CKE1 | 0 | | | 1 |
| CKE0 | 0 | | 1 | x |
| COM | 0 | | 1 | x |
| PCR40 | 0 | 1 | x | |
| Pin Function | P40 input pin | P40 output pin | SCK32 output pin | SCK32 input pin |

[Legend]

x: Don't care.

8.3 Port 5

Port 5 is an I/O port also functioning as a wakeup interrupt request input pin. Figure 8.4 shows its pin configuration.

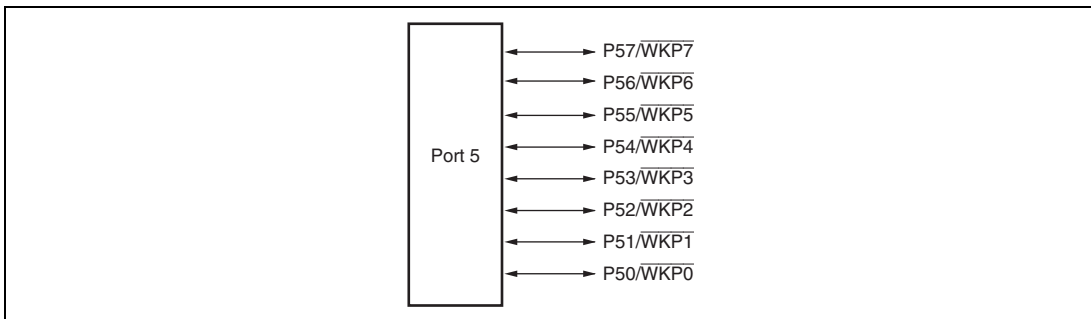


Figure 8.4 Port 5 Pin Configuration

Port 5 has the following registers.

- Port data register 5 (PDR5)
- Port control register 5 (PCR5)
- Port pull-up control register 5 (PUCR5)
- Port mode register 5 (PMR5)

8.3.1 Port Data Register 5 (PDR5)

PDR5 is a register that stores data of port 5.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P57 | 0 | R/W | If port 5 is read while PCR5 bits are set to 1, the values stored in PDR5 are read, regardless of the actual pin states. If port 5 is read while PCR5 bits are cleared to 0, the pin states are read. |
| 6 | P56 | 0 | R/W | |
| 5 | P55 | 0 | R/W | |
| 4 | P54 | 0 | R/W | |
| 3 | P53 | 0 | R/W | |
| 2 | P52 | 0 | R/W | |
| 1 | P51 | 0 | R/W | |
| 0 | P50 | 0 | R/W | |

8.3.2 Port Control Register 5 (PCR5)

PCR5 controls whether each of the port 5 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | PCR57 | 0 | W | Setting a PCR5 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR5 and in PDR5 are valid only when the corresponding pin is designated by PMR5 and the SGS3 to SGS0 bits in LPCR as a general I/O pin. PCR5 is a write-only register. Bits 7 to 0 are always read as 1. |
| 6 | PCR56 | 0 | W | |
| 5 | PCR55 | 0 | W | |
| 4 | PCR54 | 0 | W | |
| 3 | PCR53 | 0 | W | |
| 2 | PCR52 | 0 | W | |
| 1 | PCR51 | 0 | W | |
| 0 | PCR50 | 0 | W | |

8.3.3 Port Pull-Up Control Register 5 (PUCR5)

PUCR5 controls whether the pull-up MOS of each of the port 5 pins is on or off.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PUCR57 | 0 | R/W | When a PCR5 bit is cleared to 0, setting the corresponding PUCR5 bit to 1 turns on the pull-up MOS for the corresponding pin, while clearing the bit to 0 turns off the pull-up MOS. |
| 6 | PUCR56 | 0 | R/W | |
| 5 | PUCR55 | 0 | R/W | |
| 4 | PUCR54 | 0 | R/W | |
| 3 | PUCR53 | 0 | R/W | |
| 2 | PUCR52 | 0 | R/W | |
| 1 | PUCR51 | 0 | R/W | |
| 0 | PUCR50 | 0 | R/W | |

8.3.4 Port Mode Register 5 (PMR5)

PMR5 controls the selection of pin functions for port 5 pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | WKP7 | 0 | R/W | P5n/ \overline{WKPn} Pin Function Switch |
| 6 | WKP6 | 0 | R/W | These bits select whether pin P5n/ \overline{WKPn} is used as P5n or \overline{WKPn} . |
| 5 | WKP5 | 0 | R/W | |
| 4 | WKP4 | 0 | R/W | 0: P5n I/O pin |
| 3 | WKP3 | 0 | R/W | 1: \overline{WKPn} input pin |
| 2 | WKP2 | 0 | R/W | (n = 7 to 0) |
| 1 | WKP1 | 0 | R/W | |
| 0 | WKP0 | 0 | R/W | |

8.3.5 Pin Functions

The port 5 pin functions are shown below.

- P57/ $\overline{\text{WKP7}}$ to P54/ $\overline{\text{WKP4}}$ pins

The pin function depends on the combination of bit WKPn in PMR5 and bit PCR5n in PCR5.

(n = 7 to 4)

| | | | |
|--------------|---------------|----------------|------------------------------------|
| WKPn | 0 | | 1 |
| PCR5n | 0 | 1 | x |
| Pin Function | P5n input pin | P5n output pin | $\overline{\text{WKPn}}$ input pin |

[Legend]

x: Don't care.

- P53/ $\overline{\text{WKP3}}$ to P50/ $\overline{\text{WKP0}}$ pins

The pin function depends on the combination of bit WKPm in PMR5 and bit PCR5m in PCR5.

(m = 3 to 0)

| | | | |
|--------------|---------------|----------------|------------------------------------|
| WKPm | 0 | | 1 |
| PCR5m | 0 | 1 | x |
| Pin Function | P5m input pin | P5m output pin | $\overline{\text{WKPm}}$ input pin |

[Legend]

x: Don't care.

8.3.6 Input Pull-Up MOS

Port 5 has an on-chip input pull-up MOS function that can be controlled by software. When the PCR5 bit is cleared to 0, setting the corresponding PUCR5 bit to 1 turns on the input pull-up MOS for that pin. The input pull-up MOS function is in the off state after a reset.

(n = 7 to 0)

| PCR5n | 0 | | 1 |
|-------------------|-----|----|-----|
| PUCR5n | 0 | 1 | x |
| Input Pull-Up MOS | Off | On | Off |

[Legend]

x: Don't care.

8.4 Port 6

Port 6 is an I/O port. Figure 8.5 shows its pin configuration.

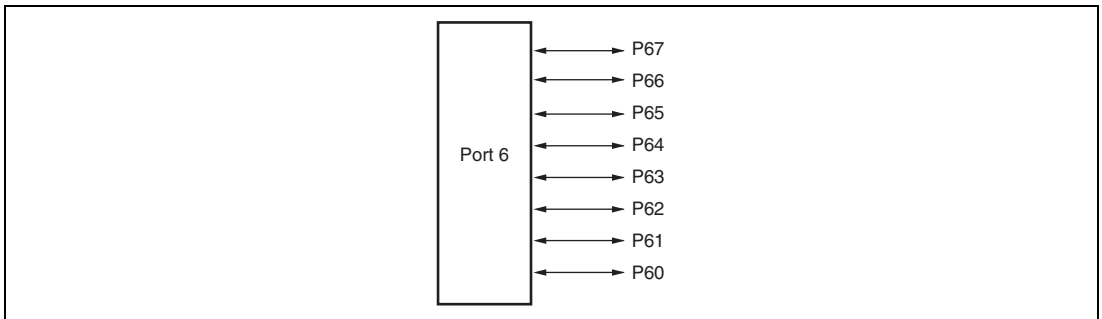


Figure 8.5 Port 6 Pin Configuration

Port 6 has the following registers.

- Port data register 6 (PDR6)
- Port control register 6 (PCR6)
- Port pull-up control register 6 (PUCR6)

8.4.1 Port Data Register 6 (PDR6)

PDR6 is a register that stores data of port 6.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P67 | 0 | R/W | If port 6 is read while PCR6 bits are set to 1, the values stored in PDR6 are read, regardless of the actual pin states. If port 6 is read while PCR6 bits are cleared to 0, the pin states are read. |
| 6 | P66 | 0 | R/W | |
| 5 | P65 | 0 | R/W | |
| 4 | P64 | 0 | R/W | |
| 3 | P63 | 0 | R/W | |
| 2 | P62 | 0 | R/W | |
| 1 | P61 | 0 | R/W | |
| 0 | P60 | 0 | R/W | |

8.4.2 Port Control Register 6 (PCR6)

PCR6 controls whether each of the port 6 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PCR67 | 0 | W | Setting a PCR6 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. PCR6 is a write-only register. Bits 7 to 0 are always read as 1. |
| 6 | PCR66 | 0 | W | |
| 5 | PCR65 | 0 | W | |
| 4 | PCR64 | 0 | W | |
| 3 | PCR63 | 0 | W | |
| 2 | PCR62 | 0 | W | |
| 1 | PCR61 | 0 | W | |
| 0 | PCR60 | 0 | W | |

8.4.3 Port Pull-Up Control Register 6 (PUCR6)

PUCR6 controls whether the pull-up MOS of each of the port 6 pins is on or off.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PUCR67 | 0 | R/W | When a PCR6 bit is cleared to 0, setting the corresponding PUCR6 bit to 1 turns on the pull-up MOS for the corresponding pin, while clearing the bit to 0 turns off the pull-up MOS. |
| 6 | PUCR66 | 0 | R/W | |
| 5 | PUCR65 | 0 | R/W | |
| 4 | PUCR64 | 0 | R/W | |
| 3 | PUCR63 | 0 | R/W | |
| 2 | PUCR62 | 0 | R/W | |
| 1 | PUCR61 | 0 | R/W | |
| 0 | PUCR60 | 0 | R/W | |

8.4.4 Pin Functions

The port 6 pin functions are shown below.

- P67 to P64 pins

The pin function depends on the setting of bit PCR6n in PCR6.

(n = 7 to 4)

| | | |
|--------------|---------------|----------------|
| PCR6n | 0 | 1 |
| Pin Function | P6n input pin | P6n output pin |

- P63 to P60 pins

The pin function depends on the setting of bit PCR6m in PCR6.

(m = 3 to 0)

| | | |
|--------------|---------------|----------------|
| PCR6m | 0 | 1 |
| Pin Function | P6m input pin | P6m output pin |

8.4.5 Input Pull-Up MOS

Port 6 has an on-chip input pull-up MOS function that can be controlled by software. When the PCR6 bit is cleared to 0, setting the corresponding PUCR6 bit to 1 turns on the input pull-up MOS for that pin. The input pull-up MOS function is in the off state after a reset.

(n = 7 to 0)

| | | | |
|-------------------|-----|----|-----|
| PCR6n | 0 | | 1 |
| PUCR6n | 0 | 1 | x |
| Input Pull-Up MOS | Off | On | Off |

[Legend]

x: Don't care.

8.5 Port 7

Port 7 is an I/O port. Figure 8.6 shows its pin configuration.

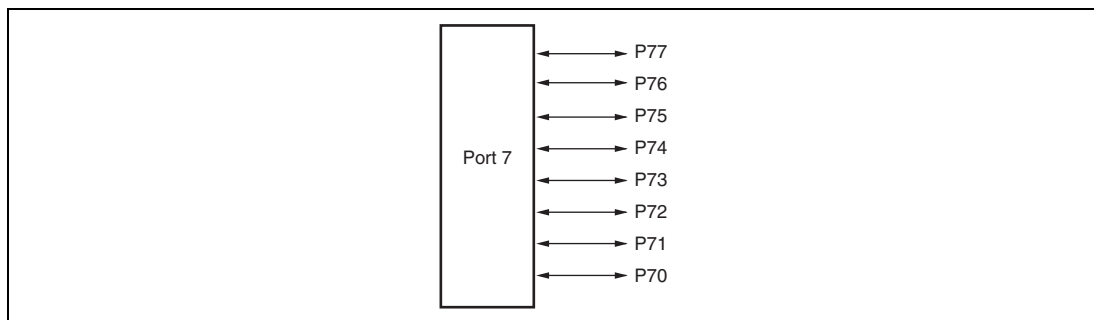


Figure 8.6 Port 7 Pin Configuration

Port 7 has the following registers.

- Port data register 7 (PDR7)
- Port control register 7 (PCR7)

8.5.1 Port Data Register 7 (PDR7)

PDR7 is a register that stores data of port 7.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | P77 | 0 | R/W | If port 7 is read while PCR7 bits are set to 1, the values stored in PDR7 are read, regardless of the actual pin states. If port 7 is read while PCR7 bits are cleared to 0, the pin states are read. |
| 6 | P76 | 0 | R/W | |
| 5 | P75 | 0 | R/W | |
| 4 | P74 | 0 | R/W | |
| 3 | P73 | 0 | R/W | |
| 2 | P72 | 0 | R/W | |
| 1 | P71 | 0 | R/W | |
| 0 | P70 | 0 | R/W | |

8.5.2 Port Control Register 7 (PCR7)

PCR7 controls whether each of the port 7 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | PCR77 | 0 | W | Setting a PCR7 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCR7 and in PDR7 are valid only when the corresponding pin is designated by the SGS3 to SGS0 bits in LPCR as a general I/O pin. |
| 6 | PCR76 | 0 | W | |
| 5 | PCR75 | 0 | W | |
| 4 | PCR74 | 0 | W | |
| 3 | PCR73 | 0 | W | PCR7 is a write-only register. Bits 7 to 0 are always read as 1. |
| 2 | PCR72 | 0 | W | |
| 1 | PCR71 | 0 | W | |
| 0 | PCR70 | 0 | W | |

8.5.3 Pin Functions

The port 7 pin functions are shown below.

- P77 to P74 pins

The pin function depends on the setting of bit PCR7n in PCR7.

(n = 7 to 4)

| | | |
|--------------|---------------|----------------|
| PCR7n | 0 | 1 |
| Pin Function | P7n input pin | P7n output pin |

- P73 to P70 pins

The pin function depends on the setting of bit PCR7m in PCR7.

(m = 3 to 0)

| | | |
|--------------|---------------|----------------|
| PCR7m | 0 | 1 |
| Pin Function | P7m input pin | P7m output pin |

8.6 Port 8

Port 8 is an I/O port. Figure 8.7 shows its pin configuration.

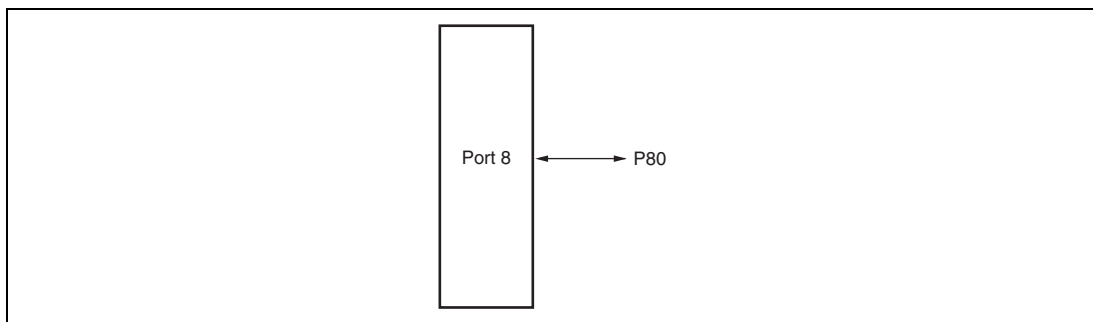


Figure 8.7 Port 8 Pin Configuration

Port 8 has the following registers.

- Port data register 8 (PDR8)
- Port control register 8 (PCR8)

8.6.1 Port Data Register 8 (PDR8)

PDR8 is a register that stores data of port 8.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 1 | — | — | — | Reserved |
| 0 | P80 | 0 | R/W | If port 8 is read while PCR8 bits are set to 1, the values stored in PDR8 are read, regardless of the actual pin states. If port 8 is read while PCR8 bits are cleared to 0, the pin states are read. |

8.6.2 Port Control Register 8 (PCR8)

PCR8 controls whether each of the port 8 pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 1 | — | — | W | Reserved The write value should always be 0. |
| 0 | PCR80 | 0 | W | Setting a PCR8 bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. PCR8 is a write-only register. |

8.6.3 Pin Functions

The port 8 pin functions are shown below.

- P80

The pin function depends on the setting of bit PCR80 in PCR8.

| | | |
|--------------|---------------|----------------|
| PCR80 | 0 | 1 |
| Pin Function | P80 input pin | P80 output pin |

8.7 Port 9

Port 9 is a dedicated current port for NMOS output that also functions as a PWM output pin. Figure 8.8 shows its pin configuration.

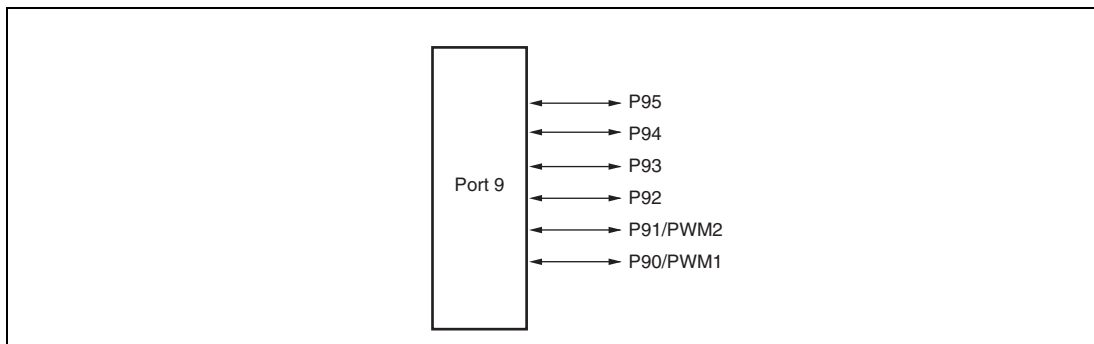


Figure 8.8 Port 9 Pin Configuration

Port 9 has the following registers.

- Port data register 9 (PDR9)
- Port mode register 9 (PMR9)

8.7.1 Port Data Register 9 (PDR9)

PDR9 is a register that stores data of port 9.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|--|
| 7, 6 | — | All 1 | — | Reserved The initial value should not be changed. |
| 5 | P95 | 1 | R/W | If PDR9 is read, the values stored in PDR9 are read. |
| 4 | P94 | 1 | R/W | |
| 3 | P93 | 1 | R/W | |
| 2 | P92 | 1 | R/W | |
| 1 | P91 | 1 | R/W | |
| 0 | P90 | 1 | R/W | |

8.7.2 Port Mode Register 9 (PMR9)

PMR9 controls the selection of the P90 and P91 pin functions.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 4 | — | All 1 | — | Reserved The initial value should not be changed. |
| 3 | — | 0 | R/W | Reserved This bit can be read from or written to. |
| 2 | — | — | W | Reserved The write value should always be 0. |
| 1 | PWM2 | 0 | R/W | P9n/PWMn+1 Pin Function Switch |
| 0 | PWM1 | 0 | R/W | These bits select whether pin P9n/PWMn+1 is used as P9n or as PWMn+1. (n = 1, 0) 0: P9n output pin 1: PWMn+1 output pin |

8.7.3 Pin Functions

The port 9 pin functions are shown below.

- P91/PWMn+1 to P90/PWMn+1 pins

(n = 1, 0)

| PMR9n | 0 | 1 |
|--------------|----------------|-------------------|
| Pin Function | P9n output pin | PWMn+1 output pin |

8.8 Port A

Port A is an I/O port. Figure 8.9 shows its pin configuration.

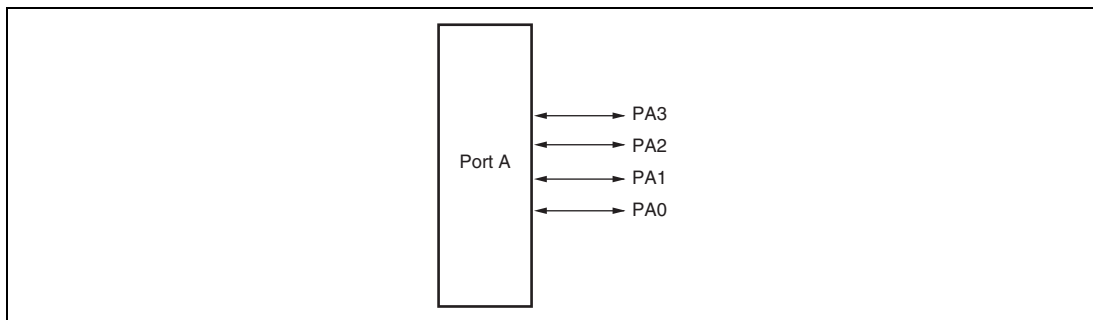


Figure 8.9 Port A Pin Configuration

Port A has the following registers.

- Port data register A (PDRA)
- Port control register A (PCRA)

8.8.1 Port Data Register A (PDRA)

PDRA is a register that stores data of port A.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 4 | — | All 1 | — | Reserved The initial value should not be changed. |
| 3 | PA3 | 0 | R/W | If port A is read while PCRA bits are set to 1, the values stored in PDRA are read, regardless of the actual pin states. If port A is read while PCRA bits are cleared to 0, the pin states are read. |
| 2 | PA2 | 0 | R/W | |
| 1 | PA1 | 0 | R/W | |
| 0 | PA0 | 0 | R/W | |

8.8.2 Port Control Register A (PCRA)

PCRA controls whether each of the port A pins functions as an input pin or output pin.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 to 4 | — | All 1 | — | Reserved The initial value should not be changed. |
| 3 | PCRA3 | 0 | W | Setting a PCRA bit to 1 makes the corresponding pin an output pin, while clearing the bit to 0 makes the pin an input pin. The settings in PCRA and in PDRA are valid only when the corresponding pin is designated in LPCR as a general I/O pin. PCRA is a write-only register. Bits 3 to 0 are always read as 1. |
| 2 | PCRA2 | 0 | W | |
| 1 | PCRA1 | 0 | W | |
| 0 | PCRA0 | 0 | W | |

8.8.3 Pin Functions

The port A pin functions are shown below.

- PA3 pin

The pin function depends on the setting of bit PCRA3 in PCRA.

| | | |
|--------------|---------------|----------------|
| PCRA3 | 0 | 1 |
| Pin Function | PA3 input pin | PA3 output pin |

- PA2 pin

The pin function depends on the setting of bit PCRA2 in PCRA.

| | | |
|--------------|---------------|----------------|
| PCRA2 | 0 | 1 |
| Pin Function | PA2 input pin | PA2 output pin |

- PA1 pin

The pin function depends on the setting of bit PCRA1 in PCRA.

| | | |
|--------------|---------------|----------------|
| PCRA1 | 0 | 1 |
| Pin Function | PA1 input pin | PA1 output pin |

- PA0 pin

The pin function depends on the setting of bit PCRA0 in PCRA.

| PCRA0 | 0 | 1 |
|--------------|---------------|----------------|
| Pin Function | PA0 input pin | PA0 output pin |

8.9 Port B

Port B is an input-only port also functioning as an analog input pin and interrupt input pin. Figure 8.10 shows its pin configuration.

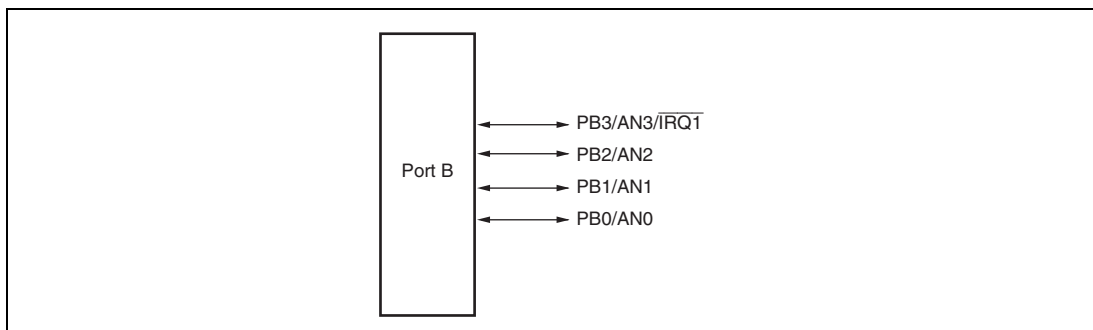


Figure 8.10 Port B Pin Configuration

Port B has the following registers.

- Port data register B (PDRB)
- Port mode register B (PMRB)

8.9.1 Port Data Register B (PDRB)

PDRB is a register that stores data of port B.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 4 | — | Undefined | — | Reserved |
| 3 | PB3 | Undefined | R | Reading PDRB always gives the pin states. However, if a port B pin is selected as an analog input channel for the A/D converter by bits CH3 to CH0 in AMR, that pin reads 0 regardless of the input voltage. |
| 2 | PB2 | | R | |
| 1 | PB1 | | R | |
| 0 | PB0 | | R | |

8.9.2 Port Mode Register B (PMRB)

PMRB controls the selection of the PB3 pin functions.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|--|
| 7 to 4 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 3 | IRQ1 | 0 | R/W | PB3/AN3/ $\overline{\text{IRQ1}}$ Pin Function Switch This bit selects whether pin PB3/AN3/ $\overline{\text{IRQ1}}$ is used as PB3/AN3 or as $\overline{\text{IRQ1}}$. 0: PB3/AN3 input pin 1: $\overline{\text{IRQ1}}$ input pin |
| 2 to 0 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |

8.9.3 Pin Functions

The port B pin functions are shown below.

- PB3/AN3/ $\overline{\text{IRQ1}}$ pin

The pin function depends on the combination of bits CH3 to CH0 in AMR and bit IRQ1 in PMRB.

| IRQ1 | 0 | | 1 |
|--------------|-------------------|---------------|------------------------------------|
| CH3 to CH0 | Other than B'0111 | B'0111 | x |
| Pin Function | PB3 input pin | AN3 input pin | $\overline{\text{IRQ1}}$ input pin |

[Legend]

x: Don't care.

- PB2/AN2 pin

The pin function depends on bits CH3 to CH0 in AMR.

| CH3 to CH0 | Other than B'0110 | B'0110 |
|--------------|-------------------|---------------|
| Pin Function | PB2 input pin | AN2 input pin |

- PB1/AN1 pin

Switching is accomplished by combining CH3 to CH0 in AMR as shown below.

| CH3 to CH0 | Other than B'0101 | B'0101 |
|--------------|-------------------|---------------|
| Pin Function | PB1 input pin | AN1 input pin |

- PB0/AN0 pin

Switching is accomplished by combining CH3 to CH0 in AMR as shown below.

| CH3 to CH0 | Other than B'0100 | B'0100 |
|--------------|-------------------|---------------|
| Pin Function | PB0 input pin | AN0 input pin |

8.10 Usage Notes

8.10.1 How to Handle Unused Pin

If an I/O pin not used by the user system is floating, pull it up or down.

- If an unused pin is an input pin, handle it in one of the following ways:
 - Pull it up to Vcc with an on-chip pull-up MOS.
 - Pull it up to Vcc with an external resistor of approximately 100 k Ω .
 - Pull it down to Vss with an external resistor of approximately 100 k Ω .
 - For a pin also used by the A/D converter, pull it up to AVcc.
- If an unused pin is an output pin, handle it in one of the following ways:
 - Set the output of the unused pin to high and pull it up to Vcc with an external resistor of approximately 100 k Ω .
 - Set the output of the unused pin to low and pull it down to GND with an external resistor of approximately 100 k Ω .

Section 9 Timers

9.1 Overview

This LSI has four timers: timer A, timer F, asynchronous event counter, and watchdog timer.

The functions of these timers are summarized in table 9.1.

Table 9.1 Timer Functions

| Name | Functions | Internal Clock | Event Input Pin | Waveform Output Pin | Remarks |
|----------------------------------|---|---|------------------------|---------------------|---------|
| Timer A | <ul style="list-style-type: none"> 8-bit timer Interval function Clock time base | $\phi/8$ to $\phi/8192$ (8 choices) $\phi_w/128$ (choice of 4 overflow periods) | — | — | |
| Timer F | <ul style="list-style-type: none"> 16-bit timer Also usable as two independent 8-bit timers. Output compare output function | $\phi/4$ to $\phi/32$, $\phi_w/4$ (4 choices) | — | TMOFL TMOFH | |
| Asynchronous event counter (AEC) | <ul style="list-style-type: none"> 16-bit counter Also usable as two independent 8-bit counters Counts events asynchronous to ϕ and ϕ_w Can count asynchronous events (rising/falling/both edges) independently of the MCU's internal clock | $\phi/2$ to $\phi/8$ (3 choices) | AEVL AEVH IRQAEC | — | |
| Watchdog timer | <ul style="list-style-type: none"> Generates a reset signal by overflow of 8-bit counter | $\phi/8192$, $\phi_w/32$ | — | — | |

9.2 Timer A

The timer A is an 8-bit timer with interval timing and realtime clock time-base functions. The clock time-base function is available when a 32.768kHz crystal oscillator is connected. Figure 9.1 shows a block diagram of the timer A.

9.2.1 Features

- The timer A can be used as an interval timer or a clock time base.
- An interrupt is requested when the counter overflows.
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

(1) Interval Timer

Choice of eight internal clock sources ($\phi/8192$, $\phi/4096$, $\phi/2048$, $\phi/512$, $\phi/256$, $\phi/128$, $\phi/32$, and $\phi 8$)

(2) Clock Time Base

Choice of four overflow periods (1 s, 0.5 s, 0.25 s, and 31.25 ms) when timer A is used as a clock time base (using a 32.768 kHz crystal oscillator)

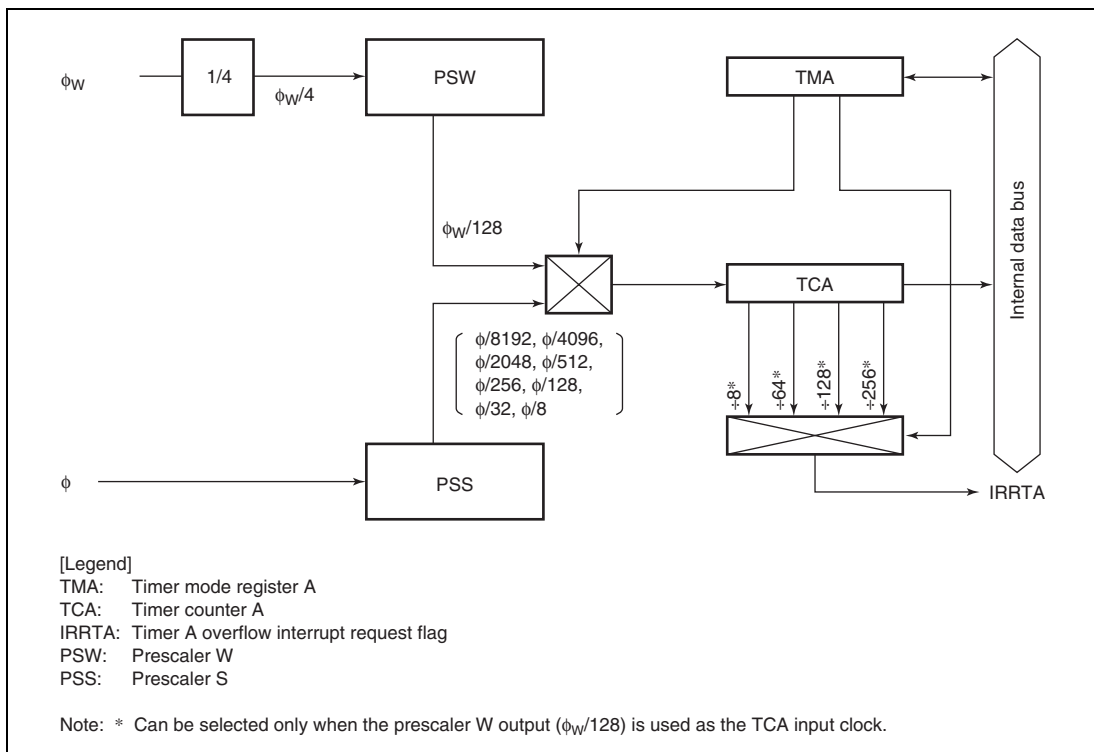


Figure 9.1 Block Diagram of Timer A

9.2.2 Register Descriptions

The timer A has the following registers.

- Timer mode register A (TMA)
- Timer counter A (TCA)

(1) Timer Mode Register A (TMA)

TMA selects the operating mode, the divided clock output, and the input clock.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | — | — | W | Reserved |
| 6 | — | — | W | The write value should always be 0. |
| 5 | — | — | W | |
| 4 | — | 1 | — | Reserved This bit is always read as 1. |
| 3 | TMA3 | 0 | R/W | Internal Clock Select 3 Selects the operating mode of the timer A. 0: Functions as an interval timer to count the outputs of prescaler S. 1: Functions as a clock-time base to count the outputs of prescaler W. |
| 2 | TMA2 | 0 | R/W | Internal Clock Select 2 to 0 |
| 1 | TMA1 | 0 | R/W | Select the clock input to TCA when TMA3 = 0. |
| 0 | TMA0 | 0 | R/W | 000: $\phi/8192$ 001: $\phi/4096$ 010: $\phi/2048$ 011: $\phi/512$ 100: $\phi/256$ 101: $\phi/128$ 110: $\phi/32$ 111: $\phi/8$ These bits select the overflow period when TMA3 = 1 (when a 32.768 kHz crystal oscillator is used as ϕ_w). 000: 1 s 001: 0.5 s 010: 0.25 s 011: 0.03125 s 1xx: Both PSW and TCA are reset |

[Legend] x: Don't care.

(2) Timer Counter A (TCA)

TCA is an 8-bit readable up-counter, which is incremented by internal clock input. The clock source for input to this counter is selected by bits TMA3 to TMA0 in TMA. TCA values can be read by the CPU in active mode, but cannot be read in subactive mode. When TCA overflows, the IRRTA bit in the interrupt request register 1 (IRR1) is set to 1. TCA is cleared by setting bits TMA3 and TMA2 in TMA to B'11. TCA is initialized to H'00.

9.2.3 Operation

(1) Interval Timer Operation

When bit TMA3 in TMA is cleared to 0, the timer A functions as an 8-bit interval timer.

Upon reset, TCA is cleared to H'00 and bit TMA3 is cleared to 0, so up-counting of the timer A resume immediately as an interval timer. The clock input to timer A is selected by bits TMA2 to TMA0 in TMA; any of eight internal clock signals output by prescaler S can be selected.

After the count value in TCA reaches H'FF, the next clock signal input causes timer A to overflow, setting bit IRRTA to 1 in interrupt Flag Register 1 (IRR1). If IENTA = 1 in the interrupt enable register 1 (IENR1), a CPU interrupt is requested. At overflow, TCA returns to H'00 and starts counting up again. In this mode the timer A functions as an interval timer that generates an overflow output at intervals of 256 input clock pulses.

(2) Clock Time Base Operation

When bit TMA3 in TMA is set to 1, the timer A functions as a clock-timer base by counting clock signals output by prescaler W. The overflow period of timer A is set by bits TMA1 and TMA0 in TMA. A choice of four periods is available. In clock time base operation (TMA3 = 1), setting bit TMA2 to 1 clears both TCA and prescaler W to H'00.

9.2.4 Timer A Operating States

Table 9.2 summarizes the timer A operating states.

Table 9.2 Timer A Operating States

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|----------------|-----------------|-----------|------------|------------|------------|-----------|-----------|----------------|
| TCA | Interval | Reset | Functions | Functions | Halted | Halted | Halted | Halted |
| | Clock time base | Reset | Functions* | Functions* | Functions | Functions | Functions | Halted |
| TMA | Reset | Functions | Retained | Retained | Functions | Retained | Retained | Retained |

Note: * When the clock time base function is selected as the internal clock of TCA in active mode or sleep mode, the internal clock is not synchronous with the system clock, so it is synchronized by a synchronizing circuit. This may result in a maximum error of $1/\phi$ (s) in the count cycle.

9.3 Timer F

The timer F has a 16-bit timer having an output compare function. The timer F also provides for counter resetting, interrupt request generation, toggle output, etc., using compare match signals. Thus, it can be applied to various systems. The timer F can also be used as two independent 8-bit timers (timer FH and timer FL). Figure 9.2 shows a block diagram of the timer F.

9.3.1 Features

- Choice of four internal clock sources ($\phi/32$, $\phi/16$, $\phi/4$, and $\phi_w/4$)
- Toggle output function
Toggle output is performed to the TMOFH pin (TMOFL pin) using a single compare match signal.
The initial value of toggle output can be set.
- Counter resetting by a compare match signal
- Two interrupt sources: One compare match, one overflow
- Choice of 16-bit or 8-bit mode by settings of bits CKSH2 to CKSH0 in TCRF
- Can operate in watch mode, subactive mode, and subsleep mode
When $\phi_w/4$ is selected as an internal clock, the timer F can operate in watch mode, subactive mode, and subsleep mode.
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

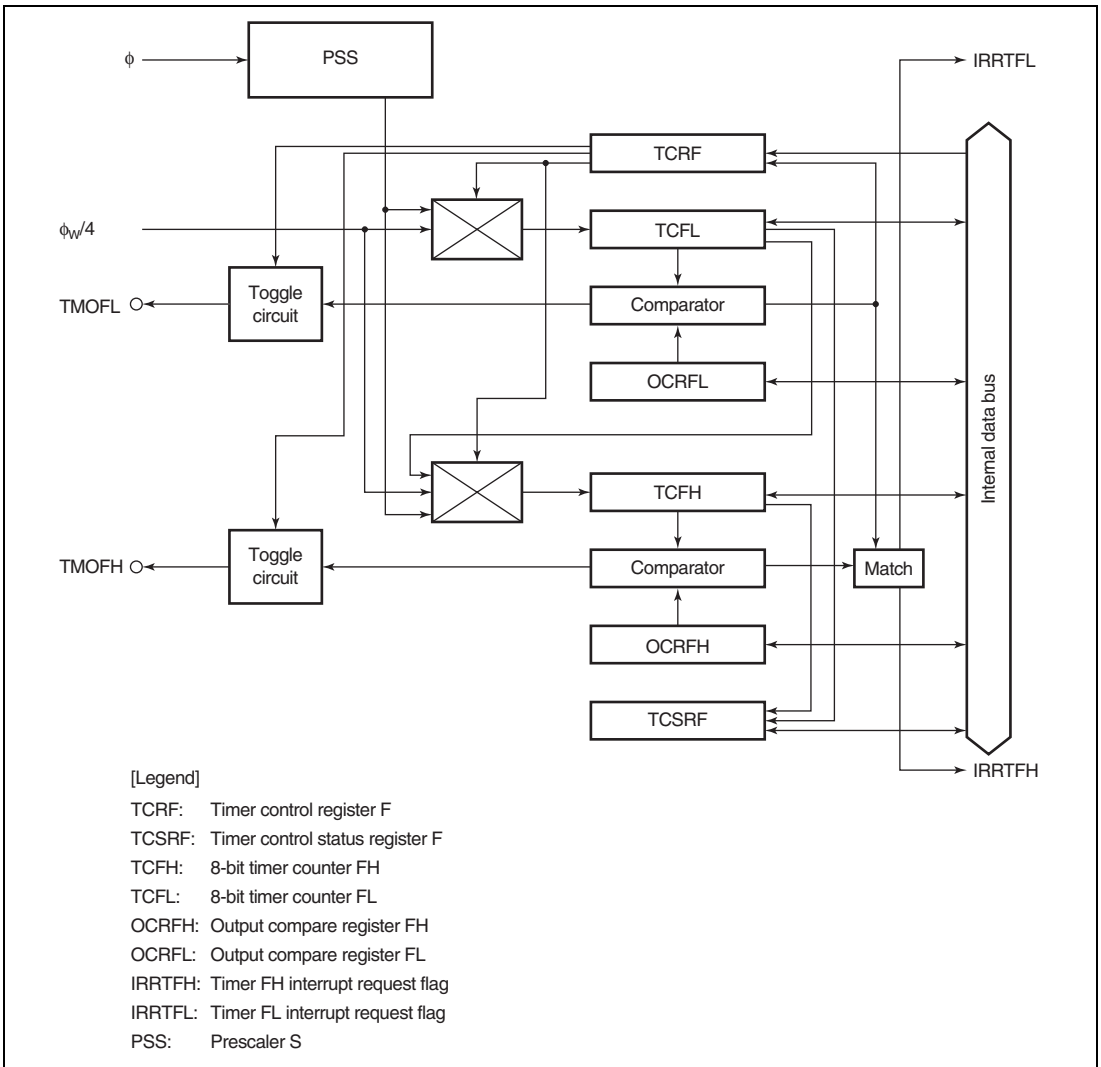


Figure 9.2 Block Diagram of Timer F

9.3.2 Input/Output Pins

Table 9.3 shows the pin configuration of the timer F.

Table 9.3 Pin Configuration

| Name | Abbreviation | I/O | Function |
|-----------------|--------------|--------|----------------------------|
| Timer FH output | TMOFH | Output | Timer FH toggle output pin |
| Timer FL output | TMOFL | Output | Timer FL toggle output pin |

9.3.3 Register Descriptions

The timer F has the following registers.

- Timer counters FH and FL (TCFH, TCFL)
- Output compare registers FH and FL (OCRFH, OCRFL)
- Timer control register F (TCRF)
- Timer control status register F (TCSRf)

(1) Timer Counters FH and FL (TCFH, TCFL)

TCF is a 16-bit read/write up-counter configured by cascaded connection of 8-bit timer counters TCFH and TCFL. In addition to the use of TCF as a 16-bit counter with TCFH as the upper 8 bits and TCFL as the lower 8 bits, TCFH and TCFL can also be used as independent 8-bit counters.

TCFH and TCFL can be read and written by the CPU, but when they are used in 16-bit mode, data transfer to and from the CPU is performed via a temporary register (TEMP). For details of TEMP, see section 9.3.4, CPU Interface. TCFH and TCFL are initialized to H'00 upon reset.

(a) 16-bit mode (TCF)

When CKSH2 is cleared to 0 in TCRF, TCF operates as a 16-bit counter. The TCF input clock is selected by bits CKSL2 to CKSL0 in TCRF.

TCF can be cleared in the event of a compare match by means of CCLR_H in TCSR_F.

When TCF overflows from H'FFFF to H'0000, OV_{FH} is set to 1 in TCSR_F. If OVIE_H in TCSR_F is 1 at this time, IRR_{TFH} is set to 1 in IRR₂, and if IENT_{TFH} in IEN₂ is 1, an interrupt request is sent to the CPU.

(b) 8-bit mode (TCFL/TCFH)

When CKSH2 is set to 1 in TCRF, TCFH and TCFL operate as two independent 8-bit counters. The TCFH (TCFL) input clock is selected by bits CKSH2 to CKSH0 (CKSL2 to CKSL0) in TCRF.

TCFH (TCFL) can be cleared in the event of a compare match by means of CCLR_H (CCLR_L) in TCSR_F.

When TCFH (TCFL) overflows from H'FF to H'00, OV_{FH} (OV_{FL}) is set to 1 in TCSR_F. If OVIE_H (OVIE_L) in TCSR_F is 1 at this time, IRR_{TFH} (IRR_{TFL}) is set to 1 in IRR2, and if IENT_{FH} (IENT_{FL}) in IENR2 is 1, an interrupt request is sent to the CPU.

(2) Output Compare Registers FH and FL (OCR_{FH}, OCR_{FL})

OCR_F is a 16-bit read/write register composed of the two registers OCR_{FH} and OCR_{FL}. In addition to the use of OCR_F as a 16-bit register with OCR_{FH} as the upper 8 bits and OCR_{FL} as the lower 8 bits, OCR_{FH} and OCR_{FL} can also be used as independent 8-bit registers.

OCR_{FH} and OCR_{FL} can be read and written by the CPU, but when they are used in 16-bit mode, data transfer to and from the CPU is performed via a temporary register (TEMP). For details of TEMP, see section 9.3.4, CPU Interface. OCR_{FH} and OCR_{FL} are initialized to H'FF upon reset.

(a) 16-bit mode (OCR_F)

When CKSH2 is cleared to 0 in TCRF, OCR_F operates as a 16-bit register. OCR_F contents are constantly compared with TCF, and when both values match, CM_{FH} is set to 1 in TCSR_F. At the same time, IRR_{TFH} is set to 1 in IRR2. If IENT_{FH} in IENR2 is 1 at this time, an interrupt request is sent to the CPU.

Toggle output can be provided from the TMO_{FH} pin by means of compare matches, and the output level can be set (high or low) by means of TOL_H in TCRF.

(b) 8-bit mode (OCR_{FH}/OCR_{FL})

When CKSH2 is set to 1 in TCRF, OCR_{FH} and OCR_{FL} operate as two independent 8-bit registers. OCR_{FH} contents are compared with TCF_H, and OCR_{FL} contents are with TCF_L. When the OCR_{FH} (OCR_{FL}) and TCF_H (TCF_L) values match, CM_{FH} (CM_{FL}) is set to 1 in TCSR_F. At the same time, IRR_{TFH} (IRR_{TFL}) is set to 1 in IRR2. If IENT_{FH} (IENT_{FL}) in IENR2 is 1 at this time, an interrupt request is sent to the CPU.

Toggle output can be provided from the TMO_{FH} pin (TMO_{FL} pin) by means of compare matches, and the output level can be set (high or low) by means of TOL_H (TOLL) in TCRF.

(3) Timer Control Register F (TCRF)

TCRF switches between 16-bit mode and 8-bit mode, selects the input clock from among four internal clock sources, and sets the output level of the TMOFH and TMOFL pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | TOLH | 0 | W | Toggle Output Level H Sets the TMOFH pin output level. 0: Low level 1: High level |
| 6 | CKSH2 | 0 | W | Clock Select H |
| 5 | CKSH1 | 0 | W | Select the clock input to TCFH from among four internal clock sources or TCFL overflow. |
| 4 | CKSH0 | 0 | W | Select the clock input to TCFH from among four internal clock sources or TCFL overflow. 000: 16-bit mode, counting on TCFL overflow signal 001: 16-bit mode, counting on TCFL overflow signal 010: 16-bit mode, counting on TCFL overflow signal 011: Using prohibited 100: Internal clock: counting on $\phi/32$ 101: Internal clock: counting on $\phi/16$ 110: Internal clock: counting on $\phi/4$ 111: Internal clock: counting on $\phi_w/4$ |
| 3 | TOLL | 0 | W | Toggle Output Level L Sets the TMOFL pin output level. 0: Low level 1: High level |
| 2 | CKSL2 | 0 | W | Clock Select L |
| 1 | CKSL1 | 0 | W | Select the clock input to TCFL from among four internal clock sources or external event input. |
| 0 | CKSL0 | 0 | W | Select the clock input to TCFL from among four internal clock sources or external event input. 000: Non-operational 001: Using prohibited 010: Using prohibited 011: Using prohibited 100: Internal clock: counting on $\phi/32$ 101: Internal clock: counting on $\phi/16$ 110: Internal clock: counting on $\phi/4$ 111: Internal clock: counting on $\phi_w/4$ |

(4) Timer Control Status Register F (TCSR F)

TCSR F performs counter clear selection, overflow flag setting, and compare match flag setting, and controls enabling of overflow interrupt requests.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 7 | OVFH | 0 | R/W* | <p>Timer Overflow Flag H</p> <p>[Setting condition]</p> <p>When TCFH overflows from H'FF to H'00</p> <p>[Clearing condition]</p> <p>When this bit is written to 0 after reading OVFH = 1</p> |
| 6 | CMFH | 0 | R/W* | <p>Compare Match Flag H</p> <p>This is a status flag indicating that TCFH has matched OCRFH.</p> <p>[Setting condition]</p> <p>When the TCFH value matches the OCRFH value</p> <p>[Clearing condition]</p> <p>When this bit is written to 0 after reading CMFH = 1</p> |
| 5 | OVIEH | 0 | R/W | <p>Timer Overflow Interrupt Enable H</p> <p>Selects enabling or disabling of interrupt generation when TCFH overflows.</p> <p>0: TCFH overflow interrupt request is disabled</p> <p>1: TCFH overflow interrupt request is enabled</p> |
| 4 | CCLR H | 0 | R/W | <p>Counter Clear H</p> <p>In 16-bit mode, this bit selects whether TCF is cleared when TCF and OCRF match. In 8-bit mode, this bit selects whether TCFH is cleared when TCFH and OCRFH match.</p> <p>In 16-bit mode:</p> <p>0: TCF clearing by compare match is disabled</p> <p>1: TCF clearing by compare match is enabled</p> <p>In 8-bit mode:</p> <p>0: TCFH clearing by compare match is disabled</p> <p>1: TCFH clearing by compare match is enabled</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|--|
| 3 | OVFL | 0 | R/W* | <p>Timer Overflow Flag L</p> <p>This is a status flag indicating that TCFL has overflowed.</p> <p>[Setting condition]</p> <p>When TCFL overflows from H'FF to H'00</p> <p>[Clearing condition]</p> <p>When this bit is written to 0 after reading OVFL = 1</p> |
| 2 | CMFL | 0 | R/W* | <p>Compare Match Flag L</p> <p>This is a status flag indicating that TCFL has matched OCRFL.</p> <p>[Setting condition]</p> <p>When the TCFL value matches the OCRFL value</p> <p>[Clearing condition]</p> <p>When this bit is written to 0 after reading CMFL = 1</p> |
| 1 | OVIEL | 0 | R/W | <p>Timer Overflow Interrupt Enable L</p> <p>Selects enabling or disabling of interrupt generation when TCFL overflows.</p> <p>0: TCFL overflow interrupt request is disabled</p> <p>1: TCFL overflow interrupt request is enabled</p> |
| 0 | CCLRL | 0 | R/W | <p>Counter Clear L</p> <p>Selects whether TCFL is cleared when TCFL and OCRFL match.</p> <p>0: TCFL clearing by compare match is disabled</p> <p>1: TCFL clearing by compare match is enabled</p> |

Note: * Only 0 can be written to clear the flag.

9.3.4 CPU Interface

TCF and OCRF are 16-bit readable/writable registers, but the CPU is connected to the on-chip peripheral modules by an 8-bit data bus. When the CPU accesses these registers, it therefore uses an 8-bit temporary register (TEMP).

When performing TCF read/write access or OCRF write access in 16-bit mode, data will not be transferred correctly if only the upper byte or only the lower byte is accessed. Access must be performed for all 16 bits (using two consecutive byte-size MOV instructions), and the upper byte must be accessed before the lower byte.

In 8-bit mode, there are no restrictions on the order of access.

(1) Write Access

Write access to the upper byte results in transfer of the upper-byte write data to TEMP. Next, write access to the lower byte results in transfer of the data in TEMP to the upper register byte, and direct transfer of the lower-byte write data to the lower register byte.

Figure 9.3 shows an example in which H'AA55 is written to TCF.

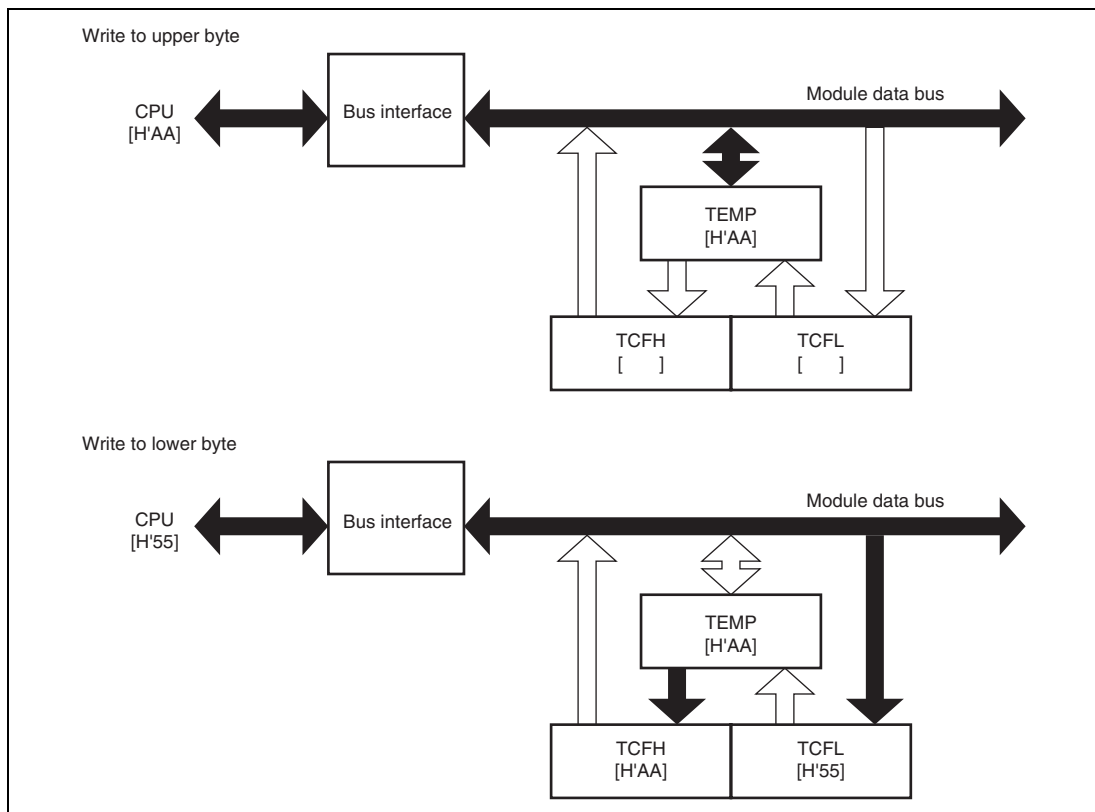


Figure 9.3 Write Access to TCF (CPU → TCF)

(2) Read Access

In access to TCF, when the upper byte is read the upper-byte data is transferred directly to the CPU and the lower-byte data is transferred to TEMP. Next, when the lower byte is read, the lower-byte data in TEMP is transferred to the CPU.

In access to OCRF, when the upper byte is read the upper-byte data is transferred directly to the CPU. When the lower byte is read, the lower-byte data is transferred directly to the CPU.

Figure 9.4 shows an example in which TCF is read when it contains H'AAFF.

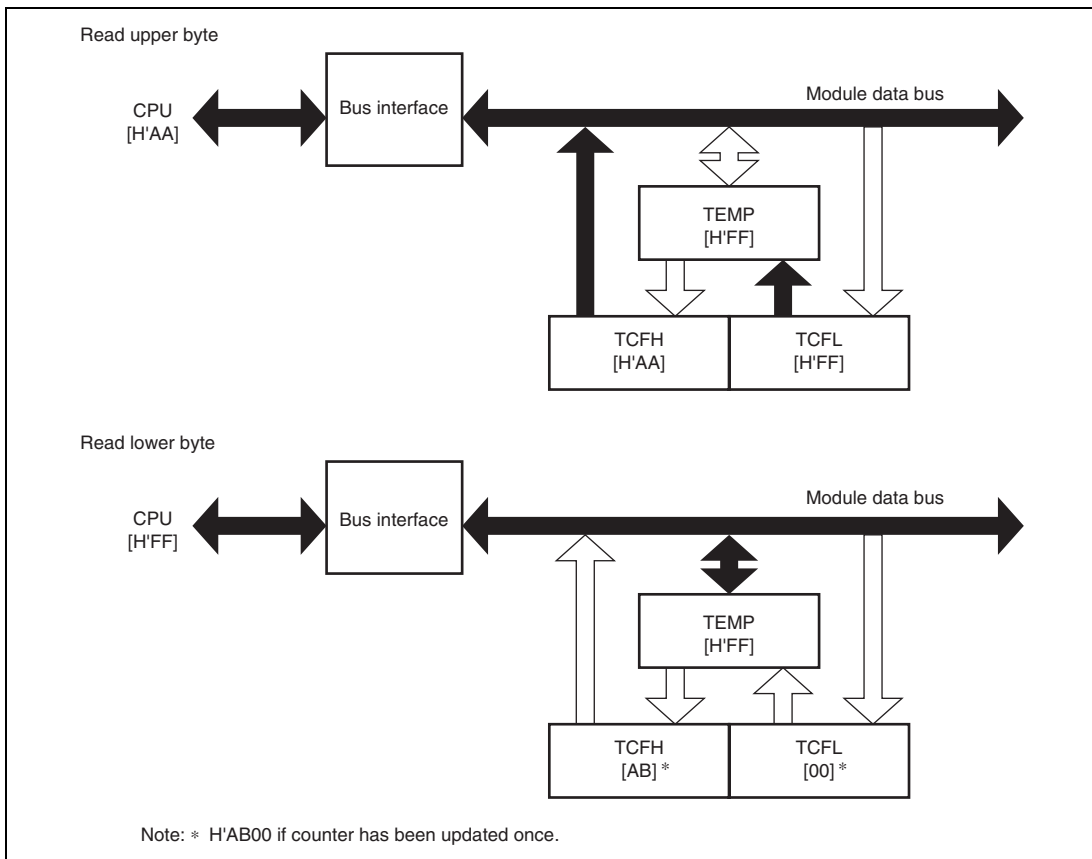


Figure 9.4 Read Access to TCF (TCF → CPU)

9.3.5 Operation

The timer F is a 16-bit counter that increments on each input clock pulse. The timer F value is constantly compared with the value set in the output compare register F, and the counter can be cleared, an interrupt requested, or port output toggled, when the two values match. The timer F can also function as two independent 8-bit timers.

(1) Timer F Operation

The timer F has two operating modes, 16-bit timer mode and 8-bit timer mode. The operation in each of these modes is described below.

(a) Operation in 16-bit timer mode

When CKSH2 is cleared to 0 in timer control register F (TCRF), timer F operates as a 16-bit timer.

The timer F operating clock can be selected from three internal clocks output by prescaler S by means of bits CKSL2 to CKSL0 in TCRF.

OCRFB contents are constantly compared with TCF, and when both values match, CMFB is set to 1 in TCSRFB. If IENFB in IENR2 is 1 at this time, an interrupt request is sent to the CPU, and at the same time, TMOFB pin output is toggled. If CCLRFB in TCSRFB is 1, TCF is cleared. TMOFB pin output can also be set by TOLFB in TCRF.

When TCF overflows from H'FFFF to H'0000, OVFB is set to 1 in TCSRFB. If OVIEB in TCSRFB and IENFB in IENR2 are both 1, an interrupt request is sent to the CPU.

(b) Operation in 8-bit timer mode

When CKSH2 is set to 1 in TCRF, TCF operates as two independent 8-bit timers, TCFH and TCFL. The TCFH/TCFL input clock is selected by CKSH2 to CKSH0/CKSL2 to CKSL0 in TCRF.

When the OCRFBH/OCRFL and TCFH/TCFL values match, CMFBH/CMFL is set to 1 in TCSRFB. If IENFBH/IENBFL in IENR2 is 1, an interrupt request is sent to the CPU, and at the same time, TMOFBH pin/TMOBFL pin output is toggled. If CCLRFBH/CCLRFL in TCSRFB is 1, TCFH/TCFL is cleared. TMOFBH pin/TMOBFL pin output can also be set by TOLFBH/TOLBFL in TCRF.

When TCFH/TCFL overflows from H'FF to H'00, OVFBH/OVFL is set to 1 in TCSRFB. If OVIEBH/OVIEFL in TCSRFB and IENFBH/IENBFL in IENR2 are both 1, an interrupt request is sent to the CPU.

(2) TCF Increment Timing

TCF is incremented by clock input (internal clock input). Bits CKSH2 to CKSH0 or CKSL2 to CKSL0 in TCRF select one of four internal clock sources ($\phi/32$, $\phi/16$, $\phi/4$, or $\phi_w/4$) created by dividing the system clock (ϕ or ϕ_w).

(3) TMOFH/TMOFL Output Timing

In TMOFH/TMOFL output, the value set in TOLH/TOLL in TCRF is output. The output is toggled by the occurrence of a compare match.

Figure 9.5 shows the output timing.

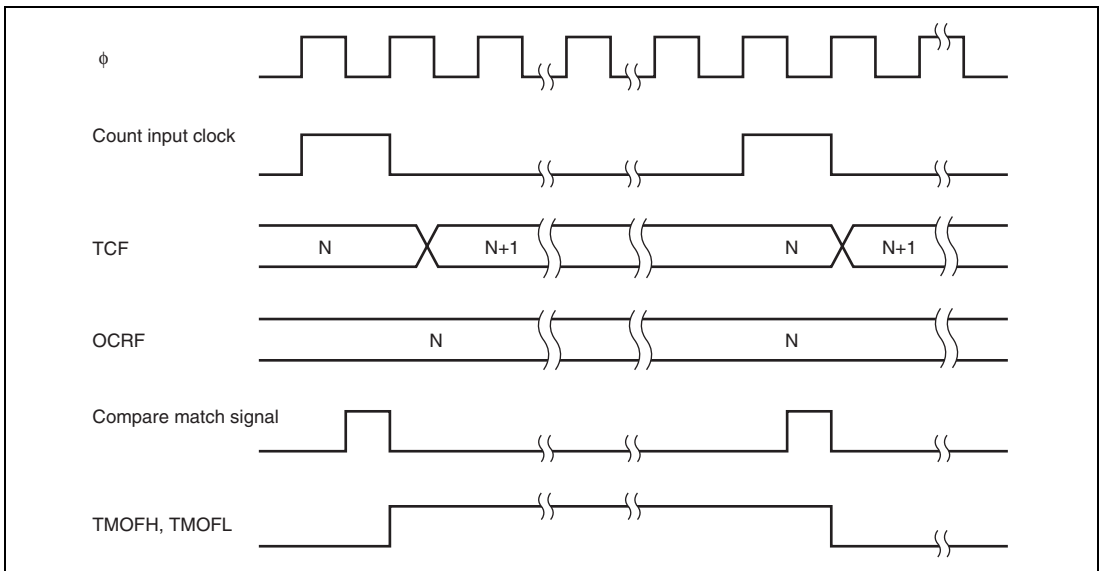


Figure 9.5 TMOFH/TMOFL Output Timing

(4) TCF Clear Timing

TCF can be cleared by a compare match with OCRF.

(5) Timer Overflow Flag (OVF) Set Timing

OVF is set to 1 when TCF overflows from H'FFFF to H'0000.

(6) Compare Match Flag Set Timing

The compare match flag (CMFH or CMFL) is set to 1 when the TCF and OCRF values match. The compare match signal is generated in the last state during which the values match (when TCF is updated from the matching value to a new value). When TCF matches OCRF, the compare match signal is not generated until the next counter clock.

9.3.6 Timer F Operating States

The timer F operating states are shown in table 9.4.

Table 9.4 Timer F Operating States

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|----------------|-------|------------|------------|-----------------------|-----------------------|-----------------------|----------|----------------|
| TCF | Reset | Functions* | Functions* | Functions/ Halted* | Functions/ Halted* | Functions/ Halted* | Halted | Halted |
| OCRF | Reset | Functions | Retained | Retained | Functions | Retained | Retained | Retained |
| TCRF | Reset | Functions | Retained | Retained | Functions | Retained | Retained | Retained |
| TCSRFB | Reset | Functions | Retained | Retained | Functions | Retained | Retained | Retained |

Note: * When $\phi_w/4$ is selected as the TCF internal clock in active mode or sleep mode, since the system clock and internal clock are mutually asynchronous, synchronization is maintained by a synchronization circuit. This results in a maximum count cycle error of $1/\phi$ (s). When the counter is operated in subactive mode, watch mode, or subsleep mode, $\phi_w/4$ must be selected as the internal clock. The counter will not operate if any other internal clock is selected.

9.3.7 Usage Notes

The following types of contention and operation can occur when the timer F is used.

(1) 16-Bit Timer Mode

In toggle output, TMOFH pin output is toggled when all 16 bits match and a compare match signal is generated. If a TCRF write by a MOV instruction and generation of the compare match signal occur simultaneously, TOLH data is output to the TMOFH pin as a result of the TCRF write. TMOFL pin output is unstable in 16-bit mode, and should not be used; the TMOFL pin should be used as a port pin.

If an OCRFL write and compare match signal generation occur simultaneously, the compare match signal is invalid. However, even if the written data and the counter value match, a compare match signal is not necessarily generated at that point. As the compare match signal is output in synchronization with the TCFL clock, a compare match will not result in compare match signal generation if the clock is stopped.

Compare match flag CMFH is set when all 16 bits match and a compare match signal is generated. Compare match flag CMFL is set if the setting conditions for the lower 8 bits are satisfied.

When TCF overflows, OVFH is set. OVFL is set if the setting conditions are satisfied when the lower 8 bits overflow. If a TCFL write and overflow signal output occur simultaneously, the overflow signal is not output.

(2) 8-Bit Timer Mode:

(a) TCFH, OCRFH

In toggle output, TMOFH pin output is toggled when a compare match occurs. If a TCRF write by a MOV instruction and generation of the compare match signal occur simultaneously, TOLH data is output to the TMOFH pin as a result of the TCRF write.

If an OCRFH write and compare match signal generation occur simultaneously, the compare match signal is invalid. However, even if the written data and the counter value match, a compare match signal is not necessarily generated at that point. The compare match signal is output in synchronization with the TCFH clock.

If a TCFH write and overflow signal output occur simultaneously, the overflow signal is not output.

(b) TCFL, OCRFL

In toggle output, TMOFL pin output is toggled when a compare match occurs. If a TCRF write by a MOV instruction and generation of the compare match signal occur simultaneously, TOLL data is output to the TMOFL pin as a result of the TCRF write.

If an OCRFL write and compare match signal generation occur simultaneously, the compare match signal is invalid. However, even if the written data and the counter value match, a compare match signal is not necessarily generated at that point. As the compare match signal is output in synchronization with the TCFL clock, a compare match will not result in compare match signal generation if the clock is stopped.

If a TCFL write and overflow signal output occur simultaneously, the overflow signal is not output.

(3) Clear Timer FH, Timer FL Interrupt Request Flags (IRRTFH, IRRNFL), Timer Overflow Flags H, L (OVFH, OVFL), and Compare Match Flags H, L (CMFH, CMFL)

When $\phi_w/4$ is selected as the internal clock, “Interrupt source generation signal” will be operated with ϕ_w and the signal will be outputted with ϕ_w width. And, “Overflow signal” and “Compare match signal” are controlled with 2 cycles of ϕ_w signals. Those signals are outputted with 2 cycles width of ϕ_w (figure 9.6)

In active (high-speed, medium-speed) mode, even if you cleared interrupt request flag during the term of validity of “Interrupt source generation signal”, same interrupt request flag is set. (1 in figure 9.6) And, the timer overflow flag and compare match flag cannot be cleared during the term of validity of “Overflow signal” and “Compare match signal”.

For interrupt request flag is set right after interrupt request is cleared, interrupt process to one time timer FH, timer FL interrupt might be repeated. (2 in figure 9.6) Therefore, to definitely clear interrupt request flag in active (high-speed, medium-speed) mode, clear should be processed after the time that calculated with below (1) formula. And, to definitely clear timer overflow flag and compare match flag, clear should be processed after read timer control status register F (TCSRFB) after the time that calculated with below (1) formula.

For ST of (1) formula, please substitute the longest number of execution states in used instruction. (10 states of RTE instruction when MULXU, DIVXU instruction is not used, 14 states when MULXU, DIVXU instruction is used)

In subactive mode, there are not limitation for interrupt request flag, timer overflow flag, and compare match flag clear.

The term of validity of “Interrupt source generation signal”

$$\begin{aligned} &= 1 \text{ cycle of } \phi_w + \text{waiting time for completion of executing instruction} \\ &+ \text{interrupt time synchronized with } \phi \\ &= 1/\phi_w + ST \times (1/\phi) + (2/\phi) \text{ (second)} \dots (1) \end{aligned}$$

ST: Executing number of execution states

Method 1 is recommended to operate for time efficiency.

Method 1

1. Prohibit interrupt in interrupt handling routine (set IENFH, IENFL to 0).
2. After program process returned normal handling, clear interrupt request flags (IRRTFH, IRRTFLL) after more than that calculated with (1) formula.
3. After reading the timer control status register F (TCSRFB), clear the timer overflow flags (OVFB, OVFL) and compare match flags (CMFB, CMFL).
4. Enable interrupts (set IENFH, IENFL to 1).

Method 2

1. Set interrupt handling routine time to more than time that calculated with (1) formula.
2. Clear interrupt request flags (IRRTFH, IRRTFLL) at the end of interrupt handling routine.
3. After read timer control status register F (TCSRFB), clear timer overflow flags (OVFB, OVFL) and compare match flags (CMFB, CMFL).

All above attentions are also applied in 16-bit mode and 8-bit mode.

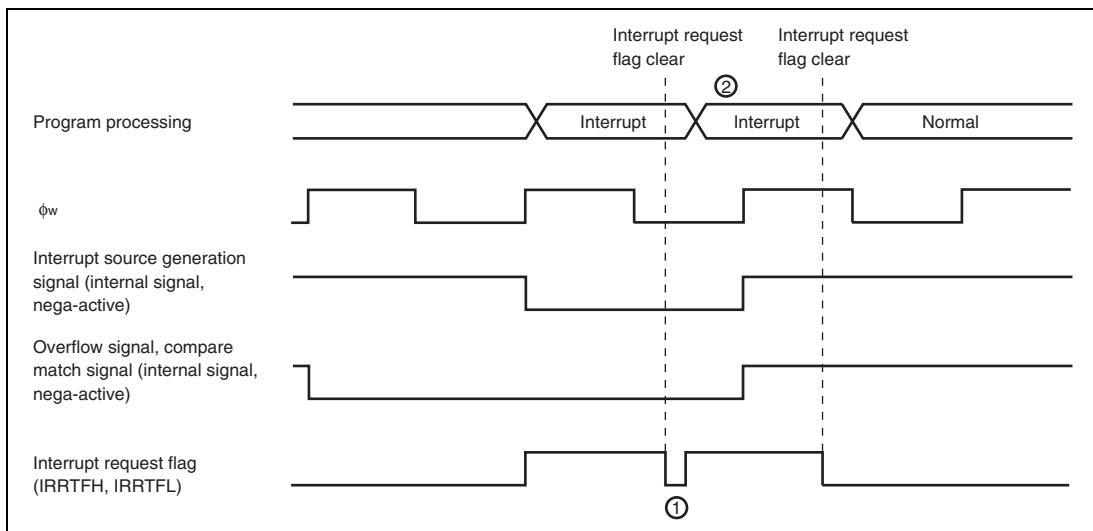


Figure 9.6 Clear Interrupt Request Flag when Interrupt Source Generation Signal is Valid

(4) Timer Counter (TCF) Read/Write

When $\phi_w/4$ is selected as the internal clock in active (high-speed, medium-speed) mode, write on TCF is impossible. And when reading TCF, as the system clock and internal clock are mutually asynchronous, TCF synchronizes with synchronization circuit. This results in a maximum TCF read value error of ± 1 .

When reading or writing TCF in active (high-speed, medium-speed) mode is needed, please select the internal clock except for $\phi_w/4$ before read/write is performed.

In subactive mode, even if $\phi_w/4$ is selected as the internal clock, TCF can be read from or written to normally.

9.4 Asynchronous Event Counter (AEC)

The asynchronous event counter is incremented by external event clock or internal clock input. Figure 9.7 shows a block diagram of the asynchronous event counter.

9.4.1 Features

- Can count asynchronous events
 - Can count external events input asynchronously without regard to the operation of system clocks ϕ and ϕ_{SUB}
- Can be used as two-channel independent 8-bit event counter or single-channel independent 16-bit event counter.
- Event/clock input is enabled only when IRQAEC is high or event counter PWM output (IECPWM) is high.
- Both edge sensing can be used for IRQAEC or event counter PWM output (IECPWM) interrupts. When the asynchronous counter is not used, they can be used as independent interrupts.
- When an event counter PWM is used, event clock input enabling/disabling can be controlled automatically in a fixed cycle.
- External event input or a prescaler output clock can be selected by software for the ECH and ECL clock sources. $\phi/2$, $\phi/4$, or $\phi/8$ can be selected as the prescaler output clock.
- Both edge counting is possible for AEVL and AEVH.
- Counter resetting and halting of the count-up function can be controlled by software
- Automatic interrupt generation on detection of an event counter overflow
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

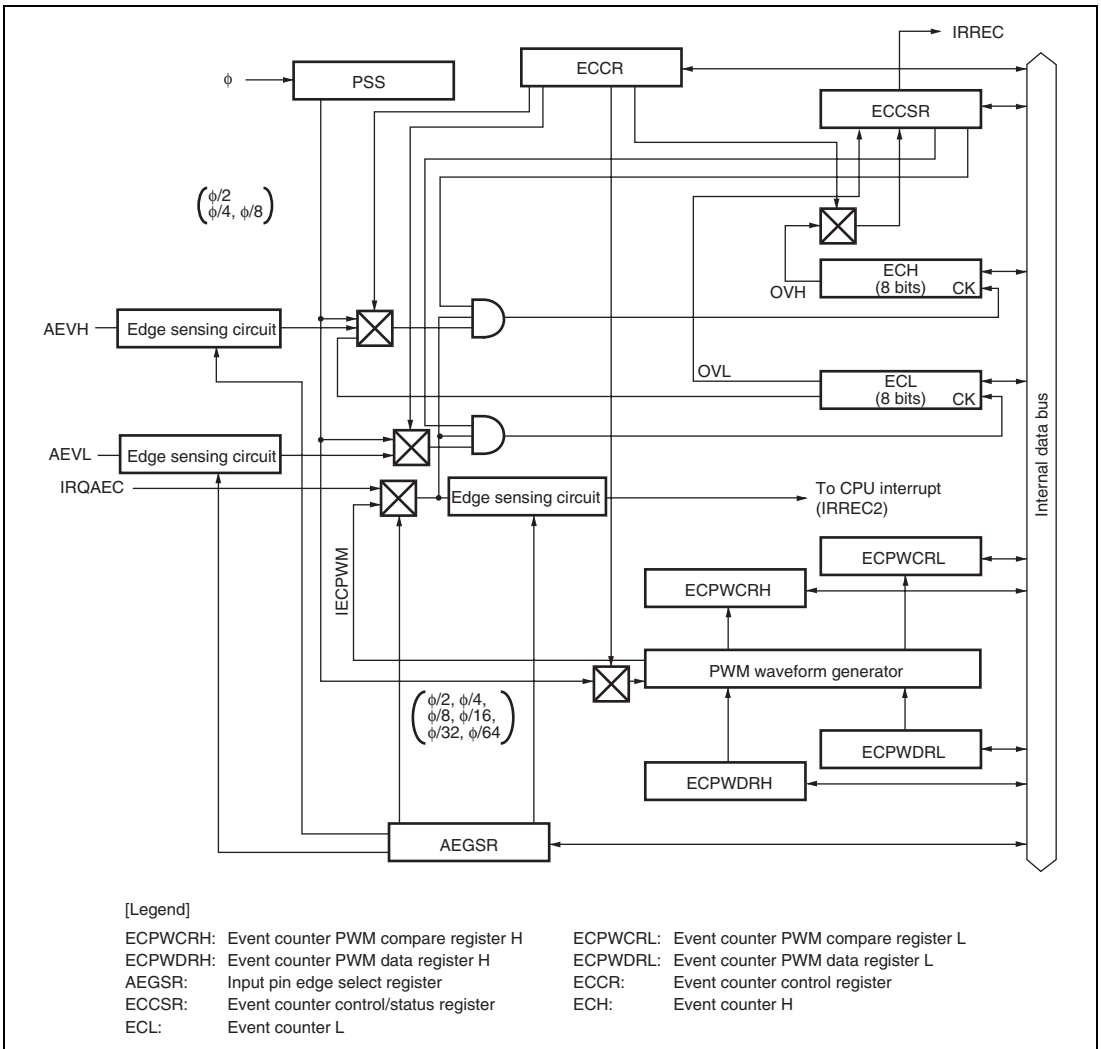


Figure 9.7 Block Diagram of Asynchronous Event Counter

9.4.2 Input/Output Pins

Table 9.5 shows the pin configuration of the asynchronous event counter.

Table 9.5 Pin Configuration

| Name | Abbreviation | I/O | Function |
|------------------------------------|---------------------|------------|--|
| Asynchronous event input H | AEVH | Input | Event input pin for input to event counter H |
| Asynchronous event input L | AEVL | Input | Event input pin for input to event counter L |
| Event input enable interrupt input | IRQAEC | Input | Input pin for interrupt enabling event input |

9.4.3 Register Descriptions

The asynchronous event counter has the following registers.

- Event counter PWM compare register H (ECPWCRH)
- Event counter PWM compare register L (ECPWCRL)
- Event counter PWM data register H (ECPWDRH)
- Event counter PWM data register L (ECPWDRL)
- Input pin edge select register (AEGSR)
- Event counter control register (ECCR)
- Event counter control/status register (ECCSR)
- Event counter H (ECH)
- Event counter L (ECL)

(1) Event Counter PWM Compare Register H (ECPWCRH)

ECPWCRH sets the one conversion period of the event counter PWM waveform.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | ECPWCRH7 | 1 | R/W | One conversion period of event counter PWM waveform |
| 6 | ECPWCRH6 | 1 | R/W | |
| 5 | ECPWCRH5 | 1 | R/W | |
| 4 | ECPWCRH4 | 1 | R/W | |
| 3 | ECPWCRH3 | 1 | R/W | |
| 2 | ECPWCRH2 | 1 | R/W | |
| 1 | ECPWCRH1 | 1 | R/W | |
| 0 | ECPWCRH0 | 1 | R/W | |

Notes: When ECPWME in AEGSR is 1, the event counter PWM is operating and therefore ECPWCRH should not be modified.

When changing the conversion period, the event counter PWM must be halted by clearing ECPWME to 0 in AEGSR before modifying ECPWCRH.

(2) Event Counter PWM Compare Register L (ECPWCRL)

ECPWCRL sets the one conversion period of the event counter PWM waveform.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | ECPWCRL7 | 1 | R/W | One conversion period of event counter PWM waveform |
| 6 | ECPWCRL6 | 1 | R/W | |
| 5 | ECPWCRL5 | 1 | R/W | |
| 4 | ECPWCRL4 | 1 | R/W | |
| 3 | ECPWCRL3 | 1 | R/W | |
| 2 | ECPWCRL2 | 1 | R/W | |
| 1 | ECPWCRL1 | 1 | R/W | |
| 0 | ECPWCRL0 | 1 | R/W | |

Notes: When ECPWME in AEGSR is 1, the event counter PWM is operating and therefore ECPWCRL should not be modified.

When changing the conversion period, the event counter PWM must be halted by clearing ECPWME to 0 in AEGSR before modifying ECPWCRL.

(3) Event Counter PWM Data Register H (ECPWDRH)

ECPWDRH controls data of the event counter PWM waveform generator.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ECPWDRH7 | 0 | W | Data control of event counter PWM waveform generator |
| 6 | ECPWDRH6 | 0 | W | |
| 5 | ECPWDRH5 | 0 | W | |
| 4 | ECPWDRH4 | 0 | W | |
| 3 | ECPWDRH3 | 0 | W | |
| 2 | ECPWDRH2 | 0 | W | |
| 1 | ECPWDRH1 | 0 | W | |
| 0 | ECPWDRH0 | 0 | W | |

Notes: When ECPWME in AEGSR is 1, the event counter PWM is operating and therefore ECPWDRH should not be modified.

When changing the data, the event counter PWM must be halted by clearing ECPWME to 0 in AEGSR before modifying ECPWDRH.

(4) Event Counter PWM Data Register L (ECPWDRL)

ECPWDRL controls data of the event counter PWM waveform generator.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ECPWDRL7 | 0 | W | Data control of event counter PWM waveform generator |
| 6 | ECPWDRL6 | 0 | W | |
| 5 | ECPWDRL5 | 0 | W | |
| 4 | ECPWDRL4 | 0 | W | |
| 3 | ECPWDRL3 | 0 | W | |
| 2 | ECPWDRL2 | 0 | W | |
| 1 | ECPWDRL1 | 0 | W | |
| 0 | ECPWDRL0 | 0 | W | |

Notes: When ECPWME in AEGSR is 1, the event counter PWM is operating and therefore ECPWDRL should not be modified.

When changing the data, the event counter PWM must be halted by clearing ECPWME to 0 in AEGSR before modifying ECPWDRL.

(5) Input Pin Edge Select Register (AEGSR)

AEGSR selects rising, falling, or both edge sensing for the AEVH, AEVL, and IRQAEC pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | AHEGS1 | 0 | R/W | AEC Edge Select H |
| 6 | AHEGS0 | 0 | R/W | Select rising, falling, or both edge sensing for the AEVH pin. 00: Falling edge on AEVH pin is sensed 01: Rising edge on AEVH pin is sensed 10: Both edges on AEVH pin are sensed 11: Setting prohibited |
| 5 | ALEGS1 | 0 | R/W | AEC Edge Select L |
| 4 | ALEGS0 | 0 | R/W | Select rising, falling, or both edge sensing for the AEVL pin. 00: Falling edge on AEVL pin is sensed 01: Rising edge on AEVL pin is sensed 10: Both edges on AEVL pin are sensed 11: Setting prohibited |
| 3 | AIEGS1 | 0 | R/W | IRQAEC Edge Select |
| 2 | AIEGS0 | 0 | R/W | Select rising, falling, or both edge sensing for the IRQAEC pin. 00: Falling edge on IRQAEC pin is sensed 01: Rising edge on IRQAEC pin is sensed 10: Both edges on IRQAEC pin are sensed 11: Setting prohibited |
| 1 | ECPWME | 0 | R/W | Event Counter PWM Enable Controls operation of event counter PWM and selection of IRQAEC. 0: AEC PWM halted, IRQAEC selected 1: AEC PWM enabled, IRQAEC not selected |
| 0 | — | 0 | R/W | Reserved This bit can be read from or written to. However, this bit should not be set to 1. |

(6) Event Counter Control Register (ECCR)

ECCR controls the counter input clock and IRQAEC/IECPWM.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ACKH1 | 0 | R/W | AEC Clock Select H |
| 6 | ACKH0 | 0 | R/W | Select the clock used by ECH. 00: AEVH pin input 01: $\phi/2$ 10: $\phi/4$ 11: $\phi/8$ |
| 5 | ACKL1 | 0 | R/W | AEC Clock Select L |
| 4 | ACKL0 | 0 | R/W | Select the clock used by ECL. 00: AEVL pin input 01: $\phi/2$ 10: $\phi/4$ 11: $\phi/8$ |
| 3 | PWCK2 | 0 | R/W | Event Counter PWM Clock Select |
| 2 | PWCK1 | 0 | R/W | Select the event counter PWM clock. |
| 1 | PWCK0 | 0 | R/W | 000: $\phi/2$ 001: $\phi/4$ 010: $\phi/8$ 011: $\phi/16$ 1x0: $\phi/32$ 1x1 $\phi/64$ |
| 0 | — | 0 | R/W | Reserved This bit can be read from or written to. However, this bit should not be set to 1. |

[Legend] x: Don't care.

(7) Event Counter Control/Status Register (ECCSR)

ECCSR controls counter overflow detection, counter clear resetting, and the count-up function.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|------|---|
| 7 | OVH | 0 | R/W* | Counter Overflow H This is a status flag indicating that ECH has overflowed. [Setting condition] When ECH overflows from H'FF to H'00 [Clearing condition] When this bit is written to 0 after reading OVH = 1 |
| 6 | OVL | 0 | R/W* | Counter Overflow L This is a status flag indicating that ECL has overflowed. [Setting condition] When ECL overflows from H'FF to H'00 [Clearing condition] When this bit is written to 0 after reading OVL = 1 |
| 5 | — | 0 | R/W | Reserved This bit can be read from or written to. However, the initial value should not be changed. |
| 4 | CH2 | 0 | R/W | Channel Select Selects how ECH and ECL event counters are used 0: ECH and ECL are used together as a single-channel 16-bit event counter 1: ECH and ECL are used as two-channel 8-bit event counter |
| 3 | CUEH | 0 | R/W | Count-Up Enable H Enables event clock input to ECH. 0: ECH event clock input is disabled (ECH value is retained) 1: ECH event clock input is enabled |
| 2 | CUEL | 0 | R/W | Count-Up Enable L Enables event clock input to ECL. 0: ECL event clock input is disabled (ECL value is retained) 1: ECL event clock input is enabled |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 1 | CRCH | 0 | R/W | Counter Reset Control H Controls resetting of ECH. 0: ECH is reset 1: ECH reset is cleared and count-up function is enabled |
| 0 | CRCL | 0 | R/W | Counter Reset Control L Controls resetting of ECL. 0: ECL is reset 1: ECL reset is cleared and count-up function is enabled |

Note: * Only 0 can be written to clear the flag.

(8) Event Counter H (ECH)

ECH is an 8-bit read-only up-counter that operates as an independent 8-bit event counter. ECH also operates as the upper 8-bit up-counter of a 16-bit event counter configured in combination with ECL.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ECH7 | 0 | R | Either the external asynchronous event AEVH pin, $\phi/2$, $\phi/4$, or $\phi/8$, or the overflow signal from lower 8-bit counter ECL can be selected as the input clock source. ECH can be cleared by clearing the CRC bits in ECCSR to 0. |
| 6 | ECH6 | 0 | R | |
| 5 | ECH5 | 0 | R | |
| 4 | ECH4 | 0 | R | |
| 3 | ECH3 | 0 | R | |
| 2 | ECH2 | 0 | R | |
| 1 | ECH1 | 0 | R | |
| 0 | ECH0 | 0 | R | |

(9) Event Counter L (ECL)

ECL is an 8-bit read-only up-counter that operates as an independent 8-bit event counter. ECL also operates as the lower 8-bit up-counter of a 16-bit event counter configured in combination with ECH.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | ECL7 | 0 | R | Either the external asynchronous event AEVL pin, $\phi/2$, $\phi/4$, or $\phi/8$ can be selected as the input clock source. ECL can be cleared by clearing the CRCL bit in ECCSR to 0. |
| 6 | ECL6 | 0 | R | |
| 5 | ECL5 | 0 | R | |
| 4 | ECL4 | 0 | R | |
| 3 | ECL3 | 0 | R | |
| 2 | ECL2 | 0 | R | |
| 1 | ECL1 | 0 | R | |
| 0 | ECL0 | 0 | R | |

9.4.4 Operation

(1) 16-Bit Counter Operation

When bit CH2 is cleared to 0 in ECCSR, ECH and ECL operate as a 16-bit event counter.

Any of four input clock sources— $\phi/2$, $\phi/4$, $\phi/8$, or AEVL pin input—can be selected by means of bits ACKL1 and ACKL0 in ECCR.

When AEVL pin input is selected, input sensing is selected with bits ALEGS1 and ALEGS0.

The input clock is enabled only when IRQAEC is high or IECPWM is high. When IRQAEC is low or IECPWM is low, the input clock is not input to the counter, which therefore does not operate. Figure 9.8 shows an example of the software processing when ECH and ECL are used as a 16-bit event counter.

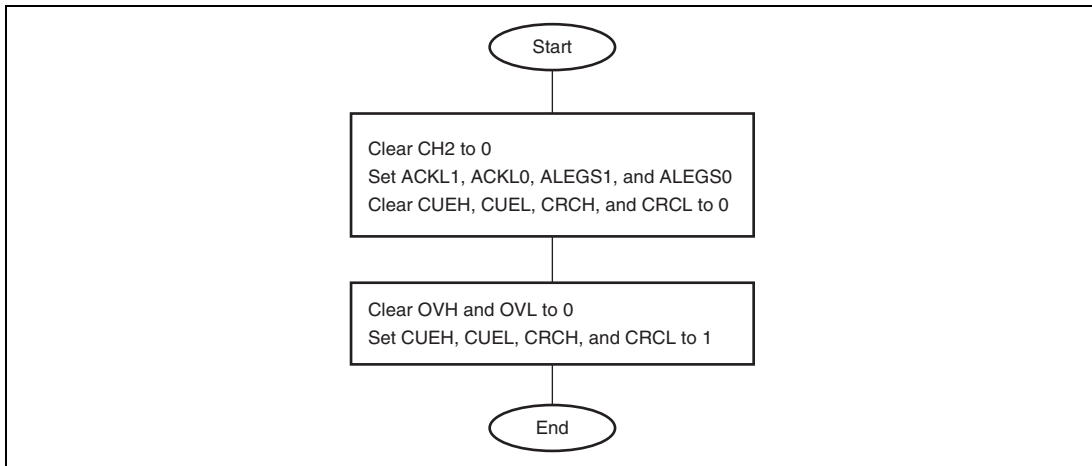


Figure 9.8 Example of Software Processing when Using ECH and ECL as 16-Bit Event Counter

As CH2 is cleared to 0 by a reset, ECH and ECL operate as a 16-bit event counter after a reset, and as ACKL1 and ACKL0 are cleared to B'00, the operating clock is asynchronous event input from the AEVL pin (using falling edge sensing).

When the next clock is input after the count value reaches H'FFF in both ECH and ECL, ECH and ECL overflow from H'FFFF to H'0000, the OVH flag is set to 1 in ECCSR, the ECH and ECL count values each return to H'00, and counting up is restarted. When overflow occurs, the IRREC bit is set to 1 in IRR2. If the IENEC bit in IENR2 is 1 at this time, an interrupt request is sent to the CPU.

(2) 8-Bit Counter Operation

When bit CH2 is set to 1 in ECCSR, ECH and ECL operate as independent 8-bit event counters.

$\phi/2$, $\phi/4$, $\phi/8$, or AEVH pin input can be selected as the input clock source for ECH by means of bits ACKH1 and ACKH0 in ECCR, and $\phi/2$, $\phi/4$, $\phi/8$, or AEVL pin input can be selected as the input clock source for ECL by means of bits ACKL1 and ACKL0 in ECCR.

Input sensing is selected with bits AHEGS1 and AHEGS0 when AEVH pin input is selected, and with bits ALEGS1 and ALEGS0 when AEVL pin input is selected.

The input clock is enabled only when IRQAEC is high or IECPWM is high. When IRQAEC is low or IECPWM is low, the input clock is not input to the counter, which therefore does not operate. Figure 9.9 shows an example of the software processing when ECH and ECL are used as 8-bit event counters.

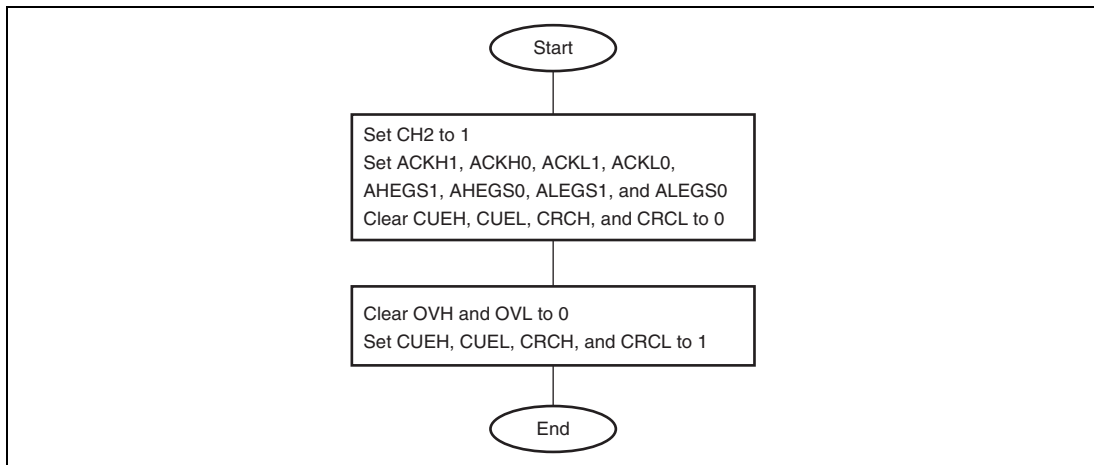


Figure 9.9 Example of Software Processing when Using ECH and ECL as 8-Bit Event Counters

ECH and ECL can be used as 8-bit event counters by carrying out the software processing shown in the example in figure 9.9. When the next clock is input after the ECH count value reaches H'FF, ECH overflows, the OVH flag is set to 1 in ECCSR, the ECH count value returns to H'00, and counting up is restarted. Similarly, when the next clock is input after the ECL count value reaches H'FF, ECL overflows, the OVL flag is set to 1 in ECCSR, the ECL count value returns to H'00, and counting up is restarted. When an overflow occurs, the IRREC bit is set to 1 in IRR2. If the IENEC bit in IENR2 is 1 at this time, an interrupt request is sent to the CPU.

(3) IRQAEC Operation

When ECPWME in AEGSR is 0, the ECH and ECL input clocks are enabled only when IRQAEC is high. When IRQAEC is low, the input clocks are not input to the counters, and so ECH and ECL do not count. ECH and ECL count operations can therefore be controlled from outside by controlling IRQAEC. In this case, ECH and ECL cannot be controlled individually.

IRQAEC can also operate as an interrupt source. In this case the vector number is 6 and the vector addresses are H'000C and H'000D.

Interrupt enabling is controlled by IENEC2 in IENR1. When an IRQAEC interrupt is generated, IRR1 interrupt request flag IRREC2 is set to 1. If IENEC2 in IENR1 is set to 1 at this time, an interrupt request is sent to the CPU.

Rising, falling, or both edge sensing can be selected for the IRQAEC input pin with bits AIAGS1 and AIAGS0 in AEGSR.

(4) Event Counter PWM Operation

When ECPWME in AEGSR is 1, the ECH and ECL input clocks are enabled only when event counter PWM output (IECPWM) is high. When IECPWM is low, the input clocks are not input to the counters, and so ECH and ECL do not count. ECH and ECL count operations can therefore be controlled cyclically from outside by controlling event counter PWM. In this case, ECH and ECL cannot be controlled individually.

IECPWM can also operate as an interrupt source. In this case the vector number is 6 and the vector addresses are H'000C and H'000D.

Interrupt enabling is controlled by IENEC2 in IENR1. When an IECPWM interrupt is generated, IRR1 interrupt request flag IRREC2 is set to 1. If IENEC2 in IENR1 is set to 1 at this time, an interrupt request is sent to the CPU.

Rising, falling, or both edge detection can be selected for IECPWM interrupt sensing with bits AIAGS1 and AIAGS0 in AEGSR.

Figure 9.10 and table 9.6 show examples of event counter PWM operation.

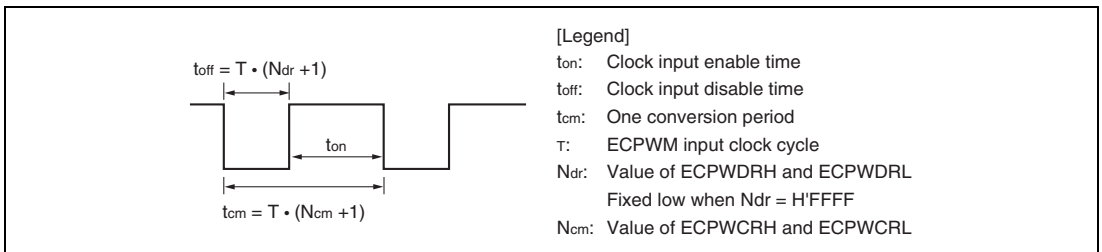


Figure 9.10 Event Counter Operation Waveform

Note: Ndr and Ncm above must be set so that $Ndr < Ncm$. If the settings do not satisfy this condition, do not set ECPWME to 1 in AEGSR.

Table 9.6 Examples of Event Counter PWM Operation

Conditions: $f_{osc} = 4 \text{ MHz}$, $f_{\phi} = 2 \text{ MHz}$, high-speed active mode, ECPWCR value (Ncm) = H'7A11, ECPWDR value (Ndr) = H'16E3

| Clock Source Selection | Clock Source Cycle (T)* | ECPWCR Value (Ncm) | ECPWDR Value (Ndr) | $t_{off} = T \times (Ndr + 1)$ | $t_{cm} = T \times (Ncm + 1)$ | $t_{on} = t_{cm} - t_{off}$ |
|------------------------|-------------------------|--------------------|--------------------|--------------------------------|-------------------------------|-----------------------------|
| $\phi/2$ | 1 μs | H'7A11 | H'16E3 | 5.86 ms | 31.25 ms | 25.39 ms |
| $\phi/4$ | 2 μs | D'31249 | D'5859 | 11.72 ms | 62.5 ms | 50.78 ms |
| $\phi/8$ | 4 μs | | | 23.44 ms | 125.0 ms | 101.56 ms |
| $\phi/16$ | 8 μs | | | 46.88 ms | 250.0 ms | 203.12 ms |
| $\phi/32$ | 16 μs | | | 93.76 ms | 500.0 ms | 406.24 ms |
| $\phi/64$ | 32 μs | | | 187.52 ms | 1000.0 ms | 812.48 ms |

Note: * t_{off} minimum width

(5) Clock Input Enable/Disable Function Operation

The clock input to the event counter can be controlled by the IRQAEC pin when ECPWME in AEGSR is 0, and by the event counter PWM output, IECPWM when ECPWME in AEGSR is 1. As this function forcibly terminates the clock input by each signal, a maximum error of one count will occur depending on the IRQAEC or IECPWM timing.

Figure 9.11 shows an example of the operation of this function.

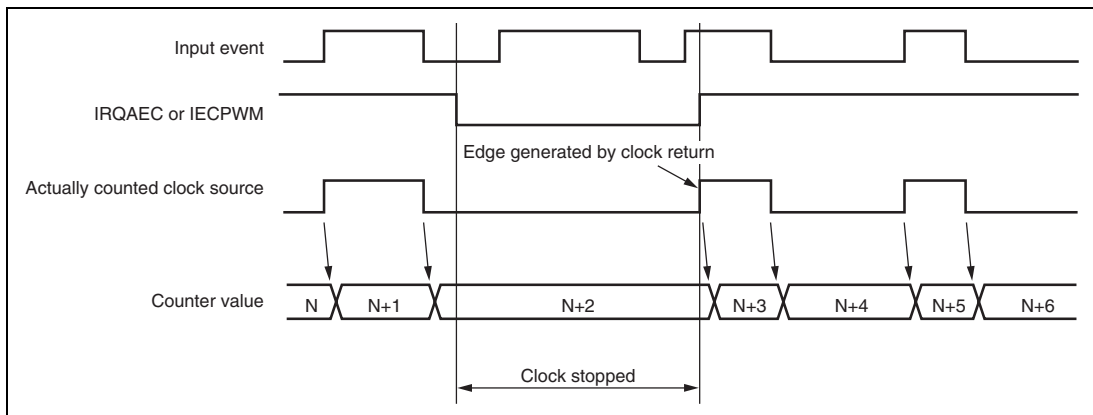


Figure 9.11 Example of Clock Control Operation

9.4.5 Operating States of Asynchronous Event Counter

The operating states of the asynchronous event counter are shown in table 9.7.

Table 9.7 Operating States of Asynchronous Event Counter

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|----------------------|-------|-----------|-----------|---------------------------|-------------------------|-------------------------|---------------------------|------------------------|
| AEGSR | Reset | Functions | Functions | Retained ^{*1} | Functions | Functions | Retained ^{*1} | Retained |
| ECCR | Reset | Functions | Functions | Retained ^{*1} | Functions | Functions | Retained ^{*1} | Retained |
| ECCSR | Reset | Functions | Functions | Retained ^{*1} | Functions | Functions | Retained ^{*1} | Retained |
| ECH | Reset | Functions | Functions | Functions ^{*1*2} | Functions ^{*2} | Functions ^{*2} | Functions ^{*1*2} | Halted |
| ECL | Reset | Functions | Functions | Functions ^{*1*2} | Functions ^{*2} | Functions ^{*2} | Functions ^{*1*2} | Halted |
| IRQAEC | Reset | Functions | Functions | Retained ^{*3} | Functions | Functions | Retained ^{*3} | Retained ^{*4} |
| Event counter PWM | Reset | Functions | Functions | Retained | Retained | Retained | Retained | Retained |

- Notes:
1. When an asynchronous external event is input, the counter increments but the counter overflow H/L flags are not affected.
 2. Functions when asynchronous external events are selected; halted and retained otherwise.
 3. Clock control by IRQAEC operates, but interrupts do not.
 4. As the clock is stopped in module standby mode, IRQAEC has no effect.

9.4.6 Usage Notes

1. When reading the values in ECH and ECL, first clear bits CUEH and CUEL to 0 in ECCSR in 8-bit mode and clear bit CUEL to 0 in 16-bit mode to prevent asynchronous event input to the counter. The correct value will not be returned if the event counter increments while being read.
2. The maximum clock frequency that may be input to the AEVH and AEVL pins is either 4MHz with voltage range of 1.8 V to 3.6 V, or 10 MHz with voltage range of 7 V to 3.6 V. For information on the clock high width and low width, see section 14, Electrical Characteristics. The duty ratio does not matter as long as the high width and low width satisfy the minimum requirement.

| Mode | | Maximum Clock Frequency Input to AEVH/AEVL Pin |
|---|--------------|---|
| Active (high-speed), sleep (high-speed) | | 10 MHz |
| Active (medium-speed), sleep (medium-speed) | $(\phi/16)$ | $2 \cdot f_{osc}$ |
| | $(\phi/32)$ | f_{osc} |
| | $(\phi/64)$ | $1/2 \cdot f_{osc}$ |
| | $(\phi/128)$ | $1/4 \cdot f_{osc}$ |
| $f_{osc} = 1 \text{ MHz to } 4 \text{ MHz}$ | | |
| Watch, subactive, subsleep, standby | $(\phi_w/2)$ | 1000 kHz |
| | $(\phi_w/4)$ | 500 kHz |
| | $(\phi_w/8)$ | 250 kHz |
| $\phi_w = 32.768 \text{ kHz or } 38.4 \text{ kHz}^{*2}$ | | |

3. When AEC uses with 16-bit mode, set CUEH in ECCSR to 1 first, set CRCH in ECCSR to 1 second, or set both CUEH and CRCH to 1 at same time before clock input. While AEC is operating on 16-bit mode, do not change CUEH. Otherwise, ECH will be miscounted up.
4. When ECPWME in AEGSR is 1, the event counter PWM is operating and therefore ECPWCRH, ECPWCRL, ECPWDRH, and ECPWDRL should not be modified.
When changing the data, the event counter PWM must be halted by clearing ECPWME to 0 in AEGSR before modifying these registers.
5. The event counter PWM data register and event counter PWM compare register must be set so that event counter PWM data register < event counter PWM compare register. If the settings do not satisfy this condition, do not set ECPWME to 1 in AEGSR.
6. As synchronization is established internally when an IRQAEC interrupt is generated, a maximum error of 1 tcyc will occur between clock halting and interrupt acceptance.

9.5 Watchdog Timer

The watchdog timer is an 8-bit timer that can generate an internal reset signal for this LSI if a system crash prevents the CPU from writing to the timer counter, thus allowing it to overflow.

Figure 9.12 shows a block diagram of the watchdog timer.

9.5.1 Features

- Selectable from two counter input clocks
Two clock sources ($\phi/8192$ or $\phi_w/32$) can be selected as the timer-counter clock.
- Reset signal generated on counter overflow
An overflow period of 1 to 256 times the selected clock can be set.
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

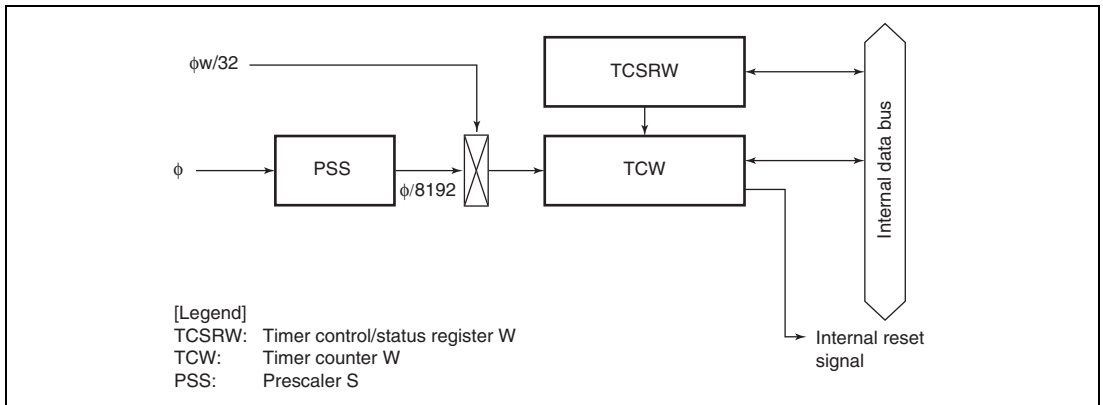


Figure 9.12 Block Diagram of Watchdog Timer

9.5.2 Register Descriptions

The watchdog timer has the following registers.

- Timer control/status register W (TCSRW)
- Timer counter W (TCW)

(1) Timer Control/Status Register W (TCSRW)

TCSRW performs the TCSRW and TCW write control. TCSRW also controls the watchdog timer operation and indicates the operating state. TCSRW must be rewritten by using the MOV instruction. The bit manipulation instruction cannot be used to change the setting value.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 7 | B6WI | 1 | R | Bit 6 Write Inhibit The TCWE bit can be written only when the write value of the B6WI bit is 0. This bit is always read as 1. |
| 6 | TCWE | 0 | R/(W)* | Timer Counter W Write Enable TCW can be written when the TCWE bit is set to 1. When writing data to this bit, the value for bit 7 must be 0. |
| 5 | B4WI | 1 | R | Bit 4 Write Inhibit The TCSRWE bit can be written only when the write value of the B4WI bit is 0. This bit is always read as 1. |
| 4 | TCSRWE | 0 | R/(W)* | Timer Control/Status Register W Write Enable The WDON and WRST bits can be written when the TCSRWE bit is set to 1. When writing data to this bit, the value for bit 5 must be 0. |
| 3 | B2WI | 1 | R | Bit 2 Write Inhibit This bit can be written to the WDON bit only when the write value of the B2WI bit is 0. This bit is always read as 1. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 2 | WDON | 0 | R/(W)* | <p>Watchdog Timer On</p> <p>TCW starts counting up when WDON is set to 1 and halts when WDON is cleared to 0.</p> <p>[Setting condition]</p> <p>When 1 is written to the WDON bit while writing 0 to the B2WI bit when the TCSRWE bit=1</p> <p>[Clearing condition]</p> <ul style="list-style-type: none"> Reset by $\overline{\text{RES}}$ pin When 0 is written to the WDON bit while writing 0 to the B2WI when the TCSRWE bit=1 |
| 1 | BOWI | 1 | R | <p>Bit 0 Write Inhibit</p> <p>This bit can be written to the WRST bit only when the write value of the BOWI bit is 0. This bit is always read as 1.</p> |
| 0 | WRST | 0 | R/(W)* | <p>Watchdog Timer Reset</p> <p>[Setting condition]</p> <p>When TCW overflows and an internal reset signal is generated</p> <p>[Clearing condition]</p> <ul style="list-style-type: none"> Reset by $\overline{\text{RES}}$ pin When 0 is written to the WRST bit while writing 0 to the BOWI bit when the TCSRWE bit = 1 |

Note: * These bits can be written only when the writing conditions are satisfied.

(2) Timer Counter W (TCW)

TCW is an 8-bit readable/writable up-counter. When TCW overflows from H'FF to H'00, the internal reset signal is generated and the WRST bit in TCSRW is set to 1. TCW is initialized to H'00.

9.5.3 Operation

The watchdog timer is provided with an 8-bit counter. The input clock is selected by the WDCKS bit in the port mode register 2 (PMR2)*: $\phi/8192$ is selected when the WDCKS bit is cleared to 0, and $\phi w/32$ when set to 1. If 1 is written to WDON while writing 0 to B2WI when the TCSRWE bit in TCSRW is set to 1, TCW begins counting up (to operate the watchdog timer, two write accesses to TCSRW are required). When a clock pulse is input after the TCW count value has reached H'FF, the watchdog timer overflows and an internal reset signal is generated. The internal reset signal is output for a period of $512 \phi_{osc}$ clock cycles. TCW is a writable counter, and when a value is set in TCW, the count-up starts from that value. An overflow period in the range of 1 to 256 input clock cycles can therefore be set, according to the TCW set value.

Note: * For details, refer to section 8.1.5, Port Mode Register 2 (PMR2).

Figure 9.13 shows an example of watchdog timer operation.

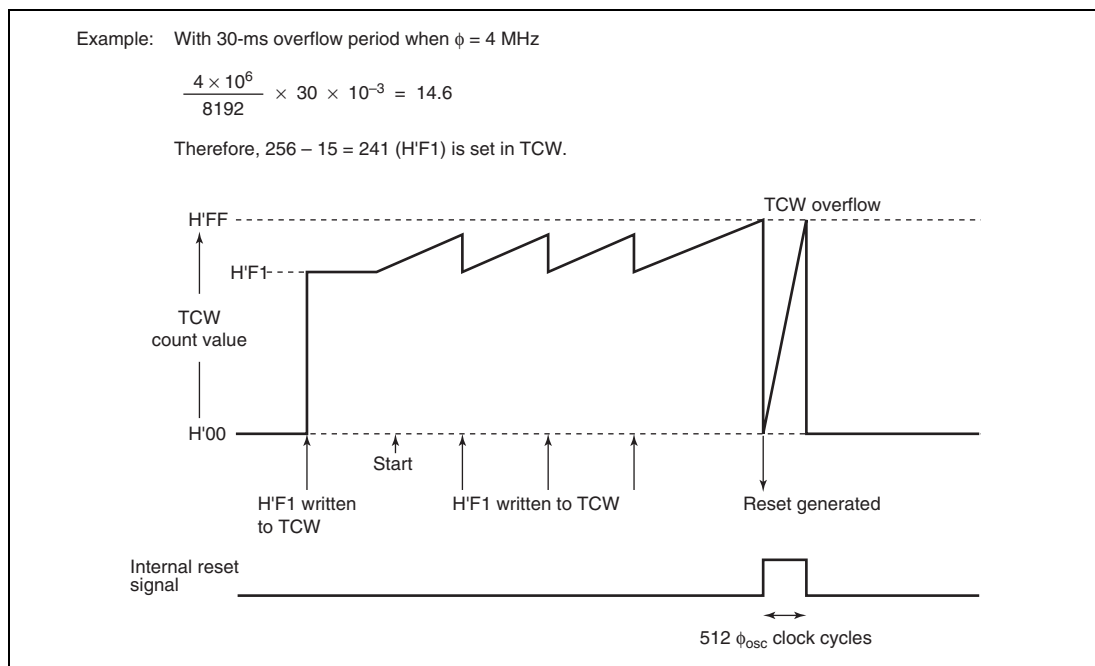


Figure 9.13 Example of Watchdog Timer Operation

9.5.4 Operating States of Watchdog Timer

Tables 9.8 summarizes the operating states of the watchdog timer.

Table 9.8 Operating States of Watchdog Timer

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|-----------------------|--------------|---------------|--------------|--------------|-----------------------|------------------|----------------|-----------------------|
| TCW | Reset | Functions | Functions | Halted | Functions/ Halted* | Halted | Halted | Halted |
| TCSRW | Reset | Functions | Functions | Retained | Functions/ Halted* | Retained | Retained | Retained |

Note: * Functions when $\phi_w/32$ is selected as the input clock.

Section 10 Serial Communication Interface 3 (SCI3)

Serial Communication Interface 3 (SCI3) can handle both asynchronous and clock synchronous serial communication. In the asynchronous method, serial data communication can be carried out using standard asynchronous communication chips such as a Universal Asynchronous Receiver/Transmitter (UART) or an Asynchronous Communication Interface Adapter (ACIA).

Figure 10.1 shows a block diagram of the SCI3.

10.1 Features

- Choice of asynchronous or clock synchronous serial communication mode
- Full-duplex communication capability

The transmitter and receiver are mutually independent, enabling transmission and reception to be executed simultaneously.

Double-buffering is used in both the transmitter and the receiver, enabling continuous transmission and continuous reception of serial data.

- On-chip baud rate generator allows any bit rate to be selected
- On-chip baud rate generator, internal clock, or external clock can be selected as a transfer clock source.
- Six interrupt sources
Transmit-end, transmit-data-empty, receive-data-full, overrun error, framing error, and parity error.
- Use of module standby mode enables this module to be placed in standby mode independently when it is not in use (for details, see section 5.4, Module Standby Function).

Asynchronous mode

- Data length: 7, 8, or 5 bits
- Stop bit length: 1 or 2 bits
- Parity: Even, odd, or none
- Receive error detection: Parity, overrun, and framing errors
- Break detection: Break can be detected by reading the RXD32 pin level directly in the case of a framing error

Clocked synchronous mode

- Data length: 8 bits
- Receive error detection: Overrun errors detected

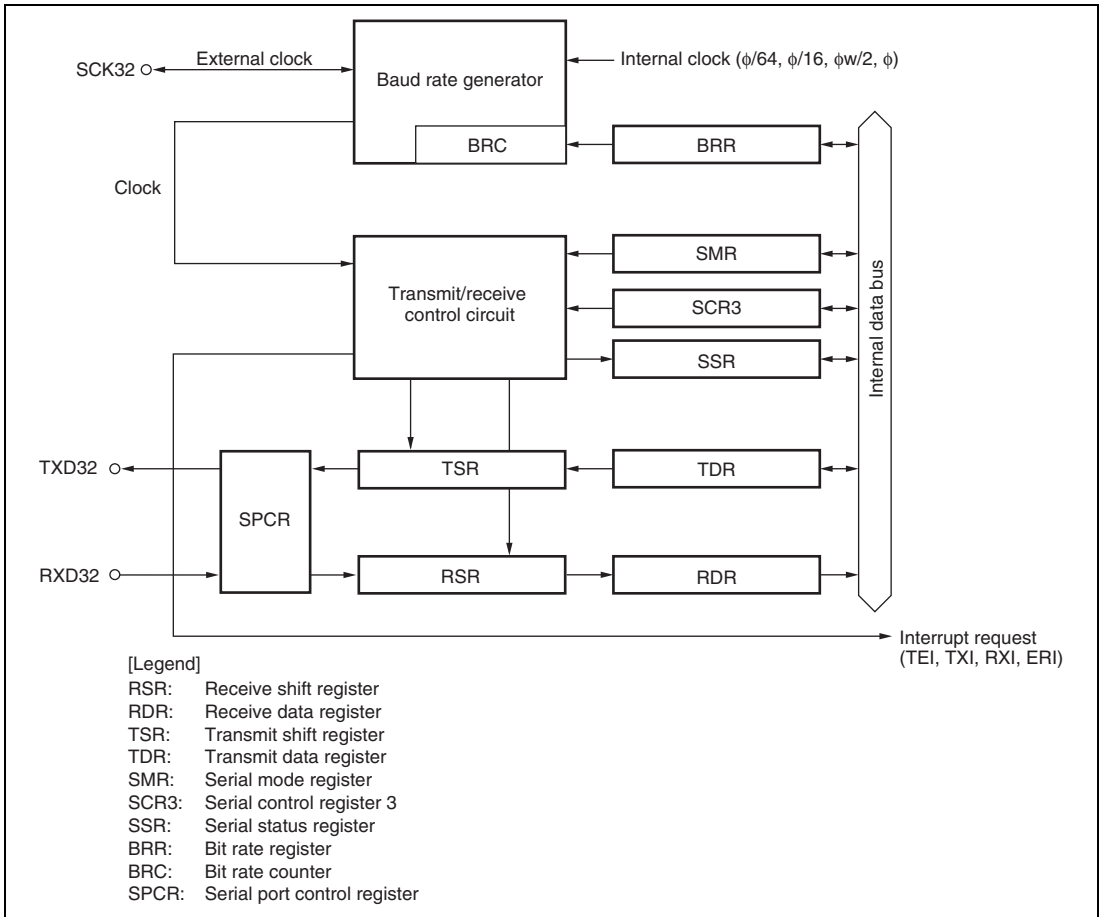


Figure 10.1 Block Diagram of SCI3

10.2 Input/Output Pins

Table 10.1 shows the SCI3 pin configuration.

Table 10.1 Pin Configuration

| Pin Name | Abbreviation | I/O | Function |
|---------------------------|--------------|--------|---------------------------|
| SCI3 clock | SCK32 | I/O | SCI3 clock input/output |
| SCI3 receive data input | RXD32 | Input | SCI3 receive data input |
| SCI3 transmit data output | TXD32 | Output | SCI3 transmit data output |

10.3 Register Descriptions

The SCI3 has the following registers.

- Receive shift register (RSR)
- Receive data register (RDR)
- Transmit shift register (TSR)
- Transmit data register (TDR)
- Serial mode register (SMR)
- Serial control register 3 (SCR3)
- Serial status register (SSR)
- Bit rate register (BRR)
- Serial port control register (SPCR)

10.3.1 Receive Shift Register (RSR)

RSR is a shift register that is used to receive serial data input from the RXD32 pin and convert it into parallel data. When one byte of data has been received, it is transferred to RDR automatically. RSR cannot be directly accessed by the CPU.

10.3.2 Receive Data Register (RDR)

RDR is an 8-bit register that stores received data. When the SCI3 has received one byte of serial data, it transfers the received serial data from RSR to RDR, where it is stored. After this, RSR is receive-enabled. As RSR and RDR function as a double buffer in this way, continuous receive operations are possible. After confirming that the RDRF bit in SSR is set to 1, read RDR only once. RDR cannot be written to by the CPU. RDR is initialized to H'00 at a reset and in standby, watch, or module standby mode.

10.3.3 Transmit Shift Register (TSR)

TSR is a shift register that transmits serial data. To perform serial data transmission, the SCI3 first transfers transmit data from TDR to TSR automatically, then sends the data that starts from the LSB to the TXD32 pin. Data transfer from TDR to TSR is not performed if no data has been written to TDR (if the TDRE bit in SSR is set to 1). TSR cannot be directly accessed by the CPU.

10.3.4 Transmit Data Register (TDR)

TDR is an 8-bit register that stores data for transmission. When the SCI3 detects that TSR is empty, it transfers the transmit data written in TDR to TSR and starts transmission. The double-buffered structure of TDR and TSR enables continuous serial transmission. If the next transmit data has already been written to TDR during transmission of one-frame data, the SCI3 transfers the written data to TSR to continue transmission. To achieve reliable serial transmission, write transmit data to TDR only once after confirming that the TDRE bit in SSR is set to 1. TDR is initialized to H'FF at a reset and in standby, watch, or module standby mode.

10.3.5 Serial Mode Register (SMR)

SMR is used to set the SCI3's serial transfer format and select the on-chip baud rate generator clock source. SMR is initialized to H'00 at a reset and in standby, watch, or module standby mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | COM | 0 | R/W | Communication Mode 0: Asynchronous mode 1: Clocked synchronous mode |
| 6 | CHR | 0 | R/W | Character Length (enabled only in asynchronous mode) 0: Selects 8 or 5 bits as the data length. 1: Selects 7 or 5 bits as the data length. When 7-bit data is selected, the MSB (bit 7) in TDR is not transmitted. To select 5 bits as the data length, set 1 to both the PE and MP bits. The three most significant bits (bits 7, 6, and 5) in TDR are not transmitted. In clock synchronous mode, the data length is fixed to 8 bits regardless of the CHR bit setting. |
| 5 | PE | 0 | R/W | Parity Enable (enabled only in asynchronous mode) When this bit is set to 1, the parity bit is added to transmit data before transmission, and the parity bit is checked in reception. In clock synchronous mode, parity bit addition and checking is not performed regardless of the PE bit setting. |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 4 | PM | 0 | R/W | <p>Parity Mode (enabled only when the PE bit is 1 in asynchronous mode)</p> <p>0: Selects even parity. 1: Selects odd parity.</p> <p>When even parity is selected, a parity bit is added in transmission so that the total number of 1 bits in the transmit data plus the parity bit is an even number; in reception, a check is carried out to confirm that the number of 1 bits in the receive data plus the parity bit is an even number.</p> <p>When odd parity is selected, a parity bit is added in transmission so that the total number of 1 bits in the transmit data plus the parity bit is an odd number; in reception, a check is carried out to confirm that the number of 1 bits in the receive data plus the parity bit is an odd number.</p> <p>If parity bit addition and checking is disabled in clock synchronous mode and asynchronous mode, the PM bit setting is invalid.</p> |
| 3 | STOP | 0 | R/W | <p>Stop Bit Length (enabled only in asynchronous mode)</p> <p>Selects the stop bit length in transmission.</p> <p>0: 1 stop bit 1: 2 stop bits</p> <p>For reception, only the first stop bit is checked, regardless of the value in the bit. If the second stop bit is 0, it is treated as the start bit of the next transmit character.</p> |
| 2 | MP | 0 | R/W | <p>Five-Bit Communications</p> <p>When this bit is set to 1, the five-bit communications format is available. When writing 1 to this bit, be sure to write 1 to the PE bit (bit 5 of this register) simultaneously.</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 1 | CKS1 | 0 | R/W | Clock Select 0 and 1 |
| 0 | CKS0 | 0 | R/W | <p>These bits select the clock source for the on-chip baud rate generator.</p> <p>00: ϕ clock (n = 0)</p> <p>01: $\phi w/2$ or ϕw clock (n = 1)</p> <p>10: $\phi/16$ clock (n = 2)</p> <p>11: $\phi/64$ clock (n = 3)</p> <p>When the setting value is 01 in active mode and sleep mode, $\phi w/2$ clock is set. In subactive mode and subsleep mode, ϕw clock is set. The SCI3 is enabled only when $\phi w/2$ is selected for the CPU operating clock.</p> <p>For the relationship between the bit rate register setting and the baud rate, see section 10.3.8, Bit Rate Register (BRR). n is the decimal representation of the value of n in BRR (see section 10.3.8, Bit Rate Register (BRR)).</p> |

10.3.6 Serial Control Register 3 (SCR3)

SCR3 is a register that enables or disables SCI3 transfer operations and interrupt requests, and is also used to select the transfer clock source. SCR3 is initialized to H'00 at a reset and in standby, watch, or module standby mode. For details on interrupt requests, refer to section 10.6, Interrupts.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | TIE | 0 | R/W | <p>Transmit Interrupt Enable</p> <p>When this bit is set to 1, the TXI interrupt request is enabled. TXI can be released by clearing the TDRE bit or TIE bit to 0.</p> |
| 6 | RIE | 0 | R/W | <p>Receive Interrupt Enable</p> <p>When this bit is set to 1, RXI and ERI interrupt requests are enabled. RXI and ERI can be released by clearing bit RDRF or the FER, PER, or OER error flag to 0, or by clearing bit RIE to 0.</p> |
| 5 | TE | 0 | R/W | <p>Transmit Enable</p> <p>When this bit is set to 1, transmission is enabled. When this bit is 0, the TDRE bit in SSR is fixed at 1. When transmit data is written to TDR while this bit is 1, bit TDRE in SSR is cleared to 0 and serial data transmission is started.</p> <p>Be sure to carry out SMR settings, and setting of bit SPC32 in SPCR, to decide the transmission format before setting bit TE to 1.</p> |
| 4 | RE | 0 | R/W | <p>Receive Enable</p> <p>When this bit is set to 1, reception is enabled. In this state, serial data reception is started when a start bit is detected in asynchronous mode or serial clock input is detected in clock synchronous mode.</p> <p>Be sure to carry out the SMR settings to decide the reception format before setting bit RE to 1.</p> <p>Note that the RDRF, FER, PER, and OER flags in SSR are not affected when bit RE is cleared to 0, and retain their previous state.</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 3 | — | 0 | R/W | Reserved Only 0 should be written to this bit. |
| 2 | TEIE | 0 | R/W | Transmit End Interrupt Enable When this bit is set to 1, the TEI interrupt request is enabled. TEI can be released by clearing bit TDRE to 0 and clearing bit TEND to 0 in SSR, or by clearing bit TEIE to 0. |
| 1 | CKE1 | 0 | R/W | Clock Enable 0 and 1 |
| 0 | CKE0 | 0 | R/W | Selects the clock source. Asynchronous mode: 00: Internal baud rate generator 01: Internal baud rate generator Outputs a clock of the same frequency as the bit rate from the SCK32 pin. 10: External clock Inputs a clock with a frequency 16 times the bit rate from the SCK32 pin. 11: Reserved Clock synchronous mode: 00: Internal clock (SCK32 pin functions as clock output) 01: Reserved 10: External clock (SCK32 pin functions as clock input) 11: Reserved |

10.3.7 Serial Status Register (SSR)

SSR is a register containing status flags of the SCI3 and multiprocessor bits for transfer. 1 cannot be written to flags TDRE, RDRF, OER, PER, and FER; they can only be cleared. SSR is initialized to H'84 at a reset and in standby, watch, or module standby mode.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 7 | TDRE | 1 | R/(W)* | <p>Transmit Data Register Empty</p> <p>Indicates that transmit data is stored in TDR.</p> <p>[Setting conditions]</p> <ul style="list-style-type: none"> • When the TE bit in SCR3 is 0 • When data is transferred from TDR to TSR <p>[Clearing conditions]</p> <ul style="list-style-type: none"> • When 0 is written to TDRE after reading TDRE = 1 • When the transmit data is written to TDR |
| 6 | RDRF | 0 | R/(W)* | <p>Receive Data Register Full</p> <p>Indicates that the received data is stored in RDR.</p> <p>[Setting condition]</p> <ul style="list-style-type: none"> • When serial reception ends normally and receive data is transferred from RSR to RDR <p>[Clearing conditions]</p> <ul style="list-style-type: none"> • When 0 is written to RDRF after reading RDRF = 1 • When data is read from RDR <p>If an error is detected in reception, or if the RE bit in SCR3 has been cleared to 0, RDR and bit RDRF are not affected and retain their previous state.</p> <p>Note that if data reception is completed while bit RDRF is still set to 1, an overrun error (OER) will occur and the receive data will be lost.</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|--|
| 5 | OER | 0 | R/(W)* | <p>Overrun Error</p> <p>[Setting condition]</p> <ul style="list-style-type: none"> When an overrun error occurs in reception <p>[Clearing condition]</p> <ul style="list-style-type: none"> When 0 is written to OER after reading OER = 1 <p>When bit RE in SCR3 is cleared to 0, bit OER is not affected and retains its previous state.</p> <p>When an overrun error occurs, RDR retains the receive data it held before the overrun error occurred, and data received after the error is lost. Reception cannot be continued with bit OER set to 1, and in clock synchronous mode, transmission cannot be continued either.</p> |
| 4 | FER | 0 | R/(W)* | <p>Framing Error</p> <p>[Setting condition]</p> <ul style="list-style-type: none"> When a framing error occurs in reception <p>[Clearing condition]</p> <ul style="list-style-type: none"> When 0 is written to FER after reading FER = 1 <p>When bit RE in SCR3 is cleared to 0, bit FER is not affected and retains its previous state.</p> <p>Note that, in 2-stop-bit mode, only the first stop bit is checked for a value of 1, and the second stop bit is not checked. When a framing error occurs, the receive data is transferred to RDR but bit RDRF is not set. Reception cannot be continued with bit FER set to 1. In clock synchronous mode, neither transmission nor reception is possible when bit FER is set to 1.</p> |

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|--------|---|
| 3 | PER | 0 | R/(W)* | <p>Parity Error</p> <p>[Setting condition]</p> <ul style="list-style-type: none"> When a parity error is generated during reception <p>[Clearing condition]</p> <ul style="list-style-type: none"> When 0 is written to PER after reading PER = 1 <p>When bit RE in SCR3 is cleared to 0, bit PER is not affected and retains its previous state.</p> <p>Receive data in which a parity error has occurred is still transferred to RDR, but bit RDRF is not set. Reception cannot be continued with bit PER set to 1. In clock synchronous mode, neither transmission nor reception is possible when bit PER is set to 1.</p> |
| 2 | TEND | 1 | R | <p>Transmit End</p> <p>[Setting conditions]</p> <ul style="list-style-type: none"> When the TE bit in SCR3 is 0 When TDRE = 1 at transmission of the last bit of a 1-byte serial transmit character <p>[Clearing conditions]</p> <ul style="list-style-type: none"> When 0 is written to TDRE after reading TDRE = 1 When the transmit data is written to TDR |
| 1 | — | 0 | R | <p>Reserved</p> <p>This is a read-only bit and cannot be modified.</p> |
| 0 | — | 0 | R/W | <p>Reserved</p> <p>The write value should always be 0.</p> |

Note: * Only 0 can be written for clearing a flag.

10.3.8 Bit Rate Register (BRR)

BRR is an 8-bit readable/writable register that adjusts the bit rate. BRR is initialized to H'FF at a reset and in standby, watch, or module standby mode. Table 10.2 shows the relationship between the N setting in BRR and the n setting in bits CKS1 and CKS0 of SMR in asynchronous mode. Table 10.4 shows the maximum bit rate for each frequency in asynchronous mode. The values shown in both tables 10.2 and 10.4 are values in active (high-speed) mode. Table 10.5 shows the relationship between the N setting in BRR and the n setting in bits CKS1 and CKS0 in SMR in clock synchronous mode. The values are shown in table 10.5. The N setting in BRR and error for other operating frequencies and bit rates can be obtained by the following formulas:

[Asynchronous Mode]

$$N = \frac{\phi}{32 \times 2^{2n} \times B} - 1$$

$$\text{Error (\%)} = \frac{B \text{ (bit rate obtained from } n, N, \phi) - R \text{ (bit rate in left-hand column in table 10.2)}}{R \text{ (bit rate in left-hand column in table 10.2)}} \times 100$$

- Legend:
- B: Bit rate (bit/s)
 - N: BRR setting for baud rate generator ($0 \leq N \leq 255$)
 - ϕ : Operating frequency (Hz)
 - n: Baud rate generator input clock number ($n = 0, 2, \text{ or } 3$)
(The relation between n and the clock is shown in table 10.3.)

Table 10.2 Examples of BRR Settings for Various Bit Rates (Asynchronous Mode) (1)

| Bit Rate (bit/s) | ϕ | | | | | | | | | | | |
|---------------------|----------|---|-----------|-----------|---|-----------|-------|-----|-----------|------------|-----|-----------|
| | 16.4 kHz | | | 19.45 kHz | | | 1 MHz | | | 1.2288 MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | — | — | — | — | — | — | 2 | 17 | -1.36 | 2 | 21 | -0.83 |
| 150 | — | — | — | 0 | 3 | 0 | 2 | 12 | 0.16 | 3 | 3 | 0 |
| 200 | — | — | — | 0 | 2 | 0 | 2 | 9 | -2.34 | 3 | 2 | 0 |
| 250 | 0 | 1 | 2.5 | — | — | — | 3 | 1 | -2.34 | 0 | 153 | -0.26 |
| 300 | — | — | — | 0 | 1 | 0 | 0 | 103 | 0.16 | 3 | 1 | 0 |
| 600 | — | — | — | 0 | 0 | 0 | 0 | 51 | 0.16 | 3 | 0 | 0 |
| 1200 | | | | — | — | — | 0 | 25 | 0.16 | 2 | 1 | 0 |
| 2400 | | | | | | | 0 | 12 | 0.16 | 2 | 0 | 0 |
| 4800 | | | | | | | — | — | — | 0 | 7 | 0 |
| 9600 | | | | | | | — | — | — | 0 | 3 | 0 |
| 19200 | | | | | | | — | — | — | 0 | 1 | 0 |
| 31250 | | | | | | | 0 | 0 | 0 | — | — | — |
| 38400 | | | | | | | — | — | — | 0 | 0 | 0 |

Table 10.2 Examples of BRR Settings for Various Bit Rates (Asynchronous Mode) (2)

| Bit Rate (bit/s) | ϕ | | | | | | | | | | | |
|---------------------|--------|-----|-----------|-------|----|-----------|-------|-----|-----------|--------|----|-----------|
| | 2 MHz | | | 5 MHz | | | 8 MHz | | | 10 MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 110 | 3 | 8 | -1.36 | 3 | 21 | 0.88 | 3 | 35 | -1.36 | 3 | 43 | 0.88 |
| 150 | 2 | 25 | 0.16 | 3 | 15 | 1.73 | 3 | 25 | 0.16 | 3 | 32 | -1.36 |
| 200 | 3 | 4 | -2.34 | 3 | 11 | 1.73 | 3 | 19 | -2.34 | 3 | 23 | 1.73 |
| 250 | 2 | 15 | -2.34 | 3 | 9 | -2.34 | 3 | 15 | -2.34 | 3 | 19 | -2.34 |
| 300 | 2 | 12 | 0.16 | 3 | 7 | 1.73 | 3 | 12 | 0.16 | 3 | 15 | 1.73 |
| 600 | 0 | 103 | 0.16 | 3 | 3 | 1.73 | 2 | 25 | 0.16 | 3 | 7 | 1.73 |
| 1200 | 0 | 51 | 0.16 | 3 | 1 | 1.73 | 2 | 12 | 0.16 | 3 | 3 | 1.73 |
| 2400 | 0 | 25 | 0.16 | 3 | 0 | 1.73 | 0 | 103 | 0.16 | 3 | 1 | 1.73 |
| 4800 | 0 | 12 | 0.16 | 2 | 1 | 1.73 | 0 | 51 | 0.16 | 3 | 0 | 1.73 |
| 9600 | — | — | — | 2 | 0 | 1.73 | 0 | 25 | 0.16 | 2 | 1 | 1.73 |
| 19200 | — | — | — | 0 | 7 | 1.73 | 0 | 12 | 0.16 | 2 | 0 | 1.73 |
| 31250 | 0 | 1 | 0 | 0 | 4 | 0 | 0 | 7 | 0 | 0 | 9 | 0 |
| 38400 | — | — | — | 0 | 3 | 1.73 | — | — | — | 0 | 7 | 1.73 |

[Legend]

No indication: Setting not possible.

—: A setting is available but error occurs

Table 10.3 Relation between n and Clock

| n | Clock | SMR Setting | |
|---|-----------------------------|-------------|------|
| | | CKS1 | CKS0 |
| 0 | ϕ | 0 | 0 |
| 0 | $\phi_w/2^{*1}/\phi_w^{*2}$ | 0 | 1 |
| 2 | $\phi/16$ | 1 | 0 |
| 3 | $\phi/64$ | 1 | 1 |

Notes: 1. $\phi_w/2$ clock in active (medium-speed/high-speed) mode and sleep (medium-speed/high-speed) mode2. ϕ_w clock in subactive mode and subsleep modeIn subactive or subsleep mode, the SCI3 can be operated when CPU clock is $\phi_w/2$ only.

Table 10.4 Maximum Bit Rate for Each Frequency (Asynchronous Mode)

| OSC (MHz) | ϕ (MHz) | Maximum Bit Rate (bit/s) | Setting | |
|-----------|--------------|--------------------------|---------|---|
| | | | n | N |
| 0.0384* | 0.0192 | 600 | 0 | 0 |
| 2 | 1 | 31250 | 0 | 0 |
| 2.4576 | 1.2288 | 38400 | 0 | 0 |
| 4 | 2 | 62500 | 0 | 0 |
| 10 | 5 | 156250 | 0 | 0 |
| 16 | 8 | 250000 | 0 | 0 |
| 20 | 10 | 312500 | 0 | 0 |

Note: * When CKS1 = 0 and CKS0 = 1 in SMR

Table 10.5 BRR Settings for Various Bit Rates (Clocked Synchronous Mode) (1)

| Bit Rate (bit/s) | ϕ | | | | | | | | |
|---------------------|----------|----|-----------|-------|-----|-----------|-------|-----|-----------|
| | 19.2 kHz | | | 1 MHz | | | 2 MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 200 | 0 | 23 | 0 | — | — | — | — | — | — |
| 250 | — | — | — | — | — | — | 2 | 124 | 0 |
| 300 | 2 | 0 | 0 | — | — | — | — | — | — |
| 500 | — | — | — | — | — | — | — | — | — |
| 1k | — | — | — | 0 | 249 | 0 | — | — | — |
| 2.5k | — | — | — | 0 | 99 | 0 | 0 | 199 | 0 |
| 5k | — | — | — | 0 | 49 | 0 | 0 | 99 | 0 |
| 10k | — | — | — | 0 | 24 | 0 | 0 | 49 | 0 |
| 25k | — | — | — | 0 | 9 | 0 | 0 | 19 | 0 |
| 50k | — | — | — | 0 | 4 | 0 | 0 | 9 | 0 |
| 100k | — | — | — | — | — | — | 0 | 4 | 0 |
| 250k | — | — | — | 0 | 0 | 0 | 0 | 1 | 0 |
| 500k | — | — | — | — | — | — | 0 | 0 | 0 |
| 1M | — | — | — | — | — | — | — | — | — |

Table 10.5 BRR Settings for Various Bit Rates (Clocked Synchronous Mode) (2)

| Bit Rate (bit/s) | ϕ | | | | | | | | |
|---------------------|--------|-----|-----------|-------|-----|-----------|--------|-------|-----------|
| | 5 MHz | | | 8 MHz | | | 10 MHz | | |
| | n | N | Error (%) | n | N | Error (%) | n | N | Error (%) |
| 200 | — | — | — | — | — | — | 0 | 12499 | 0 |
| 250 | — | — | — | 3 | 124 | 0 | 2 | 624 | 0 |
| 300 | — | — | — | — | — | — | 0 | 8332 | 0 |
| 500 | — | — | — | 2 | 249 | 0 | 0 | 4999 | 0 |
| 1k | — | — | — | 2 | 124 | 0 | 0 | 2499 | 0 |
| 2.5k | — | — | — | 2 | 49 | 0 | 0 | 999 | 0 |
| 5k | 0 | 249 | 0 | 2 | 24 | 0 | 0 | 499 | 0 |
| 10k | 0 | 124 | 0 | 0 | 199 | 0 | 0 | 249 | 0 |
| 25k | 0 | 49 | 0 | 0 | 79 | 0 | 0 | 99 | 0 |
| 50k | 0 | 24 | 0 | 0 | 39 | 0 | 0 | 49 | 0 |
| 100k | — | — | — | 0 | 19 | 0 | 0 | 24 | 0 |
| 250k | 0 | 4 | 0 | 0 | 7 | 0 | 0 | 9 | 0 |
| 500k | — | — | — | 0 | 3 | 0 | 0 | 4 | 0 |
| 1M | — | — | — | 0 | 1 | 0 | — | — | — |

[Legend]

Blankx: No setting is available.

—: A setting is available but error occurs.

Note: The value set in BRR is given by the following formula:

$$N = \frac{\phi}{8 \times 2^{2n} \times B} - 1$$

B: Bit rate (bit/s)

N: BRR setting for baud rate generator ($0 \leq N \leq 255$) ϕ : Operating frequency (Hz)n: Baud rate generator input clock number ($n = 0, 2, \text{ or } 3$)

(The relation between n and the clock is shown in table 10.6.)

Table 10.6 Relation between n and Clock

| n | Clock | SMR Setting | |
|---|-----------------------------|-------------|------|
| | | CKS1 | CKS0 |
| 0 | ϕ | 0 | 0 |
| 0 | $\phi_w/2^{*1}/\phi_w^{*2}$ | 0 | 1 |
| 2 | $\phi/16$ | 1 | 0 |
| 3 | $\phi/64$ | 1 | 1 |

- Notes: 1. $\phi_w/2$ clock in active (medium-speed/high-speed) mode and sleep (medium-speed/high-speed) mode
2. ϕ_w clock in subactive mode and subsleep mode
 In subactive or subsleep mode, the SCI3 can be operated when CPU clock is $\phi_w/2$ only.

10.3.9 Serial Port Control Register (SPCR)

SPCR selects whether input/output data of the RXD32 and TXD32 pins is inverted or not.

| Bit | Bit Name | Initial Value | R/W | Description |
|------|----------|---------------|-----|---|
| 7, 6 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |
| 5 | SPC32 | 0 | R/W | P42/TXD32 Pin Function Switch This bit selects whether pin P42/TXD32 is used as P42 or as TXD32. 0: P42 I/O pin 1: TXD32 output pin* Note: * Set the TE bit in SCR3 after setting this bit to 1. |
| 4 | — | — | W | Reserved The write value should always be 0. |
| 3 | SCINV3 | 0 | R/W | TXD32 Pin Output Data Inversion Switch This bit selects whether or not the logic level of the TXD32 pin output data is inverted. 0: TXD32 output data is not inverted 1: TXD32 output data is inverted |
| 2 | SCINV2 | 0 | R/W | RXD32 Pin Input Data Inversion Switch This bit selects whether or not the logic level of the RXD32 pin input data is inverted. 0: RXD32 input data is not inverted 1: RXD32 input data is inverted |
| 1, 0 | — | — | W | Reserved The write value should always be 0. |

Note: When the serial port control register is modified, the data being input or output up to that point is inverted immediately after the modification, and an invalid data change is input or output. When modifying the serial port control register, modification must be made in a state in which data changes are invalidated.

10.4 Operation in Asynchronous Mode

Figure 10.2 shows the general format for asynchronous serial communication. One frame consists of a start bit (low level), followed by data (in LSB-first order), a parity bit (high or low level), and finally stop bits (high level). In asynchronous mode, synchronization is performed at the falling edge of the start bit during reception. The data is sampled on the 8th pulse of a clock with a frequency 16 times the bit period, so that the transfer data is latched at the center of each bit. Inside the SCI3, the transmitter and receiver are independent units, enabling full duplex. Both the transmitter and the receiver also have a double-buffered structure, so data can be read or written during transmission or reception, enabling continuous data transfer. Table 10.7 shows the 16 data transfer formats that can be set in asynchronous mode. The format is selected by the settings in SMR as shown in table 10.8.

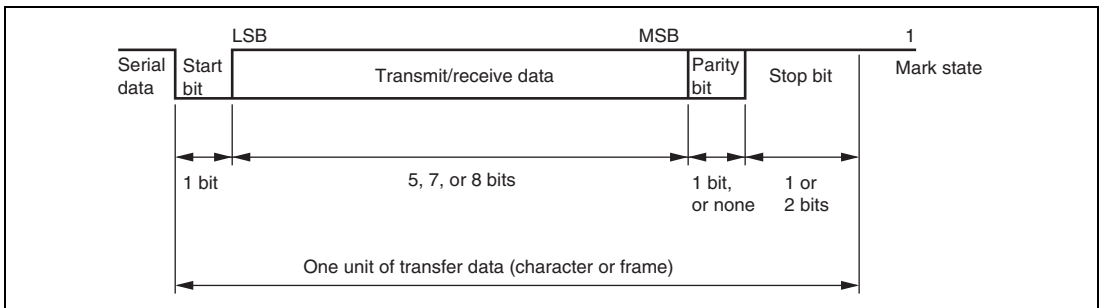


Figure 10.2 Data Format in Asynchronous Communication

10.4.1 Clock

Either an internal clock generated by the on-chip baud rate generator or an external clock input at the SCK32 pin can be selected as the SCI3's serial clock source, according to the setting of the COM bit in SMR and the CKE0 and CKE1 bits in SCR3. For details on selection of the clock source, see table 10.9. When an external clock is input at the SCK32 pin, the clock frequency should be 16 times the bit rate used. When the SCI3 is operated on an internal clock, the clock can be output from the SCK32 pin. The frequency of the clock output in this case is equal to the bit rate, and the phase is such that the rising edge of the clock is in the middle of the transmit data, as shown in figure 10.3.

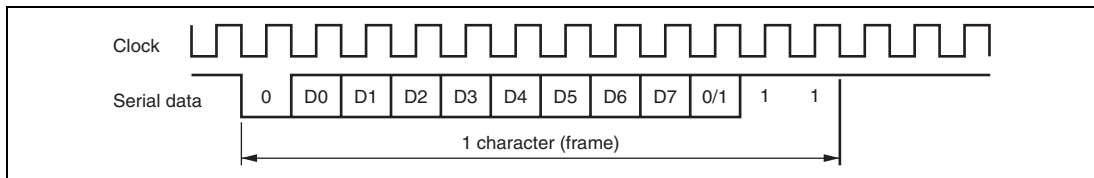


Figure 10.3 Relationship between Output Clock and Transfer Data Phase (Asynchronous Mode) (Example with 8-Bit Data, Parity, Two Stop Bits)

Table 10.7 Data Transfer Formats (Asynchronous Mode)

| SMR | | | | Serial Data Transfer Format and Frame Length | | | | | | | | | | | | | |
|-----|----|----|------|--|------------|---|---|---|------|------|------|------|------|------|------|--|--|
| CHR | PE | MP | STOP | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | | |
| 0 | 0 | 0 | 0 | START | 8-bit data | | | | | | | | STOP | | | | |
| 0 | 0 | 0 | 1 | START | 8-bit data | | | | | | | | STOP | STOP | | | |
| 0 | 0 | 1 | 0 | Setting prohibited | | | | | | | | | | | | | |
| 0 | 0 | 1 | 1 | Setting prohibited | | | | | | | | | | | | | |
| 0 | 1 | 0 | 0 | START | 8-bit data | | | | | | | | P | STOP | | | |
| 0 | 1 | 0 | 1 | START | 8-bit data | | | | | | | | P | STOP | STOP | | |
| 0 | 1 | 1 | 0 | START | 5-bit data | | | | STOP | | | | | | | | |
| 0 | 1 | 1 | 1 | START | 5-bit data | | | | STOP | STOP | | | | | | | |
| 1 | 0 | 0 | 0 | START | 7-bit data | | | | | | | STOP | | | | | |
| 1 | 0 | 0 | 1 | START | 7-bit data | | | | | | | STOP | STOP | | | | |
| 1 | 0 | 1 | 0 | Setting prohibited | | | | | | | | | | | | | |
| 1 | 0 | 1 | 1 | Setting prohibited | | | | | | | | | | | | | |
| 1 | 1 | 0 | 0 | START | 7-bit data | | | | | | | P | STOP | | | | |
| 1 | 1 | 0 | 1 | START | 7-bit data | | | | | | | P | STOP | STOP | | | |
| 1 | 1 | 1 | 0 | START | 5-bit data | | | | P | STOP | | | | | | | |
| 1 | 1 | 1 | 1 | START | 5-bit data | | | | P | STOP | STOP | | | | | | |

[Legend]

START: Start bit

STOP: Stop bit

P: Parity bit

MPB Multiprocessor bit

Table 10.8 SMR Settings and Corresponding Data Transfer Formats

| SMR | | | | | Data Transfer Format | | | | | | | |
|--------------|--------------|-------------|-------------|------------------------------|------------------------------|----------------|-----------------------|-------------------------|-------------------------|-----|-------|-------|
| Bit 7 COM | Bit 6 CHR | Bit 2 MP | Bit 5 PE | Bit 3 STOP | Mode | Data Length | Multiprocessor Bit | Parity Bit | Stop Bit Length | | | |
| 0 | 0 | 0 | 0 | 0 | Asynchronous mode | 8-bit data | No | No | 1 bit | | | |
| | | | | 1 | | | | | 2 bits | | | |
| | | | | 0 | | | | | 1 bit | | | |
| | | | | 1 | | | | | 2 bits | | | |
| | | | | 0 | | | | | 7-bit data | No | 1 bit | |
| | | | | 1 | | | | | 2 bits | | | |
| | 1 | 0 | 0 | 0 | Asynchronous mode | 5-bit data | No | No | 1 bit | | | |
| | | | | 1 | | | | | 2 bits | | | |
| | | | | 0 | | | | | Setting prohibited | | | |
| | | | | 1 | | | | | Setting prohibited | | | |
| | | | | 0 | | | | | Asynchronous 5-bit data | No | No | 1 bit |
| | | | | 1 | | | | | 2 bits | | | |
| 0 | 1 | 0 | 0 | Clock synchronous mode | 8-bit data | No | No | No | | | | |
| | | | 1 | | | | | Setting prohibited | | | | |
| | | | 0 | | | | | Setting prohibited | | | | |
| | | | 1 | | | | | Setting prohibited | | | | |
| | | | 0 | | | | | Asynchronous 5-bit data | No | Yes | 1 bit | |
| | | | 1 | | | | | 2 bits | | | | |
| 1 | * | 0 | * | * | Clock synchronous mode | 8-bit data | No | No | No | | | |

[Legend] *: Don't care

Table 10.9 SMR and SCR3 Settings and Clock Source Selection

| SMR | | SCR3 | | Transmit/Receive Clock | |
|-------|-------|-------|--|------------------------|---|
| Bit 7 | Bit 1 | Bit 0 | Mode | Clock Source | SCK32 Pin Function |
| COM | CKE1 | CKE0 | | | |
| 0 | 0 | 0 | Asynchronous mode | Internal | I/O port (SCK32 pin not used) |
| | | 1 | | | Outputs clock with same frequency as bit rate |
| 1 | 1 | 0 | Clocked synchronous mode | Internal | Outputs serial clock |
| | | 1 | | | Inputs clock with frequency 16 times bit rate |
| 0 | 1 | 1 | Reserved (Do not specify these combinations) | | |
| 1 | 0 | 1 | | | |
| 1 | 1 | 1 | | | |

10.4.2 SCI3 Initialization

Follow the flowchart as shown in figure 10.4 to initialize the SCI3. When the TE bit is cleared to 0, the TDRE flag is set to 1. Note that clearing the RE bit to 0 does not initialize the contents of the RDRF, PER, FER, and OER flags, or the contents of RDR. When the external clock is used in asynchronous mode, the clock must be supplied even during initialization. When the external clock is used in clock synchronous mode, the clock must not be supplied during initialization.

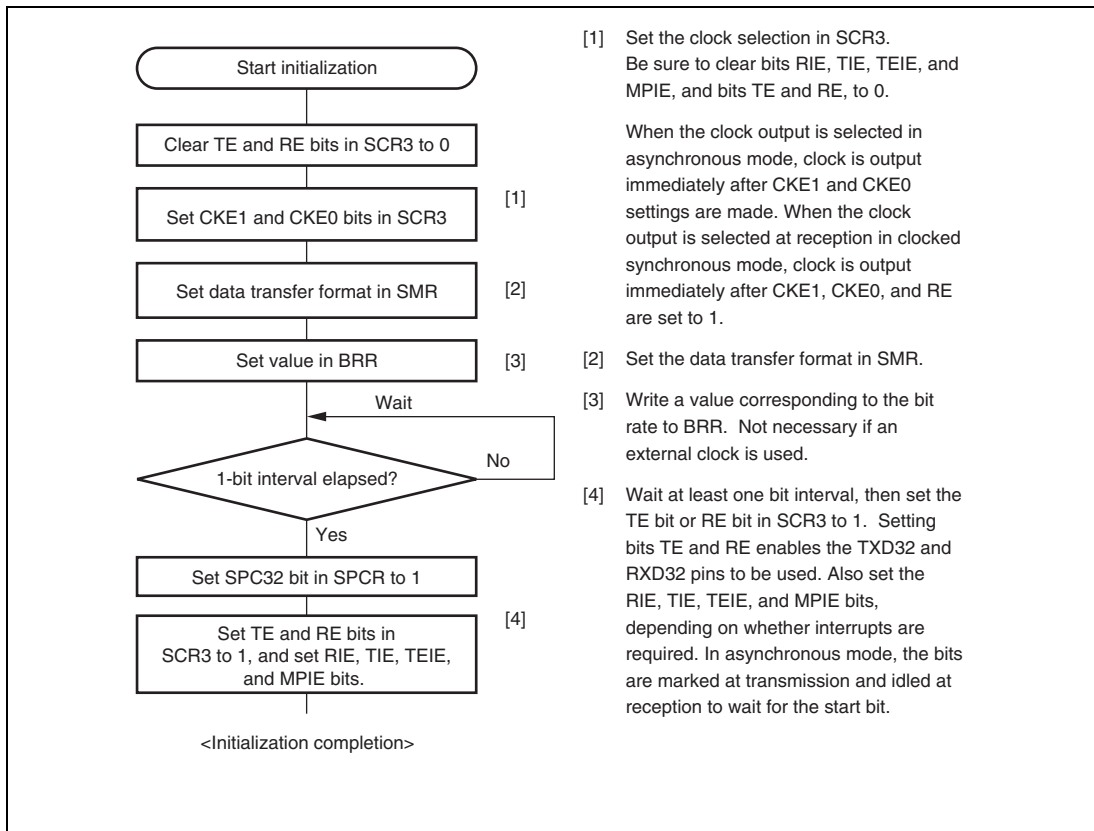


Figure 10.4 Sample SCI3 Initialization Flowchart

10.4.3 Data Transmission

Figure 10.5 shows an example of operation for transmission in asynchronous mode. In transmission, the SCI3 operates as described below.

1. The SCI3 monitors the TDRE flag in SSR. If the flag is cleared to 0, the SCI3 recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
2. After transferring data from TDR to TSR, the SCI3 sets the TDRE flag to 1 and starts transmission. If the TIE bit is set to 1 at this time, a TXI interrupt request is generated. Continuous transmission is possible because the TXI interrupt routine writes next transmit data to TDR before transmission of the current transmit data has been completed.
3. The SCI3 checks the TDRE flag at the timing for sending the stop bit.
4. If the TDRE flag is 0, the data is transferred from TDR to TSR, the stop bit is sent, and then serial transmission of the next frame is started.
5. If the TDRE flag is 1, the TEND flag in SSR is set to 1, the stop bit is sent, and then the “mark state” is entered, in which 1 is output. If the TEIE bit in SCR3 is set to 1 at this time, a TEI interrupt request is generated.
6. Figure 10.6 shows a sample flowchart for transmission in asynchronous mode.

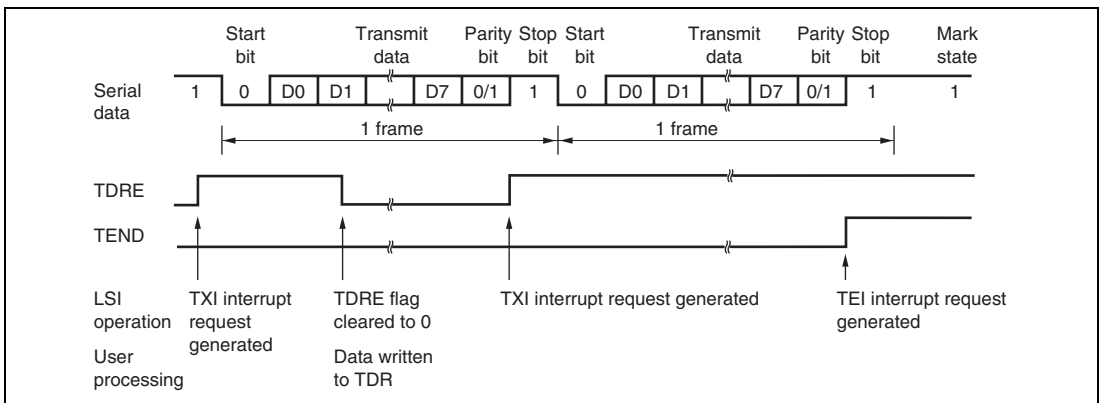


Figure 10.5 Example SCI3 Operation in Transmission in Asynchronous Mode (8-Bit Data, Parity, One Stop Bit)

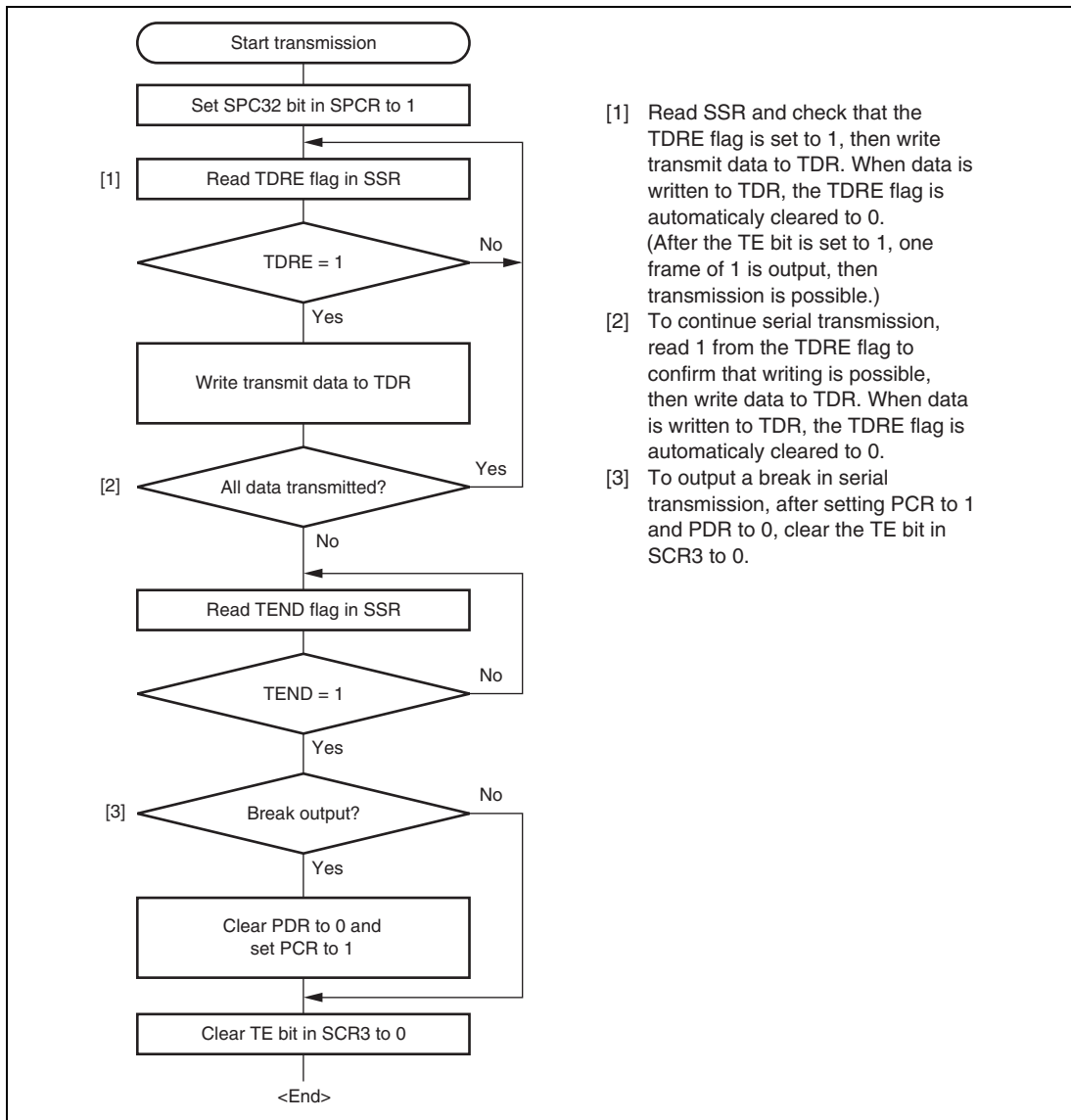


Figure 10.6 Sample Serial Transmission Flowchart (Asynchronous Mode)

10.4.4 Serial Data Reception

Figure 10.7 shows an example of operation for reception in asynchronous mode. In serial reception, the SCI operates as described below.

1. The SCI3 monitors the communication line. If a start bit is detected, the SCI3 performs internal synchronization, receives data in RSR, and checks the parity bit and stop bit.
 - Parity check
The SCI3 checks that the number of 1 bits in the receive data conforms to the parity (odd or even) set in bit PM in the serial mode register (SMR).
 - Stop bit check
The SCI3 checks that the stop bit is 1. If two stop bits are used, only the first is checked.
 - Status check
The SCI3 checks that bit RDRF is set to 0, indicating that the receive data can be transferred from RSR to RDR.
2. If an overrun error occurs (when reception of the next data is completed while the RDRF flag is still set to 1), the OER bit in SSR is set to 1. If the RIE bit in SCR3 is set to 1 at this time, an ERI interrupt request is generated. Receive data is not transferred to RDR.
3. If a parity error is detected, the PER bit in SSR is set to 1 and receive data is transferred to RDR. If the RIE bit in SCR3 is set to 1 at this time, an ERI interrupt request is generated.
4. If a framing error is detected (when the stop bit is 0), the FER bit in SSR is set to 1 and receive data is transferred to RDR. If the RIE bit in SCR3 is set to 1 at this time, an ERI interrupt request is generated.
5. If reception is completed successfully, the RDRF bit in SSR is set to 1, and receive data is transferred to RDR. If the RIE bit in SCR3 is set to 1 at this time, an RXI interrupt request is generated. Continuous reception is possible because the RXI interrupt routine reads the receive data transferred to RDR before reception of the next receive data has been completed.

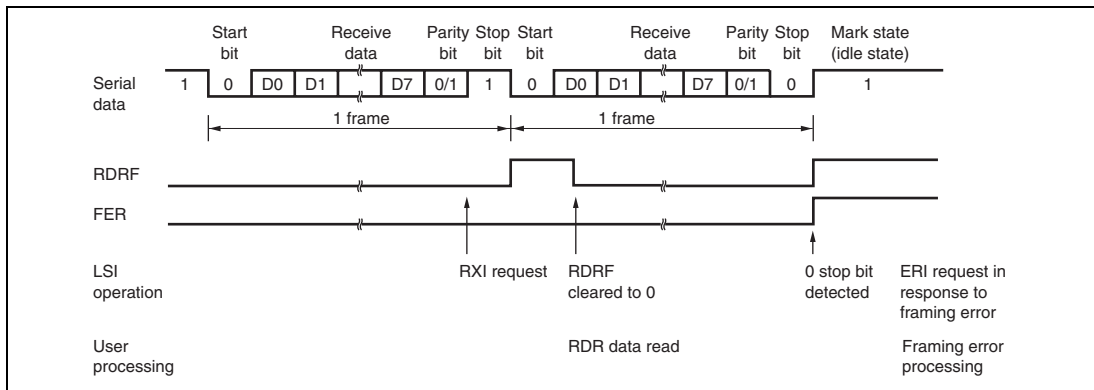


Figure 10.7 Example SCI3 Operation in Reception in Asynchronous Mode (8-Bit Data, Parity, One Stop Bit)

Table 10.10 shows the states of the SSR status flags and receive data handling when a receive error is detected. If a receive error is detected, the RDRF flag retains its state before receiving data. Reception cannot be resumed while a receive error flag is set to 1. Accordingly, clear the OER, FER, PER, and RDRF bits to 0 before resuming reception. Figure 10.8 shows a sample flowchart for serial data reception.

Table 10.10 SSR Status Flags and Receive Data Handling

| SSR Status Flag | | | | Receive Data | Receive Error Type |
|-----------------|-----|-----|-----|--------------------|--|
| RDRF* | OER | FER | PER | | |
| 1 | 1 | 0 | 0 | Lost | Overrun error |
| 0 | 0 | 1 | 0 | Transferred to RDR | Framing error |
| 0 | 0 | 0 | 1 | Transferred to RDR | Parity error |
| 1 | 1 | 1 | 0 | Lost | Overrun error + framing error |
| 1 | 1 | 0 | 1 | Lost | Overrun error + parity error |
| 0 | 0 | 1 | 1 | Transferred to RDR | Framing error + parity error |
| 1 | 1 | 1 | 1 | Lost | Overrun error + framing error + parity error |

Note: * The RDRF flag retains the state it had before data reception. However, note that if RDR is read after an overrun error has occurred in a frame because reading of the receive data in the previous frame was delayed, the RDRF flag will be cleared to 0.

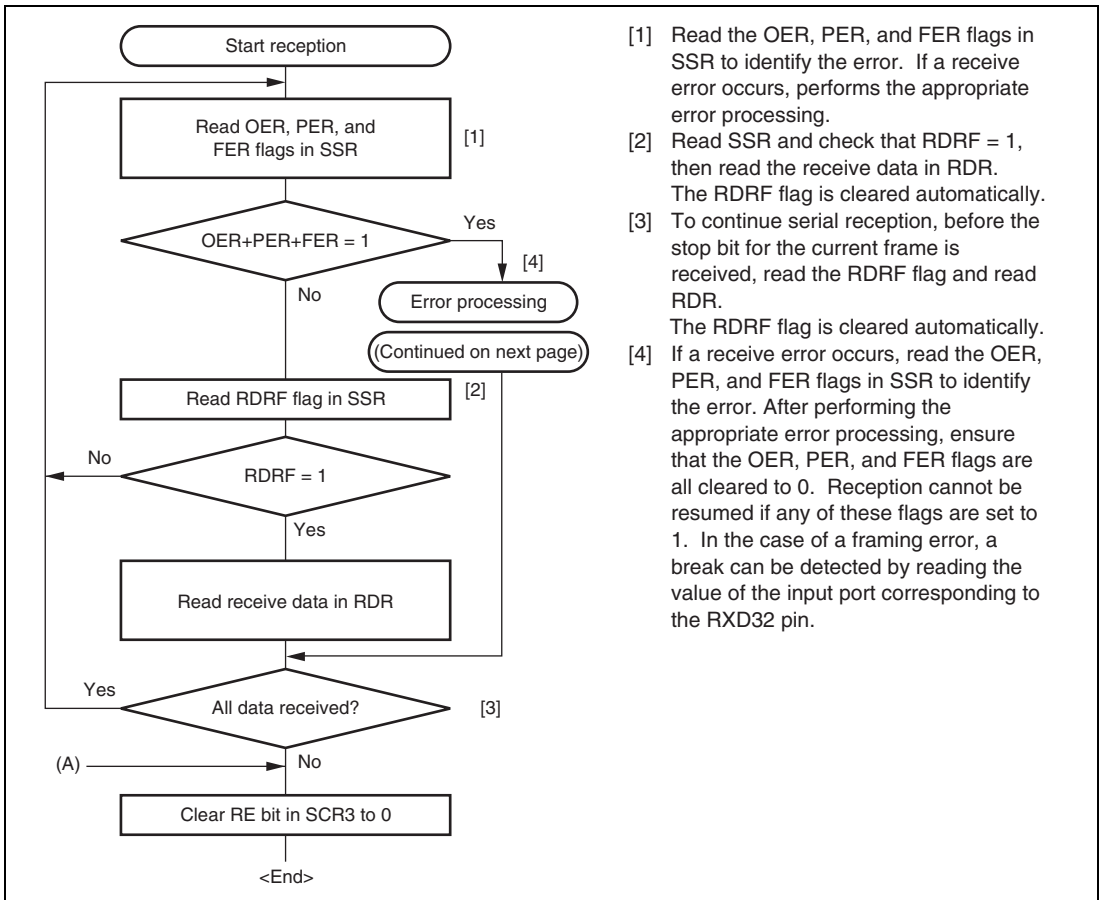


Figure 10.8 Sample Serial Data Reception Flowchart (Asynchronous Mode) (1)

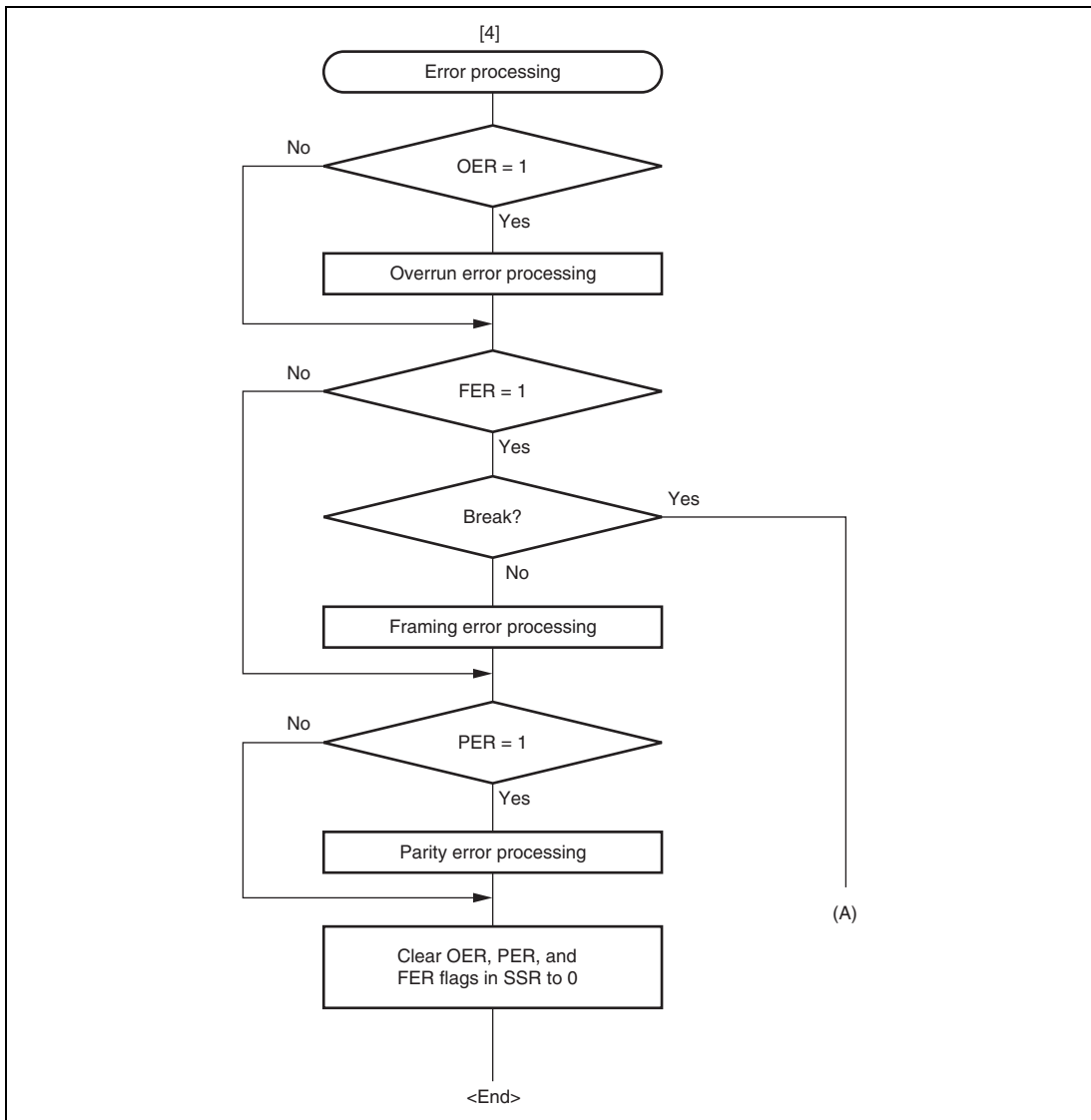


Figure 10.8 Sample Serial Data Reception Flowchart (Asynchronous Mode) (2)

10.5 Operation in Clocked Synchronous Mode

Figure 10.9 shows the general format for clock synchronous communication. In clock synchronous mode, data is transmitted or received synchronous with clock pulses. A single character in the transmit data consists of the 8-bit data starting from the LSB. In clock synchronous serial communication, data on the transmission line is output from one falling edge of the serial clock to the next. In clock synchronous mode, the SCI3 receives data in synchronous with the rising edge of the serial clock. After 8-bit data is output, the transmission line holds the MSB state. In clock synchronous mode, no parity or multiprocessor bit is added. Inside the SCI3, the transmitter and receiver are independent units, enabling full-duplex communication through the use of a common clock. Both the transmitter and the receiver also have a double-buffered structure, so data can be read or written during transmission or reception, enabling continuous data transfer.

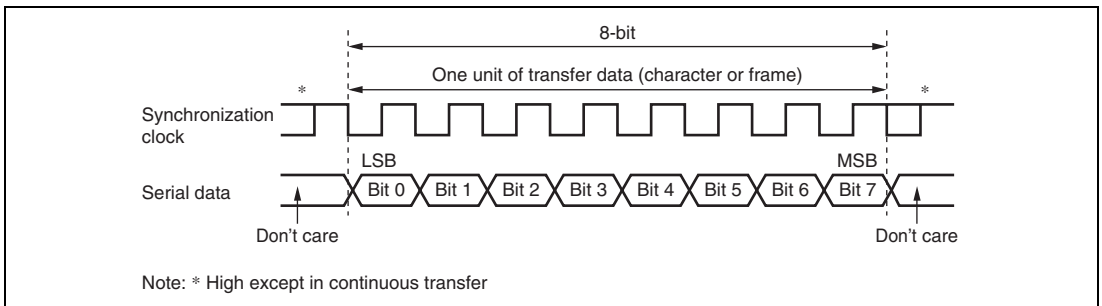


Figure 10.9 Data Format in Clocked Synchronous Communication

10.5.1 Clock

Either an internal clock generated by the on-chip baud rate generator or an external synchronization clock input at the SCK32 pin can be selected, according to the setting of the COM bit in SMR and CKE0 and CKE1 bits in SCR3. When the SCI3 is operated on an internal clock, the serial clock is output from the SCK32 pin. Eight serial clock pulses are output in the transfer of one character, and when no transfer is performed the clock is fixed high.

10.5.2 SCI3 Initialization

Before transmitting and receiving data, the SCI3 should be initialized as described in a sample flowchart in figure 10.4.

10.5.3 Serial Data Transmission

Figure 10.10 shows an example of SCI3 operation for transmission in clock synchronous mode. In serial transmission, the SCI3 operates as described below.

1. The SCI3 monitors the TDRE flag in SSR, and if the flag is 0, the SCI recognizes that data has been written to TDR, and transfers the data from TDR to TSR.
2. The SCI3 sets the TDRE flag to 1 and starts transmission. If the TIE bit in SCR3 is set to 1 at this time, a transmit data empty interrupt (TXI) is generated.
3. 8-bit data is sent from the TXD32 pin synchronized with the output clock when output clock mode has been specified, and synchronized with the input clock when use of an external clock has been specified. Serial data is transmitted sequentially from the LSB (bit 0), from the TXD32 pin.
4. The SCI checks the TDRE flag at the timing for sending the MSB (bit 7).
5. If the TDRE flag is cleared to 0, data is transferred from TDR to TSR, and serial transmission of the next frame is started.
6. If the TDRE flag is set to 1, the TEND flag in SSR is set to 1, and the TDRE flag maintains the output state of the last bit. If the TEIE bit in SCR3 is set to 1 at this time, a TEI interrupt request is generated.
7. The SCK32 pin is fixed high.

Figure 10.11 shows a sample flowchart for serial data transmission. Even if the TDRE flag is cleared to 0, transmission will not start while a receive error flag (OER, FER, or PER) is set to 1. Make sure that the receive error flags are cleared to 0 before starting transmission.

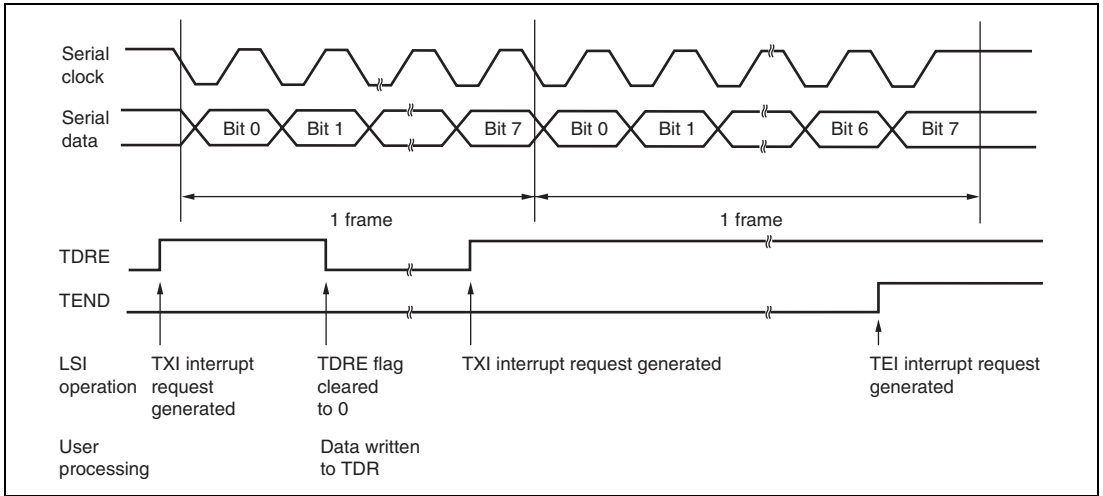


Figure 10.10 Example of SCI3 Operation in Transmission in Clocked Synchronous Mode

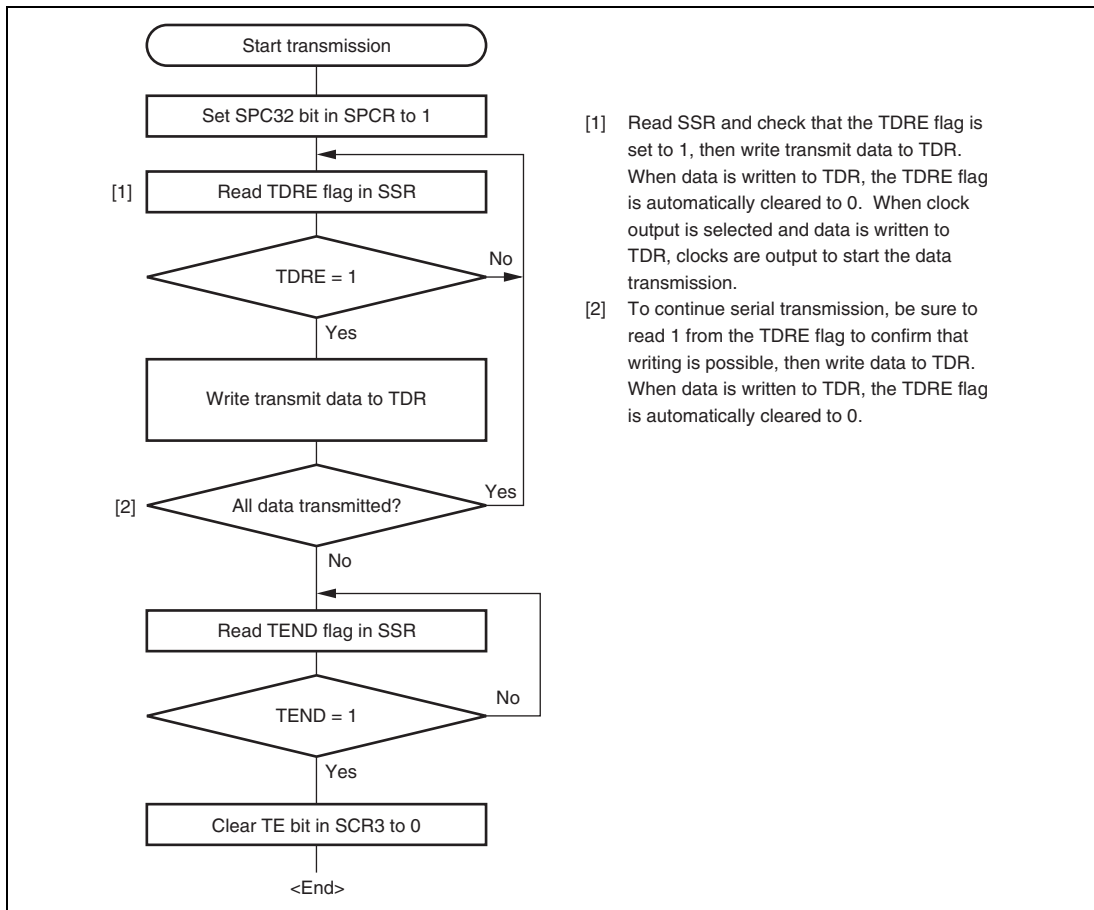


Figure 10.11 Sample Serial Transmission Flowchart (Clocked Synchronous Mode)

10.5.4 Serial Data Reception

Figure 10.12 shows an example of SCI3 operation for reception in clock synchronous mode. In serial reception, the SCI3 operates as described below.

1. The SCI3 performs internal initialization synchronous with a synchronous clock input or output, starts receiving data.
2. The SCI3 stores the received data in RSR.
3. If an overrun error occurs (when reception of the next data is completed while the RDRF flag in SSR is still set to 1), the OER bit in SSR is set to 1. If the RIE bit in SCR3 is set to 1 at this time, an ERI interrupt request is generated, receive data is not transferred to RDR, and the RDRF flag remains to be set to 1.
4. If reception is completed successfully, the RDRF bit in SSR is set to 1, and receive data is transferred to RDR. If the RIE bit in SCR3 is set to 1 at this time, an RXI interrupt request is generated.

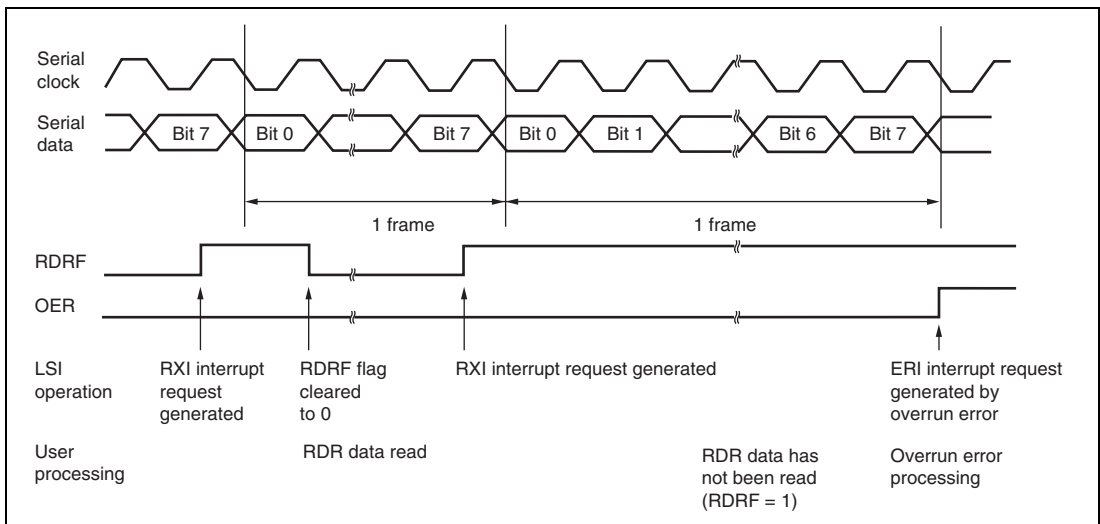


Figure 10.12 Example of SCI3 Reception Operation in Clocked Synchronous Mode

Reception cannot be resumed while a receive error flag is set to 1. Accordingly, clear the OER, FER, PER, and RDRF bits to 0 before resuming reception. Figure 10.13 shows a sample flowchart for serial data reception.

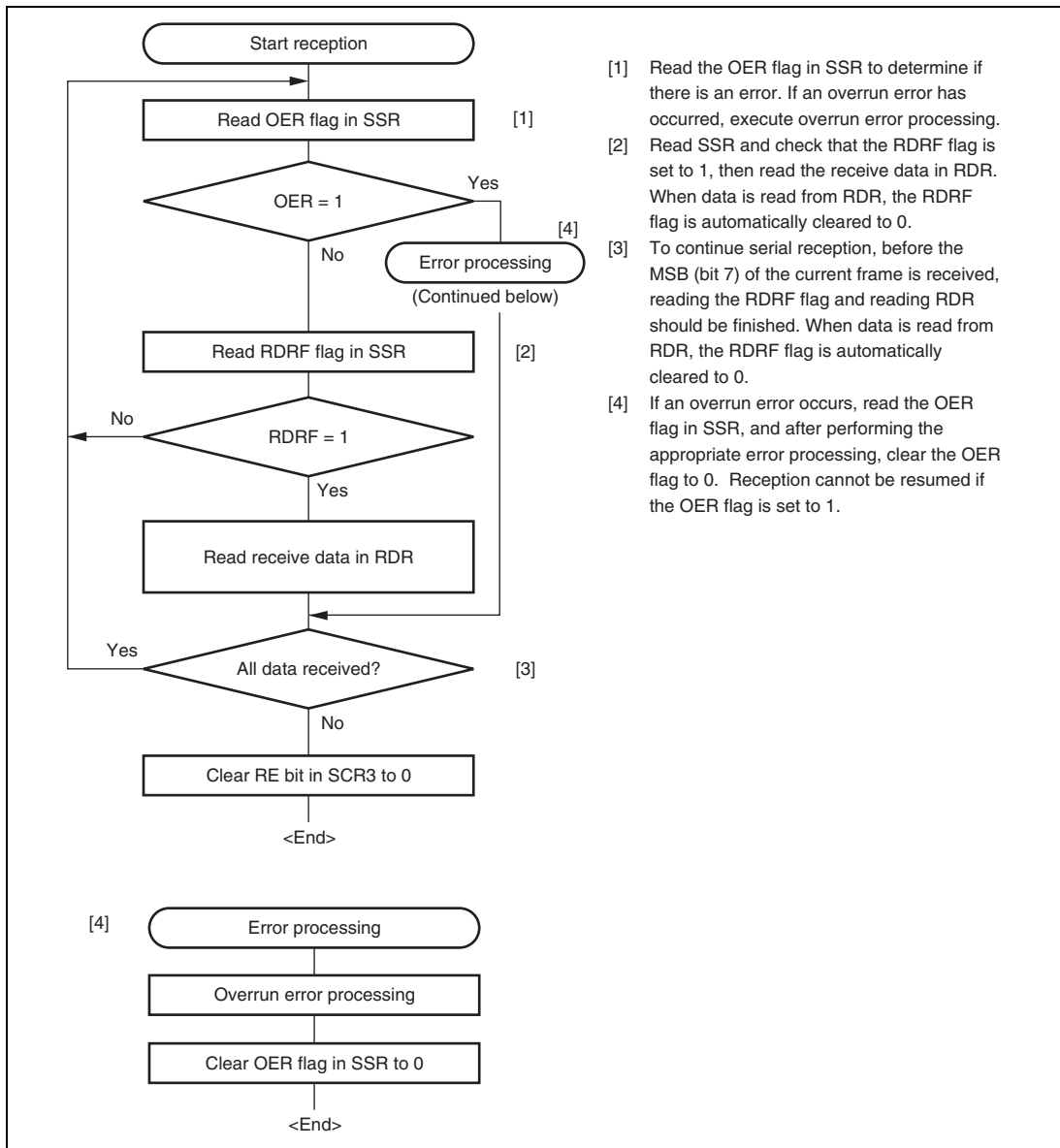


Figure 10.13 Sample Serial Reception Flowchart (Clocked Synchronous Mode)

10.5.5 Simultaneous Serial Data Transmission and Reception

Figure 10.14 shows a sample flowchart for simultaneous serial transmit and receive operations. The following procedure should be used for simultaneous serial data transmit and receive operations. To switch from transmit mode to simultaneous transmit and receive mode, after checking that the SCI3 has finished transmission and the TDRE and TEND flags are set to 1, clear TE to 0. Then simultaneously set TE and RE to 1 with a single instruction. To switch from receive mode to simultaneous transmit and receive mode, after checking that the SCI3 has finished reception, clear RE to 0. Then after checking that the RDRF and receive error flags (OER, FER, and PER) are cleared to 0, simultaneously set TE and RE to 1 with a single instruction.

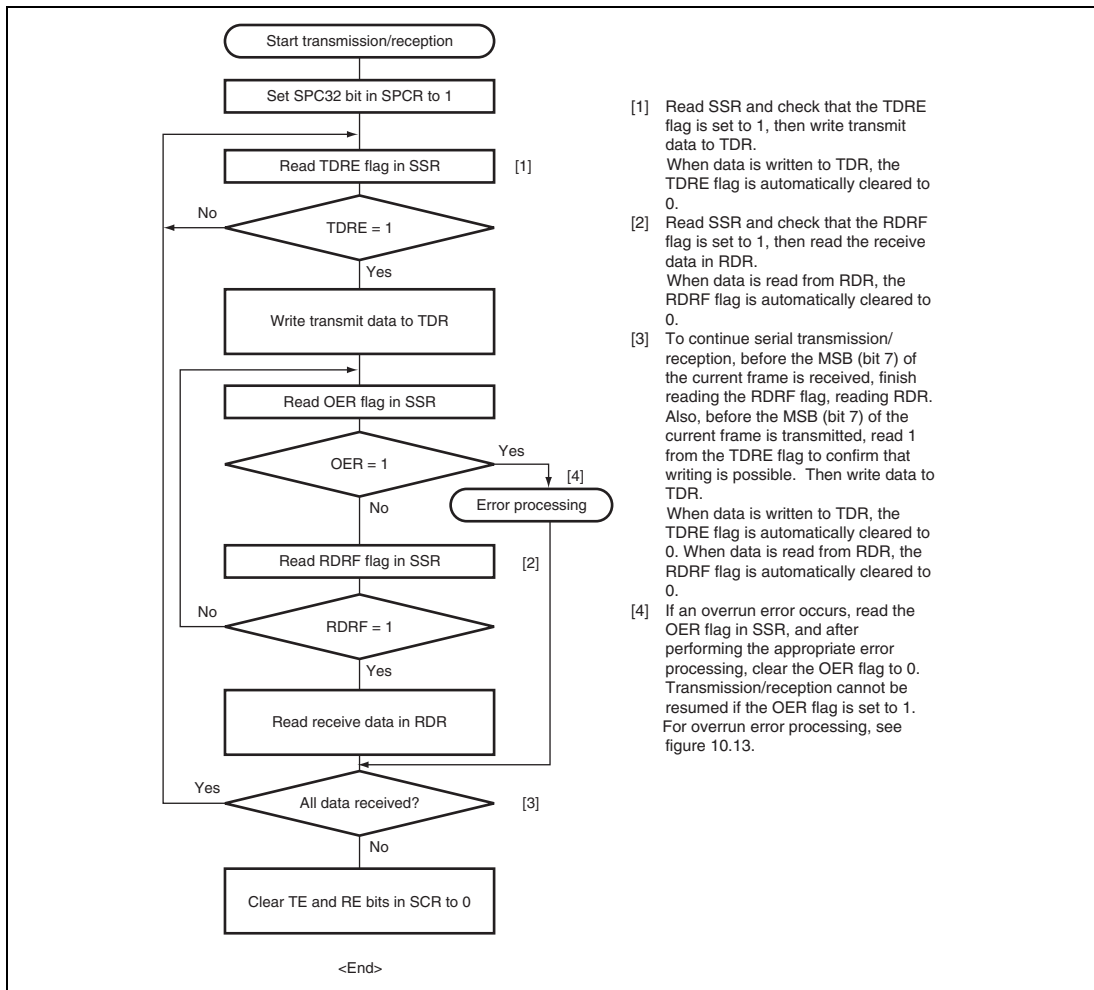


Figure 10.14 Sample Flowchart of Simultaneous Serial Transmit and Receive Operations (Clocked Synchronous Mode)

10.6 Interrupts

The SCI3 creates the following six interrupt requests: transmission end, transmit data empty, receive data full, and receive errors (overrun error, framing error, and parity error). Table 10.11 shows the interrupt sources.

Table 10.11 SCI3 Interrupt Requests

| Interrupt Requests | Abbreviation | Interrupt Sources | Enable Bit |
|---------------------|--------------|---------------------------------|------------|
| Receive Data Full | RXI | Setting RDRF in SSR | RIE |
| Transmit Data Empty | TXI | Setting TDRE in SSR | TIE |
| Transmission End | TEI | Setting TEND in SSR | TEIE |
| Receive Error | ERI | Setting OER, FER, or PER in SSR | RIE |

Each interrupt request can be enabled or disabled by means of bits TIE, RIE and TEIE in SCR3.

When bit TDRE is set to 1 in SSR, a TXI interrupt is requested. When bit TEND is set to 1 in SSR, a TEI interrupt is requested. These two interrupts are generated during transmission.

The initial value of the TDRE flag in SSR is 1. Thus, when the TIE bit in SCR3 is set to 1 before transferring the transmit data to TDR, a TXI interrupt request is generated even if the transmit data is not ready. The initial value of the TEND flag in SSR is 1. Thus, when the TEIE bit in SCR3 is set to 1 before transferring the transmit data to TDR, a TEI interrupt request is generated even if the transmit data has not been sent. It is possible to make use of the most of these interrupt requests efficiently by transferring the transmit data to TDR in the interrupt routine. To prevent the generation of these interrupt requests (TXI and TEI), set the enable bits (TIE and TEIE) that correspond to these interrupt requests to 1, after transferring the transmit data to TDR.

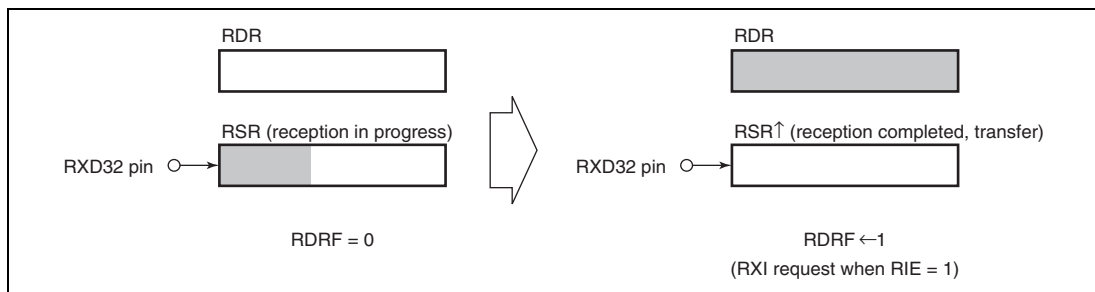
When bit RDRF is set to 1 in SSR, an RXI interrupt is requested, and if any of bits OER, PER, and FER is set to 1, an ERI interrupt is requested. These two interrupt requests are generated during reception.

For further details, see section 3, Exception Handling.

The SCI3 can carry out continuous reception using RXI and continuous transmission using TXI. These interrupts are shown in table 10.12.

Table 10.12 Transmit/Receive Interrupts

| Interrupt | Flag and Enable Bit | Interrupt Request Conditions | Notes |
|-----------|---------------------|---|---|
| RXI | RDRF RIE | When serial reception is performed normally and receive data is transferred from RSR to RDR, bit RDRF is set to 1, and if bit RIE is set to 1 at this time, RXI is enabled and an interrupt is requested. (See figure 10.15(a).) | The RXI interrupt routine reads the receive data transferred to RDR and clears bit RDRF to 0. Continuous reception can be performed by repeating the above operations until reception of the next RSR data is completed. |
| TXI | TDRE TIE | When TSR is found to be empty (on completion of the previous transmission) and the transmit data placed in TDR is transferred to TSR, bit TDRE is set to 1. If bit TIE is set to 1 at this time, TXI is enabled and an interrupt is requested. (See figure 10.15(b).) | The TXI interrupt routine writes the next transmit data to TDR and clears bit TDRE to 0. Continuous transmission can be performed by repeating the above operations until the data transferred to TSR has been transmitted. |
| TEI | TEND TEIE | When the last bit of the character in TSR is transmitted, if bit TDRE is set to 1, bit TEND is set to 1. If bit TEIE is set to 1 at this time, TEI is enabled and an interrupt is requested. (See figure 10.15(c).) | TEI indicates that the next transmit data has not been written to TDR when the last bit of the transmit character in TSR is transmitted. |

**Figure 10.15(a) RDRF Setting and RXI Interrupt**

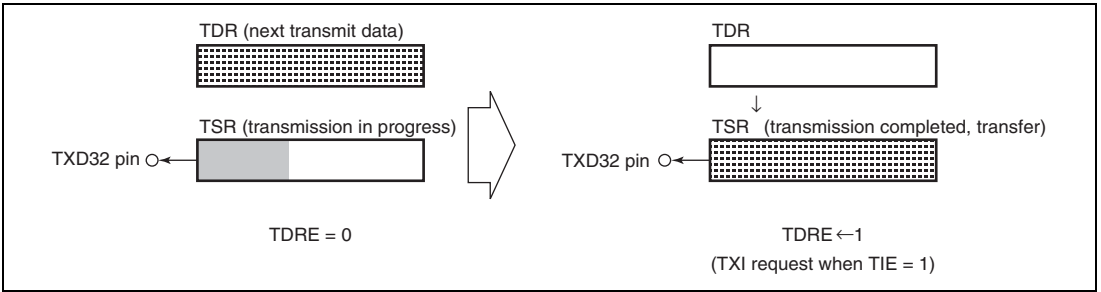


Figure 10.15(b) TDRE Setting and TXI Interrupt

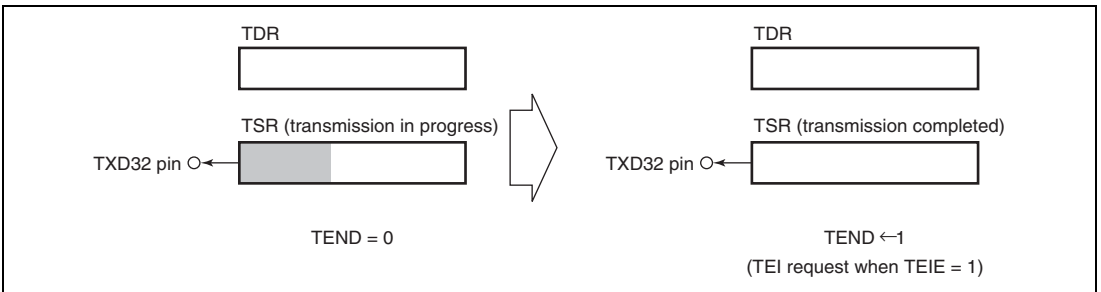


Figure 10.15(c) TEND Setting and TEI Interrupt

10.7 Usage Notes

10.7.1 Break Detection and Processing

When framing error detection is performed, a break can be detected by reading the RXD32 pin value directly. In a break, the input from the RXD32 pin becomes all 0, setting the FER flag, and possibly the PER flag. Note that as the SCI3 continues the receive operation after receiving a break, even if the FER flag is cleared to 0, it will be set to 1 again.

10.7.2 Mark State and Break Sending

When TE is 0, the TXD32 pin is used as an I/O port whose direction (input or output) and level are determined by PCR and PDR. This can be used to set the TXD32 pin to mark state (high level) or send a break during serial data transmission. To maintain the communication line at mark state until TE is set to 1, set both PCR and PDR to 1. As TE is cleared to 0 at this point, the TXD32 pin becomes an I/O port, and 1 is output from the TXD32 pin. To send a break during serial transmission, first set PCR to 1 and PDR to 0, and then clear TE to 0. When TE is cleared to 0, the transmitter is initialized regardless of the current transmission state, the TXD32 pin becomes an I/O port, and 0 is output from the TXD32 pin.

10.7.3 Receive Error Flags and Transmit Operations (Clocked Synchronous Mode Only)

Transmission cannot be started when a receive error flag (OER, PER, or FER) is set to 1, even if the TDRE flag is cleared to 0. Be sure to clear the receive error flags to 0 before starting transmission. Note also that receive error flags cannot be cleared to 0 even if the RE bit is cleared to 0.

10.7.4 Receive Data Sampling Timing and Reception Margin in Asynchronous Mode

In asynchronous mode, the SCI3 operates on a basic clock with a frequency of 16 times the transfer rate. In reception, the SCI3 samples the falling edge of the start bit using the basic clock, and performs internal synchronization. Receive data is latched internally at the rising edge of the 8th pulse of the basic clock as shown in figure 10.16.

Thus, the reception margin in asynchronous mode is given by formula (1) below.

$$M = \left\{ \left(0.5 - \frac{1}{2N} \right) - \frac{D - 0.5}{N} - (L - 0.5) F \right\} \cdot 100(\%)$$

... Formula (1)

Where N : Ratio of bit rate to clock (N = 16)
 D : Clock duty (D = 0.5 to 1.0)
 L : Frame length (L = 9 to 12)
 F : Absolute value of clock rate deviation

Assuming values of F (absolute value of clock rate deviation) = 0 and D (clock duty) = 0.5 in formula (1), the reception margin can be given by the formula.

$$M = \{ 0.5 - 1/(2 \cdot 16) \} \times 100 [\%] = 46.875\%$$

However, this is only the computed value, and a margin of 20% to 30% should be allowed for in system design.

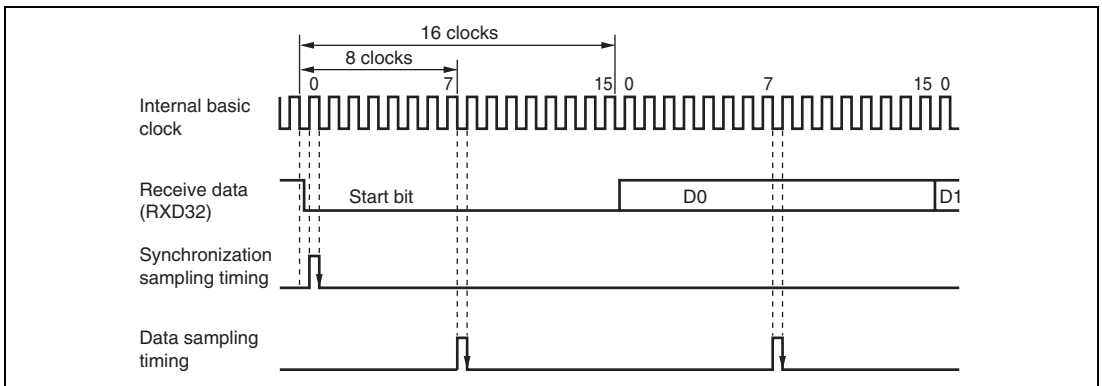


Figure 10.16 Receive Data Sampling Timing in Asynchronous Mode

10.7.5 Note on Switching SCK32 Function

If pin SCK32 is used as a clock output pin by the SCI3 in clock synchronous mode and is then switched to a general input/output pin (a pin with a different function), the pin outputs a low level signal for half a system clock (ϕ) cycle immediately after it is switched.

This can be prevented by either of the following methods according to the situation.

- a. When an SCK32 function is switched from clock output to non clock-output
When stopping data transfer, issue one instruction to clear bits TE and RE to 0 and to set bits CKE1 and CKE0 in SCR3 to 1 and 0, respectively.
In this case, bit COM in SMR should be left 1. The above prevents SCK32 from being used as a general input/output pin. To avoid an intermediate level of voltage from being applied to SCK32, the line connected to SCK32 should be pulled up to the V_{cc} level via a resistor, or supplied with output from an external device.
- b. When an SCK32 function is switched from clock output to general input/output
When stopping data transfer,
 - (i) Issue one instruction to clear bits TE and RE to 0 and to set bits CKE1 and CKE0 in SCR3 to 1 and 0, respectively.
 - (ii) Clear bit COM in SMR to 0
 - (iii) Clear bits CKE1 and CKE0 in SCR3 to 0
 Note that special care is also needed here to avoid an intermediate level of voltage from being applied to SCK32.

10.7.6 Relation between Writing to TDR and Bit TDRE

Bit TDRE in the serial status register (SSR) is a status flag that indicates that data for serial transmission has not been prepared in TDR. When data is written to TDR, bit TDRE is cleared to 0 automatically. When the SCI3 transfers data from TDR to TSR, bit TDRE is set to 1.

Data can be written to TDR irrespective of the state of bit TDRE, but if new data is written to TDR while bit TDRE is cleared to 0, the data previously stored in TDR will be lost if it has not yet been transferred to TSR. Accordingly, to ensure that serial transmission is performed dependably, you should first check that bit TDRE is set to 1, then write the transmit data to TDR only once (not two or more times).

10.7.7 Relation between RDR Reading and bit RDRF

In a receive operation, the SCI3 continually checks the RDRF flag. If bit RDRF is cleared to 0 when reception of one frame ends, normal data reception is completed. If bit RDRF is set to 1, this indicates that an overrun error has occurred.

When the contents of RDR are read, bit RDRF is cleared to 0 automatically. Therefore, if RDR is read more than once, the second and subsequent read operations will be performed while bit RDRF is cleared to 0. Note that, when an RDR read is performed while bit RDRF is cleared to 0, if the read operation coincides with completion of reception of a frame, the next frame of data may be read. This is shown in figure 10.17.

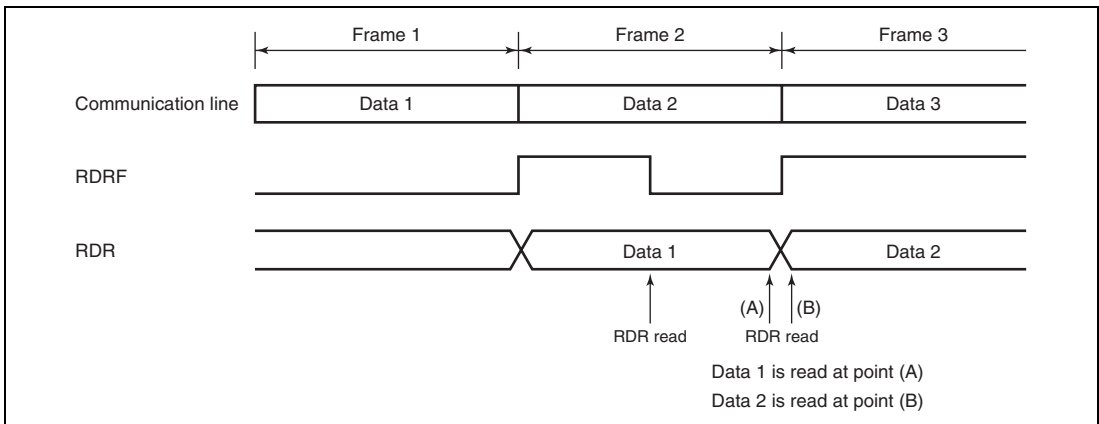


Figure 10.17 Relation between RDR Read Timing and Data

In this case, only a single RDR read operation (not two or more) should be performed after first checking that bit RDRF is set to 1. If two or more reads are performed, the data read the first time should be transferred to RAM, etc., and the RAM contents used. Also, ensure that there is sufficient margin in an RDR read operation before reception of the next frame is completed. To be precise in terms of timing, the RDR read should be completed before bit 7 is transferred in clock synchronous mode, or before the STOP bit is transferred in asynchronous mode.

10.7.8 Transmit and Receive Operations when Making State Transition

Make sure that transmit and receive operations have completely finished before carrying out state transition processing.

10.7.9 Setting in Subactive or Subsleep Mode

In subactive or subsleep mode, the SCI3 can operate only when the CPU clock is $\phi_w/2$. The SA1 bit in SYSCR2 should be set to 1.

Section 11 10-Bit PWM

This LSI has a two-channel 10-bit PWM. The PWM with a low-pass filter connected can be used as a D/A converter. Figure 11.1 shows a block diagram of the 10-bit PWM.

11.1 Features

- Choice of four conversion periods

A conversion period of $4096/\phi$ with a minimum modulation width of $4/\phi$, a conversion period of $2048/\phi$ with a minimum modulation width of $2/\phi$, a conversion period of $1024/\phi$ with a minimum modulation width of $1/\phi$, or a conversion period of $512/\phi$ with a minimum modulation width of $1/2\phi$ can be selected.

- Pulse division method for less ripple
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

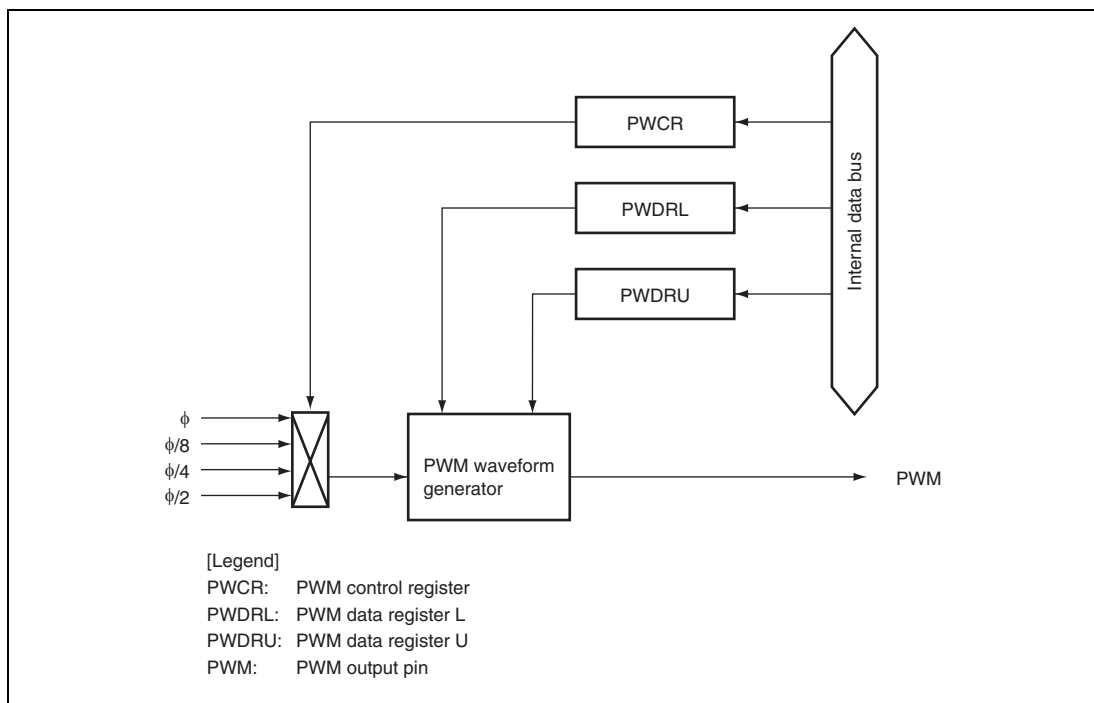


Figure 11.1 Block Diagram of 10-Bit PWM

11.2 Input/Output Pins

Table 11.1 shows the 10-bit PWM pin configuration.

Table 11.1 Pin Configuration

| Name | Abbreviation | I/O | Function |
|---------------------------------|---------------------|------------|--|
| 10-bit PWM square-wave output 1 | PWM1 | Output | Channel 1: 10-bit PWM waveform output pin/event counter PWM output pin |
| 10-bit PWM square-wave output 2 | PWM2 | Output | Channel 2: 10-bit PWM waveform output pin/event counter PWM output pin |

11.3 Register Descriptions

The 10-bit PWM has the following registers.

- PWM control register (PWCR)
- PWM data register U (PWDRU)
- PWM data register L (PWDRL)

11.3.1 PWM Control Register (PWCR)

PWCR selects the conversion period.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|---|
| 7 | — | 1 | — | Reserved |
| 6 | — | 1 | — | These bits are always read as 1, and cannot be modified. |
| 5 | — | 1 | — | |
| 4 | — | 1 | — | |
| 3 | — | 1 | — | |
| 2 | — | 1 | — | |
| 1 | PWCR1 | 0 | W | Clock Select 1, 0 |
| 0 | PWCR0 | 0 | W | 00: The input clock is ϕ ($t\phi = 1/\phi$) <ul style="list-style-type: none"> — The conversion period is $512/\phi$, with a minimum modulation width of $1/2\phi$ 01: The input clock is $\phi/2$ ($t\phi = 2/\phi$) <ul style="list-style-type: none"> — The conversion period is $1024/\phi$, with a minimum modulation width of $1/\phi$ 10: The input clock is $\phi/4$ ($t\phi = 4/\phi$) <ul style="list-style-type: none"> — The conversion period is $2048/\phi$, with a minimum modulation width of $2/\phi$ 11: The input clock is $\phi/8$ ($t\phi = 8/\phi$) <ul style="list-style-type: none"> — The conversion period is $4096/\phi$, with a minimum modulation width of $4/\phi$ |

[Legend] $t\phi$: Period of PWM clock input

11.3.2 PWM Data Registers U and L (PWDRU, PWDRL)

PWDRU and PWDRL indicate high level width in one PWM waveform cycle. PWDRU and PWDRL are 10-bit write-only registers, with the upper 2 bits assigned to PWDRU and the lower 8 bits to PWDRL. When read, all bits are always read as 1.

Both PWDRU and PWDRL are accessible only in bytes. Note that the operation is not guaranteed if word access is performed. When 10-bit data is written in PWDRU and PWDRL, the contents are latched in the PWM waveform generator and the PWM waveform generation data is updated. When writing the 10-bit data, the order is as follows: PWDRL to PWDRU.

PWDRU and PWDRL are initialized to H'FC00.

11.4 Operation

11.4.1 Operation

When using the 10-bit PWM, set the registers in this sequence:

1. Set the PWM2 and/or PWM1 bits in port mode register 9 (PMR9) to 1 to set the P91/PWM2 pin or P90/PWM1 pin, or both, to function as PWM output pins.
2. Set the PWCR0 and PWCR1 bits in PWCR to select one conversion period of either.
3. Set the output waveform data in PWDRU and PWDRL. Be sure to write byte data first to PWDRL and then to PWDRU. When the data is written in PWDRU, the contents of these registers are latched in the PWM waveform generator, and the PWM waveform generation data is updated in synchronization with internal signals.

One conversion period consists of four pulses, as shown in figure 11.2. The total high-level width during this period (T_H) corresponds to the data in PWDRU and PWDRL. This relation can be expressed as follows:

$$T_H = (\text{data value in PWDRU and PWDRL} + 4) \times t\phi/2$$

where $t\phi$ is the period of PWM clock input: $1/\phi$ (PWCR1 = 0, PWCR0 = 0), $2/\phi$ (PWCR1 = 0, PWCR0 = 1), $4/\phi$ (PWCR1 = 1, PWCR0 = 0), or $8/\phi$ (PWCR1 = 1, PWCR0 = 1).

If the data value in PWDRU and PWDRL is from H'FFFC to H'FFFF, the PWM output stays high. When the data value is H'FC3C, T_H is calculated as follows:

$$T_H = 64 \times t\phi/2 = 32 \times t\phi$$

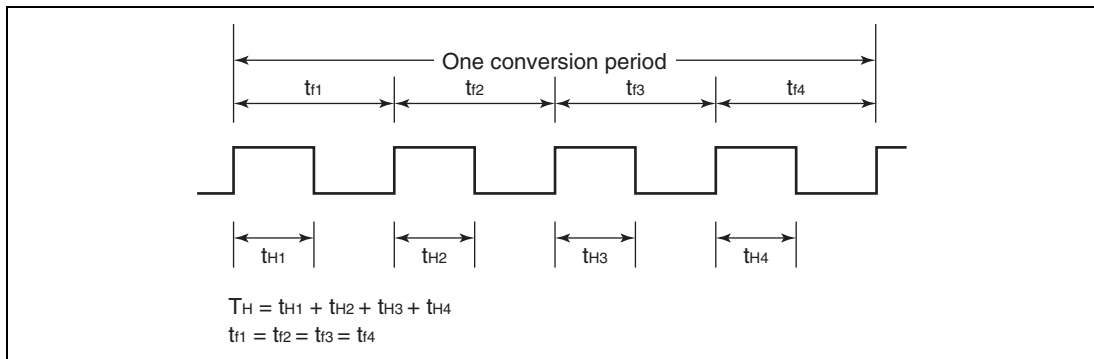


Figure 11.2 Waveform Output by 10-Bit PWM

11.4.2 PWM Operating States

Table 11.2 shows the PWM operating states.

Table 11.2 PWM Operating States

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|-----------------------|--------------|---------------|--------------|--------------|-------------------|------------------|----------------|-----------------------|
| PWCR | Reset | Functions | Functions | Retained | Retained | Retained | Retained | Retained |
| PWDRU | Reset | Functions | Functions | Retained | Retained | Retained | Retained | Retained |
| PWDRL | Reset | Functions | Functions | Retained | Retained | Retained | Retained | Retained |

Section 12 A/D Converter

This LSI includes a successive approximation type 10-bit A/D converter that allows up to four analog input channels to be selected. The block diagram of the A/D converter is shown in figure 12.1.

12.1 Features

- 10-bit resolution
- Four input channels
- Conversion time: at least 12.4 μ s per channel ($\phi = 5$ MHz operation)
- Sample and hold function
- Conversion start method
 - Software
- Interrupt request
 - An A/D conversion end interrupt request (ADI) can be generated
- Use of module standby mode enables this module to be placed in standby mode independently when not used. (For details, refer to section 5.4, Module Standby Function.)

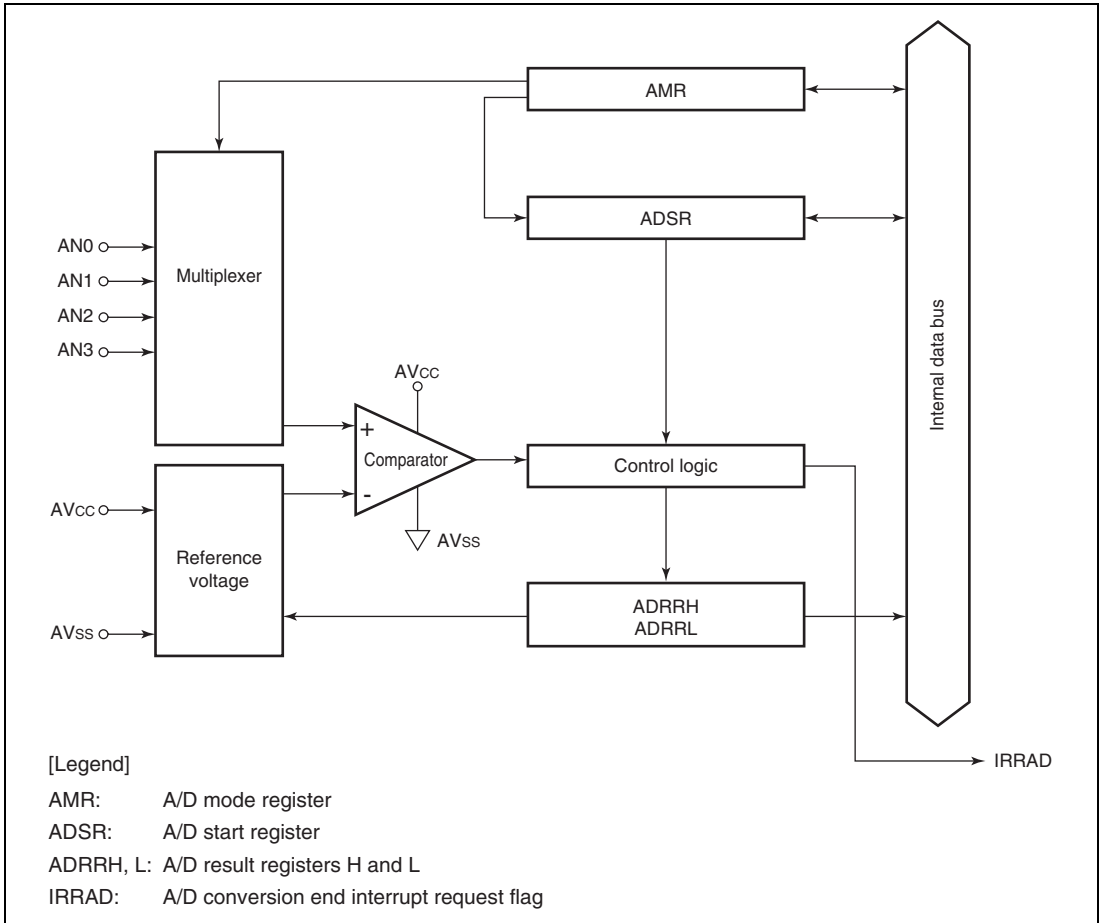


Figure 12.1 Block Diagram of A/D Converter

12.2 Input/Output Pins

Table 12.1 shows the input pins used by the A/D converter.

Table 12.1 Pin Configuration

| Pin Name | Abbreviation | I/O | Function |
|-------------------------|--------------|-------|---|
| Analog power supply pin | AVcc | Input | Power supply and reference voltage of analog part |
| Analog ground pin | AVss | Input | Ground and reference voltage of analog part |
| Analog input pin 0 | AN0 | Input | Analog input pins |
| Analog input pin 1 | AN1 | Input | |
| Analog input pin 2 | AN2 | Input | |
| Analog input pin 3 | AN3 | Input | |

12.3 Register Descriptions

The A/D converter has the following registers.

- A/D result registers H and L (ADRRH and ADRRL)
- A/D mode register (AMR)
- A/D start register (ADSR)

12.3.1 A/D Result Registers H and L (ADRRH and ADRRL)

ADRRH and ADRRL are 16-bit read-only registers that store the results of A/D conversion.

The upper 8 bits of the data are stored in ADRRH, and the lower 2 bits in ADRRL.

ADRRH and ADRRL can be read by the CPU at any time, but the ADRRH and ADRRL values during A/D conversion are undefined. After A/D conversion is completed, the conversion result is stored as 10-bit data, and this data is retained until the next conversion operation starts.

The initial values of ADRRH and ADRRL are undefined.

12.3.2 A/D Mode Register (AMR)

AMR sets the A/D conversion time and analog input pins.

| Bit | Bit Name | Initial Value | R/W | Description |
|-----|----------|---------------|-----|--|
| 7 | CKS | 0 | R/W | Clock Select Sets the A/D conversion time. 0: Conversion time = 62 states 1: Conversion time = 31 states |
| 6 | — | 0 | R/W | Reserved Only 0 can be written to this bit. |
| 5 | — | 1 | — | Reserved |
| 4 | — | 1 | — | These bits are always read as 1 and cannot be modified. |
| 3 | CH3 | 0 | R/W | Channel Select 3 to 0 |
| 2 | CH2 | 0 | R/W | Selects the analog input channel. |
| 1 | CH1 | 0 | R/W | 00XX: No channel selected |
| 0 | CH0 | 0 | R/W | 0100: AN0 0101: AN1 0110: AN2 0111: AN3 1XXX: Using prohibited The channel selection should be made while the ADSF bit is cleared to 0. |

[Legend] X: Don't care.

12.3.3 A/D Start Register (ADSR)

ADSR starts and stops the A/D conversion.

| Bit | Bit Name | Initial Value | R/W | Description |
|--------|----------|---------------|-----|---|
| 7 | ADSF | 0 | R/W | When this bit is set to 1, A/D conversion is started. When conversion is completed, the converted data is set in ADDRHH and ADDRLL and at the same time this bit is cleared to 0. If this bit is written to 0, A/D conversion can be forcibly terminated. |
| 6 to 0 | — | All 1 | — | Reserved These bits are always read as 1 and cannot be modified. |

12.4 Operation

The A/D converter operates by successive approximation with 10-bit resolution. When changing the conversion time or analog input channel, in order to prevent incorrect operation, first clear the bit ADSF to 0 in ADSR.

12.4.1 A/D Conversion

1. A/D conversion is started from the selected channel when the ADSF bit in ADSR is set to 1, according to software.
2. When A/D conversion is completed, the result is transferred to the A/D result register.
3. On completion of conversion, the IRRAD flag in IRR2 is set to 1. If the IENAD bit in IENR2 is set to 1 at this time, an A/D conversion end interrupt request is generated.
4. The ADSF bit remains set to 1 during A/D conversion. When A/D conversion ends, the ADSF bit is automatically cleared to 0 and the A/D converter enters the wait state.

12.4.2 Operating States of A/D Converter

Table 12.2 shows the operating states of the A/D converter.

Table 12.2 Operating States of A/D Converter

| Operating Mode | Reset | Active | Sleep | Watch | Sub-active | Sub-sleep | Standby | Module Standby |
|----------------|-----------|-----------|-----------|----------|------------|-----------|----------|----------------|
| AMR | Reset | Functions | Functions | Retained | Retained | Retained | Retained | Retained |
| ADSR | Reset | Functions | Functions | Reset | Reset | Reset | Reset | Reset |
| ADRRH | Retained* | Functions | Functions | Retained | Retained | Retained | Retained | Retained |
| ADRRL | Retained* | Functions | Functions | Retained | Retained | Retained | Retained | Retained |

Note: * Undefined in a power-on reset.

12.5 Example of Use

An example of how the A/D converter can be used is given below, using channel 1 (pin AN1) as the analog input channel. Figure 12.2 shows the operation timing.

1. Bits CH3 to CH0 in the A/D mode register (AMR) are set to 0101, making pin AN1 the analog input channel. A/D interrupts are enabled by setting bit IENAD to 1, and A/D conversion is started by setting bit ADSF to 1.
2. When A/D conversion is completed, bit IRRAD is set to 1, and the A/D conversion result is stored in ADRRH and ADRRL. At the same time bit ADSF is cleared to 0, and the A/D converter goes to the idle state.
3. Bit IENAD = 1, so an A/D conversion end interrupt is requested.
4. The A/D interrupt handling routine starts.
5. The A/D conversion result is read and processed.
6. The A/D interrupt handling routine ends.

If bit ADSF is set to 1 again afterward, A/D conversion starts and steps 2 through 6 take place. Figures 12.3 and 12.4 show flowcharts of procedures for using the A/D converter.

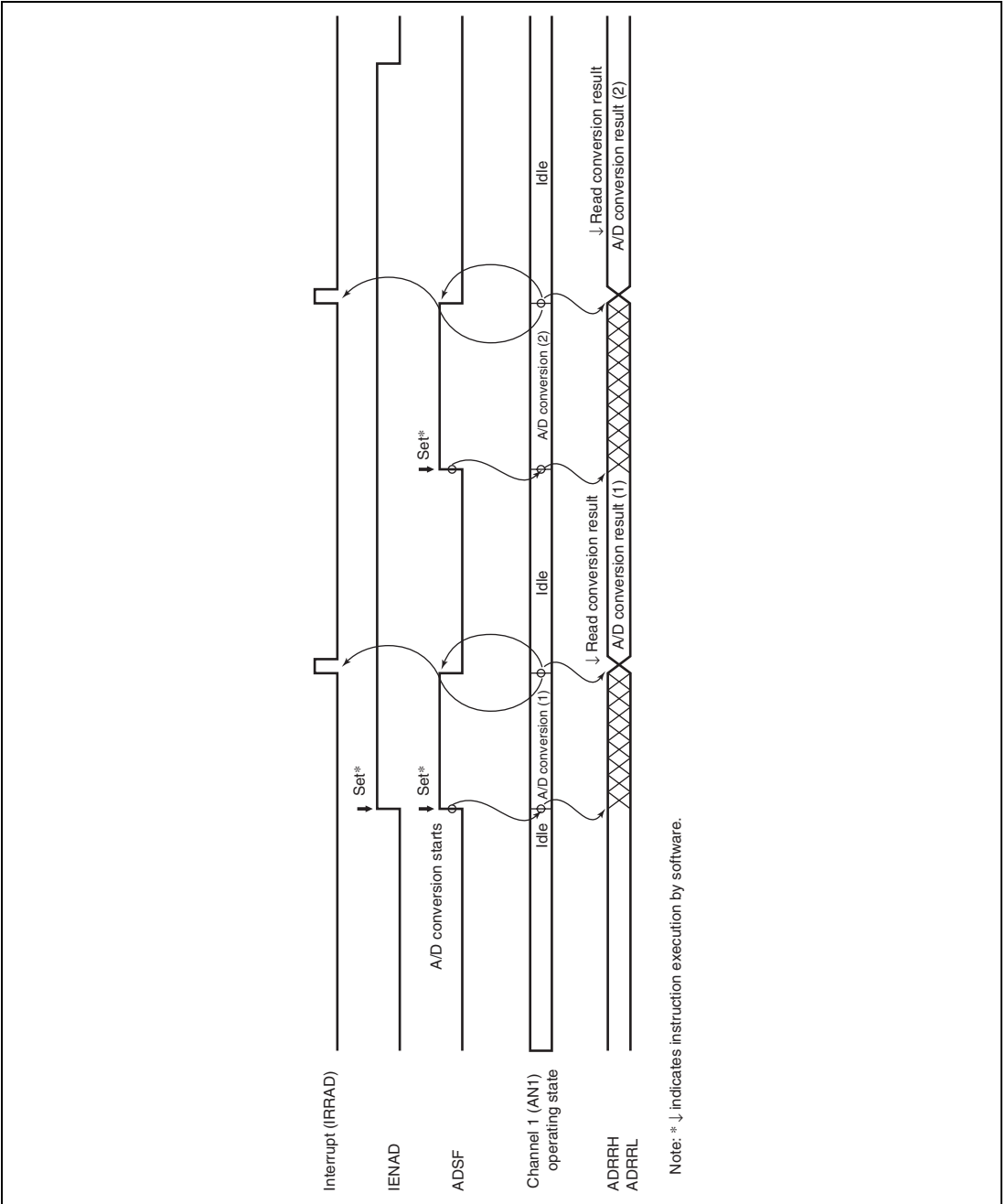


Figure 12.2 Example of A/D Conversion Operation

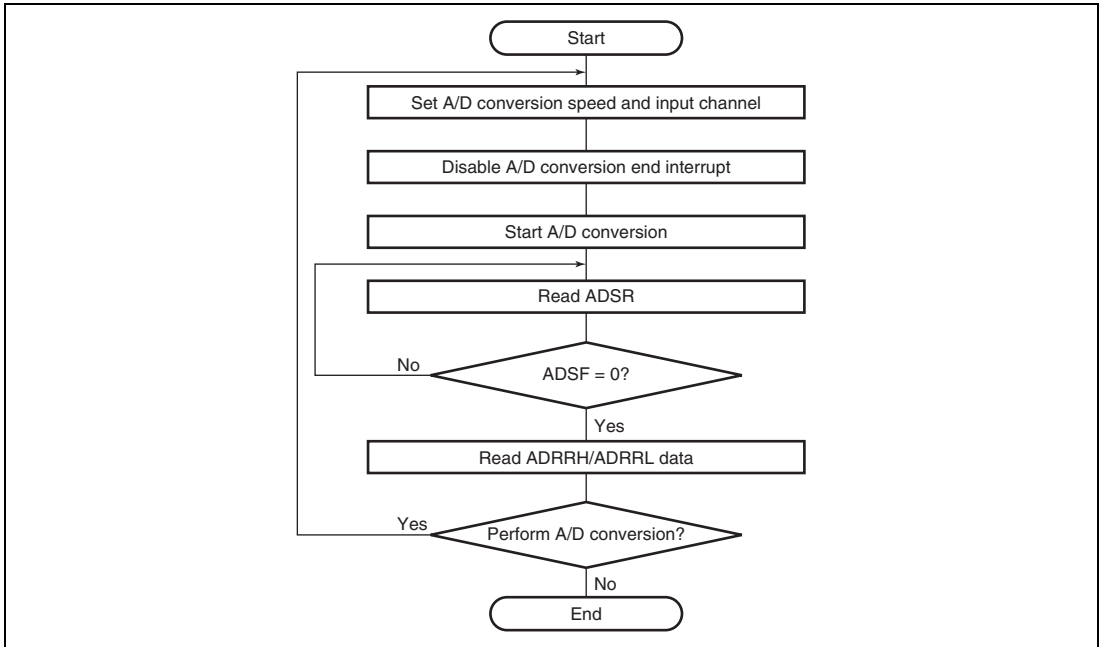


Figure 12.3 Flowchart of Procedure for Using A/D Converter (Polling by Software)

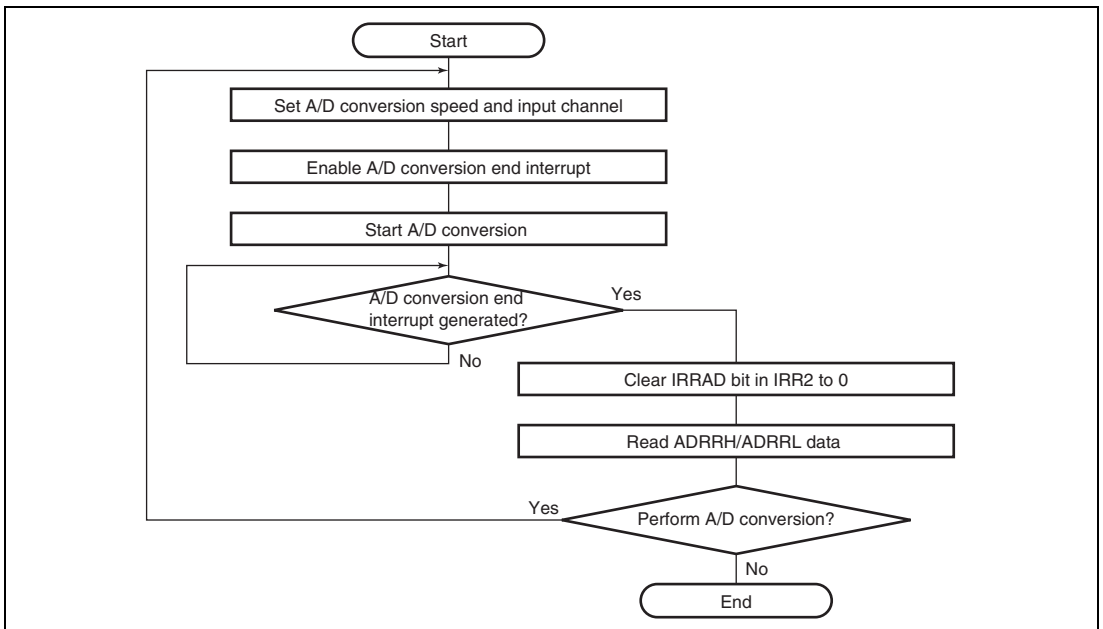


Figure 12.4 Flowchart of Procedure for Using A/D Converter (Interrupts Used)

12.6 A/D Conversion Accuracy Definitions

This LSI's A/D conversion accuracy definitions are given below.

- Resolution
The number of A/D converter digital output codes
- Quantization error
The deviation inherent in the A/D converter, given by 1/2 LSB (see figure 12.5).
- Offset error
The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from the minimum voltage value 0000000000 to 0000000001 (see figure 12.6).
- Full-scale error
The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from 1111111110 to 1111111111 (see figure 12.6).
- Nonlinearity error
The error with respect to the ideal A/D conversion characteristics between zero voltage and full-scale voltage. Does not include offset error, full-scale error, or quantization error.
- Absolute accuracy
The deviation between the digital value and the analog input value. Includes offset error, full-scale error, quantization error, and nonlinearity error.

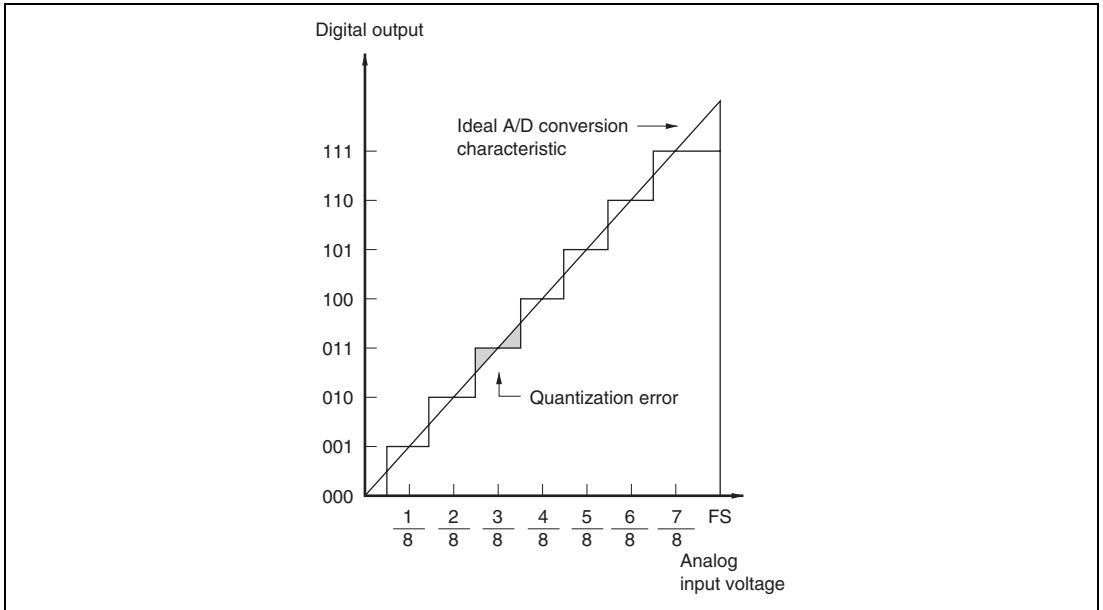


Figure 12.5 A/D Conversion Accuracy Definitions (1)

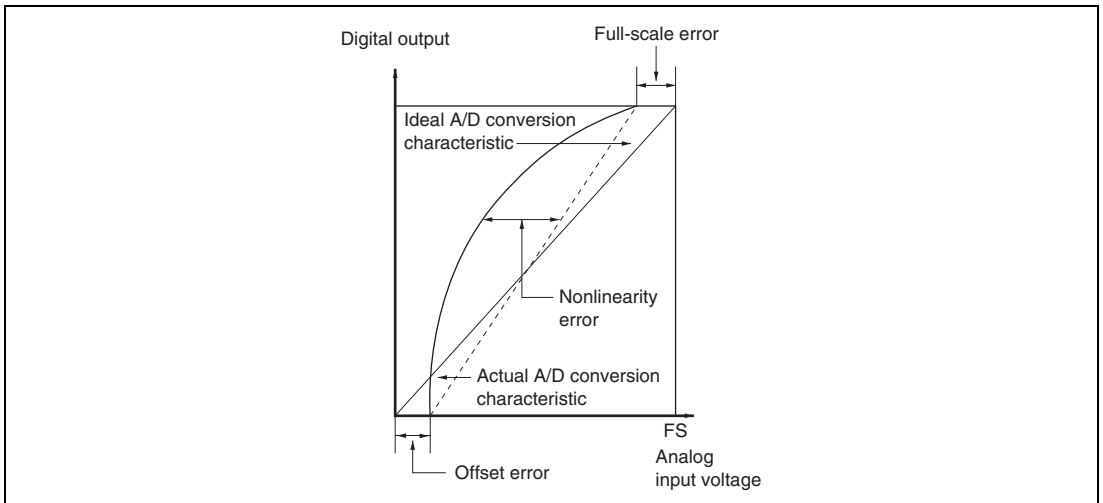


Figure 12.6 A/D Conversion Accuracy Definitions (2)

12.7 Usage Notes

12.7.1 Permissible Signal Source Impedance

This LSI's analog input is designed such that conversion accuracy is guaranteed for an input signal for which the signal source impedance is 10 k Ω or less. This specification is provided to enable the A/D converter's sample-and-hold circuit input capacitance to be charged within the sampling time; if the sensor output impedance exceeds 10 k Ω , charging may be insufficient and it may not be possible to guarantee A/D conversion accuracy.

As a countermeasure, a large capacitance can be provided externally to the analog input pin. This will cause the actual input resistance to comprise only the internal input resistance of 10 k Ω , the signal source impedance does not need to be taken into consideration. This countermeasure has the disadvantage of creating a low-pass filter from the signal source impedance and capacitance, with the result that it may not be possible to follow analog signals having a large differential coefficient (e.g., 5 mV/ μ s or greater) (see figure 12.7). When converting a high-speed analog signal, a low-impedance buffer should be inserted.

12.7.2 Influences on Absolute Accuracy

Adding capacitance results in coupling with GND, and therefore noise in GND may adversely affect absolute accuracy. Be sure to make the connection to an electrically stable GND.

Care is also required to ensure that filter circuits do not interfere with digital signals or act as antennas on the mounting board.

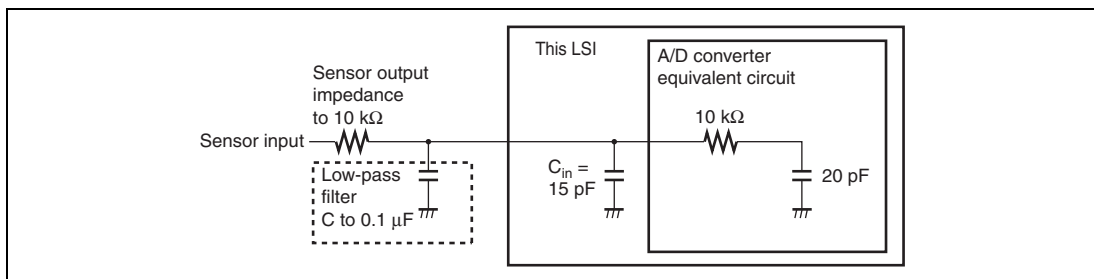


Figure 12.7 Example of Analog Input Circuit

12.7.3 Additional Usage Notes

1. ADRRH and ADRRL should be read only when the ADSF bit in ADSR is cleared to 0.
2. Changing the digital input signal at an adjacent pin during A/D conversion may adversely affect conversion accuracy.
3. When A/D conversion is started after clearing module standby mode, wait for 10 ϕ clock cycles before starting A/D conversion.
4. In active mode and sleep mode, the analog power supply current flows in the ladder resistance even when the A/D converter is on standby. Therefore, if the A/D converter is not used, it is recommended that AV_{CC} be connected to the system power supply and the ADCKSTP bit be cleared to 0 in CKSTPR1.

Section 13 List of Registers

The register list gives information on the on-chip I/O register addresses, how the register bits are configured, and the register states in each operating mode. The information is given as shown below.

1. Register addresses (address order)
 - Registers are listed from the lower allocation addresses.
 - Registers are classified by functional modules.
 - The data bus width is indicated.
 - The number of access states is indicated.
2. Register bits
 - Bit configurations of the registers are described in the same order as the register addresses.
 - Reserved bits are indicated by — in the bit name column.
 - When registers consist of 16 bits, bits are described from the MSB side.
3. Register states in each operating mode
 - Register states are described in the same order as the register addresses.
 - The register states described here are for the basic operating modes. If there is a specific reset for an on-chip peripheral module, refer to the section on that on-chip peripheral module.

13.1 Register Addresses (Address Order)

The data bus width indicates the numbers of bits by which the register is accessed.

The number of access states indicates the number of states based on the specified reference clock.

| Register Name | Abbreviation | Bit No | Address | Module Name | Data Bus Access Width | Access State |
|---------------------------------------|--------------|--------|---------|-------------------|-----------------------|--------------|
| Flash memory control register 1 | FLMCR1 | 8 | H'F020 | ROM | 8 | 2 |
| Flash memory control register 2 | FLMCR2 | 8 | H'F021 | ROM | 8 | 2 |
| Flash memory power control register | FLPWCR | 8 | H'F022 | ROM | 8 | 2 |
| Erase block register | EBR | 8 | H'F023 | ROM | 8 | 2 |
| Flash memory enable register | FENR | 8 | H'F02B | ROM | 8 | 2 |
| Event counter PWM compare register H | ECPWCRH | 8 | H'FF8C | AEC ^{*1} | 8 | 2 |
| Event counter PWM compare register L | ECPWCRL | 8 | H'FF8D | AEC ^{*1} | 8 | 2 |
| Event counter PWM data register H | ECPWDRH | 8 | H'FF8E | AEC ^{*1} | 8 | 2 |
| Event counter PWM data register L | ECPWDRL | 8 | H'FF8F | AEC ^{*1} | 8 | 2 |
| Wakeup edge select register | WEGR | 8 | H'FF90 | Interrupts | 8 | 2 |
| Serial port control register | SPCR | 8 | H'FF91 | SCI3 | 8 | 2 |
| Input pin edge select register | AEGSR | 8 | H'FF92 | AEC ^{*1} | 8 | 2 |
| Event counter control register | ECCR | 8 | H'FF94 | AEC ^{*1} | 8 | 2 |
| Event counter control/status register | ECCSR | 8 | H'FF95 | AEC ^{*1} | 8 | 2 |
| Event counter H | ECH | 8 | H'FF96 | AEC ^{*1} | 8 | 2 |
| Event counter L | ECL | 8 | H'FF97 | AEC ^{*1} | 8 | 2 |
| Serial mode register | SMR | 8 | H'FFA8 | SCI3 | 8 | 3 |
| Bit rate register | BRR | 8 | H'FFA9 | SCI3 | 8 | 3 |
| Serial control register 3 | SCR3 | 8 | H'FFAA | SCI3 | 8 | 3 |
| Transmit data register | TDR | 8 | H'FFAB | SCI3 | 8 | 3 |
| Serial status register | SSR | 8 | H'FFAC | SCI3 | 8 | 3 |
| Receive data register | RDR | 8 | H'FFAD | SCI3 | 8 | 3 |

| Register Name | Abbreviation | Bit No | Address | Module Name | Data Bus Width | Access State |
|---------------------------------|--------------|--------|---------|-------------------|----------------|--------------|
| Timer mode register A | TMA | 8 | H'FFB0 | Timer A | 8 | 2 |
| Timer counter A | TCA | 8 | H'FFB1 | Timer A | 8 | 2 |
| Timer control/status register W | TCSRW | 8 | H'FFB2 | WDT ^{*2} | 8 | 2 |
| Timer counter W | TCW | 8 | H'FFB3 | WDT ^{*2} | 8 | 2 |
| Timer control register F | TCRF | 8 | H'FFB6 | Timer F | 8 | 2 |
| Timer control status register F | TCSRFB | 8 | H'FFB7 | Timer F | 8 | 2 |
| 8-bit timer counter FH | TCFH | 8 | H'FFB8 | Timer F | 8 | 2 |
| 8-bit timer counter FL | TCFL | 8 | H'FFB9 | Timer F | 8 | 2 |
| Output compare register FH | OCRFH | 8 | H'FFBA | Timer F | 8 | 2 |
| Output compare register FL | OCRFL | 8 | H'FFBB | Timer F | 8 | 2 |
| A/D result register H | ADRRH | 8 | H'FFC4 | A/D converter | 8 | 2 |
| A/D result register L | ADRRL | 8 | H'FFC5 | A/D converter | 8 | 2 |
| A/D mode register | AMR | 8 | H'FFC6 | A/D converter | 8 | 2 |
| A/D start register | ADSR | 8 | H'FFC7 | A/D converter | 8 | 2 |
| Port mode register 2 | PMR2 | 8 | H'FFC9 | I/O port | 8 | 2 |
| Port mode register 3 | PMR3 | 8 | H'FFCA | I/O port | 8 | 2 |
| Port mode register 5 | PMR5 | 8 | H'FFCC | I/O port | 8 | 2 |
| PWM2 control register | PWCR2 | 8 | H'FFCD | 10-bit PWM | 8 | 2 |
| PWM2 data register U | PWDRU2 | 8 | H'FFCE | 10-bit PWM | 8 | 2 |
| PWM2 data register L | PWDRL2 | 8 | H'FFCF | 10-bit PWM | 8 | 2 |
| PWM1 control register | PWCR1 | 8 | H'FFD0 | 10-bit PWM | 8 | 2 |
| PWM1 data register U | PWDRU1 | 8 | H'FFD1 | 10-bit PWM | 8 | 2 |
| PWM1 data register L | PWDRL1 | 8 | H'FFD2 | 10-bit PWM | 8 | 2 |
| Port data register 3 | PDR3 | 8 | H'FFD6 | I/O port | 8 | 2 |
| Port data register 4 | PDR4 | 8 | H'FFD7 | I/O port | 8 | 2 |
| Port data register 5 | PDR5 | 8 | H'FFD8 | I/O port | 8 | 2 |
| Port data register 6 | PDR6 | 8 | H'FFD9 | I/O port | 8 | 2 |
| Port data register 7 | PDR7 | 8 | H'FFDA | I/O port | 8 | 2 |
| Port data register 8 | PDR8 | 8 | H'FFDB | I/O port | 8 | 2 |
| Port data register 9 | PDR9 | 8 | H'FFDC | I/O port | 8 | 2 |
| Port data register A | PDRA | 8 | H'FFDD | I/O port | 8 | 2 |

| Register Name | Abbreviation | Bit No | Address | Module Name | Data Bus Access Width | Access State |
|-----------------------------------|--------------|--------|---------|-------------|-----------------------|--------------|
| Port data register B | PDRB | 8 | H'FFDE | I/O port | 8 | 2 |
| Port pull-up control register 3 | PUCR3 | 8 | H'FFE1 | I/O port | 8 | 2 |
| Port pull-up control register 5 | PUCR5 | 8 | H'FFE2 | I/O port | 8 | 2 |
| Port pull-up control register 6 | PUCR6 | 8 | H'FFE3 | I/O port | 8 | 2 |
| Port control register 3 | PCR3 | 8 | H'FFE6 | I/O port | 8 | 2 |
| Port control register 4 | PCR4 | 8 | H'FFE7 | I/O port | 8 | 2 |
| Port control register 5 | PCR5 | 8 | H'FFE8 | I/O port | 8 | 2 |
| Port control register 6 | PCR6 | 8 | H'FFE9 | I/O port | 8 | 2 |
| Port control register 7 | PCR7 | 8 | H'FFEA | I/O port | 8 | 2 |
| Port control register 8 | PCR8 | 8 | H'FFEB | I/O port | 8 | 2 |
| Port mode register 9 | PMR9 | 8 | H'FFEC | I/O port | 8 | 2 |
| Port control register A | PCRA | 8 | H'FFED | I/O port | 8 | 2 |
| Port mode register B | PMRB | 8 | H'FFEE | I/O port | 8 | 2 |
| System control register 1 | SYSCR1 | 8 | H'FFF0 | SYSTEM | 8 | 2 |
| System control register 2 | SYSCR2 | 8 | H'FFF1 | SYSTEM | 8 | 2 |
| IRQ edge select register | IEGR | 8 | H'FFF2 | Interrupts | 8 | 2 |
| Interrupt enable register 1 | IENR1 | 8 | H'FFF3 | Interrupts | 8 | 2 |
| Interrupt enable register 2 | IENR2 | 8 | H'FFF4 | Interrupts | 8 | 2 |
| Interrupt request register 1 | IRR1 | 8 | H'FFF6 | Interrupts | 8 | 2 |
| Interrupt request register 2 | IRR2 | 8 | H'FFF7 | Interrupts | 8 | 2 |
| Wakeup interrupt request register | IWPR | 8 | H'FFF9 | Interrupts | 8 | 2 |
| Clock stop register 1 | CKSTPR1 | 8 | H'FFFA | SYSTEM | 8 | 2 |
| Clock stop register 2 | CKSTPR2 | 8 | H'FFFB | SYSTEM | 8 | 2 |

Notes: 1. AEC: Asynchronous event counter
2. WDT: Watchdog timer

13.2 Register Bits

Register bit names of the on-chip peripheral modules are described below.

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module Name |
|-----------------------|----------|----------|----------|----------|----------|----------|----------|----------|-------------------|
| FLMCR1 | — | SWE | ESU | PSU | EV | PV | E | P | ROM |
| FLMCR2 | FLER | — | — | — | — | — | — | — | |
| FLPWCR | PDWND | — | — | — | — | — | — | — | |
| EBR | — | — | — | EB4 | EB3 | EB2 | EB1 | EB0 | |
| FENR | FLSHE | — | — | — | — | — | — | — | |
| ECPWCRH | ECPWCRH7 | ECPWCRH6 | ECPWCRH5 | ECPWCRH4 | ECPWCRH3 | ECPWCRH2 | ECPWCRH1 | ECPWCRH0 | AEC* ¹ |
| ECPWCRL | ECPWCRL7 | ECPWCRL6 | ECPWCRL5 | ECPWCRL4 | ECPWCRL3 | ECPWCRL2 | ECPWCRL1 | ECPWCRL0 | |
| ECPWDRH | ECPWDRH7 | ECPWDRH6 | ECPWDRH5 | ECPWDRH4 | ECPWDRH3 | ECPWDRH2 | ECPWDRH1 | ECPWDRH0 | |
| ECPWDRL | ECPWDRL7 | ECPWDRL6 | ECPWDRL5 | ECPWDRL4 | ECPWDRL3 | ECPWDRL2 | ECPWDRL1 | ECPWDRL0 | |
| WEGR | WKEGS7 | WKEGS6 | WKEGS5 | WKEGS4 | WKEGS3 | WKEGS2 | WKEGS1 | WKEGS0 | Interrupts |
| SPCR | — | — | SPC32 | — | SCINV3 | SCINV2 | — | — | SCI3 |
| AEGSR | AHEGS1 | AHEGS0 | ALEGS1 | ALEGS0 | AIEGS1 | AIEGS0 | ECPWME | — | AEC* ¹ |
| ECCR | ACKH1 | ACKH0 | ACKL1 | ACKL0 | PWCK2 | PWCK1 | PWCK0 | — | |
| ECCSR | OVH | OVL | — | CH2 | CUEH | CUEL | CRCH | CRCL | |
| ECH | ECH7 | ECH6 | ECH5 | ECH4 | ECH3 | ECH2 | ECH1 | ECH0 | |
| ECL | ECL7 | ECL6 | ECL5 | ECL4 | ECL3 | ECL2 | ECL1 | ECL0 | |
| SMR | COM | CHR | PE | PM | STOP | MP | CKS1 | CKS0 | SCI3 |
| BRR | BRR7 | BRR6 | BRR5 | BRR4 | BRR3 | BRR2 | BRR1 | BRR0 | |
| SCR3 | TIE | RIE | TE | RE | — | TEIE | CKE1 | CKE0 | |
| TDR | TDR7 | TDR6 | TDR5 | TDR4 | TDR3 | TDR2 | TDR1 | TDR0 | |
| SSR | TDRE | RDRF | OER | FER | PER | TEND | MPBR | MPBT | |
| RDR | RDR7 | RDR6 | RDR5 | RDR4 | RDR3 | RDR2 | RDR1 | RDR0 | |
| TMA | — | — | — | — | TMA3 | TMA2 | TMA1 | TMA0 | Timer A |
| TCA | TCA7 | TCA6 | TCA5 | TCA4 | TCA3 | TCA2 | TCA1 | TCA0 | |
| TCSRW | B6WI | TCWE | B4WI | TCSRWE | B2WI | WDON | BOWI | WRST | WDT* ² |
| TCW | TCW7 | TCW6 | TCW5 | TCW4 | TCW3 | TCW2 | TCW1 | TCW0 | |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module Name |
|-----------------------|---------|---------|---------|---------|---------|---------|---------|---------|---------------|
| TCRF | TOLH | CKSH2 | CKSH1 | CKSH0 | TOLL | CKSL2 | CKSL1 | CKSL0 | Timer F |
| TCSR | OVFH | CMFH | OVIEH | CCLR | OVFL | CMFL | OVIEL | CCLRL | |
| TCFH | TCFH7 | TCFH6 | TCFH5 | TCFH4 | TCFH3 | TCFH2 | TCFH1 | TCFH0 | |
| TCFL | TCFL7 | TCFL6 | TCFL5 | TCFL4 | TCFL3 | TCFL2 | TCFL1 | TCFL0 | |
| OCRFH | OCRFH7 | OCRFH6 | OCRFH5 | OCRFH4 | OCRFH3 | OCRFH2 | OCRFH1 | OCRFH0 | |
| OCRFL | OCRFL7 | OCRFL6 | OCRFL5 | OCRFL4 | OCRFL3 | OCRFL2 | OCRFL1 | OCRFL0 | |
| ADRRH | ADR9 | ADR8 | ADR7 | ADR6 | ADR5 | ADR4 | ADR3 | ADR2 | A/D converter |
| ADRRL | ADR1 | ADR0 | — | — | — | — | — | — | |
| AMR | CKS | — | — | — | CH3 | CH2 | CH1 | CH0 | |
| ADSR | ADSF | — | — | — | — | — | — | — | |
| PMR2 | — | — | POF1 | — | — | WDCKS | — | IRQ0 | I/O port |
| PMR3 | AEVL | AEVH | — | — | — | TMOFH | TMOFL | — | |
| PMR5 | WKP7 | WKP6 | WKP5 | WKP4 | WKP3 | WKP2 | WKP1 | WKP0 | |
| PWCR2 | — | — | — | — | — | — | PWCR21 | PWCR20 | 10-bit PWM |
| PWDRU2 | — | — | — | — | — | — | PWDRU21 | PWDRU20 | |
| PWDRL2 | PWDRL27 | PWDRL26 | PWDRL25 | PWDRL24 | PWDRL23 | PWDRL22 | PWDRL21 | PWDRL20 | |
| PWCR1 | — | — | — | — | — | — | PWCR11 | PWCR10 | |
| PWDRU1 | — | — | — | — | — | — | PWDRU11 | PWDRU10 | |
| PWDRL1 | PWDRL17 | PWDRL16 | PWDRL15 | PWDRL14 | PWDRL13 | PWDRL12 | PWDRL11 | PWDRL10 | |
| PDR3 | P37 | P36 | P35 | P34 | P33 | P32 | P31 | — | I/O port |
| PDR4 | — | — | — | — | P43 | P42 | P41 | P40 | |
| PDR5 | P57 | P56 | P55 | P54 | P53 | P52 | P51 | P50 | |
| PDR6 | P67 | P66 | P65 | P64 | P63 | P62 | P61 | P60 | |
| PDR7 | P77 | P76 | P75 | P74 | P73 | P72 | P71 | P70 | |
| PDR8 | — | — | — | — | — | — | — | P80 | |
| PDR9 | — | — | P95 | P94 | P93 | P92 | P91 | P90 | |
| PDRA | — | — | — | — | PA3 | PA2 | PA1 | PA0 | |
| PDRB | — | — | — | — | PB3 | PB2 | PB1 | PB0 | |
| PUCR3 | PUCR37 | PUCR36 | PUCR35 | PUCR34 | PUCR33 | PUCR32 | PUCR31 | — | |
| PUCR5 | PUCR57 | PUCR56 | PUCR55 | PUCR54 | PUCR53 | PUCR52 | PUCR51 | PUCR50 | |
| PUCR6 | PUCR67 | PUCR66 | PUCR65 | PUCR64 | PUCR63 | PUCR62 | PUCR61 | PUCR60 | |
| PCR3 | PCR37 | PCR36 | PCR35 | PCR34 | PCR33 | PCR32 | PCR31 | — | |
| PCR4 | — | — | — | — | — | PCR42 | PCR41 | PCR40 | |

| Register Abbreviation | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Module Name |
|-----------------------|--------|-------|----------|----------|---------|---------|----------|---------|-------------|
| PCR5 | PCR57 | PCR56 | PCR55 | PCR54 | PCR53 | PCR52 | PCR51 | PCR50 | I/O port |
| PCR6 | PCR67 | PCR66 | PCR65 | PCR64 | PCR63 | PCR62 | PCR61 | PCR60 | |
| PCR7 | PCR77 | PCR76 | PCR75 | PCR74 | PCR73 | PCR72 | PCR71 | PCR70 | |
| PCR8 | — | — | — | — | — | — | — | PCR80 | |
| PMR9 | — | — | — | — | PIOFF | — | PWM2 | PWM1 | |
| PCRA | — | — | — | — | PCRA3 | PCRA2 | PCRA1 | PCRA0 | |
| PMRB | — | — | — | — | IRQ1 | — | — | — | |
| SYSCR1 | SSBY | STS2 | STS1 | STS0 | LSON | — | MA1 | MA0 | SYSTEM |
| SYSCR2 | — | — | — | NESEL | DTON | MSON | SA1 | SA0 | |
| IEGR | — | — | — | — | — | — | IEG1 | IEG0 | Interrupts |
| IENR1 | IENTA | — | IENWP | — | — | IENEC2 | IEN1 | IEN0 | |
| IENR2 | IENDT | IENAD | — | — | IENTFH | IENTFL | — | IENEC | |
| IRR1 | IRRRTA | — | — | — | — | IRREC2 | IRRI1 | IRRI0 | Interrupts |
| IRR2 | IRRDT | IRRAD | — | — | IRRTFH | IRRTFL | — | IRREC | |
| IWPR | IWPF7 | IWPF6 | IWPF5 | IWPF4 | IWPF3 | IWPF2 | IWPF1 | IWPF0 | Interrupts |
| CKSTPR1 | — | — | S32CKSTP | ADCKSTP | — | TFCKSTP | — | TACKSTP | SYSTEM |
| CKSTPR2 | — | — | — | PW2CKSTP | AECKSTP | WDCKSTP | PW1CKSTP | — | |

Notes: 1. AEC: Asynchronous event counter
2. WDT: Watchdog timer

13.3 Register States in Each Operating Mode

| Register Abbreviation | Reset | Active | Sleep | Watch | Subactive | Subsleep | Standby | Module |
|--------------------------|-------------|--------|-------|-------------|-------------|-------------|-------------|-------------------|
| FLMCR1 | Initialized | — | — | Initialized | Initialized | Initialized | Initialized | ROM |
| FLMCR2 | Initialized | — | — | — | — | — | — | |
| FLPWCR | Initialized | — | — | — | — | — | — | |
| EBR | Initialized | — | — | Initialized | Initialized | Initialized | Initialized | |
| FENR | Initialized | — | — | — | — | — | — | |
| ECPWCRH | Initialized | — | — | — | — | — | — | AEC ^{*1} |
| ECPWCRL | Initialized | — | — | — | — | — | — | |
| ECPWDRH | Initialized | — | — | — | — | — | — | |
| ECPWDRL | Initialized | — | — | — | — | — | — | |
| WEGR | Initialized | — | — | — | — | — | — | Interrupts |
| SPCR | Initialized | — | — | — | — | — | — | SCI3 |
| AEGSR | Initialized | — | — | — | — | — | — | AEC ^{*1} |
| ECCR | Initialized | — | — | — | — | — | — | |
| ECCSR | Initialized | — | — | — | — | — | — | |
| ECH | Initialized | — | — | — | — | — | — | |
| ECL | Initialized | — | — | — | — | — | — | |
| SMR | Initialized | — | — | Initialized | — | — | Initialized | SCI3 |
| BRR | Initialized | — | — | Initialized | — | — | Initialized | |
| SCR3 | Initialized | — | — | Initialized | — | — | Initialized | |
| TDR | Initialized | — | — | Initialized | — | — | Initialized | |
| SSR | Initialized | — | — | Initialized | — | — | Initialized | |
| RDR | Initialized | — | — | Initialized | — | — | Initialized | |
| TMA | Initialized | — | — | — | — | — | — | Timer A |
| TCA | Initialized | — | — | — | — | — | — | |
| TCSRW | Initialized | — | — | — | — | — | — | WDT ^{*2} |
| TCW | Initialized | — | — | — | — | — | — | |

| Register Abbreviation | Reset | Active | Sleep | Watch | Subactive | Subsleep | Standby | Module |
|--------------------------|-------------|--------|-------|-------------|-------------|-------------|-------------|---------------|
| TCRF | Initialized | — | — | — | — | — | — | Timer F |
| TCSRF | Initialized | — | — | — | — | — | — | |
| TCFH | Initialized | — | — | — | — | — | — | |
| TCFL | Initialized | — | — | — | — | — | — | |
| OCRFH | Initialized | — | — | — | — | — | — | |
| OCRFL | Initialized | — | — | — | — | — | — | |
| ADRRH | — | — | — | — | — | — | — | |
| ADRRL | — | — | — | — | — | — | — | |
| AMR | Initialized | — | — | — | — | — | — | |
| ADSR | Initialized | — | — | Initialized | Initialized | Initialized | Initialized | |
| PMR2 | Initialized | — | — | — | — | — | — | I/O port |
| PMR3 | Initialized | — | — | — | — | — | — | |
| PMR5 | Initialized | — | — | — | — | — | — | |
| PWCR2 | Initialized | — | — | — | — | — | — | 10-bit PWM |
| PWDRU2 | Initialized | — | — | — | — | — | — | |
| PWDRL2 | Initialized | — | — | — | — | — | — | |
| PWCR1 | Initialized | — | — | — | — | — | — | |
| PWDRU1 | Initialized | — | — | — | — | — | — | |
| PWDRL1 | Initialized | — | — | — | — | — | — | |
| PDR3 | Initialized | — | — | — | — | — | — | |
| PDR4 | Initialized | — | — | — | — | — | — | |
| PDR5 | Initialized | — | — | — | — | — | — | |
| PDR6 | Initialized | — | — | — | — | — | — | |
| PDR7 | Initialized | — | — | — | — | — | — | |
| PDR8 | Initialized | — | — | — | — | — | — | |
| PDR9 | Initialized | — | — | — | — | — | — | |
| PDRA | Initialized | — | — | — | — | — | — | |
| PDRB | Initialized | — | — | — | — | — | — | |
| PUCR3 | Initialized | — | — | — | — | — | — | |
| PUCR5 | Initialized | — | — | — | — | — | — | |
| PUCR6 | Initialized | — | — | — | — | — | — | |
| PCR3 | Initialized | — | — | — | — | — | — | |
| PCR4 | Initialized | — | — | — | — | — | — | |

| Register Abbreviation | Reset | Active | Sleep | Watch | Subactive | Subsleep | Standby | Module |
|--------------------------|-------------|--------|-------|-------|-----------|----------|---------|------------|
| PCR5 | Initialized | — | — | — | — | — | — | I/O port |
| PCR6 | Initialized | — | — | — | — | — | — | |
| PCR7 | Initialized | — | — | — | — | — | — | |
| PCR8 | Initialized | — | — | — | — | — | — | |
| PMR9 | Initialized | — | — | — | — | — | — | |
| PCRA | Initialized | — | — | — | — | — | — | |
| PMRB | Initialized | — | — | — | — | — | — | |
| SYSCR1 | Initialized | — | — | — | — | — | — | SYSTEM |
| SYSCR2 | Initialized | — | — | — | — | — | — | |
| IEGR | Initialized | — | — | — | — | — | — | Interrupts |
| IENR1 | Initialized | — | — | — | — | — | — | |
| IENR2 | Initialized | — | — | — | — | — | — | |
| IRR1 | Initialized | — | — | — | — | — | — | |
| IRR2 | Initialized | — | — | — | — | — | — | |
| IWPR | Initialized | — | — | — | — | — | — | |
| CKSTPR1 | Initialized | — | — | — | — | — | — | SYSTEM |
| CKSTPR2 | Initialized | — | — | — | — | — | — | |

Notes: — is not initialized

1. AEC: Asynchronous event counter
2. WDT: Watchdog timer

Section 14 Electrical Characteristics

14.1 Absolute Maximum Ratings of H8/38704 Group (Flash Memory Version, Mask ROM Version), H8/38702S Group (Mask ROM Version)

Table 14.1 lists the absolute maximum ratings.

Table 14.1 Absolute Maximum Ratings

| Item | Symbol | Value | Unit | Note |
|-----------------------------|-------------------|--|-------------------------|------|
| Power supply voltage | V_{CC} | -0.3 to +4.3 | V | *1 |
| Analog power supply voltage | AV_{CC} | -0.3 to +4.3 | V | |
| Input voltage | Other than port B | V_{in} | -0.3 to $V_{CC} + 0.3$ | V |
| | Port B | AV_{in} | -0.3 to $AV_{CC} + 0.3$ | V |
| Port 9 pin voltage | V_{P9} | -0.3 to $V_{CC} + 0.3$ | V | |
| Operating temperature | T_{opr} | Regular specifications: | °C | |
| | | -20 to +75*2 | | |
| | | Wide-range temperature specifications: | | |
| | | -40 to +85*3 | | |
| Storage temperature | T_{stg} | -55 to +125 | °C | |

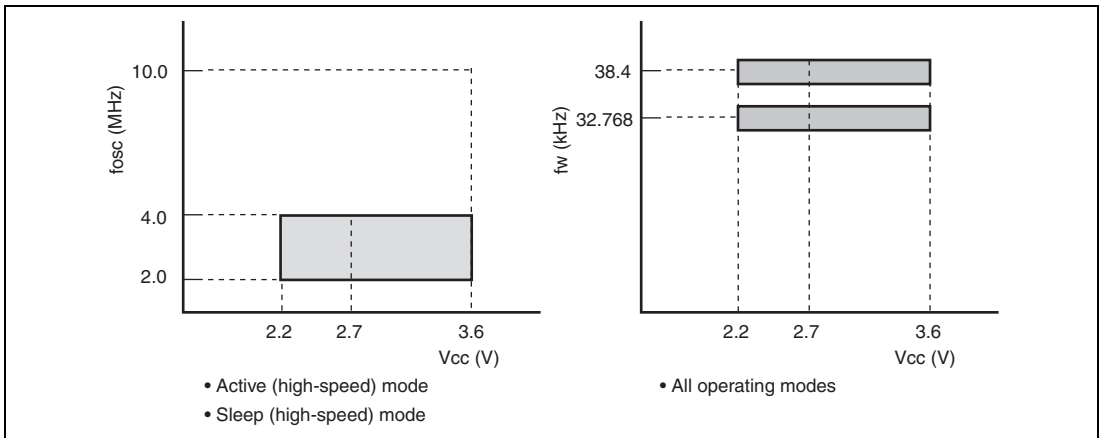
- Notes: 1. Permanent damage may result if maximum ratings are exceeded. Normal operation should be under the conditions specified in Electrical Characteristics. Exceeding these values can result in incorrect operation and reduced reliability.
2. When the operating voltage is $V_{CC} = 2.7$ to 3.6 V during flash memory reading, the operating temperature ranges from -20°C to $+75^{\circ}\text{C}$ when programming or erasing the flash memory. When the operating voltage is $V_{CC} = 2.2$ to 3.6 V during flash memory reading, the operating temperature ranges from -20°C to $+50^{\circ}\text{C}$ when programming or erasing the flash memory.
3. The operating temperature ranges from -20°C to $+75^{\circ}\text{C}$ when programming or erasing the flash memory.

14.2 Electrical Characteristics of H8/38704 Group (Flash Memory Version, Mask ROM Version), H8/38702S Group (Mask ROM Version)

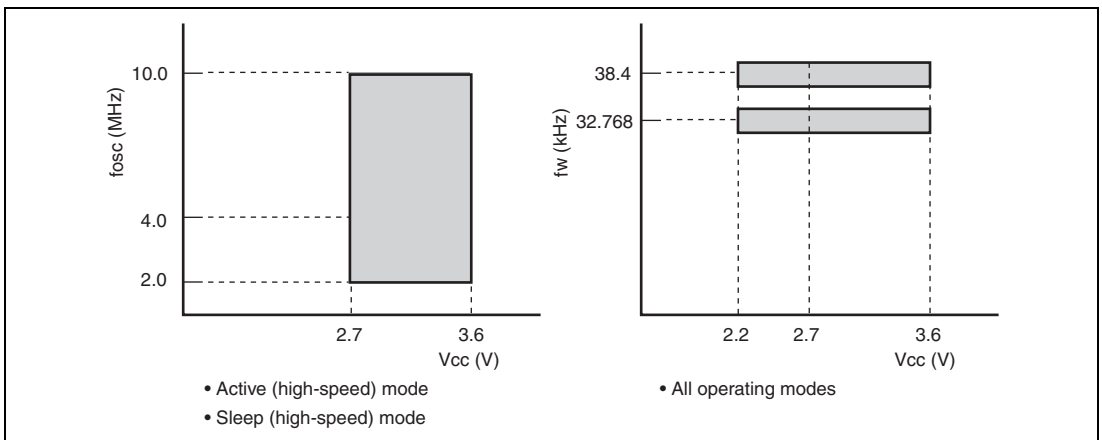
14.2.1 Power Supply Voltage and Operating Ranges

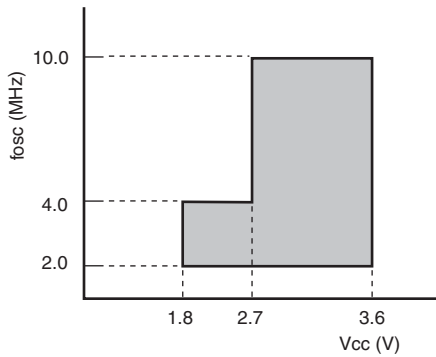
(1) Power Supply Voltage and Oscillation Frequency Range (Flash Memory Version)

(a) 4-MHz Specification

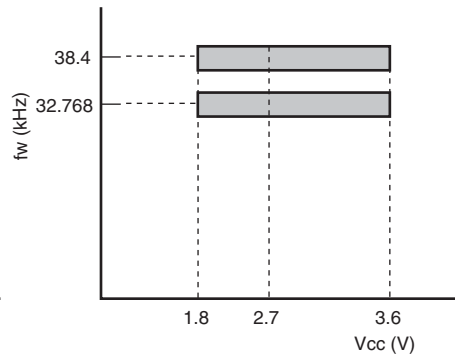


(b) 10-MHz Specification



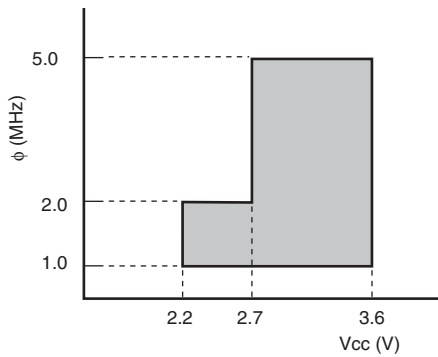
(2) Power Supply Voltage and Oscillation Frequency Range (Mask ROM Version)

- Active (high-speed) mode
- Sleep (high-speed) mode

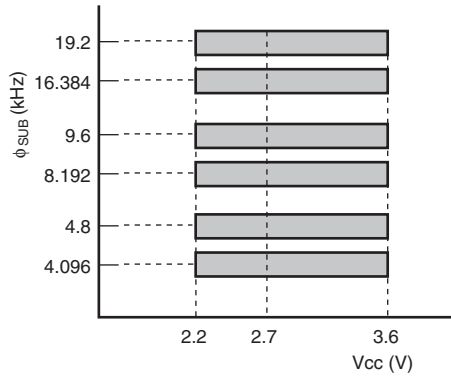


- All operating modes
- When a resonator is used, hold Vcc at 2.2 V to 3.6 V from power-on until the oscillation stabilization time has elapsed.

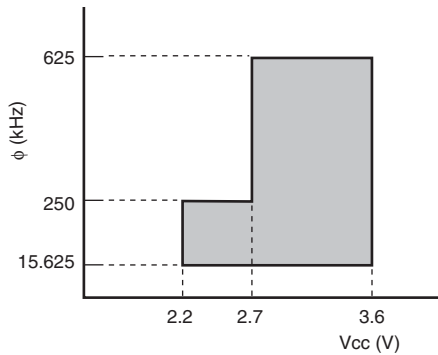
(3) Power Supply Voltage and Operating Frequency Range (Flash Memory Version)



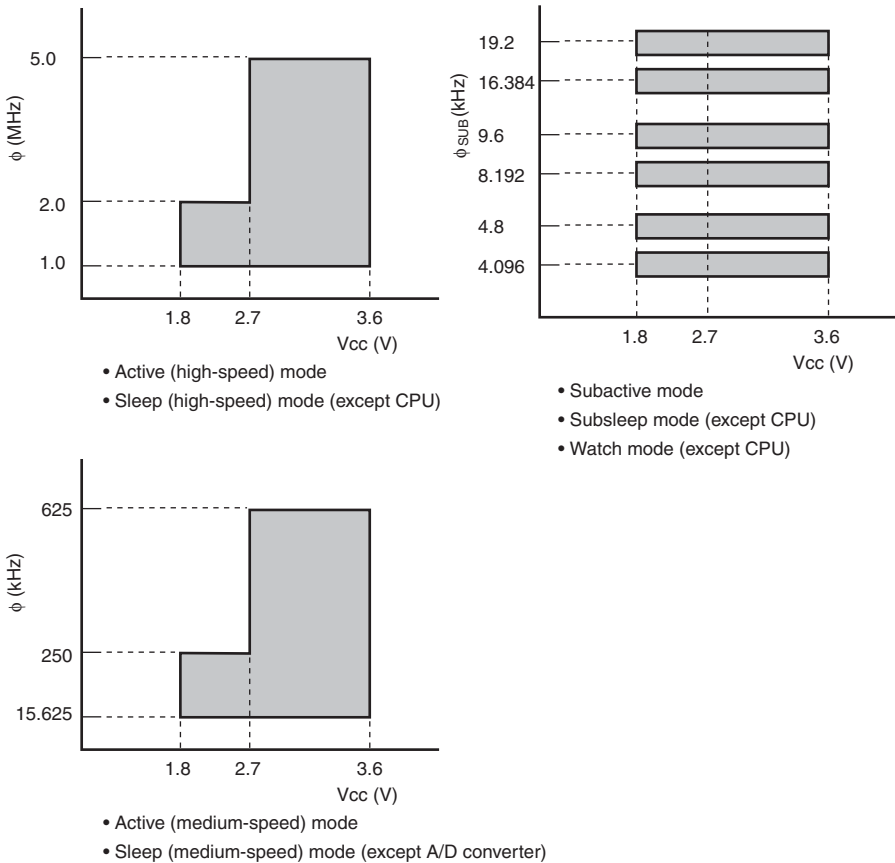
- Active (high-speed) mode
- Sleep (high-speed) mode (except CPU)



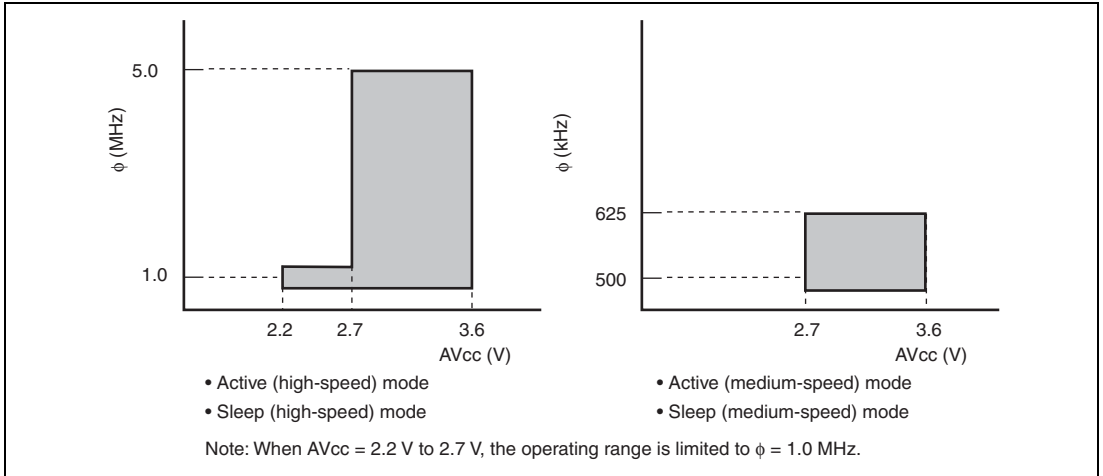
- Subactive mode
- Subsleeper mode (except CPU)
- Watch mode (except CPU)



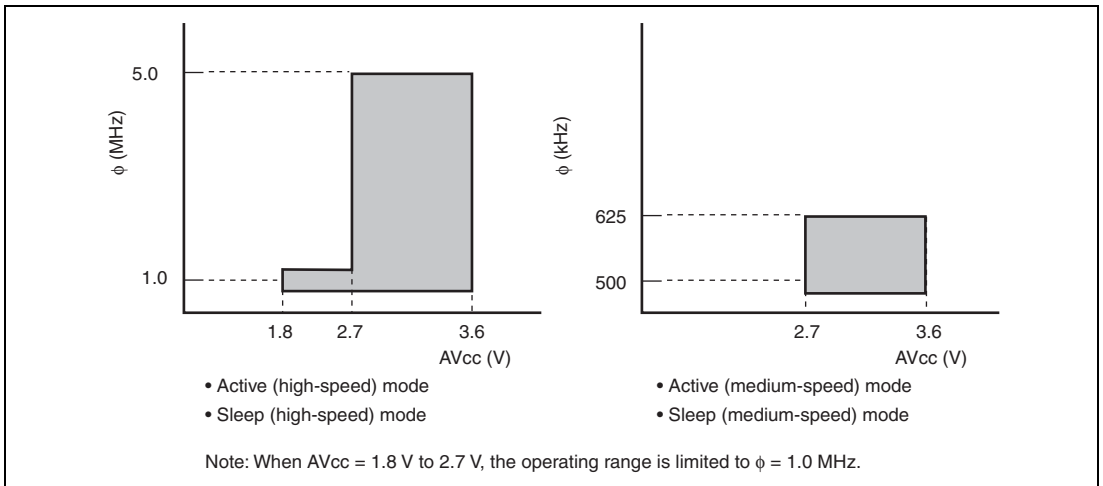
- Active (medium-speed) mode
- Sleep (medium-speed) mode (except A/D converter)

(4) Power Supply Voltage and Operating Frequency Range (Mask ROM Version)

(5) Analog Power Supply Voltage and A/D Converter Operating Range (Flash Memory Version)



(6) Analog Power Supply Voltage and A/D Converter Operating Range (Mask ROM Version)



14.2.2 DC Characteristics

Table 14.2 lists the DC characteristics.

Table 14.2 DC Characteristics

One of following conditions is applied unless otherwise specified.

Condition A (Flash memory version): $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition B (Flash memory version): $V_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition C (Mask ROM version): $V_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|--------------------|----------|---|--|---------------------|------|-----------------|------|-------|
| | | | | Min. | Typ. | Max. | | |
| Input high voltage | V_{IH} | RES, WKP0 to WKP7, IRQ0, AEVL, AEVH, SCK32 | | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | | IRQ1 | | $V_{CC} \times 0.9$ | — | $AV_{CC} + 0.3$ | V | |
| | | RXD32 | | $V_{CC} \times 0.8$ | — | $V_{CC} + 0.3$ | V | |
| | | OSC1 | | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | | X1 | $V_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$ | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |
| | | P31 to P37, P40 to P43, P50 to P57, P60 to P67, P70 to P77, P80, PA0 to PA3 | | $V_{CC} \times 0.8$ | — | $V_{CC} + 0.3$ | V | |
| | | PB0 to PB3 | | $V_{CC} \times 0.8$ | — | $AV_{CC} + 0.3$ | V | |
| | | IRQAEC, P95*5 | | $V_{CC} \times 0.9$ | — | $V_{CC} + 0.3$ | V | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|---------------------|----------|--|---------------------------|----------------|------|---------------------|------|-------|
| | | | | Min. | Typ. | Max. | | |
| Input low voltage | V_{IL} | RES, WKP0 to WKP7, IRQ0, IRQ1, IRQAEC, P95 ^{*5} , AEVL, AEVH, SCK32 | | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | | RXD32 | | -0.3 | — | $V_{CC} \times 0.2$ | V | |
| | | OSC1 | | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | | X1 | | -0.3 | — | $V_{CC} \times 0.1$ | V | |
| | | P31 to P37, P40 to P43, P50 to P57, P60 to P67, P70 to P77, P80, PA0 to PA3, PB0 to PB3 | | -0.3 | — | $V_{CC} \times 0.2$ | V | |
| Output high voltage | V_{OH} | P31 to P37, P40 to P42, P50 to P57, P60 to P67, P70 to P77, P80, PA0 to PA3 | $V_{CC} = 2.7$ V to 3.6 V | $V_{CC} - 1.0$ | — | — | V | |
| | | | $-I_{OH} = 1.0$ mA | | | | | |
| | | | $-I_{OH} = 0.1$ mA | $V_{CC} - 0.3$ | — | — | | |
| Output low voltage | V_{OL} | P40 to P42, P50 to P57, P60 to P67, P70 to P77, P80, PA0 to PA3, P31 to P37 | $I_{OL} = 0.4$ mA | — | — | 0.5 | V | |
| | | | | | | | | |
| | | P90 to P95 | $V_{CC} = 2.2$ V to 3.6 V | — | — | 0.5 | | |
| | | | $I_{OL} = 10.0$ mA | | | | | |
| | | $V_{CC} = 1.8$ V to 3.6 V | | | | | | |
| | | $I_{OL} = 8.0$ mA | | | | | | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|--|-----------------|--|---|--------|------|------|---------------|-------|
| | | | | Min. | Typ. | Max. | | |
| Input/ output leakage current | $ I_{IL} $ | RES, P43, OSC1, X1, P31 to P37, P40 to P42, P50 to P57, P60 to P67, P70 to P77, P80, IRQAEC, PA0 to PA3, P90 to P95 | $V_{IN} = 0.5 \text{ V to } V_{CC} - 0.5 \text{ V}$ | — | — | 1.0 | μA | |
| | | PB0 to PB3 | $V_{IN} = 0.5 \text{ V to } AV_{CC} - 0.5 \text{ V}$ | — | — | 1.0 | | |
| Pull-up MOS current | $-I_p$ | P31 to P37, P50 to P57, P60 to P67 | $V_{CC} = 3.0 \text{ V},$ $V_{IN} = 0.0 \text{ V}$ | 30 | — | 180 | μA | |
| Input capaci- tance | C_{in} | All input pins except power supply pin | $f = 1 \text{ MHz},$ $V_{IN} = 0.0 \text{ V},$ $T_a = 25^\circ\text{C}$ | — | — | 15.0 | pF | |
| Vcc start voltage | V_{CC_START} | V_{CC} | | 0 | — | 0.1 | V | *2 |
| Vcc rising slope | SV_{CC} | V_{CC} | | 0.05 | — | — | V/ms | *2 |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|----------------------------|-------------------|-----------------|---|--------|------|------|------|---|
| | | | | Min. | Typ. | Max. | | |
| Active mode supply current | I_{OPE1} | V_{CC} | Active (high-speed) mode $V_{\text{CC}} = 1.8 \text{ V}$, $f_{\text{OSC}} = 2 \text{ MHz}$ | — | 0.4 | — | mA | *1**4 Approx. max. value = $1.1 \times$ Typ. |
| | | | Active (high-speed) mode $V_{\text{CC}} = 3 \text{ V}$, $f_{\text{OSC}} = 2 \text{ MHz}$ | — | 0.6 | — | | *1**4 Approx. max. value = $1.1 \times$ Typ. |
| | | | | — | 1.0 | — | | *2**4 Approx. max. value = $1.1 \times$ Typ. |
| | | | Active (high-speed) mode $V_{\text{CC}} = 3 \text{ V}$, $f_{\text{OSC}} = 4 \text{ MHz}$ | — | 1.2 | — | | *1**4 Approx. max. value = $1.1 \times$ Typ. |
| | | | | — | 1.6 | 2.8 | | *2**4 Condition B |
| | | | Active (high-speed) mode $V_{\text{CC}} = 3 \text{ V}$, $f_{\text{OSC}} = 10 \text{ MHz}$ | — | 3.1 | 6.0 | | *1**4 *2**4 Condition A |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|----------------------------|------------|-----------------|---|--------|------|------|--|--|
| | | | | Min. | Typ. | Max. | | |
| Active mode supply current | I_{OPE2} | V_{CC} | Active (medium-speed) mode $V_{CC} = 1.8\text{ V}$, $f_{OSC} = 2\text{ MHz}$, $\phi_{OSC}/128$ | — | 0.06 | — | — | *1*3*4 Approx. max. value = $1.1 \times$ Typ. |
| | | | Active (medium-speed) mode $V_{CC} = 3\text{ V}$, $f_{OSC} = 2\text{ MHz}$, $\phi_{OSC}/128$ | — | 0.1 | — | | *1*3*4 Approx. max. value = $1.1 \times$ Typ. |
| | | | | — | 0.5 | — | *2*3*4 Approx. max. value = $1.1 \times$ Typ. | |
| | | | Active (medium-speed) mode $V_{CC} = 3\text{ V}$, $f_{OSC} = 4\text{ MHz}$, $\phi_{OSC}/128$ | — | 0.2 | — | *1*3*4 Approx. max. value = $1.1 \times$ Typ. | |
| | | | | — | 0.7 | 1.3 | *2*3*4 Condition B | |
| | | | Active (medium-speed) mode $V_{CC} = 3\text{ V}$, $f_{OSC} = 10\text{ MHz}$, $\phi_{OSC}/128$ | — | 0.6 | 1.8 | *1*3*4 Condition A | |
| | | | — | 1.0 | 1.8 | | *2*3*4 | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes | |
|---------------------------|--------------------|-----------------|--|--------|------|-----------------------|------|--|--|
| | | | | Min. | Typ. | Max. | | | |
| Sleep mode supply current | I_{SLEEP} | V_{CC} | $V_{\text{CC}} = 1.8 \text{ V},$ $f_{\text{OSC}} = 2 \text{ MHz}$ | — | 0.16 | — | mA | *1*3*4 Approx. max. value = $1.1 \times$ Typ. | |
| | | | | — | 0.3 | — | | *1*3*4 Approx. max. value = $1.1 \times$ Typ. | |
| | | | — | 0.6 | — | — | — | — | *2*3*4 Approx. max. value = $1.1 \times$ Typ. |
| | | | | | | | | | *1*3*4 Approx. max. value = $1.1 \times$ Typ. |
| | | | — | 0.9 | 2.2 | — | — | — | *2*3*4 Condition B |
| | | | | | | | | | *1*3*4 Approx. max. value = $1.1 \times$ Typ. |
| — | 1.3 | 4.8 | — | — | — | *1*3*4 Condition A | | | |
| | | | | | | *2*3*4 Condition A | | | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes | |
|-------------------------------|-------------|-----------------|---|--------|------|------|---------------|---------------------------|--------|
| | | | | Min. | Typ. | Max. | | | |
| Subactive mode supply current | I_{SUB} | V_{CC} | $V_{CC} = 1.8\text{ V}$, 32-kHz external clock input ($\phi_{SUB} = \phi_W/2$) | — | 6.2 | — | μA | *1*3*4 Reference value | |
| | | | $V_{CC} = 1.8\text{ V}$, 32-kHz crystal resonator used ($\phi_{SUB} = \phi_W/2$) | — | 5.4 | — | | | |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz external clock input ($\phi_{SUB} = \phi_W/2$) | — | 10 | 40 | | | *1*3*4 |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz crystal resonator used ($\phi_{SUB} = \phi_W/2$) | — | 11 | 40 | | | |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz external clock input ($\phi_{SUB} = \phi_W/2$) | — | 28 | 50 | | | *2*3*4 |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz crystal resonator used ($\phi_{SUB} = \phi_W/2$) | — | 25 | 50 | | | |
| Subsleep mode supply current | I_{SUBSP} | V_{CC} | $V_{CC} = 2.7\text{ V}$, 32-kHz external clock input ($\phi_{SUB} = \phi_W/2$) | — | 4.6 | 16 | μA | *3*4 | |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz crystal resonator used ($\phi_{SUB} = \phi_W/2$) | — | 5.1 | 16 | | | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Notes |
|-----------------------------|-------------|-----------------|--|--------|------|------|---------------|-----------------------------|
| | | | | Min. | Typ. | Max. | | |
| Watch mode supply current | I_{WATCH} | V_{CC} | $V_{CC} = 1.8\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz external clock input | — | 1.2 | — | μA | *1**3**4 Reference value |
| | | | $V_{CC} = 1.8\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz crystal resonator used | — | 0.6 | — | | |
| | | | $V_{CC} = 2.7\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz external clock input | — | 2.0 | — | | *3**4 Reference value |
| | | | $V_{CC} = 2.7\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz crystal resonator used | — | 2.9 | — | | |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz external clock input | — | 2.0 | 6.0 | | *3**4 |
| | | | $V_{CC} = 2.7\text{ V}$, 32-kHz crystal resonator used | — | 2.9 | 6.0 | | |
| Standby mode supply current | I_{STBY} | V_{CC} | $V_{CC} = 1.8\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz crystal resonator not used | — | 0.1 | — | μA | *1**3**4 Reference value |
| | | | $V_{CC} = 3.0\text{ V}$, $T_a = 25^\circ\text{C}$, 32-kHz crystal resonator not used | — | 0.3 | — | | *3**4 Reference value |
| | | | 32-kHz crystal resonator not used | — | 1.0 | 5.0 | | *3**4 |
| RAM data retaining voltage | V_{RAM} | V_{CC} | | 1.5 | — | — | V | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Item | Symbol |
|---|----------------|---------------------------|--|--|------|------|------|--------|
| | | | | Min. | Typ. | Max. | | |
| Allowable output low current (per pin) | I_{OL} | Output pins except port 9 | | — | — | 0.5 | mA | |
| | | | P90 to P95 | $V_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$ | — | — | | 10.0 |
| | | | | Other than above | — | — | | 8.0 |
| Allowable output low current (total) | $\sum I_{OL}$ | Output pins except port 9 | | — | — | 20.0 | mA | |
| | | Port 9 | | — | — | 60.0 | | |
| Allowable output high current (per pin) | $-I_{OH}$ | All output pins | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | — | — | 2.0 | mA | |
| | | | Other than above | — | — | 0.2 | | |
| Allowable output high current (total) | $\sum -I_{OH}$ | All output pins | | — | — | 10.0 | mA | |

Notes: Connect the TEST pin to V_{SS} .

1. Applies to the mask-ROM version.
2. Applies to the flash memory version.
3. Pin states when supply current is measured

| Mode | $\overline{\text{RES}}$ Pin | Internal State | Other Pins | Oscillator Pins |
|--|-----------------------------|--|------------|---|
| Active (high-speed) mode (I_{OPE1}) | V_{CC} | Only CPU operates | V_{CC} | System clock: crystal resonator |
| Active (medium-speed) mode (I_{OPE2}) | | | | Subclock: Pin X1 = GND |
| Sleep mode | V_{CC} | Only all on-chip timers operate | V_{CC} | |
| Subactive mode | V_{CC} | Only CPU operates | V_{CC} | System clock: crystal resonator |
| Subsleep mode | V_{CC} | Only all on-chip timers operate CPU stops | V_{CC} | Subclock: crystal resonator |
| Watch mode | V_{CC} | Only clock time base operates CPU stops | V_{CC} | |
| Standby mode | V_{CC} | CPU and timers both stop | V_{CC} | System clock: crystal resonator Subclock: Pin X1 = GND |

4. Except current which flows to the pull-up MOS or output buffer
5. Used when user mode or boot mode is determined after canceling a reset in the flash memory version

14.2.3 AC Characteristics

Table 14.3 lists the control signal timing and table 14.4 lists the serial interface timing.

Table 14.3 Control Signal Timing

One of following conditions is applied unless otherwise specified.

Condition A (Flash memory version): $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition B (Flash memory version): $V_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition C (Mask ROM version): $V_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|---------------------------------------|--------------|-----------------|--|--------|----------------|------|---------------------------|------------------|
| | | | | Min. | Typ. | Max. | | |
| System clock oscillation frequency | f_{OSC} | OSC1, OSC2 | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ in conditions A and C | 2.0 | — | 10.0 | MHz | |
| | | | Other than above in condition C and condition B | 2.0 | — | 4.0 | | |
| OSC clock (ϕ_{OSC}) cycle time | t_{OSC} | OSC1, OSC2 | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ in conditions A and C | 100 | — | 500 | ns | Figure 14.1 |
| | | | Other than above in condition C and condition B | 250 | — | 500 | | |
| System clock (ϕ) cycle time | t_{cyc} | | | 2 | — | 128 | t_{OSC} | |
| | | | | — | — | 64 | | |
| Subclock oscillation frequency | f_W | X1, X2 | | — | 32.768 or 38.4 | — | kHz | |
| Watch clock (ϕ_W) cycle time | t_W | X1, X2 | | — | 30.5 or 26.0 | — | μs | Figure 14.1 |
| Subclock (ϕ_{SUB}) cycle time | t_{subcyc} | | | 2 | — | 8 | t_W | * |
| Instruction cycle time | | | | 2 | — | — | t_{cyc} t_{subcyc} | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|--------------------------------|----------|---|---|--------|------|------|---------------|------------------|
| | | | | Min. | Typ. | Max. | | |
| Oscillation stabilization time | t_{rc} | OSC1, OSC2 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ when using crystal resonator in figure 14.8 | — | 0.8 | 2.0 | ms | Figure 14.8 |
| | | | $V_{CC} = 2.2\text{ V to }3.6\text{ V}$ when using crystal resonator in figure 14.8 and in conditions B and C | — | 1.2 | 3.0 | | |
| | | | Other than above in condition C and when using crystal resonator in figure 14.8 | — | 4.0 | — | | |
| | | | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ when using ceramic resonator in figure 14.8 and in conditions A and C | — | 20 | 45 | μs | |
| | | | $V_{CC} = 2.2\text{ V to }3.6\text{ V}$ when using ceramic resonator (1) in figure 14.8 and in conditions B and C | — | 20 | 45 | | |
| | | | Other than above in condition C and when using ceramic resonator (1) in figure 14.8 | — | 80 | — | | |
| | | | Other than above | — | — | 50 | ms | |
| Other than above | — | — | 50 | | | | | |
| t_{rc} | X1, X2 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | — | — | 2.0 | s | | |
| | | $V_{CC} = 2.2\text{ V to }3.6\text{ V}$ and in conditions B and C | — | — | 2.0 | | | |
| | | Other than above in condition C | — | 4.0 | — | | | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|---------------------------------------|-----------|-----------------------------------|---|--------|----------------|------|---------------------------|------------------|
| | | | | Min. | Typ. | Max. | | |
| External clock high width | t_{CPH} | OSC1 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ in conditions A and C | 40 | — | — | ns | Figure 14.1 |
| | | | Other than above in condition C and condition B | 100 | — | — | | |
| | | X1 | | — | 15.26 or 13.02 | — | μs | |
| External clock low width | t_{CPL} | OSC1 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ in conditions A and C | 40 | — | — | ns | Figure 14.1 |
| | | | Other than above in condition C and condition B | 100 | — | — | | |
| | | X1 | | — | 15.26 or 13.02 | — | μs | |
| External clock rise time | t_{CPr} | OSC1 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ in conditions A and C | — | — | 10 | ns | Figure 14.1 |
| | | | Other than above in condition C and condition B | — | — | 25 | | |
| | | X1 | | — | — | 55.0 | ns | |
| External clock fall time | t_{CPl} | OSC1 | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ in conditions A and C | — | — | 10 | ns | Figure 14.1 |
| | | | Other than above in condition C and condition B | — | — | 25 | | |
| | | X1 | | — | — | 55.0 | ns | |
| $\overline{\text{RES}}$ pin low width | t_{REL} | RES | | 10 | — | — | t_{cyc} | Figure 14.2 |
| Input pin high width | t_{IH} | IRQ0, IRQ1, IRQAEC, WKP0 to WKP7, | | 2 | — | — | t_{cyc} t_{subcyc} | Figure 14.3 |
| | | AEVL, AEVH | | 0.5 | — | — | t_{OSC} | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|---------------------|----------|---|----------------|--------|------|------|---------------------------|------------------|
| | | | | Min. | Typ. | Max. | | |
| Input pin low width | t_{IL} | $\overline{IRQ0}$, $\overline{IRQ1}$, $\overline{IRQAE0}$, $\overline{WKP0}$ to $\overline{WKP7}$, AEVL, AEVH | | 2 | — | — | t_{cyc} t_{subcyc} | Figure 14.3 |
| | | | | 0.5 | — | — | | |

Note: * Determined by the SA1 and SA0 bits in the system control register 2 (SYSCR2).

Table 14.4 Serial Interface (SCI3) Timing

One of following conditions is applied unless otherwise specified.

Condition A (Flash memory version): $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition B (Flash memory version): $V_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition C (Mask ROM version): $V_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

| Item | Symbol | Test Condition | Values | | | Unit | Reference Figure |
|--|---------------------|----------------|--------|------|------|---------------------------|------------------|
| | | | Min. | Typ. | Max. | | |
| Input clock cycle | Asynchronous | t_{scyc} | 4 | — | — | t_{cyc} or t_{subcyc} | Figure 14.4 |
| | Clocked synchronous | | 6 | — | — | | |
| Input clock pulse width | t_{SCKW} | | 0.4 | — | 0.6 | t_{scyc} | Figure 14.4 |
| Transmit data delay time (clocked synchronous) | t_{TXD} | | — | — | 1 | t_{cyc} or t_{subcyc} | Figure 14.5 |
| Receive data setup time (clocked synchronous) | t_{RXS} | | 400.0 | — | — | ns | Figure 14.5 |
| Receive data hold time (clocked synchronous) | t_{RXH} | | 400.0 | — | — | ns | Figure 14.5 |

14.2.4 A/D Converter Characteristics

Table 14.5 shows the A/D converter characteristics.

Table 14.5 A/D Converter Characteristics

One of following conditions is applied unless otherwise specified.

Condition A (Flash memory version): $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition B (Flash memory version): $V_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 2.2 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

Condition C (Mask ROM version): $V_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$, $AV_{CC} = 1.8 \text{ V to } 3.6 \text{ V}$,
 $V_{SS} = AV_{SS} = 0.0 \text{ V}$

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|-----------------------------------|--------------|-----------------|---------------------------|--------|------|-----------------|---------------|-----------------------|
| | | | | Min. | Typ. | Max. | | |
| Analog power supply voltage | AV_{CC} | AV_{CC} | Condition A | 2.7 | — | 3.6 | V | *1 |
| | | | Condition B | 2.2 | — | 3.6 | | |
| | | | Condition C | 1.8 | — | 3.6 | | |
| Analog input voltage | AV_{IN} | AN0 to AN3 | | -0.3 | — | $AV_{CC} + 0.3$ | V | |
| Analog power supply current | AI_{OPE} | AV_{CC} | $AV_{CC} = 3.0 \text{ V}$ | — | — | 1.0 | mA | |
| | AI_{STOP1} | AV_{CC} | | — | 600 | — | μA | *2 Reference value |
| | AI_{STOP2} | AV_{CC} | | — | — | 5.0 | μA | *3 |
| Analog input capacitance | C_{AIN} | AN0 to AN3 | | — | — | 15.0 | pF | |
| Allowable signal source impedance | R_{AIN} | | | — | — | 10.0 | k Ω | |
| Resolution (data length) | | | | — | — | 10 | bit | |

| Item | Symbol | Applicable Pins | Test Condition | Values | | | Unit | Reference Figure |
|--------------------|--------|-----------------|---|--------|-----------|-----------|---------------|------------------|
| | | | | Min. | Typ. | Max. | | |
| Nonlinearity error | | | $AV_{CC} = 2.7\text{ V}$ to 3.6 V | — | — | ± 3.5 | LSB | |
| | | | $AV_{CC} = 2.2\text{ V}$ to 3.6 V in condition B, $AV_{CC} = 2.0\text{ V}$ to 3.6 V in condition C | — | — | ± 5.5 | | |
| | | | Other than above in condition C | — | — | ± 7.5 | | |
| Quantization error | | | | — | — | ± 0.5 | LSB | |
| Absolute accuracy | | | $AV_{CC} = 2.7\text{ V}$ to 3.6 V | — | ± 2.0 | ± 4.0 | LSB | |
| | | | $AV_{CC} = 2.2\text{ V}$ to 3.6 V in condition B, $AV_{CC} = 2.0\text{ V}$ to 3.6 V in condition C | — | ± 2.5 | ± 6.0 | | |
| | | | Other than above in condition C | — | ± 2.5 | ± 8.0 | | |
| Conversion time | | | $AV_{CC} = 2.7\text{ V}$ to 3.6 V | 12.4 | — | 124 | μs | |
| | | | Other than above | 62 | — | 124 | | |

- Notes: 1. Set $AV_{CC} = V_{CC}$ when the A/D converter is not used.
2. AI_{STOP1} is the current in active and sleep modes while the A/D converter is idle.
3. AI_{STOP2} is the current at reset and in standby, watch, subactive, and subsleep modes while the A/D converter is idle.
4. The conversion time is $62\ \mu\text{s}$.

14.2.5 Flash Memory Characteristics

Table 14.6 shows the flash memory characteristics.

Table 14.6 Flash Memory Characteristics

Condition A: $AV_{CC} = 2.7\text{ V to }3.6\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ (range of operating voltage when reading), $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ (range of operating voltage when programming/erasing), $T_a = -20^\circ\text{C to }+75^\circ\text{C}$ (range of operating temperature when programming/erasing: product with regular specifications, product with wide-range temperature specifications)

Condition B: $AV_{CC} = 2.2\text{ V to }3.6\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $V_{CC} = 2.2\text{ V to }3.6\text{ V}$ (range of operating voltage when reading), $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ (range of operating voltage when programming/erasing), $T_a = -20^\circ\text{C to }+50^\circ\text{C}$ (range of operating temperature when programming/erasing: product with regular specifications)

| Item | Symbol | Test Conditions | Values | | | Unit | |
|--|---|-----------------|------------------------|---------------------|------|------------------|---------------|
| | | | Min. | Typ. | Max. | | |
| Programming time ^{*1*2*4} | t_p | | — | 7 | 200 | ms/ 128 bytes | |
| Erase time ^{*1*3*5} | t_E | | — | 100 | 1200 | ms/ block | |
| Reprogramming count | N_{WEC} | | 1000 ^{*8} | 10000 ^{*9} | — | times | |
| Data retain period | t_{DRP} | | 10 ^{*10} | — | — | year | |
| Programming | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs | |
| | Wait time after PSU-bit setting ^{*1} | y | 50 | — | — | μs | |
| | Wait time after P-bit setting ^{*1*4} | z1 | $1 \leq n \leq 6$ | 28 | 30 | 32 | μs |
| | | z2 | $7 \leq n \leq 1000$ | 198 | 200 | 202 | μs |
| | | z3 | Additional programming | 8 | 10 | 12 | μs |
| | Wait time after P-bit clear ^{*1} | α | | 5 | — | — | μs |
| | Wait time after PSU-bit clear ^{*1} | β | | 5 | — | — | μs |
| Wait time after PV-bit setting ^{*1} | γ | | 4 | — | — | μs | |

| Item | Symbol | Test Conditions | Values | | | Unit |
|-------------|---|-----------------|--------|------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Programming | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs |
| | Wait time after PV-bit clear ^{*1} | η | 2 | — | — | μs |
| | Wait time after SWE-bit clear ^{*1} | θ | 100 | — | — | μs |
| | Maximum programming count ^{*1*4*5} | N | — | — | 1000 | times |
| Erase | Wait time after SWE-bit setting ^{*1} | x | 1 | — | — | μs |
| | Wait time after ESU-bit setting ^{*1} | y | 100 | — | — | μs |
| | Wait time after E-bit setting ^{*1*6} | z | 10 | — | 100 | ms |
| | Wait time after E-bit clear ^{*1} | α | 10 | — | — | μs |
| | Wait time after ESU-bit clear ^{*1} | β | 10 | — | — | μs |
| | Wait time after EV-bit setting ^{*1} | γ | 20 | — | — | μs |
| | Wait time after dummy write ^{*1} | ε | 2 | — | — | μs |
| | Wait time after EV-bit clear ^{*1} | η | 4 | — | — | μs |
| | Wait time after SWE-bit clear ^{*1} | θ | 100 | — | — | μs |
| | Maximum erase count ^{*1*6*7} | N | — | — | 120 | times |

- Notes:
- Set the times according to the program/erase algorithms.
 - Programming time per 128 bytes (Shows the total period for which the P bit in FLMCR1 is set. It does not include the programming verification time.)
 - Block erase time (Shows the total period for which the E bit in FLMCR1 is set. It does not include the erase verification time.)
 - Maximum programming time (t_p (max))
 t_p (max) = Wait time after P-bit setting (z) • maximum number of writes (N)
 - The maximum number of writes (N) should be set according to the actual set value of z1, z2, and z3 to allow programming within the maximum programming time (t_p (max)).
 The wait time after P-bit setting (z1 and z2) should be alternated according to the number of writes (n) as follows:
 $1 \leq n \leq 6$ z1 = 30 μs
 $7 \leq n \leq 1000$ z2 = 200 μs

6. Maximum erase time (t_E (max))
 t_E (max) = Wait time after E-bit setting (z) • maximum erase count (N)
7. The maximum number of erases (N) should be set according to the actual set value of z to allow erasing within the maximum erase time (t_E (max)).
8. This minimum value guarantees all characteristics after reprogramming (the guaranteed range is from 1 to the minimum value).
9. Reference value when the temperature is 25°C (normally reprogramming will be performed by this count).
10. This is a data retain characteristic when reprogramming is performed within the specification range including this minimum value.

14.3 Operation Timing

Figures 14.1 to 14.5 show the operation timings.

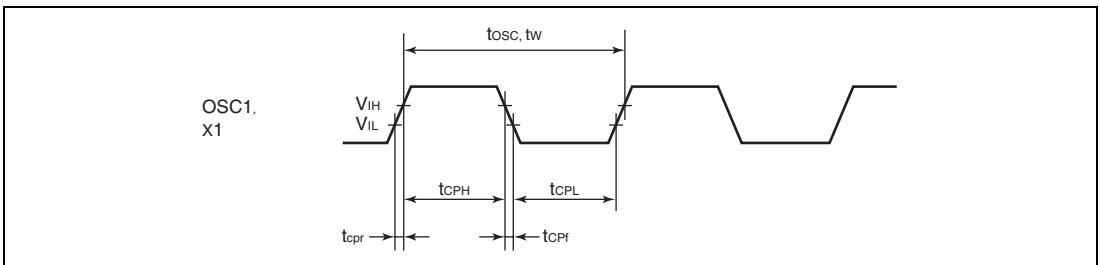


Figure 14.1 Clock Input Timing

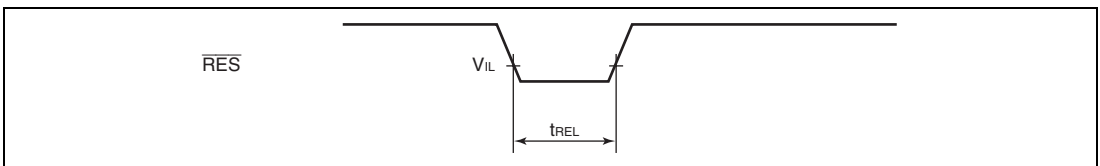


Figure 14.2 $\overline{\text{RES}}$ Low Width Timing

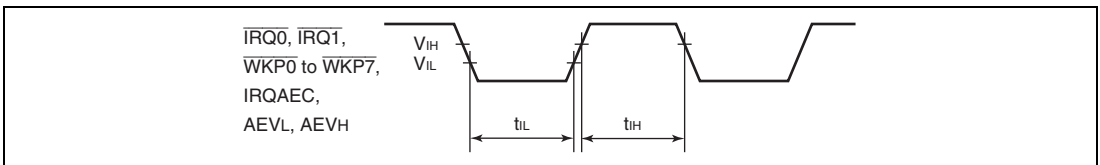


Figure 14.3 Input Timing

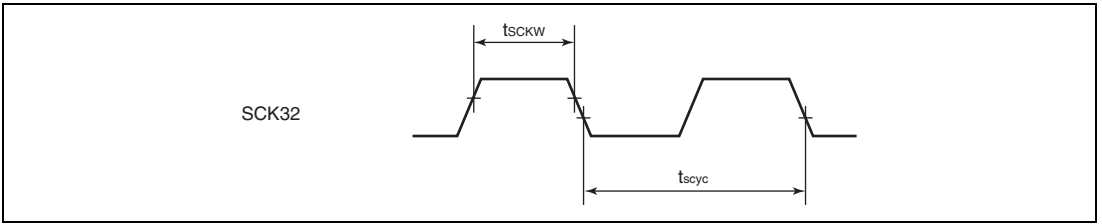


Figure 14.4 SCK3 Input Clock Timing

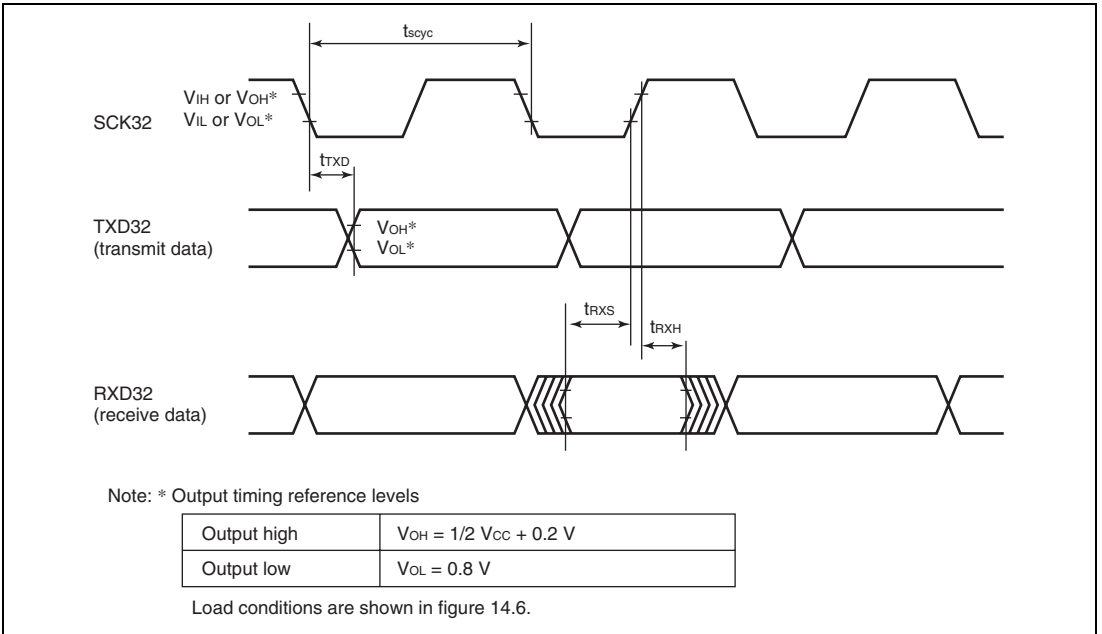


Figure 14.5 SCI3 Input/Output Timing in Clocked Synchronous Mode

14.4 Output Load Condition

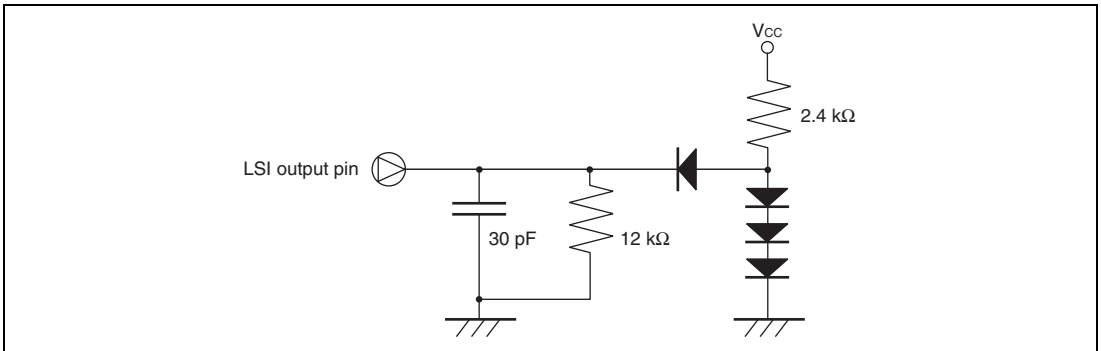


Figure 14.6 Output Load Circuit

14.5 Resonator Equivalent Circuit

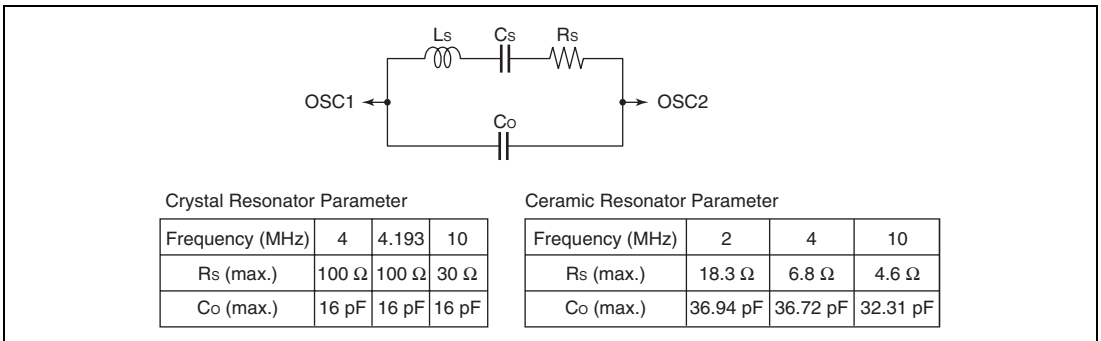
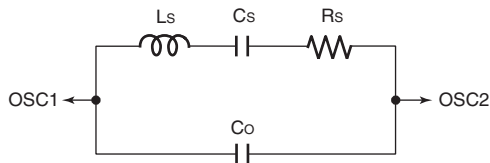


Figure 14.7 Resonator Equivalent Circuit



Crystal Resonator Parameter
(Nominal Values by Manufacturer)

| Frequency | 4 | Manufacturer |
|-----------|------|-----------------------------------|
| Rs (max) | 150Ω | KYOCERA KINSEKI CORPORATION |
| Co (max) | 12pF | |

Ceramic Resonator Parameter (1)
(Nominal Values by Manufacturer)

| Frequency | 2 | Manufacturer |
|-----------|---------|--------------------------------------|
| Rs (max) | 18.3Ω | Murata Manufacturing Co., Ltd. |
| Co (max) | 36.94pF | |

Ceramic Resonator Parameter (2)
(Nominal Values by Manufacturer)

| Frequency | 10 | Manufacturer |
|-----------|---------|--------------------------------------|
| Rs (max) | 4.6Ω | Murata Manufacturing Co., Ltd. |
| Co (max) | 32.31pF | |

Figure 14.8 Resonator Equivalent Circuit

14.6 Usage Note

The flash memory and mask ROM versions satisfy the electrical characteristics shown in this manual, but actual electrical characteristic values, operating margins, noise margins, and other properties may vary due to differences in manufacturing process, on-chip ROM, layout patterns, and so on.

When system evaluation testing is carried out using the flash memory version, the same evaluation testing should also be conducted for the mask ROM version when changing over to that version.

Appendix

A. Instruction Set

A.1 Instruction List

Condition Code

| Symbol | Description |
|--------|---|
| Rd | General destination register |
| Rs | General source register |
| Rn | General register |
| ERd | General destination register (address register or 32-bit register) |
| ERs | General source register (address register or 32-bit register) |
| ERn | General register (32-bit register) |
| (EAd) | Destination operand |
| (EAs) | Source operand |
| PC | Program counter |
| SP | Stack pointer |
| CCR | Condition-code register |
| N | N (negative) flag in CCR |
| Z | Z (zero) flag in CCR |
| V | V (overflow) flag in CCR |
| C | C (carry) flag in CCR |
| disp | Displacement |
| → | Transfer from the operand on the left to the operand on the right, or transition from the state on the left to the state on the right |
| + | Addition of the operands on both sides |
| – | Subtraction of the operand on the right from the operand on the left |
| × | Multiplication of the operands on both sides |
| ÷ | Division of the operand on the left by the operand on the right |
| ^ | Logical AND of the operands on both sides |
| ∨ | Logical OR of the operands on both sides |
| ⊕ | Logical exclusive OR of the operands on both sides |

| Symbol | Description |
|---------------|--------------------------|
| \neg | NOT (logical complement) |
| (), < > | Contents of operand |

Note: General registers include 8-bit registers (R0H to R7H and R0L to R7L) and 16-bit registers (R0 to R7 and E0 to E7).

Condition Code Notation (cont)

| Symbol | Description |
|----------------|--|
| \updownarrow | Changed according to execution result |
| * | Undetermined (no guaranteed value) |
| 0 | Cleared to 0 |
| 1 | Set to 1 |
| — | Not affected by execution of the instruction |
| Δ | Varies depending on conditions, described in notes |

Table A.1 Instruction Set

1. Data Transfer Instructions

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | No. of States ^{*1} | | |
|----------|------------------------|--------------|--|----|------|-----------|-------------|-----|----------|-----|-----------|----------------|---|---|---|---|-----------------------------|--------|----------|
| | | | #xx | Rn | @ERn | @(d, ERn) | @-ERn/@ERn+ | @aa | @(d, PC) | @aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | |
| MOV | MOV.B #xx:8, Rd | B | 2 | | | | | | | | | | | | | | | 2 | |
| | MOV.B Rs, Rd | B | | 2 | | | | | | | | | | | | | | 2 | |
| | MOV.B @ERs, Rd | B | | | 2 | | | | | | | | | | | | | 4 | |
| | MOV.B @(d:16, ERs), Rd | B | | | | 4 | | | | | | | | | | | | 6 | |
| | MOV.B @(d:24, ERs), Rd | B | | | | | 8 | | | | | | | | | | | 10 | |
| | MOV.B @ERs+, Rd | B | | | | | | 2 | | | | | | | | | | 6 | |
| | MOV.B @aa:8, Rd | B | | | | | | | 2 | | | | | | | | | 4 | |
| | MOV.B @aa:16, Rd | B | | | | | | | | 4 | | | | | | | | 6 | |
| | MOV.B @aa:24, Rd | B | | | | | | | | | 6 | | | | | | | 8 | |
| | MOV.B Rs, @ERd | B | | | 2 | | | | | | | | | | | | | 4 | |
| | MOV.B Rs, @(d:16, ERd) | B | | | | 4 | | | | | | | | | | | | 6 | |
| | MOV.B Rs, @(d:24, ERd) | B | | | | | 8 | | | | | | | | | | | 10 | |
| | MOV.B Rs, @-ERd | B | | | | | | 2 | | | | | | | | | | 6 | |
| | MOV.B Rs, @aa:8 | B | | | | | | | | | 2 | | | | | | | 4 | |
| | MOV.B Rs, @aa:16 | B | | | | | | | | | | 4 | | | | | | 6 | |
| | MOV.B Rs, @aa:24 | B | | | | | | | | | | | 6 | | | | | 8 | |
| | MOV.W #xx:16, Rd | W | 4 | | | | | | | | | | | | | | | 4 | |
| | MOV.W Rs, Rd | W | | 2 | | | | | | | | | | | | | | 2 | |
| | MOV.W @ERs, Rd | W | | | 2 | | | | | | | | | | | | | 4 | |
| | MOV.W @(d:16, ERs), Rd | W | | | | 4 | | | | | | | | | | | | 6 | |
| | MOV.W @(d:24, ERs), Rd | W | | | | | 8 | | | | | | | | | | | 10 | |
| | MOV.W @ERs+, Rd | W | | | | | | 2 | | | | | | | | | | 6 | |
| | MOV.W @aa:16, Rd | W | | | | | | | | | | 4 | | | | | | 6 | |
| | MOV.W @aa:24, Rd | W | | | | | | | | | | | 6 | | | | | 8 | |
| | MOV.W Rs, @ERd | W | | | 2 | | | | | | | | | | | | | 4 | |
| | MOV.W Rs, @(d:16, ERd) | W | | | | 4 | | | | | | | | | | | | 6 | |
| | MOV.W Rs, @(d:24, ERd) | W | | | | | 8 | | | | | | | | | | | 10 | |

| Mnemonic | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | |
|-------------------|-------------------------|--|----|------|-----------|-------------|-----|----------|----------------------------|---------------------------------|----------------|---|---|---|---|----|-----------------------------|----------|
| | | #xx | Rn | @ERn | @(d, ERn) | @-ERn/@ERn+ | @aa | @(d, PC) | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | |
| MOV | MOV.W Rs, @-ERd | W | | | | 2 | | | | ERd32-2 → ERd32 Rs16 → @ERd | — | — | ↑ | ↓ | 0 | — | 6 | |
| | MOV.W Rs, @aa:16 | W | | | | 4 | | | | Rs16 → @aa:16 | — | — | ↑ | ↓ | 0 | — | | 6 |
| | MOV.W Rs, @aa:24 | W | | | | 6 | | | | Rs16 → @aa:24 | — | — | ↑ | ↓ | 0 | — | 8 | |
| | MOV.L #xx:32, Rd | L | 6 | | | | | | | #xx:32 → Rd32 | — | — | ↑ | ↓ | 0 | — | 6 | |
| | MOV.L ERs, ERd | L | | 2 | | | | | | ERs32 → ERd32 | — | — | ↑ | ↓ | 0 | — | 2 | |
| | MOV.L @ERs, ERd | L | | | 4 | | | | | @ERs → ERd32 | — | — | ↑ | ↓ | 0 | — | 8 | |
| | MOV.L @(d:16, ERs), ERd | L | | | | 6 | | | | @(d:16, ERs) → ERd32 | — | — | ↑ | ↓ | 0 | — | 10 | |
| | MOV.L @(d:24, ERs), ERd | L | | | | 10 | | | | @(d:24, ERs) → ERd32 | — | — | ↑ | ↓ | 0 | — | 14 | |
| | MOV.L @ERs+, ERd | L | | | | | 4 | | | @ERs → ERd32 ERs32+4 → ERs32 | — | — | ↑ | ↓ | 0 | — | 10 | |
| | MOV.L @aa:16, ERd | L | | | | | 6 | | | @aa:16 → ERd32 | — | — | ↑ | ↓ | 0 | — | 10 | |
| | MOV.L @aa:24, ERd | L | | | | | 8 | | | @aa:24 → ERd32 | — | — | ↑ | ↓ | 0 | — | 12 | |
| | MOV.L ERs, @ERd | L | | | 4 | | | | | ERs32 → @ERd | — | — | ↑ | ↓ | 0 | — | 8 | |
| | MOV.L ERs, @(d:16, ERd) | L | | | | 6 | | | | ERs32 → @(d:16, ERd) | — | — | ↑ | ↓ | 0 | — | 10 | |
| | MOV.L ERs, @(d:24, ERd) | L | | | | 10 | | | | ERs32 → @(d:24, ERd) | — | — | ↑ | ↓ | 0 | — | 14 | |
| | MOV.L ERs, @-ERd | L | | | | | 4 | | | ERd32-4 → ERd32 ERs32 → @ERd | — | — | ↑ | ↓ | 0 | — | 10 | |
| MOV.L ERs, @aa:16 | L | | | | | 6 | | | ERs32 → @aa:16 | — | — | ↑ | ↓ | 0 | — | 10 | | |
| MOV.L ERs, @aa:24 | L | | | | | 8 | | | ERs32 → @aa:24 | — | — | ↑ | ↓ | 0 | — | 12 | | |
| POP | POP.W Rn | W | | | | | | 2 | @SP → Rn16 SP+2 → SP | — | — | ↑ | ↓ | 0 | — | 6 | | |
| | POP.L ERn | L | | | | | | 4 | @SP → ERn32 SP+4 → SP | — | — | ↑ | ↓ | 0 | — | 10 | | |
| PUSH | PUSH.W Rn | W | | | | | | 2 | SP-2 → SP Rn16 → @SP | — | — | ↓ | ↑ | 0 | — | 6 | | |
| | PUSH.L ERn | L | | | | | | 4 | SP-4 → SP ERn32 → @SP | — | — | ↓ | ↑ | 0 | — | 10 | | |
| MOVFPE | MOVFPE @aa:16, Rd | B | | | | | 4 | | Cannot be used in this LSI | Cannot be used in this LSI | | | | | | | | |
| MOVTPPE | MOVTPPE Rs, @aa:16 | B | | | | | 4 | | Cannot be used in this LSI | Cannot be used in this LSI | | | | | | | | |

2. Arithmetic Instructions

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | | | | | | | | | | | |
|----------------|-------------------|--------------|--|----|------|------------|-------------|-----|-----------|-----------|----------------|--|---|---|---|---|-----------------------------|---|--------|---------------------|--------------------------|-----|-----|---|-----|---|---|---|--|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | | @aa | | I | H | N | Z | V | C | Normal | Advanced | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| ADD | ADD.B #xx:8, Rd | B | 2 | | | | | | | | | | | | | | | | | Rd8+#xx:8 → Rd8 | — | ↓ | ↓ | ↓ | ↓ | ↓ | ↓ | 2 | |
| | ADD.B Rs, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8+Rs8 → Rd8 | — | ↓ | ↓ | ↓ | ↓ | ↓ | 2 | |
| | ADD.W #xx:16, Rd | W | 4 | | | | | | | | | | | | | | | | | | Rd16+#xx:16 → Rd16 | — | (1) | ↓ | ↓ | ↓ | ↓ | 4 | |
| | ADD.W Rs, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16+Rs16 → Rd16 | — | (1) | ↓ | ↓ | ↓ | ↓ | 2 | |
| | ADD.L #xx:32, ERd | L | 6 | | | | | | | | | | | | | | | | | | ERd32+#xx:32 → ERd32 | — | (2) | ↓ | ↓ | ↓ | ↓ | 6 | |
| ADD.L ERs, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+ERs32 → ERd32 | — | (2) | ↓ | ↓ | ↓ | ↓ | 2 | | |
| ADDX | ADDX.B #xx:8, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8+#xx:8 +C → Rd8 | — | ↓ | ↓ | (3) | ↓ | ↓ | 2 | |
| | ADDX.B Rs, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8+Rs8 +C → Rd8 | — | ↓ | ↓ | (3) | ↓ | ↓ | 2 | |
| ADDS | ADDS.L #1, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+1 → ERd32 | — | — | — | — | — | — | 2 | |
| | ADDS.L #2, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+2 → ERd32 | — | — | — | — | — | — | 2 | |
| | ADDS.L #4, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+4 → ERd32 | — | — | — | — | — | — | 2 | |
| INC | INC.B Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8+1 → Rd8 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | INC.W #1, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16+1 → Rd16 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | INC.W #2, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16+2 → Rd16 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | INC.L #1, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+1 → ERd32 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | INC.L #2, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32+2 → ERd32 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| DAA | DAA Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8 decimal adjust → Rd8 | — | * | ↓ | ↓ | * | — | 2 | |
| SUB | SUB.B Rs, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8-Rs8 → Rd8 | — | ↓ | ↓ | ↓ | ↓ | ↓ | 2 | |
| | SUB.W #xx:16, Rd | W | 4 | | | | | | | | | | | | | | | | | | Rd16-#xx:16 → Rd16 | — | (1) | ↓ | ↓ | ↓ | ↓ | 4 | |
| | SUB.W Rs, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16-Rs16 → Rd16 | — | (1) | ↓ | ↓ | ↓ | ↓ | 2 | |
| | SUB.L #xx:32, ERd | L | 6 | | | | | | | | | | | | | | | | | | ERd32-#xx:32 → ERd32 | — | (2) | ↓ | ↓ | ↓ | ↓ | 6 | |
| | SUB.L ERs, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32-ERs32 → ERd32 | — | (2) | ↓ | ↓ | ↓ | ↓ | 2 | |
| SUBX | SUBX.B #xx:8, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8-#xx:8-C → Rd8 | — | ↓ | ↓ | (3) | ↓ | ↓ | 2 | |
| | SUBX.B Rs, Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8-Rs8-C → Rd8 | — | ↓ | ↓ | (3) | ↓ | ↓ | 2 | |
| SUBS | SUBS.L #1, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32-1 → ERd32 | — | — | — | — | — | — | 2 | |
| | SUBS.L #2, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32-2 → ERd32 | — | — | — | — | — | — | 2 | |
| | SUBS.L #4, ERd | L | 2 | | | | | | | | | | | | | | | | | | ERd32-4 → ERd32 | — | — | — | — | — | — | 2 | |
| DEC | DEC.B Rd | B | 2 | | | | | | | | | | | | | | | | | | Rd8-1 → Rd8 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | DEC.W #1, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16-1 → Rd16 | — | — | ↓ | ↓ | ↓ | — | 2 | |
| | DEC.W #2, Rd | W | 2 | | | | | | | | | | | | | | | | | | Rd16-2 → Rd16 | — | — | ↓ | ↓ | ↓ | — | 2 | |

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | Operation | Condition Code | | | | | | No. of States ¹ | | | |
|----------|-------------------|--------------|--|----|------|------------|--------------|-----|-----------|-----------|----------------|-----|-----|---|---|---|----------------------------|----|--------|----------|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @ -ERn/@ERn+ | @aa | @ (d, PC) | | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| DEC | DEC.L #1, ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| | DEC.L #2, ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| DAS | DAS.Rd | B | 2 | | | | | | | | | * | | | | | | 2 | | |
| MULXU | MULXU. B Rs, Rd | B | 2 | | | | | | | | | | | | | | | 14 | | |
| | MULXU. W Rs, ERd | W | 2 | | | | | | | | | | | | | | | 22 | | |
| MULXS | MULXS. B Rs, Rd | B | 4 | | | | | | | | | | | | | | | 16 | | |
| | MULXS. W Rs, ERd | W | 4 | | | | | | | | | | | | | | | 24 | | |
| DIVXU | DIVXU. B Rs, Rd | B | 2 | | | | | | | | | (6) | (7) | | | | | 14 | | |
| | DIVXU. W Rs, ERd | W | 2 | | | | | | | | | (6) | (7) | | | | | 22 | | |
| DIVXS | DIVXS. B Rs, Rd | B | 4 | | | | | | | | | (8) | (7) | | | | | 16 | | |
| | DIVXS. W Rs, ERd | W | 4 | | | | | | | | | (8) | (7) | | | | | 24 | | |
| CMP | CMP.B #xx:8, Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | CMP.B Rs, Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | CMP.W #xx:16, Rd | W | 4 | | | | | | | | | (1) | | | | | | 4 | | |
| | CMP.W Rs, Rd | W | 2 | | | | | | | | | (1) | | | | | | 2 | | |
| | CMP.L #xx:32, ERd | L | 6 | | | | | | | | | (2) | | | | | | 4 | | |
| | CMP.L ERs, ERd | L | 2 | | | | | | | | | (2) | | | | | | 2 | | |

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | |
|----------|------------|--------------|--|----|------|------------|-------------|-----|-----------|------|-----------|----------------|---|---|---|---|---|-----------------------------|--------|----------|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | @@aa | | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| NEG | NEG.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | NEG.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | NEG.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| EXTU | EXTU.W Rd | W | 2 | | | | | | | | | | 0 | ↓ | 0 | — | | 2 | | |
| | EXTU.L ERd | L | 2 | | | | | | | | | | 0 | ↓ | 0 | — | | 2 | | |
| EXTS | EXTS.W Rd | W | 2 | | | | | | | | | | ↓ | ↓ | 0 | — | | 2 | | |
| | EXTS.L ERd | L | 2 | | | | | | | | | | ↓ | ↓ | 0 | — | | 2 | | |

4. Shift Instructions

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | |
|----------|-------------|--------------|--|----|------|------------|-------------|-----|-----------|------|-----------|----------------|---|---|---|---|---|-----------------------------|--------|----------|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | @@aa | | I | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| SHAL | SHAL.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHAL.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHAL.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| SHAR | SHAR.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHAR.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHAR.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| SHLL | SHLL.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHLL.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHLL.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| SHLR | SHLR.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHLR.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | SHLR.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| ROTXL | ROTXL.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTXL.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTXL.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| ROTXR | ROTXR.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTXR.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTXR.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| ROTL | ROTL.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTL.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTL.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |
| ROTR | ROTR.B Rd | B | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTR.W Rd | W | 2 | | | | | | | | | | | | | | | 2 | | |
| | ROTR.L ERd | L | 2 | | | | | | | | | | | | | | | 2 | | |

5. Bit-Manipulation Instructions

| Mnemonic | | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | | | | | | | | | | | | | |
|----------|-------------------|--|-----|----|------|------------|-------------|-----|-----------|-----------|----------------|---|---|---|---|---|-----------------------------|---|--------|--------------------|--|---|---|---|---|---|---|---|---|---|---|
| | | Operand Size | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | | @@aa | I | I | H | N | Z | V | C | Normal | Advanced | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| BSET | BSET #xx:3, Rd | B | 2 | | | | | | | | | | | | | | | | | (#xx:3 of Rd8) ← 1 | — | — | — | — | — | — | — | — | — | — | 2 |
| | BSET #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (#xx:3 of @ERd) ← 1 | — | — | — | — | — | — | — | — | — | 8 |
| | BSET #xx:3, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (#xx:3 of @aa:8) ← 1 | — | — | — | — | — | — | — | — | — | 8 |
| | BSET Rn, Rd | B | 2 | | | | | | | | | | | | | | | | | | (Rn8 of Rd8) ← 1 | — | — | — | — | — | — | — | — | — | 2 |
| | BSET Rn, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (Rn8 of @ERd) ← 1 | — | — | — | — | — | — | — | — | — | 8 |
| | BSET Rn, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (Rn8 of @aa:8) ← 1 | — | — | — | — | — | — | — | — | — | 8 |
| BCLR | BCLR #xx:3, Rd | B | 2 | | | | | | | | | | | | | | | | | | (#xx:3 of Rd8) ← 0 | — | — | — | — | — | — | — | — | — | 2 |
| | BCLR #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (#xx:3 of @ERd) ← 0 | — | — | — | — | — | — | — | — | — | 8 |
| | BCLR #xx:3, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (#xx:3 of @aa:8) ← 0 | — | — | — | — | — | — | — | — | — | 8 |
| | BCLR Rn, Rd | B | 2 | | | | | | | | | | | | | | | | | | (Rn8 of Rd8) ← 0 | — | — | — | — | — | — | — | — | — | 2 |
| | BCLR Rn, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (Rn8 of @ERd) ← 0 | — | — | — | — | — | — | — | — | — | 8 |
| | BCLR Rn, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (Rn8 of @aa:8) ← 0 | — | — | — | — | — | — | — | — | — | 8 |
| BNOT | BNOT #xx:3, Rd | B | 2 | | | | | | | | | | | | | | | | | | (#xx:3 of Rd8) ← ¬ (#xx:3 of Rd8) | — | — | — | — | — | — | — | — | — | 2 |
| | BNOT #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (#xx:3 of @ERd) ← ¬ (#xx:3 of @ERd) | — | — | — | — | — | — | — | — | — | 8 |
| | BNOT #xx:3, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (#xx:3 of @aa:8) ← ¬ (#xx:3 of @aa:8) | — | — | — | — | — | — | — | — | — | 8 |
| | BNOT Rn, Rd | B | 2 | | | | | | | | | | | | | | | | | | (Rn8 of Rd8) ← ¬ (Rn8 of Rd8) | — | — | — | — | — | — | — | — | — | 2 |
| | BNOT Rn, @ERd | B | | 4 | | | | | | | | | | | | | | | | | (Rn8 of @ERd) ← ¬ (Rn8 of @ERd) | — | — | — | — | — | — | — | — | — | 8 |
| | BNOT Rn, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | (Rn8 of @aa:8) ← ¬ (Rn8 of @aa:8) | — | — | — | — | — | — | — | — | — | 8 |
| BTST | BTST #xx:3, Rd | B | 2 | | | | | | | | | | | | | | | | | | ¬ (#xx:3 of Rd8) → Z | — | — | — | ↑ | — | — | — | — | — | 2 |
| | BTST #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | | | | | ¬ (#xx:3 of @ERd) → Z | — | — | — | ↑ | — | — | — | — | — | 6 |
| | BTST #xx:3, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | ¬ (#xx:3 of @aa:8) → Z | — | — | — | ↑ | — | — | — | — | — | 6 |
| | BTST Rn, Rd | B | 2 | | | | | | | | | | | | | | | | | | ¬ (Rn8 of @Rd8) → Z | — | — | — | ↑ | — | — | — | — | — | 2 |
| | BTST Rn, @ERd | B | | 4 | | | | | | | | | | | | | | | | | ¬ (Rn8 of @ERd) → Z | — | — | — | ↑ | — | — | — | — | — | 6 |
| | BTST Rn, @aa:8 | B | | | | | | 4 | | | | | | | | | | | | | ¬ (Rn8 of @aa:8) → Z | — | — | — | ↑ | — | — | — | — | — | 6 |
| BLD | BLD #xx:3, Rd | B | 2 | | | | | | | | | | | | | | | | | | (#xx:3 of Rd8) → C | — | — | — | — | — | — | — | ↑ | — | 2 |

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | | |
|----------|--------------------|--------------|--|----|------|------------|-------------|-----|-----------|-----------|----------------|--|---|---|---|---|-----------------------------|---|--------|----------|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| BLD | BLD #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BLD #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BILD | BILD #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BILD #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BILD #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BST | BST #xx:3, Rd | B | 2 | | | | | | | | | | | | | | 2 | | | |
| | BST #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | 8 | | | |
| | BST #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | | | 8 | | | |
| BIST | BIST #xx:3, Rd | B | 2 | | | | | | | | | | | | | | 2 | | | |
| | BIST #xx:3, @ERd | B | | 4 | | | | | | | | | | | | | 8 | | | |
| | BIST #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | | | 8 | | | |
| BAND | BAND #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BAND #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BAND #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BIAND | BIAND #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BIAND #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BIAND #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BOR | BOR #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BOR #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BOR #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BIOR | BIOR #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BIOR #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BIOR #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BXOR | BXOR #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BXOR #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BXOR #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |
| BIXOR | BIXOR #xx:3, Rd | B | 2 | | | | | | | | | | | | ↕ | | 2 | | | |
| | BIXOR #xx:3, @ERd | B | | 4 | | | | | | | | | | | ↕ | | 6 | | | |
| | BIXOR #xx:3, @aa:8 | B | | | | | 4 | | | | | | | | ↕ | | 6 | | | |

6. Branching Instructions

| Mnemonic | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | No. of States ^{*1} | | | | | | | | | | |
|----------|--|-----|----|------|------------|-------------|-----|-----------|-----------|--|-----------------------------|----------------------------|------------------|---|---|---|---|---|---|--------|----------|
| | Operand Size | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | | | @ @aa | | Branch Condition | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | | |
| Bcc | BRA d:8 (BT d:8) | — | | | | | | 2 | | If condition is true then PC ← PC+d else next; | Always | — | — | — | — | — | — | 4 | | | |
| | BRA d:16 (BT d:16) | — | | | | | | 4 | | | Never | — | — | — | — | — | — | — | 6 | | |
| | BRN d:8 (BF d:8) | — | | | | | | 2 | | | Never | — | — | — | — | — | — | — | 4 | | |
| | BRN d:16 (BF d:16) | — | | | | | | | 4 | | | Never | — | — | — | — | — | — | — | 6 | |
| | BHI d:8 | — | | | | | | 2 | | | | C _v Z = 0 | — | — | — | — | — | — | — | 4 | |
| | BHI d:16 | — | | | | | | | 4 | | | C _v Z = 0 | — | — | — | — | — | — | — | 6 | |
| | BLS d:8 | — | | | | | | 2 | | | | C _v Z = 1 | — | — | — | — | — | — | — | 4 | |
| | BLS d:16 | — | | | | | | | 4 | | | C _v Z = 1 | — | — | — | — | — | — | — | 6 | |
| | BCC d:8 (BHS d:8) | — | | | | | | 2 | | | | C = 0 | — | — | — | — | — | — | — | 4 | |
| | BCC d:16 (BHS d:16) | — | | | | | | | 4 | | | C = 0 | — | — | — | — | — | — | — | 6 | |
| | BCS d:8 (BLO d:8) | — | | | | | | 2 | | | | C = 1 | — | — | — | — | — | — | — | 4 | |
| | BCS d:16 (BLO d:16) | — | | | | | | | 4 | | | C = 1 | — | — | — | — | — | — | — | 6 | |
| | BNE d:8 | — | | | | | | 2 | | | | Z = 0 | — | — | — | — | — | — | — | 4 | |
| | BNE d:16 | — | | | | | | | 4 | | | Z = 0 | — | — | — | — | — | — | — | 6 | |
| | BEQ d:8 | — | | | | | | 2 | | | | Z = 1 | — | — | — | — | — | — | — | 4 | |
| | BEQ d:16 | — | | | | | | | 4 | | | Z = 1 | — | — | — | — | — | — | — | 6 | |
| | BVC d:8 | — | | | | | | 2 | | | | V = 0 | — | — | — | — | — | — | — | 4 | |
| | BVC d:16 | — | | | | | | | 4 | | | V = 0 | — | — | — | — | — | — | — | 6 | |
| | BVS d:8 | — | | | | | | 2 | | | | V = 1 | — | — | — | — | — | — | — | 4 | |
| | BVS d:16 | — | | | | | | | 4 | | | V = 1 | — | — | — | — | — | — | — | 6 | |
| | BPL d:8 | — | | | | | | 2 | | | | N = 0 | — | — | — | — | — | — | — | 4 | |
| | BPL d:16 | — | | | | | | | 4 | | | N = 0 | — | — | — | — | — | — | — | 6 | |
| | BMI d:8 | — | | | | | | 2 | | | | N = 1 | — | — | — | — | — | — | — | 4 | |
| | BMI d:16 | — | | | | | | | 4 | | | N = 1 | — | — | — | — | — | — | — | 6 | |
| | BGE d:8 | — | | | | | | 2 | | | | N ⊕ V = 0 | — | — | — | — | — | — | — | 4 | |
| | BGE d:16 | — | | | | | | | 4 | | | N ⊕ V = 0 | — | — | — | — | — | — | — | 6 | |
| | BLT d:8 | — | | | | | | 2 | | | | N ⊕ V = 1 | — | — | — | — | — | — | — | 4 | |
| | BLT d:16 | — | | | | | | | 4 | | | N ⊕ V = 1 | — | — | — | — | — | — | — | 6 | |
| | BGT d:8 | — | | | | | | 2 | | | | Z _v (N ⊕ V) = 0 | — | — | — | — | — | — | — | 4 | |
| | BGT d:16 | — | | | | | | | 4 | | | Z _v (N ⊕ V) = 0 | — | — | — | — | — | — | — | 6 | |
| | BLE d:8 | — | | | | | | 2 | | | | Z _v (N ⊕ V) = 1 | — | — | — | — | — | — | — | 4 | |
| | BLE d:16 | — | | | | | | | 4 | | | Z _v (N ⊕ V) = 1 | — | — | — | — | — | — | — | 6 | |

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | | |
|----------|------------|--------------|--|----|------|------------|-------------|-----|-----------|------|-----------|----------------|---|---|---|---|---|-----------------------------|--------|----------|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | @@aa | | I | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | | |
| JMP | JMP @ERn | — | | | 2 | | | | | | | | | | | | | 4 | | |
| | JMP @aa:24 | — | | | | | | 4 | | | | | | | | | | 6 | | |
| | JMP @@aa:8 | — | | | | | | | | 2 | | | | | | | | 8 | 10 | |
| BSR | BSR d:8 | — | | | | | | | | 2 | | | | | | | | 6 | 8 | |
| | BSR d:16 | — | | | | | | | 4 | | | | | | | | | 8 | 10 | |
| JSR | JSR @ERn | — | | | 2 | | | | | | | | | | | | | 6 | 8 | |
| | JSR @aa:24 | — | | | | | | 4 | | | | | | | | | | 8 | 10 | |
| | JSR @@aa:8 | — | | | | | | | | 2 | | | | | | | | 8 | 12 | |
| RTS | RTS | — | | | | | | | | | | | | | | | | 2 | 10 | |

7. System Control Instructions

| Mnemonic | | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States*1 | | | | | | | | | | | | |
|-----------------|-----------------------|--------------|--|----|------|------------|-------------|-----|-----------|------|-----------|----------------|---|---|---|---|---|-----------------|--------|-------------------------|--------------------------------|---|---|---|---|---|---|--|----|----|
| | | | #xx | Rn | @ERn | @ (d, ERn) | @-ERn/@ERn+ | @aa | @ (d, PC) | @@aa | | I | I | H | N | Z | V | C | Normal | Advanced | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RTE | RTE | — | | | | | | | | | | | | | | | | | | CCR ← @SP+ PC ← @SP+ | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 10 | |
| SLEEP | SLEEP | — | | | | | | | | | | | | | | | | | | | Transition to power-down state | | | | | | | | | 2 |
| LDC | LDC #xx:8, CCR | B | 2 | | | | | | | | | | | | | | | | | #xx:8 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 2 | |
| | LDC Rs, CCR | B | | 2 | | | | | | | | | | | | | | | | | Rs8 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 2 |
| | LDC @ERs, CCR | W | | | 4 | | | | | | | | | | | | | | | | @ERs → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 6 |
| | LDC @(d:16, ERs), CCR | W | | | | 6 | | | | | | | | | | | | | | | @(d:16, ERs) → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 8 |
| | LDC @(d:24, ERs), CCR | W | | | | 10 | | | | | | | | | | | | | | | @(d:24, ERs) → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 12 |
| | LDC @ERs+, CCR | W | | | | | 4 | | | | | | | | | | | | | | @ERs → CCR ERs32+2 → ERs32 | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 8 |
| | LDC @aa:16, CCR | W | | | | | | 6 | | | | | | | | | | | | | @aa:16 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 8 |
| | LDC @aa:24, CCR | W | | | | | | 8 | | | | | | | | | | | | | @aa:24 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 10 |
| STC | STC CCR, Rd | B | | 2 | | | | | | | | | | | | | | | | | CCR → Rd8 | | | | | | | | | 2 |
| | STC CCR, @ERd | W | | | 4 | | | | | | | | | | | | | | | | CCR → @ERd | | | | | | | | | 6 |
| | STC CCR, @(d:16, ERd) | W | | | | 6 | | | | | | | | | | | | | | | CCR → @(d:16, ERd) | | | | | | | | | 8 |
| | STC CCR, @(d:24, ERd) | W | | | | 10 | | | | | | | | | | | | | | | CCR → @(d:24, ERd) | | | | | | | | | 12 |
| | STC CCR, @-ERd | W | | | | | 4 | | | | | | | | | | | | | | ERd32-2 → ERd32 CCR → @ERd | | | | | | | | | 8 |
| | STC CCR, @aa:16 | W | | | | | | 6 | | | | | | | | | | | | | CCR → @aa:16 | | | | | | | | | 8 |
| STC CCR, @aa:24 | W | | | | | | 8 | | | | | | | | | | | | | CCR → @aa:24 | | | | | | | | | 10 | |
| ANDC | ANDC #xx:8, CCR | B | 2 | | | | | | | | | | | | | | | | | | CCR ∧ #xx:8 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 2 |
| ORC | ORC #xx:8, CCR | B | 2 | | | | | | | | | | | | | | | | | | CCR ∨ #xx:8 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 2 |
| XORC | XORC #xx:8, CCR | B | 2 | | | | | | | | | | | | | | | | | | CCR ⊕ #xx:8 → CCR | ↑ | ↓ | ↑ | ↓ | ↑ | ↓ | | | 2 |
| NOP | NOP | — | | | | | | | | | | | | | | | | | | | PC ← PC+2 | | | | | | | | | 2 |

8. Block Transfer Instructions

| | Mnemonic | Operand Size | Addressing Mode and Instruction Length (bytes) | | | | | | | | Operation | Condition Code | | | | | | No. of States ^{*1} | |
|--------|-----------|--------------|--|----|------|-----------|-------------|-----|----------|------|--|----------------|---|---|---|---|---|-----------------------------|----------|
| | | | #xx | Rn | @ERn | @(d, ERn) | @-ERn/@ERn+ | @aa | @(d, PC) | @@aa | | I | H | N | Z | V | C | Normal | Advanced |
| | | | | | | | | | | | | | | | | | | | |
| EEPMOV | EEPMOV. B | — | | | | | | | | 4 | if R4L ≠ 0 then repeat @R5 → @R6 R5+1 → R5 R6+1 → R6 R4L-1 → R4L until R4L=0 else next | — | — | — | — | — | — | 8+ 4n ⁺² | |
| | EEPMOV. W | — | | | | | | | | 4 | if R4 ≠ 0 then repeat @R5 → @R6 R5+1 → R5 R6+1 → R6 R4-1 → R4 until R4=0 else next | — | — | — | — | — | — | 8+ 4n ⁺² | |

Notes: 1. The number of states in cases where the instruction code and its operands are located in on-chip memory is shown here. For other cases, see appendix A.3, Number of Execution States.

2. n is the value set in register R4L or R4.


- (1) Set to 1 when a carry or borrow occurs at bit 11; otherwise cleared to 0.
- (2) Set to 1 when a carry or borrow occurs at bit 27; otherwise cleared to 0.
- (3) Retains its previous value when the result is zero; otherwise cleared to 0.
- (4) Set to 1 when the adjustment produces a carry; otherwise retains its previous value.
- (5) The number of states required for execution of an instruction that transfers data in synchronization with the E clock is variable.
- (6) Set to 1 when the divisor is negative; otherwise cleared to 0.
- (7) Set to 1 when the divisor is zero; otherwise cleared to 0.
- (8) Set to 1 when the quotient is negative; otherwise cleared to 0.

A.2 Operation Code Map

Table A.2 Operation Code Map (1)

Instruction code:

| | | | |
|----------|----|----------|----|
| 1st byte | | 2nd byte | |
| AH | AL | BH | BL |



| AL/AH | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | |
|-------|---------------|---------------|---------------|---------------|------|-------|-------|---------------|---------------|---------------|---------------|---------------|---------------|------|---------------|---------------|--|
| | NOP | Table A-2 (2) | STC | LDC | ORC | XORC | ANDC | LDC | ADD | ADD | Table A-2 (2) | Table A-2 (2) | MOV | ADDX | Table A-2 (2) | | |
| | Table A-2 (2) | Table A-2 (2) | Table A-2 (2) | Table A-2 (2) | OR.B | XOR.B | AND.B | Table A-2 (2) | SUB | SUB | Table A-2 (2) | Table A-2 (2) | CMP | SUBX | Table A-2 (2) | Table A-2 (2) | |
| 2 | MOV.B | | | | | | | | | | | | | | | | |
| 3 | MOV | | | | | | | | | | | | | | | | |
| 4 | BRA | BRN | BHI | BLS | BCC | BCS | BNE | BEQ | BVC | BVS | BPL | BMI | BGE | BLT | BGT | BLE | |
| 5 | MULXU | DIVXU | MULXU | DIVXU | RTS | BSR | RTE | Table A-2 (2) | Table A-2 (2) | JMP | BSR | JSR | | | | | |
| 6 | BSET | BNOT | BCLR | BTST | BOR | XOR | AND | BST | MOV | | | | | | | | |
| 7 | | | | | BIOR | BIXOR | BAND | BLD | MOV | Table A-2 (2) | Table A-2 (2) | EEMOV | Table A-2 (3) | | | | |
| 8 | ADD | | | | | | | | | | | | | | | | |
| 9 | ADDX | | | | | | | | | | | | | | | | |
| A | CMP | | | | | | | | | | | | | | | | |
| B | SUBX | | | | | | | | | | | | | | | | |
| C | OR | | | | | | | | | | | | | | | | |
| D | XOR | | | | | | | | | | | | | | | | |
| E | AND | | | | | | | | | | | | | | | | |
| F | MOV | | | | | | | | | | | | | | | | |

Table A.2 Operation Code Map (2)

Instruction code:

| | | | |
|----------|----|----------|----|
| 1st byte | | 2nd byte | |
| AH | AL | BH | BL |

| BH AH | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |
|----------|-------|-----|---|-----|---------|-----|-----|-----|-------|------|-----|------|------------------|------------------|-----|------------------|
| 01 | MOV | | | | LDC/STC | | | | SLEEP | | | | Table A-2 (3) | Table A-2 (3) | | Table A-2 (3) |
| 0A | INC | | | | | | | | | | | | ADD | | | |
| 0B | ADDS | | | | | INC | | INC | ADDS | | | | | INC | | INC |
| 0F | DAA | | | | | | | | | | | | MOV | | | |
| 10 | SHLL | | | | | | | | SHAL | | | SHAL | | | | |
| 11 | SHLR | | | | | | | | SHAR | | | SHAR | | | | |
| 12 | ROTXL | | | | | | | | ROTL | | | ROTL | | | | |
| 13 | ROTXR | | | | | | | | ROTR | | | ROTR | | | | |
| 17 | NOT | | | | | | | | EXTU | EXTU | | NEG | | EXTS | | EXTS |
| 1A | DEC | | | | | | | | | | | | SUB | | | |
| 1B | SUBS | | | | | | | | | | | | | SUB | | DEC |
| 1F | DAS | | | | | | | | | | | | | | | DEC |
| 58 | BRA | BRN | | BHI | BLS | BCC | BNE | BEQ | BVC | BVS | BPL | BMI | BGE | BLT | BGT | BLE |
| 79 | MOV | ADD | | CMP | SUB | OR | XOR | AND | | | | | | | | |
| 7A | MOV | ADD | | CMP | SUB | OR | XOR | AND | | | | | | | | |

Table A.2 Operation Code Map (3)

Instruction code:

| | | | | | | | |
|----------|----|----------|----|----------|----|----------|----|
| 1st byte | | 2nd byte | | 3rd byte | | 4th byte | |
| AH | AL | BH | BL | CH | CL | DH | DL |

| CL | 0 | | 1 | | 2 | | 3 | | 4 | | 5 | | 6 | | 7 | | 8 | | 9 | | A | | B | | C | | D | | E | | F | | | | | |
|---------|-------|----|-------|----|------|----|-----|----|-----|------|------|-------|------|-------|-----|------|-----|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|---|--|--|--|--|--|
| | AH | AL | BH | BL | CH | CL | DH | DL | BOR | BIOR | BXOR | BIXOR | BAND | BIAND | BLD | BILD | BST | BIST | LDC | STC | LDC | STC | LDC | STC | LDC | STC | LDC | STC | LDC | STC | | | | | | |
| 01406 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 01C05 | MULXS | | MULXS | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 01D05 | DIVXS | | DIVXS | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 01F06 | | | OR | | XOR | | AND | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7C06*1 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7C07*1 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7D06*1 | BSET | | BNOT | | BCLR | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7D07*1 | BSET | | BNOT | | BCLR | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7Eaa6*2 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7Eaa7*2 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7Faa6*2 | BSET | | BNOT | | BCLR | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 7Faa7*2 | BSET | | BNOT | | BCLR | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

Notes: 1. r is the register designation field.
 2. aa is the absolute address field.

A.3 Number of Execution States

The status of execution for each instruction of the H8/300H CPU and the method of calculating the number of states required for instruction execution are shown below. Table A.4 shows the number of cycles of each type occurring in each instruction, such as instruction fetch and data read/write. Table A.3 shows the number of states required for each cycle. The total number of states required for execution of an instruction can be calculated by the following expression:

$$\text{Execution states} = I \times S_I + J \times S_J + K \times S_K + L \times S_L + M \times S_M + N \times S_N$$

Examples: When instruction is fetched from on-chip ROM, and an on-chip RAM is accessed.

BSET #0, @FF00

From table A.4:

$$I = L = 2, \quad J = K = M = N = 0$$

From table A.3:

$$S_I = 2, \quad S_L = 2$$

$$\text{Number of states required for execution} = 2 \times 2 + 2 \times 2 = 8$$

When instruction is fetched from on-chip ROM, branch address is read from on-chip ROM, and on-chip RAM is used for stack area.

JSR @@ 30

From table A.4:

$$I = 2, \quad J = K = 1, \quad L = M = N = 0$$

From table A.3:

$$S_I = S_J = S_K = 2$$

$$\text{Number of states required for execution} = 2 \times 2 + 1 \times 2 + 1 \times 2 = 8$$

Table A.3 Number of Cycles in Each Instruction

| Execution Status (Instruction Cycle) | | Access Location | |
|---|-------|------------------------|----------------------------------|
| | | On-Chip Memory | On-Chip Peripheral Module |
| Instruction fetch | S_I | 2 | — |
| Branch address read | S_J | | |
| Stack operation | S_K | | |
| Byte data access | S_L | | 2 or 3* |
| Word data access | S_M | | — |
| Internal operation | S_N | | 1 |

Note: * Depends on which on-chip peripheral module is accessed. See section 13.1, Register Addresses (Address Order).

Table A.4 Number of Cycles in Each Instruction

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|-------------------|-------------|-----------------|----------------|-------------|-------------|----------------|
| | | Fetch I | Addr. Read J | Operation K | Access L | Access M | Operation N |
| ADD | ADD.B #xx:8, Rd | 1 | | | | | |
| | ADD.B Rs, Rd | 1 | | | | | |
| | ADD.W #xx:16, Rd | 2 | | | | | |
| | ADD.W Rs, Rd | 1 | | | | | |
| | ADD.L #xx:32, ERd | 3 | | | | | |
| | ADD.L ERs, ERd | 1 | | | | | |
| ADDS | ADDS #1/2/4, ERd | 1 | | | | | |
| ADDX | ADDX #xx:8, Rd | 1 | | | | | |
| | ADDX Rs, Rd | 1 | | | | | |
| AND | AND.B #xx:8, Rd | 1 | | | | | |
| | AND.B Rs, Rd | 1 | | | | | |
| | AND.W #xx:16, Rd | 2 | | | | | |
| | AND.W Rs, Rd | 1 | | | | | |
| | AND.L #xx:32, ERd | 3 | | | | | |
| | AND.L ERs, ERd | 2 | | | | | |
| ANDC | ANDC #xx:8, CCR | 1 | | | | | |
| BAND | BAND #xx:3, Rd | 1 | | | | | |
| | BAND #xx:3, @ERd | 2 | | | 1 | | |
| | BAND #xx:3, @aa:8 | 2 | | | 1 | | |
| Bcc | BRA d:8 (BT d:8) | 2 | | | | | |
| | BRN d:8 (BF d:8) | 2 | | | | | |
| | BHI d:8 | 2 | | | | | |
| | BLS d:8 | 2 | | | | | |
| | BCC d:8 (BHS d:8) | 2 | | | | | |
| | BCS d:8 (BLO d:8) | 2 | | | | | |
| | BNE d:8 | 2 | | | | | |
| | BEQ d:8 | 2 | | | | | |
| | BVC d:8 | 2 | | | | | |
| | BVS d:8 | 2 | | | | | |
| | BPL d:8 | 2 | | | | | |
| | BMI d:8 | 2 | | | | | |
| | BGE d:8 | 2 | | | | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|--------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| Bcc | BLT d:8 | 2 | | | | | |
| | BGT d:8 | 2 | | | | | |
| | BLE d:8 | 2 | | | | | |
| | BRA d:16(BT d:16) | 2 | | | | | 2 |
| | BRN d:16(BF d:16) | 2 | | | | | 2 |
| | BHI d:16 | 2 | | | | | 2 |
| | BLS d:16 | 2 | | | | | 2 |
| | BCC d:16(BHS d:16) | 2 | | | | | 2 |
| | BCS d:16(BLO d:16) | 2 | | | | | 2 |
| | BNE d:16 | 2 | | | | | 2 |
| | BEQ d:16 | 2 | | | | | 2 |
| | BVC d:16 | 2 | | | | | 2 |
| | BVS d:16 | 2 | | | | | 2 |
| | BPL d:16 | 2 | | | | | 2 |
| | BMI d:16 | 2 | | | | | 2 |
| | BGE d:16 | 2 | | | | | 2 |
| | BLT d:16 | 2 | | | | | 2 |
| BGT d:16 | 2 | | | | | 2 | |
| BLE d:16 | 2 | | | | | 2 | |
| BCLR | BCLR #xx:3, Rd | 1 | | | | | |
| | BCLR #xx:3, @ERd | 2 | | | 2 | | |
| | BCLR #xx:3, @aa:8 | 2 | | | 2 | | |
| | BCLR Rn, Rd | 1 | | | | | |
| | BCLR Rn, @ERd | 2 | | | 2 | | |
| | BCLR Rn, @aa:8 | 2 | | | 2 | | |
| BIAND | BIAND #xx:3, Rd | 1 | | | | | |
| | BIAND #xx:3, @ERd | 2 | | | 1 | | |
| | BIAND #xx:3, @aa:8 | 2 | | | 1 | | |
| BILD | BILD #xx:3, Rd | 1 | | | | | |
| | BILD #xx:3, @ERd | 2 | | | 1 | | |
| | BILD #xx:3, @aa:8 | 2 | | | 1 | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|--------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| BIOR | BIOR #xx:3, Rd | 1 | | | | | |
| | BIOR #xx:3, @ERd | 2 | | | 1 | | |
| | BIOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BIST | BIST #xx:3, Rd | 1 | | | | | |
| | BIST #xx:3, @ERd | 2 | | | 2 | | |
| | BIST #xx:3, @aa:8 | 2 | | | 2 | | |
| BIXOR | BIXOR #xx:3, Rd | 1 | | | | | |
| | BIXOR #xx:3, @ERd | 2 | | | 1 | | |
| | BIXOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BLD | BLD #xx:3, Rd | 1 | | | | | |
| | BLD #xx:3, @ERd | 2 | | | 1 | | |
| | BLD #xx:3, @aa:8 | 2 | | | 1 | | |
| BNOT | BNOT #xx:3, Rd | 1 | | | | | |
| | BNOT #xx:3, @ERd | 2 | | | 2 | | |
| | BNOT #xx:3, @aa:8 | 2 | | | 2 | | |
| | BNOT Rn, Rd | 1 | | | | | |
| | BNOT Rn, @ERd | 2 | | | 2 | | |
| | BNOT Rn, @aa:8 | 2 | | | 2 | | |
| BOR | BOR #xx:3, Rd | 1 | | | | | |
| | BOR #xx:3, @ERd | 2 | | | 1 | | |
| | BOR #xx:3, @aa:8 | 2 | | | 1 | | |
| BSET | BSET #xx:3, Rd | 1 | | | | | |
| | BSET #xx:3, @ERd | 2 | | | 2 | | |
| | BSET #xx:3, @aa:8 | 2 | | | 2 | | |
| | BSET Rn, Rd | 1 | | | | | |
| | BSET Rn, @ERd | 2 | | | 2 | | |
| | BSET Rn, @aa:8 | 2 | | | 2 | | |
| BSR | BSR d:8 | 2 | | 1 | | | |
| | BSR d:16 | 2 | | 1 | | | 2 |
| BST | BST #xx:3, Rd | 1 | | | | | |
| | BST #xx:3, @ERd | 2 | | | 2 | | |
| | BST #xx:3, @aa:8 | 2 | | | 2 | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|-------------------|-------------|------------|-----------|-------------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| BTST | BTST #xx:3, Rd | 1 | | | | | |
| | BTST #xx:3, @ERd | 2 | | | 1 | | |
| | BTST #xx:3, @aa:8 | 2 | | | 1 | | |
| | BTST Rn, Rd | 1 | | | | | |
| | BTST Rn, @ERd | 2 | | | 1 | | |
| | BTST Rn, @aa:8 | 2 | | | 1 | | |
| BXOR | BXOR #xx:3, Rd | 1 | | | | | |
| | BXOR #xx:3, @ERd | 2 | | | 1 | | |
| | BXOR #xx:3, @aa:8 | 2 | | | 1 | | |
| CMP | CMP.B #xx:8, Rd | 1 | | | | | |
| | CMP.B Rs, Rd | 1 | | | | | |
| | CMP.W #xx:16, Rd | 2 | | | | | |
| | CMP.W Rs, Rd | 1 | | | | | |
| | CMP.L #xx:32, ERd | 3 | | | | | |
| | CMP.L ERs, ERd | 1 | | | | | |
| DAA | DAA Rd | 1 | | | | | |
| DAS | DAS Rd | 1 | | | | | |
| DEC | DEC.B Rd | 1 | | | | | |
| | DEC.W #1/2, Rd | 1 | | | | | |
| | DEC.L #1/2, ERd | 1 | | | | | |
| DIVXS | DIVXS.B Rs, Rd | 2 | | | | | 12 |
| | DIVXS.W Rs, ERd | 2 | | | | | 20 |
| DIVXU | DIVXU.B Rs, Rd | 1 | | | | | 12 |
| | DIVXU.W Rs, ERd | 1 | | | | | 20 |
| EEPMOV | EEPMOV.B | 2 | | | $2n+2^{*1}$ | | |
| | EEPMOV.W | 2 | | | $2n+2^{*1}$ | | |
| EXTS | EXTS.W Rd | 1 | | | | | |
| | EXTS.L ERd | 1 | | | | | |
| EXTU | EXTU.W Rd | 1 | | | | | |
| | EXTU.L ERd | 1 | | | | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|----------------|------------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| INC | INC.B Rd | 1 | | | | | |
| | INC.W #1/2, Rd | 1 | | | | | |
| | INC.L #1/2, ERd | 1 | | | | | |
| JMP | JMP @ERn | 2 | | | | | |
| | JMP @aa:24 | 2 | | | | | 2 |
| | JMP @@@aa:8 | 2 | 1 | | | | 2 |
| JSR | JSR @ERn | 2 | | 1 | | | |
| | JSR @aa:24 | 2 | | 1 | | | 2 |
| | JSR @@@aa:8 | 2 | 1 | 1 | | | |
| LDC | LDC #xx:8, CCR | 1 | | | | | |
| | LDC Rs, CCR | 1 | | | | | |
| | LDC@ERs, CCR | 2 | | | | 1 | |
| | LDC@(d:16, ERs), CCR | 3 | | | | 1 | |
| | LDC@(d:24,ERs), CCR | 5 | | | | 1 | |
| | LDC@ERs+, CCR | 2 | | | | 1 | 2 |
| | LDC@aa:16, CCR | 3 | | | | 1 | |
| LDC@aa:24, CCR | 4 | | | | 1 | | |
| MOV | MOV.B #xx:8, Rd | 1 | | | | | |
| | MOV.B Rs, Rd | 1 | | | | | |
| | MOV.B @ERs, Rd | 1 | | | 1 | | |
| | MOV.B @(d:16, ERs), Rd | 2 | | | 1 | | |
| | MOV.B @(d:24, ERs), Rd | 4 | | | 1 | | |
| | MOV.B @ERs+, Rd | 1 | | | 1 | | 2 |
| | MOV.B @aa:8, Rd | 1 | | | 1 | | |
| | MOV.B @aa:16, Rd | 2 | | | 1 | | |
| | MOV.B @aa:24, Rd | 3 | | | 1 | | |
| | MOV.B Rs, @ERd | 1 | | | 1 | | |
| | MOV.B Rs, @(d:16, ERd) | 2 | | | 1 | | |
| | MOV.B Rs, @(d:24, ERd) | 4 | | | 1 | | |
| | MOV.B Rs, @-ERd | 1 | | | 1 | | 2 |
| | MOV.B Rs, @@@aa:8 | 1 | | | 1 | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|----------------------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| MOV | MOV.B Rs, @aa:16 | 2 | | | 1 | | |
| | MOV.B Rs, @aa:24 | 3 | | | 1 | | |
| | MOV.W #xx:16, Rd | 2 | | | | | |
| | MOV.W Rs, Rd | 1 | | | | | |
| | MOV.W @ERs, Rd | 1 | | | | 1 | |
| | MOV.W @(d:16,ERs), Rd | 2 | | | | 1 | |
| | MOV.W @(d:24,ERs), Rd | 4 | | | | 1 | |
| | MOV.W @ERs+, Rd | 1 | | | | 1 | 2 |
| | MOV.W @aa:16, Rd | 2 | | | | 1 | |
| | MOV.W @aa:24, Rd | 3 | | | | 1 | |
| | MOV.W Rs, @ERd | 1 | | | | 1 | |
| | MOV.W Rs, @(d:16,ERd) | 2 | | | | 1 | |
| | MOV.W Rs, @(d:24,ERd) | 4 | | | | 1 | |
| MOV | MOV.W Rs, @-ERd | 1 | | | | 1 | 2 |
| | MOV.W Rs, @aa:16 | 2 | | | | 1 | |
| | MOV.W Rs, @aa:24 | 3 | | | | 1 | |
| | MOV.L #xx:32, ERd | 3 | | | | | |
| | MOV.L ERs, ERd | 1 | | | | | |
| | MOV.L @ERs, ERd | 2 | | | | 2 | |
| | MOV.L @(d:16,ERs), ERd | 3 | | | | 2 | |
| | MOV.L @(d:24,ERs), ERd | 5 | | | | 2 | |
| | MOV.L @ERs+, ERd | 2 | | | | 2 | 2 |
| | MOV.L @aa:16, ERd | 3 | | | | 2 | |
| | MOV.L @aa:24, ERd | 4 | | | | 2 | |
| | MOV.L ERs, @ERd | 2 | | | | 2 | |
| | MOV.L ERs, @(d:16,ERd) | 3 | | | | 2 | |
| | MOV.L ERs, @(d:24,ERd) | 5 | | | | 2 | |
| | MOV.L ERs, @-ERd | 2 | | | | 2 | 2 |
| | MOV.L ERs, @aa:16 | 3 | | | | 2 | |
| | MOV.L ERs, @aa:24 | 4 | | | | 2 | |
| MOVFPPE | MOVFPPE @aa:16, Rd* ² | 2 | | | 1 | | |
| MOVTPPE | MOVTPPE Rs, @aa:16* ² | 2 | | | 1 | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| MULXS | MULXS.B Rs, Rd | 2 | | | | | 12 |
| | MULXS.W Rs, ERd | 2 | | | | | 20 |
| MULXU | MULXU.B Rs, Rd | 1 | | | | | 12 |
| | MULXU.W Rs, ERd | 1 | | | | | 20 |
| NEG | NEG.B Rd | 1 | | | | | |
| | NEG.W Rd | 1 | | | | | |
| | NEG.L ERd | 1 | | | | | |
| NOP | NOP | 1 | | | | | |
| NOT | NOT.B Rd | 1 | | | | | |
| | NOT.W Rd | 1 | | | | | |
| | NOT.L ERd | 1 | | | | | |
| OR | OR.B #xx:8, Rd | 1 | | | | | |
| | OR.B Rs, Rd | 1 | | | | | |
| | OR.W #xx:16, Rd | 2 | | | | | |
| | OR.W Rs, Rd | 1 | | | | | |
| | OR.L #xx:32, ERd | 3 | | | | | |
| | OR.L ERs, ERd | 2 | | | | | |
| ORC | ORC #xx:8, CCR | 1 | | | | | |
| POP | POP.W Rn | 1 | | | | 1 | 2 |
| | POP.L ERn | 2 | | | | 2 | 2 |
| PUSH | PUSH.W Rn | 1 | | | | 1 | 2 |
| | PUSH.L ERn | 2 | | | | 2 | 2 |
| ROTL | ROTL.B Rd | 1 | | | | | |
| | ROTL.W Rd | 1 | | | | | |
| | ROTL.L ERd | 1 | | | | | |
| ROTR | ROTR.B Rd | 1 | | | | | |
| | ROTR.W Rd | 1 | | | | | |
| | ROTR.L ERd | 1 | | | | | |
| ROTXL | ROTXL.B Rd | 1 | | | | | |
| | ROTXL.W Rd | 1 | | | | | |
| | ROTXL.L ERd | 1 | | | | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|----------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| ROTXR | ROTXR.B Rd | 1 | | | | | |
| | ROTXR.W Rd | 1 | | | | | |
| | ROTXR.L ERd | 1 | | | | | |
| RTE | RTE | 2 | | 2 | | | 2 |
| RTS | RTS | 2 | | 1 | | | 2 |
| SHAL | SHAL.B Rd | 1 | | | | | |
| | SHAL.W Rd | 1 | | | | | |
| | SHAL.L ERd | 1 | | | | | |
| SHAR | SHAR.B Rd | 1 | | | | | |
| | SHAR.W Rd | 1 | | | | | |
| | SHAR.L ERd | 1 | | | | | |
| SHLL | SHLL.B Rd | 1 | | | | | |
| | SHLL.W Rd | 1 | | | | | |
| | SHLL.L ERd | 1 | | | | | |
| SHLR | SHLR.B Rd | 1 | | | | | |
| | SHLR.W Rd | 1 | | | | | |
| | SHLR.L ERd | 1 | | | | | |
| SLEEP | SLEEP | 1 | | | | | |
| STC | STC CCR, Rd | 1 | | | | | |
| | STC CCR, @ERd | 2 | | | | 1 | |
| | STC CCR, @(d:16,ERd) | 3 | | | | 1 | |
| | STC CCR, @(d:24,ERd) | 5 | | | | 1 | |
| | STC CCR,@-ERd | 2 | | | | 1 | 2 |
| | STC CCR, @aa:16 | 3 | | | | 1 | |
| | STC CCR, @aa:24 | 4 | | | | 1 | |
| SUB | SUB.B Rs, Rd | 1 | | | | | |
| | SUB.W #xx:16, Rd | 2 | | | | | |
| | SUB.W Rs, Rd | 1 | | | | | |
| | SUB.L #xx:32, ERd | 3 | | | | | |
| | SUB.L ERs, ERd | 1 | | | | | |
| SUBS | SUBS #1/2/4, ERd | 1 | | | | | |

| Instruction | Mnemonic | Instruction | Branch | Stack | Byte Data | Word Data | Internal |
|-------------|-------------------|-------------|------------|-----------|-----------|-----------|-----------|
| | | Fetch | Addr. Read | Operation | Access | Access | Operation |
| | | I | J | K | L | M | N |
| SUBX | SUBX #xx:8, Rd | 1 | | | | | |
| | SUBX. Rs, Rd | 1 | | | | | |
| XOR | XOR.B #xx:8, Rd | 1 | | | | | |
| | XOR.B Rs, Rd | 1 | | | | | |
| | XOR.W #xx:16, Rd | 2 | | | | | |
| | XOR.W Rs, Rd | 1 | | | | | |
| | XOR.L #xx:32, ERd | 3 | | | | | |
| | XOR.L ERs, ERd | 2 | | | | | |
| XORC | XORC #xx:8, CCR | 1 | | | | | |

- Notes:
1. n: Specified value in R4L. The source and destination operands are accessed n+1 times respectively.
 2. It cannot be used in this LSI.

A.4 Combinations of Instructions and Addressing Modes

Table A.5 Combinations of Instructions and Addressing Modes

| Functions | Instructions | Addressing Mode | | | | | | | | | | | | |
|----------------------------------|-------------------------------------|-----------------|-----|-------|---------------|---------------|--------------|--------|---------|---------|-------------|--------------|---------|----|
| | | #xx | Rn | @ ERn | @ (d1:16.ERn) | @ (d1:24.ERn) | @ ERn+/@ ERn | @ aa:8 | @ aa:16 | @ aa:24 | @ (d1:8.PC) | @ (d1:16.PC) | @ @aa:8 | |
| Data transfer instructions | MOV | BWL | BWL | BWL | BWL | BWL | BWL | B | BWL | BWL | — | — | — | — |
| | POP, PUSH | — | — | — | — | — | — | — | — | — | — | — | — | WL |
| | MOVFPPE, MOVTPPE | — | — | — | — | — | — | — | — | — | — | — | — | — |
| Arithmetic operations | ADD, CMP | BWL | BWL | — | — | — | — | — | — | — | — | — | — | — |
| | SUB | WL | BWL | — | — | — | — | — | — | — | — | — | — | — |
| | ADDX, SUBX | B | B | — | — | — | — | — | — | — | — | — | — | — |
| | ADDS, SUBS | — | L | — | — | — | — | — | — | — | — | — | — | — |
| | INC, DEC | — | BWL | — | — | — | — | — | — | — | — | — | — | — |
| | DAA, DAS | — | B | — | — | — | — | — | — | — | — | — | — | — |
| | MULXU, MULXS, DIVXU, DIVXS | — | BW | — | — | — | — | — | — | — | — | — | — | — |
| | NEG | — | BWL | — | — | — | — | — | — | — | — | — | — | — |
| EXTU, EXTS | — | WL | — | — | — | — | — | — | — | — | — | — | — | |
| Logical operations | AND, OR, XOR | — | BWL | — | — | — | — | — | — | — | — | — | — | — |
| | NOT | — | BWL | — | — | — | — | — | — | — | — | — | — | — |
| Shift operations | | — | BWL | — | — | — | — | — | — | — | — | — | — | — |
| Bit manipulations | | — | B | B | — | — | — | B | — | — | — | — | — | — |
| Branching instructions | BCC, BSR | — | — | — | — | — | — | — | — | — | — | — | — | — |
| | JMP, JSR | — | — | ○ | — | — | — | — | — | — | ○ | ○ | — | — |
| | RTS | — | — | — | — | — | — | — | — | ○ | — | — | ○ | — |
| System control instructions | RTE | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| | SLEEP | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| | LDC | B | B | W | W | W | W | — | W | W | — | — | — | ○ |
| | STC | — | B | W | W | W | W | — | W | W | — | — | — | — |
| | ANDC, ORC, XORC | B | — | — | — | — | — | — | — | — | — | — | — | — |
| | NOP | — | — | — | — | — | — | — | — | — | — | — | — | ○ |
| Block data transfer instructions | | — | — | — | — | — | — | — | — | — | — | — | — | BW |

B. I/O Port Block Diagrams

B.1 Port 3 Block Diagrams

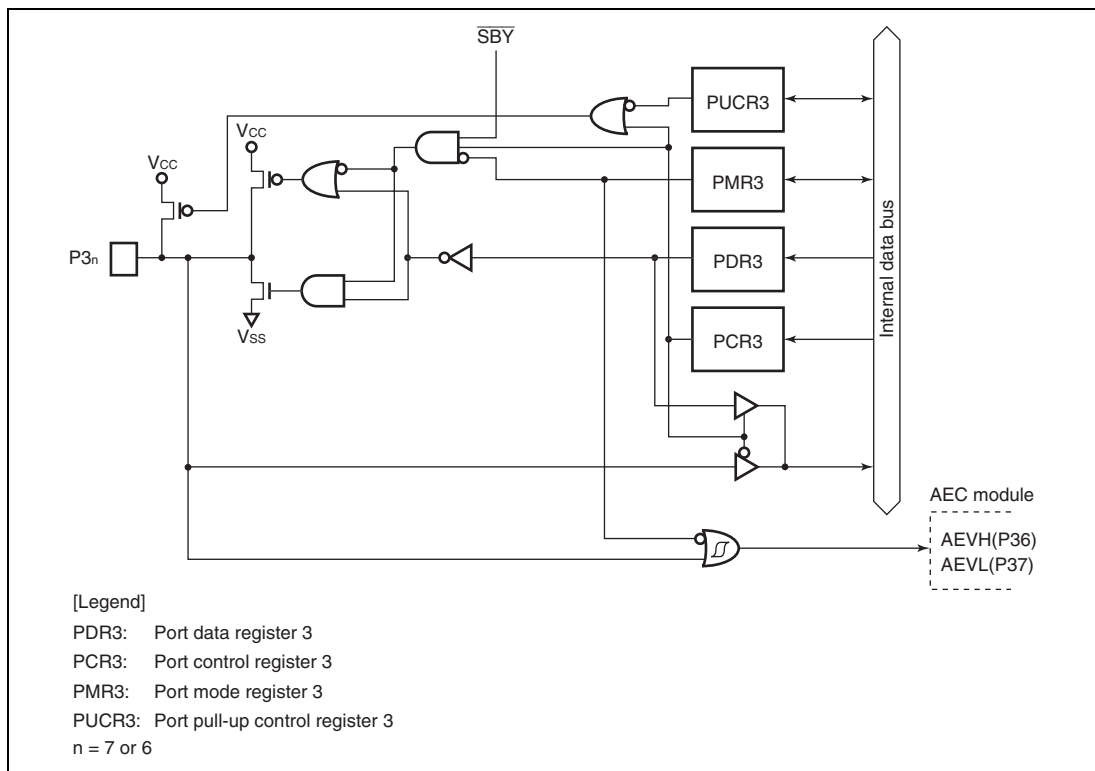


Figure B.1(a) Port 3 Block Diagram (Pins P37 and P36)

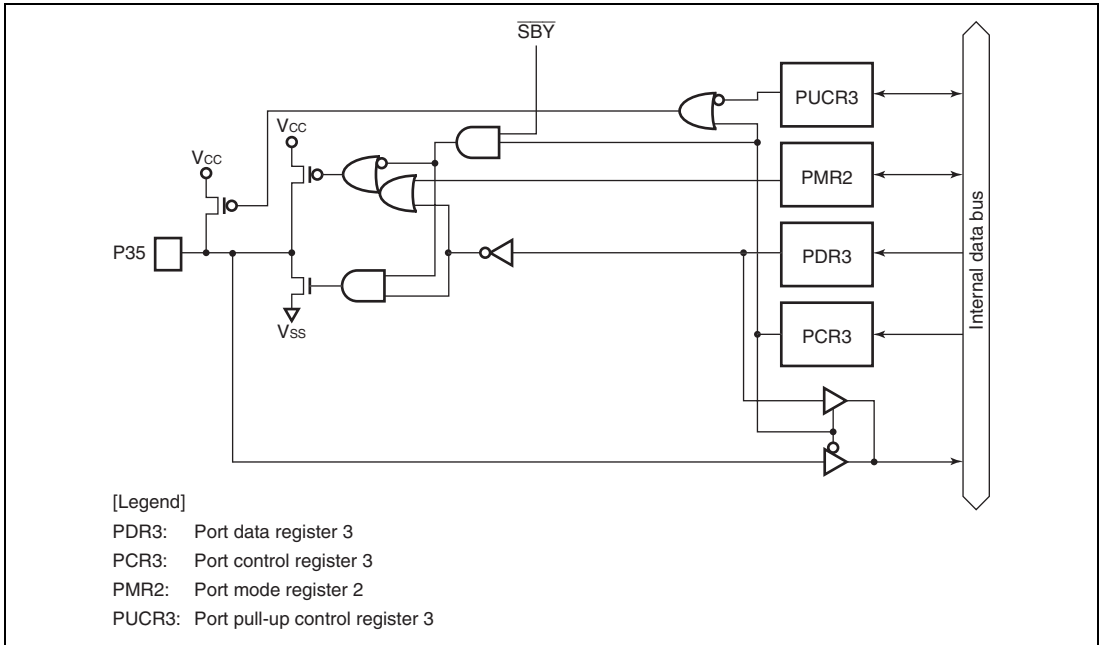


Figure B.1(b) Port 3 Block Diagram (Pin P35)

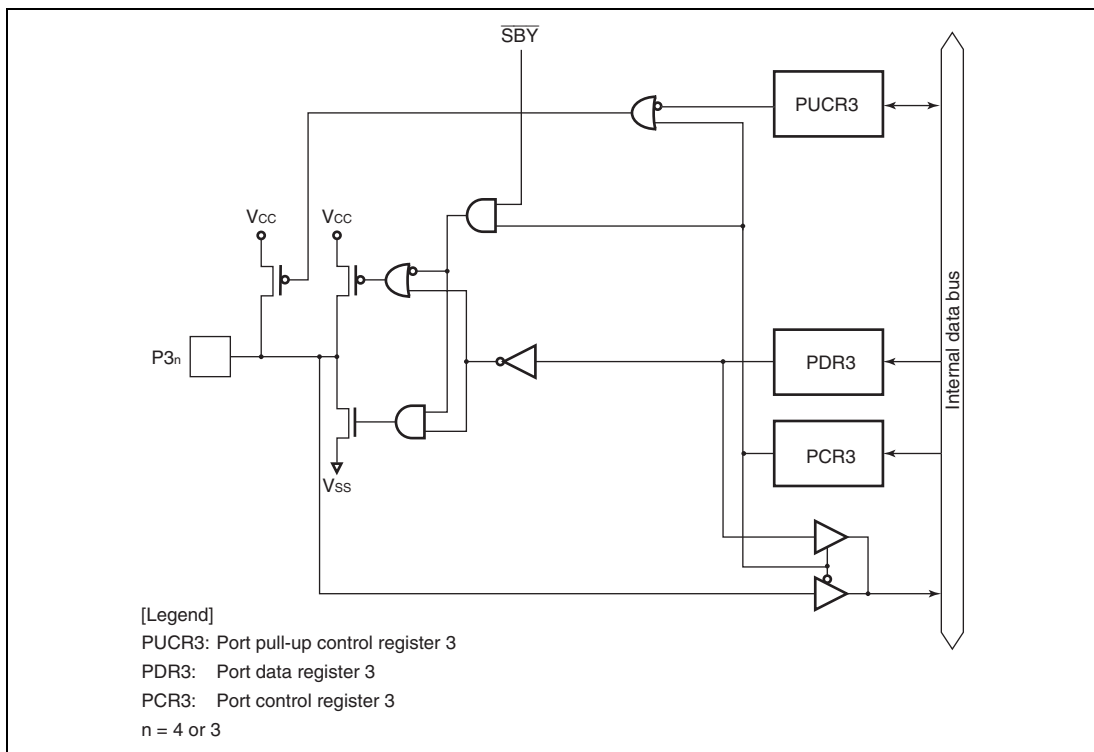


Figure B.1(c) Port 3 Block Diagram (Pins P34 and P33)

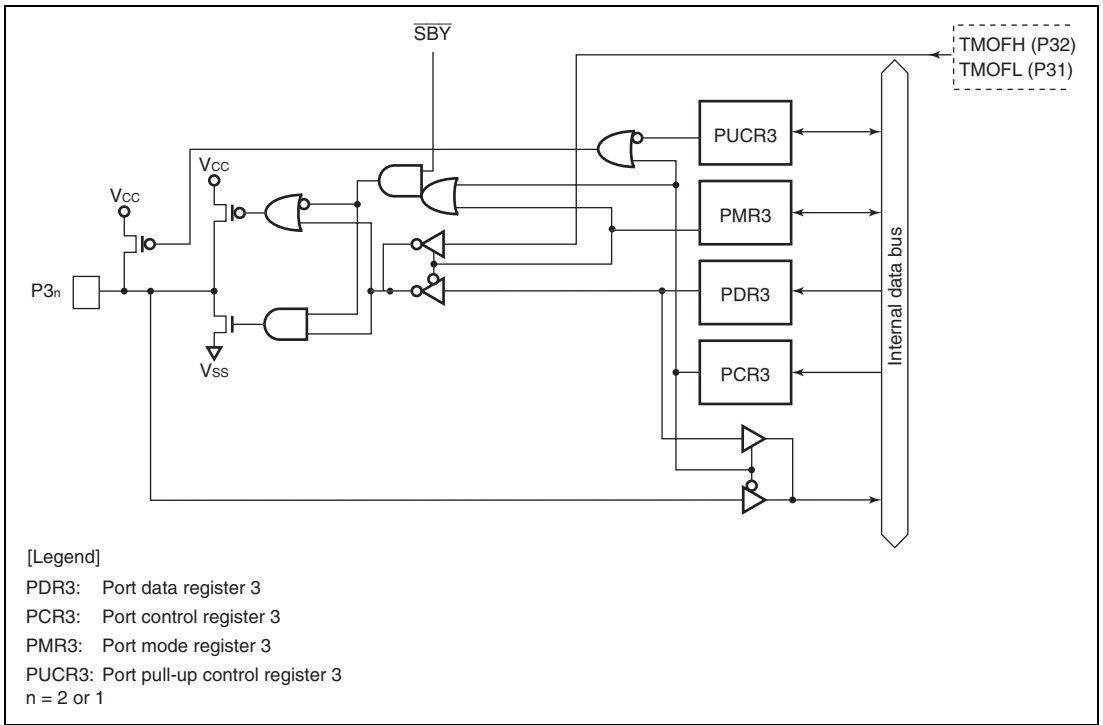


Figure B.1(d) Port 3 Block Diagram (Pins P32 and P31)

B.2 Port 4 Block Diagrams

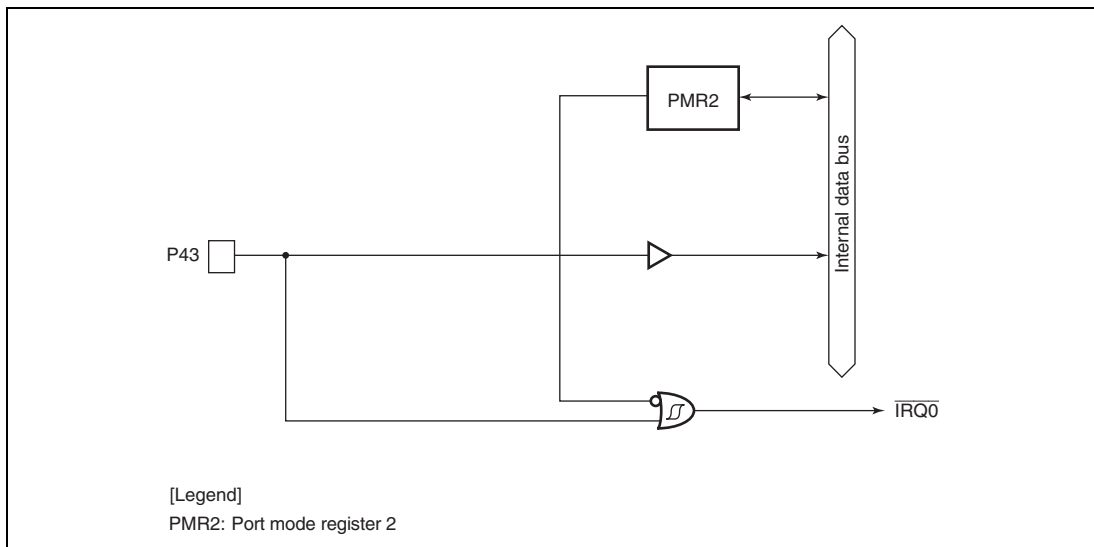


Figure B.2(a) Port 4 Block Diagram (Pin P43)

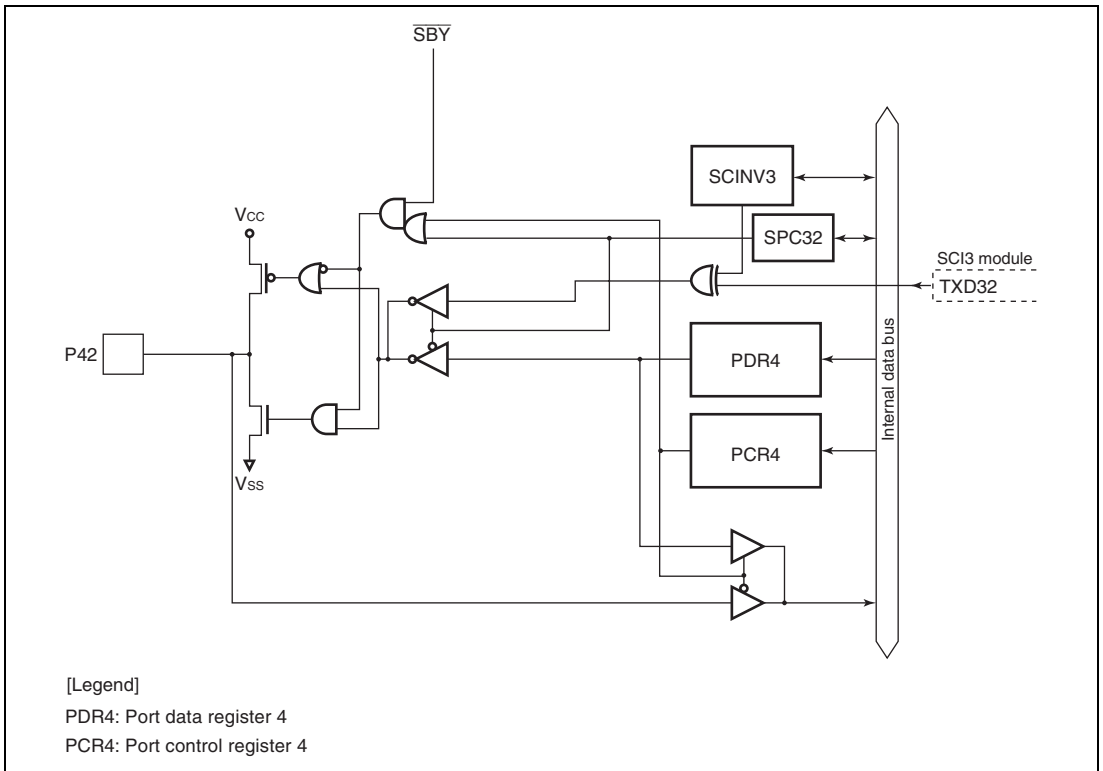


Figure B.2(b) Port 4 Block Diagram (Pin P42)

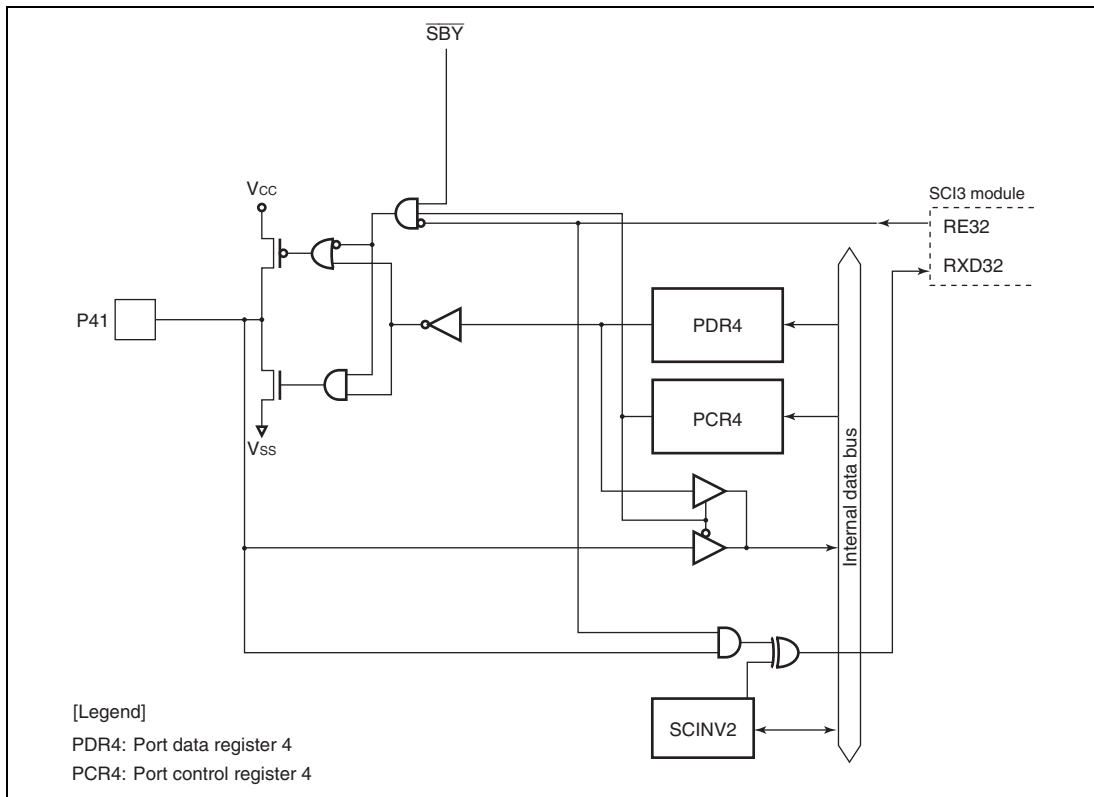


Figure B.2(c) Port 4 Block Diagram (Pin P41)

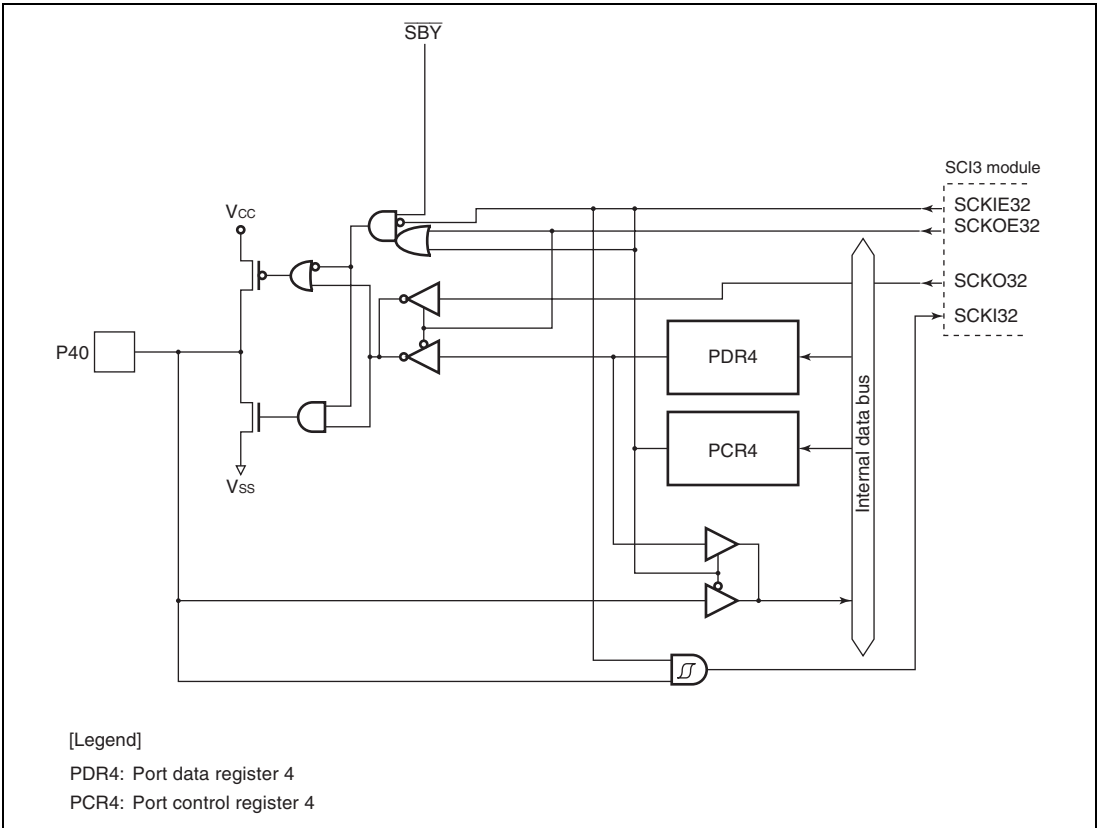


Figure B.2(d) Port 4 Block Diagram (Pin P40)

B.3 Port 5 Block Diagram

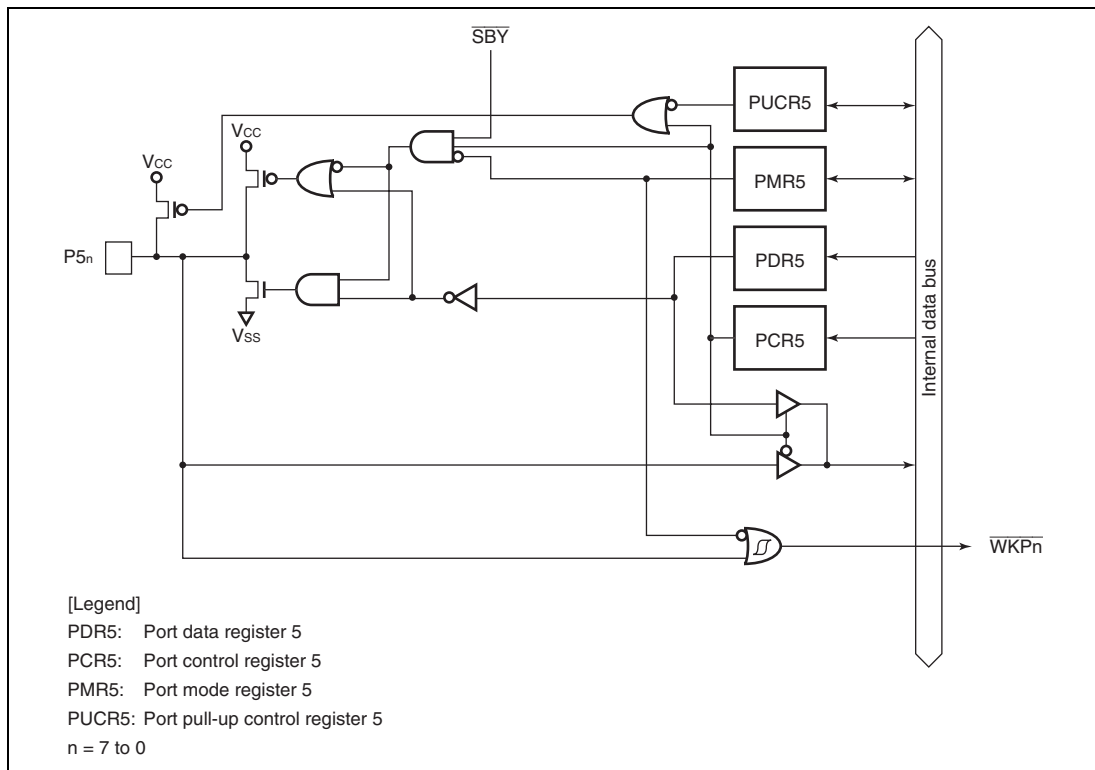


Figure B.3 Port 5 Block Diagram

B.4 Port 6 Block Diagram

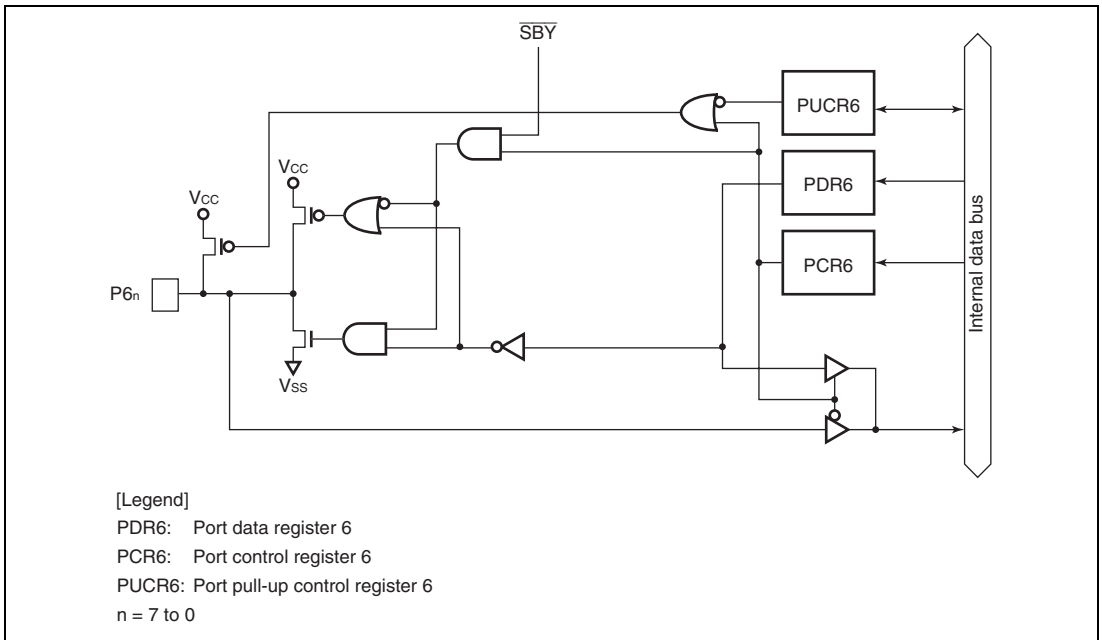


Figure B.4 Port 6 Block Diagram

B.5 Port 7 Block Diagram

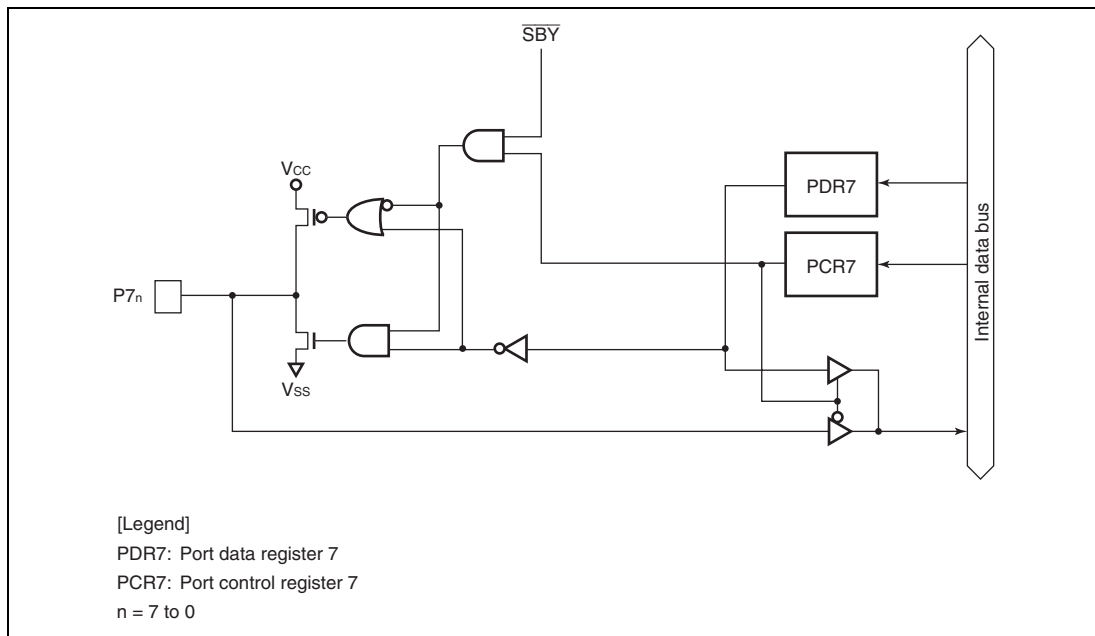


Figure B.5 Port 7 Block Diagram

B.6 Port 8 Block Diagram

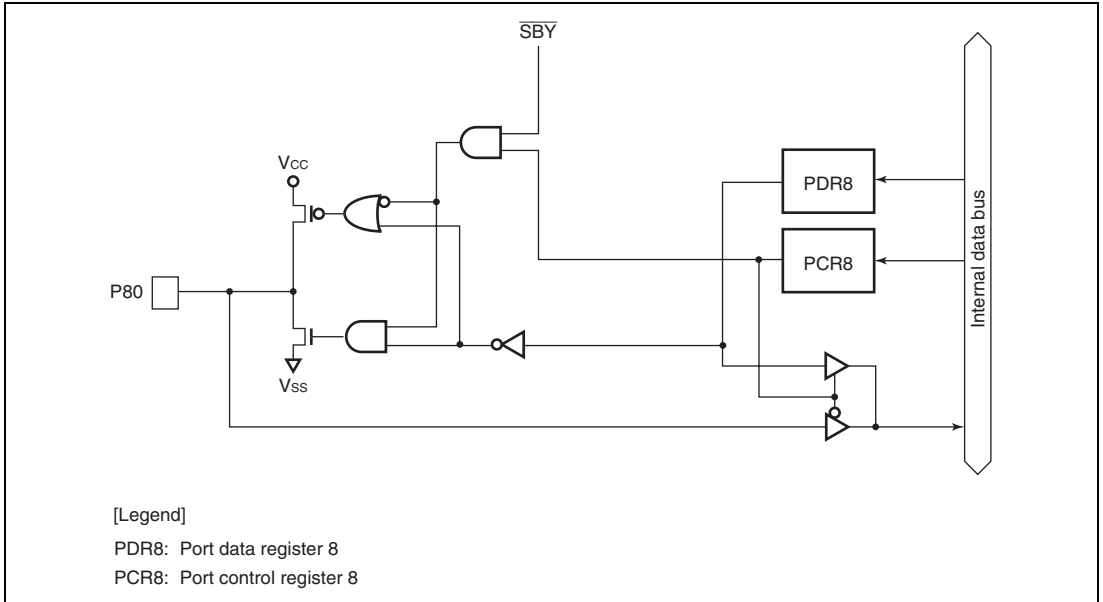


Figure B.6 Port 8 Block Diagram (Pin P80)

B.7 Port 9 Block Diagrams

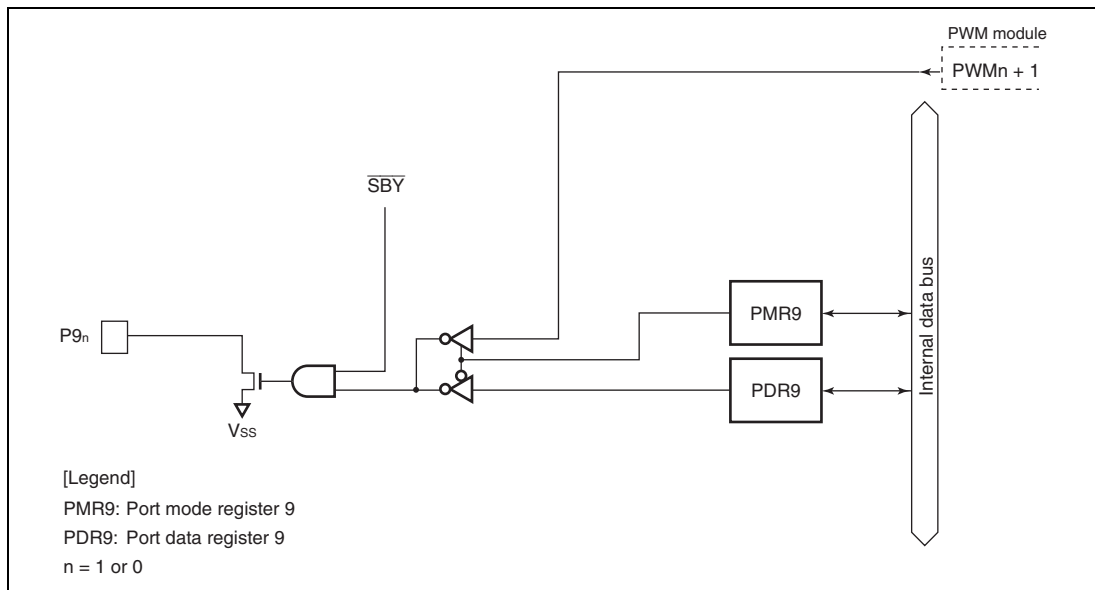


Figure B.7(a) Port 9 Block Diagram (Pins P91 and P90)

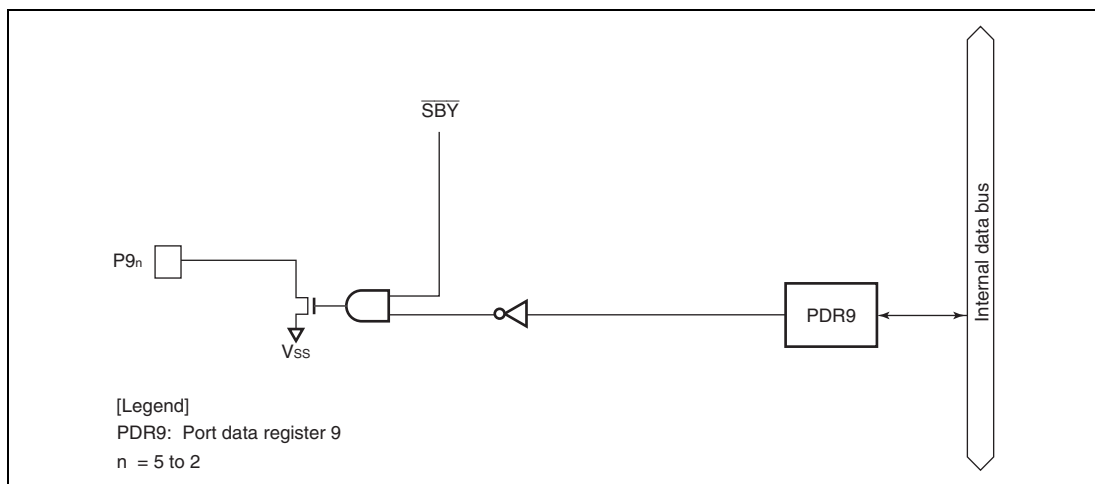
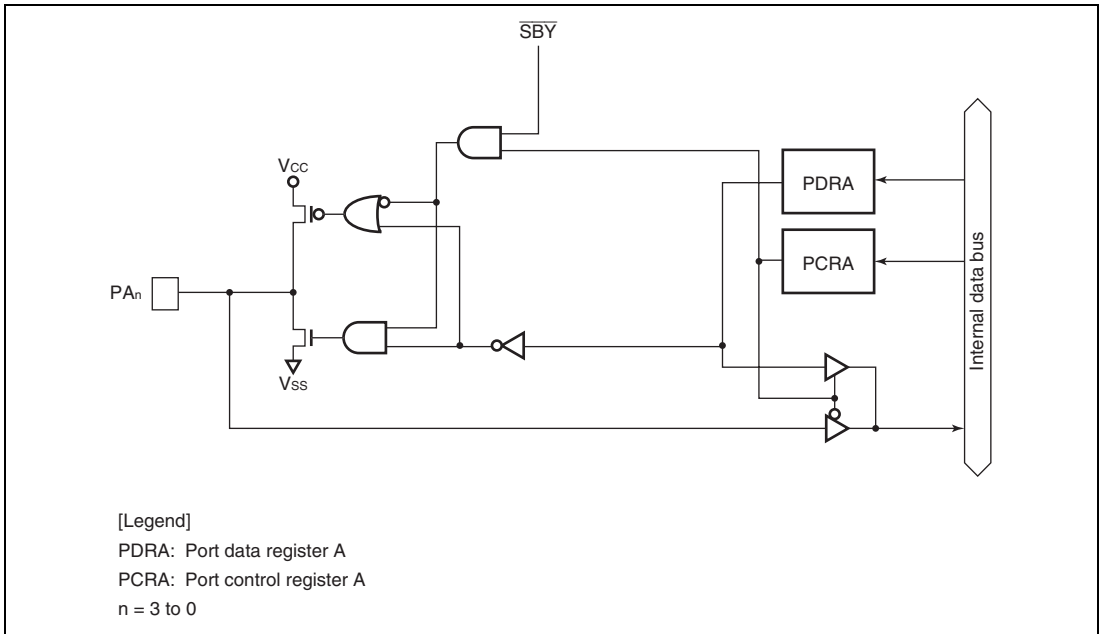


Figure B.7(b) Port 9 Block Diagram (Pins P95 to P92)

B.8 Port A Block Diagram**Figure B.8 Port A Block Diagram**

B.9 Port B Block Diagrams

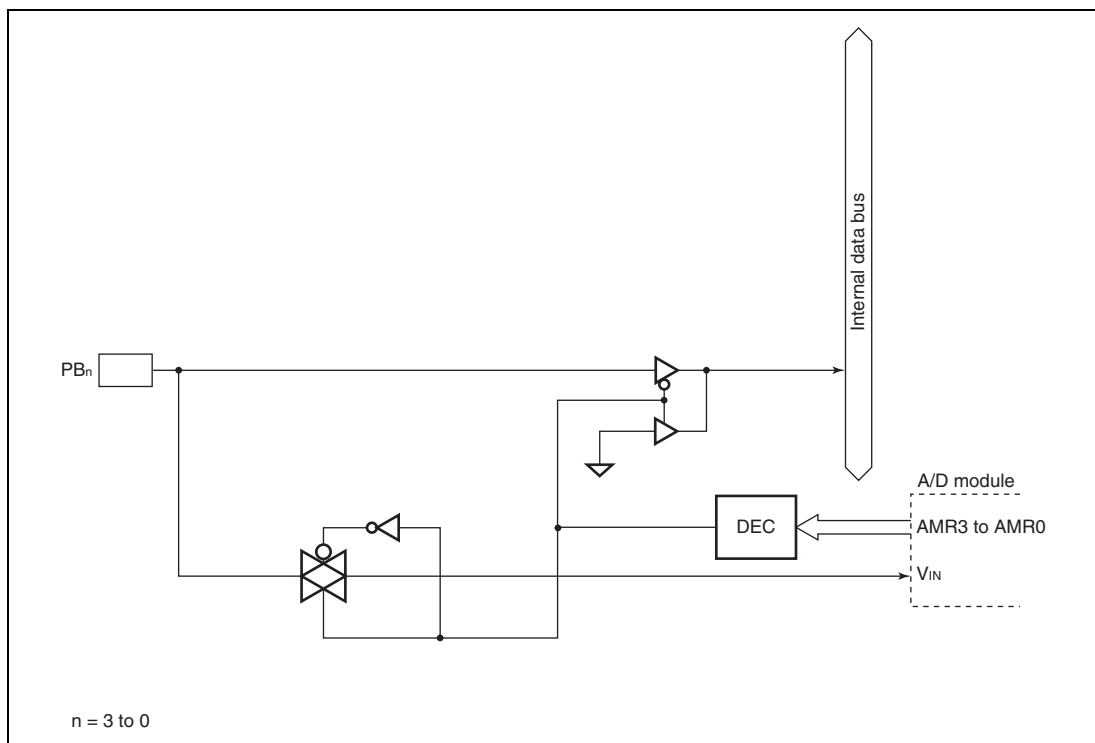


Figure B.9 Port B Block Diagram

C. Port States in Each Operating State

Table C.1 Port States

| Port | Reset | Sleep | Subsleep | Standby | Watch | Subactive | Active |
|-------------|----------------|----------------|-----------------|-----------------|----------------|------------------|----------------|
| P37 to P31 | High impedance | Retained | Retained | High impedance* | Retained | Functioning | Functioning |
| P43 to P40 | High impedance | Retained | Retained | High impedance | Retained | Functioning | Functioning |
| P57 to P50 | High impedance | Retained | Retained | High impedance* | Retained | Functioning | Functioning |
| P67 to P60 | High impedance | Retained | Retained | High impedance* | Retained | Functioning | Functioning |
| P77 to P70 | High impedance | Retained | Retained | High impedance | Retained | Functioning | Functioning |
| P80 | High impedance | Retained | Retained | High impedance | Retained | Functioning | Functioning |
| P95 to P90 | High impedance | Retained | Retained | High impedance | Retained | Functioning | Functioning |
| PA3 to PA0 | High impedance | Retained | Retained | High impedance | Retained | Functioning | Functioning |
| PB3 to PB0 | High impedance | High impedance | High impedance | High impedance | High impedance | High impedance | High impedance |

Note: * High level output when the pull-up MOS is in on state.

D. Product Code Lineup

Table D.1 Product Code Lineup of H8/38704 Group

| Product Type | | | Product Code | Model Marking | Package (Package Code) |
|---|--|---|----------------|----------------------|---------------------------|
| H8/38704 | Flash memory version | Regular product (2.7 V) | HD64F38704H10 | 64F38704H10 | 64-pin QFP (FP-64A) |
| | | | HD64F38704FP10 | F38704FP10 | 64-pin LQFP (FP-64E) |
| | | | HD64F38704FT10 | F38704FT10 | 64-pin QFN (TNP-64B) |
| | | Regular product (2.2 V) | HD64F38704H4 | 64F38704H4 | 64-pin QFP (FP-64A) |
| | | | HD64F38704FP4 | F38704FP4 | 64-pin LQFP (FP-64E) |
| | | | HD64F38704 FT4 | F38704FT4 | 64-pin QFN (TNP-64B) |
| | Product with wide-range temperature specifications (2.7 V) | HD64F38704H10W | 64F38704H10 | 64-pin QFP (FP-64A) | |
| | | HD64F38704FP10W | F38704FP10 | 64-pin LQFP (FP-64E) | |
| | | HD64F38704FT10W | 38704FT10 | 64-pin QFN (TNP-64B) | |
| | Mask ROM version | Regular product | HD64338704H | HD64338704H | 64-pin QFP (FP-64A) |
| | | | HD64338704FP | 38704 (***) FP | 64-pin LQFP (FP-64E) |
| | | | HD64338704FT | 38704 (***) FT | 64-pin QFN (TNP-64B) |
| Product with wide-range temperature specifications | | HD64338704HW | HD64338704H | 64-pin QFP (FP-64A) | |
| | | HD64338704FPW | 38704 (***) FP | 64-pin LQFP (FP-64E) | |
| | | HD64338704FTW | 38704 (***) FT | 64-pin QFN (TNP-64B) | |
| H8/38703 | Mask ROM version | Regular product | HD64338703H | HD64338703H | 64-pin QFP (FP-64A) |
| | | | HD64338703FP | 38703 (***) FP | 64-pin LQFP (FP-64E) |
| | | | HD64338703FT | 38703 (***) FT | 64-pin QFN (TNP-64B) |
| | | Product with wide-range temperature specifications | HD64338703HW | HD64338703H | 64-pin QFP (FP-64A) |
| | | | HD64338703FPW | 38703 (***) FP | 64-pin LQFP (FP-64E) |
| | | | HD64338703FTW | 38703 (***) FT | 64-pin QFN (TNP-64B) |

| Product Type | Product Code | Package | | Product Type | Product Code |
|--------------|----------------------|--|-----------------|----------------|-----------------------|
| | | Model Marking | (Package Code) | | |
| H8/38702 | Flash memory version | Regular product (2.7 V) | HD64F38702H10 | 64F38702H10 | 64-pin QFP (FP-64A) |
| | | | HD64F38702FP10 | F38702FP10 | 64-pin LQFP (FP-64E) |
| | | | HD64F38702FT10 | F38702FT10 | 64-pin QFN (TNP-64B) |
| | | Regular product (2.2 V) | HD64F38702H4 | 64F38702H4 | 64-pin QFP (FP-64A) |
| | | | HD64F38702FP4 | F38702FP4 | 64-pin LQFP (FP-64E) |
| | | | HD64F38702FT4 | F38702FT4 | 64-pin QFN (TNP-64B) |
| | | Product with wide-range temperature specifications (2.7 V) | HD64F38702H10W | 64F38702H10 | 64-pin QFP (FP-64A) |
| | | | HD64F38702FP10W | F38702FP10 | 64-pin LQFP (FP-64E) |
| | | | HD64F38702FT10W | F38702FT10 | 64-pin QFN (TNP-64B) |
| | Mask ROM version | Regular product | HD64338702H | HD64338702H | 64-pin QFP (FP-64A) |
| | | | HD64338702FP | 38702 (***) FP | 64-pin LQFP (FP-64E) |
| | | | HD64338702FT | 38702 (***) FT | 64-pin LQFN (TNP-64B) |
| | | Product with wide-range temperature specifications | HD64338702HW | HD64338702H | 64-pin QFP (FP-64A) |
| | | | HD64338702FPW | 38702 (***) FP | 64-pin LQFP (FP-64E) |
| | | | HD64338702FTW | 38702 (***) FT | 64-pin QFN (TNP-64B) |

[Legend]

(***) : ROM code

Table D.2 Product Code Lineup of H8/38702S Group

| Product Type | | | Product Code | Model Marking | Package (Package Code) |
|--------------|---|--------------------|----------------|----------------------|---------------------------|
| H8/38702S | Mask ROM version | Regular product | HD64338702SH | 38702 (***) H | 64-pin QFP (FP-64A) |
| | | | HD64338702SFZ | 38702 (***) | 64-pin LQFP (FP-64K) |
| | | | HD64338702SFT | 38702 (***) FT | 64-pin QFN (TNP-64B) |
| | Product with wide-range temperature specifications | HD64338702SHW | 38702 (***) H | 64-pin QFP (FP-64A) | |
| | | HD64338702SFZW | 38702 (***) | 64-pin LQFP (FP-64K) | |
| | | HD64338702SFTW | 38702 (***) FT | 64-pin QFN (TNP-64B) | |
| H8/38701S | Mask ROM version | Regular product | HD64338701SH | 38701 (***) H | 64-pin QFP (FP-64A) |
| | | | HD64338701SFZ | 38701 (***) | 64-pin LQFP (FP-64K) |
| | | | HD64338701SFT | 38701 (***) FT | 64-pin QFN (TNP-64B) |
| | Product with wide-range temperature specifications | HD64338701SHW | 38701 (***) H | 64-pin QFP (FP-64A) | |
| | | HD64338701SFZW | 38701 (***) | 64-pin LQFP (FP-64K) | |
| | | HD64338701SFTW | 38701 (***) FT | 64-pin QFN (TNP-64B) | |
| H8/38700S | Mask ROM version | Regular product | HD64338700SH | 38700 (***) H | 64-pin QFP (FP-64A) |
| | | | HD64338700SFZ | 38700 (***) | 64-pin LQFP (FP-64K) |
| | | | HD64338700SFT | 38700 (***) FT | 64-pin QFN (TNP-64B) |
| | Product with wide-range temperature specifications | HD64338700SHW | 38700 (***) H | 64-pin QFP (FP-64A) | |
| | | HD64338700SFZW | 38700 (***) | 64-pin LQFP (FP-64K) | |
| | | HD64338700SFTW | 38700 (***) FT | 64-pin QFN (TNP-64B) | |

[Legend]

(***) : ROM code

E. Package Dimensions

The package dimensions are shown in figure E.1 (FP-64A), figure E.2 (FP-64E), figure E.3 (FP-64K), and figure E.4 (TNP-64B).

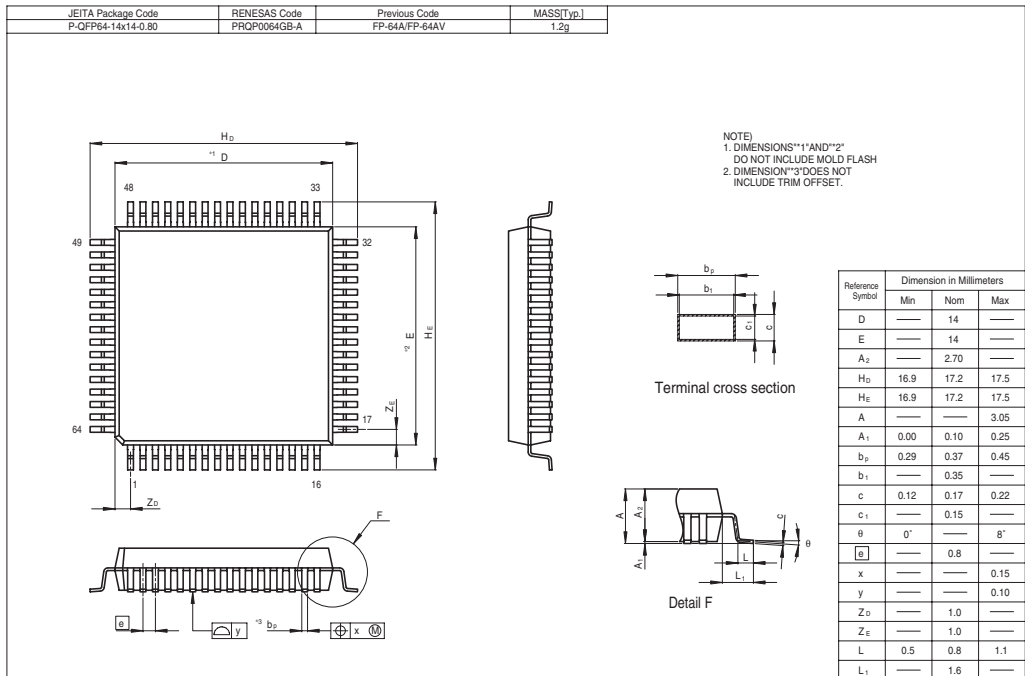
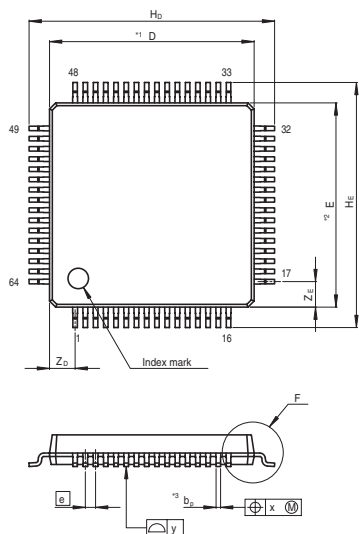
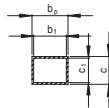


Figure E.1 Package Dimensions (FP-64A)

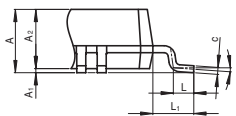
| | | | |
|---|------------------------------|---------------------------------|--------------------|
| JEITA Package Code P-LOFP64-10x10-0.50 | RENESAS Code PLOP0064KC-A | Previous Code FP-64E/FP-64EV | MASS[Typ.] 0.4g |
|---|------------------------------|---------------------------------|--------------------|



NOTE
 1. DIMENSIONS*1*1 AND*2*2
 DO NOT INCLUDE MOLD FLASH
 2. DIMENSION*3*3 DOES NOT
 INCLUDE TRIM OFFSET.



Terminal cross section



Detail F

| Reference Symbol | Dimension in Millimeters | | |
|------------------|--------------------------|------|------|
| | Min | Nom | Max |
| D | — | 10 | — |
| E | — | 10 | — |
| A ₂ | — | 1.45 | — |
| H _D | 11.8 | 12.0 | 12.2 |
| H _E | 11.8 | 12.0 | 12.2 |
| A | — | — | 1.70 |
| A ₁ | 0.00 | 0.10 | 0.20 |
| b _p | 0.17 | 0.22 | 0.27 |
| b ₁ | — | 0.20 | — |
| c | 0.12 | 0.17 | 0.22 |
| c ₁ | — | 0.15 | — |
| theta | 0° | — | 8° |
| g | — | 0.5 | — |
| x | — | — | 0.08 |
| y | — | — | 0.10 |
| Z _D | — | 1.25 | — |
| Z _E | — | 1.25 | — |
| L | 0.3 | 0.5 | 0.7 |
| L ₁ | — | 1.0 | — |

Figure E.2 Package Dimensions (FP-64E)

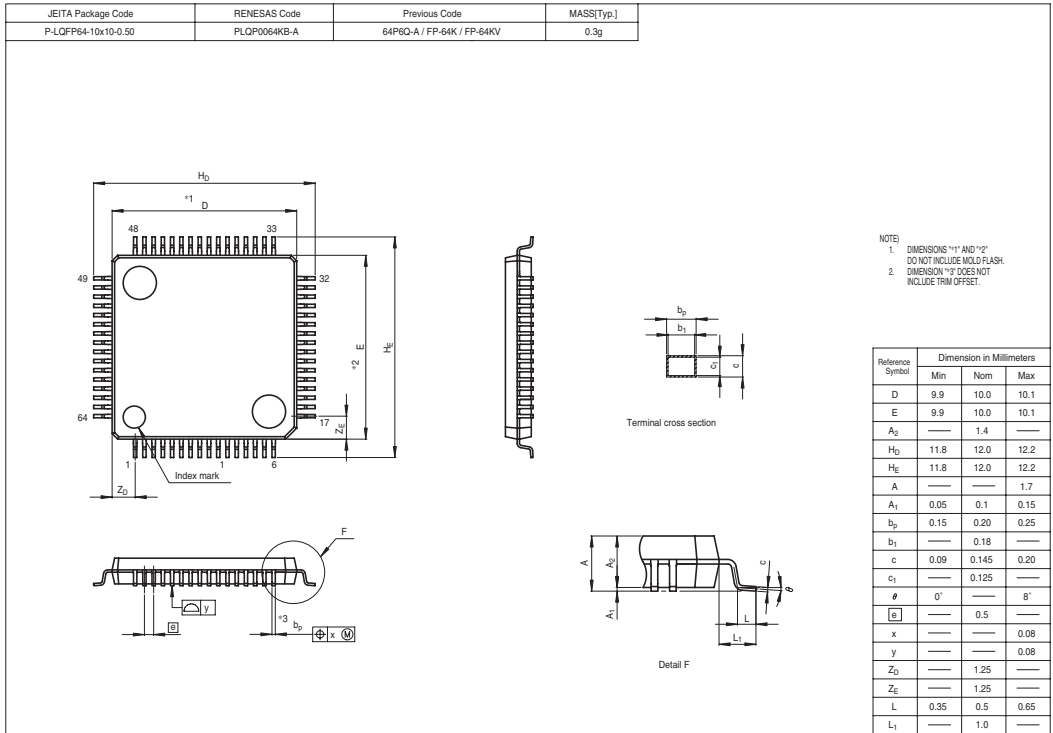


Figure E.3 Package Dimensions (FP-64K)

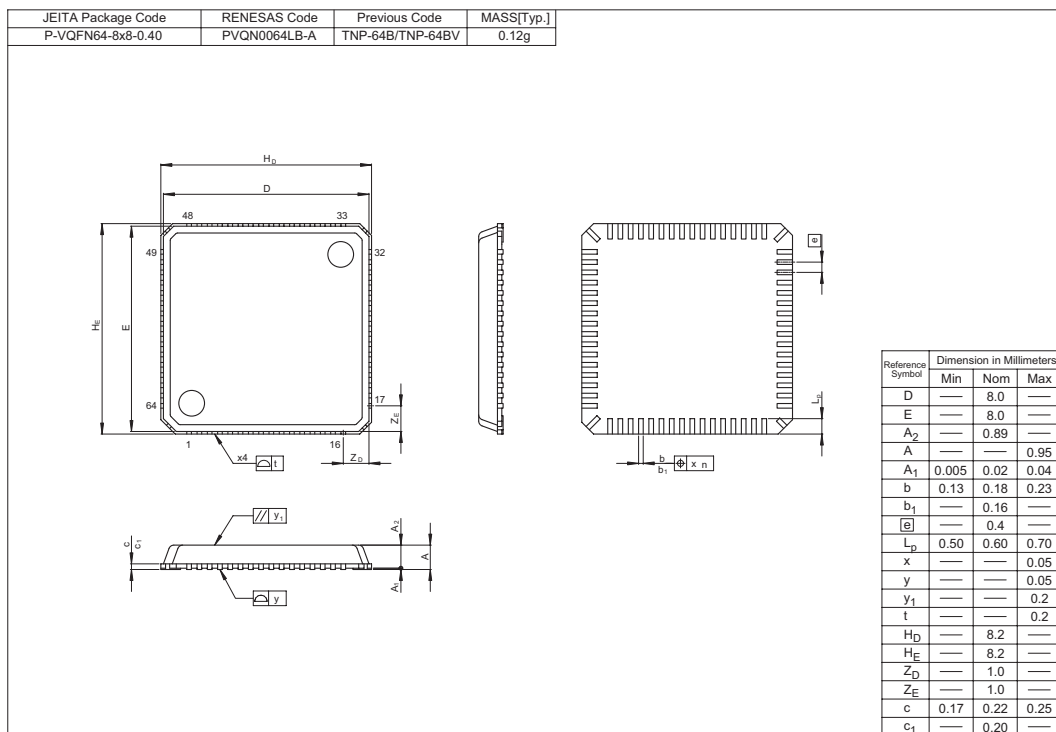


Figure E.4 Package Dimensions (TNP-64B)

Index

Numerics

| | |
|-------------------------|-----|
| 10-bit PWM | 267 |
| 16-bit timer mode | 191 |
| 8-bit timer mode | 191 |

A

| | |
|--|-----|
| A/D converter | 273 |
| Absolute address | 40 |
| Addressing modes | 39 |
| Arithmetic operations instructions | 30 |
| Asynchronous mode | 238 |
| Auto-erase mode | 136 |
| Auto-program mode | 134 |

B

| | |
|--|-----|
| Bit manipulation instructions | 33 |
| Bit rate | 231 |
| Block data transfer instructions | 37 |
| Boot mode | 117 |
| Boot program | 117 |
| Branch instructions | 35 |
| Break | 261 |

C

| | |
|-------------------------------------|-----|
| Clock pulse generators | 75 |
| Clocked synchronous mode | 250 |
| Condition field | 38 |
| Condition-code register (CCR) | 23 |
| CPU | 13 |

D

| | |
|----------------------------------|----|
| Data transfer instructions | 29 |
|----------------------------------|----|

E

| | |
|-----------------------------------|-----|
| Effective address | 43 |
| Effective address extension | 38 |
| Erase/erase-verify | 125 |
| Erasing units | 112 |
| Error protection | 127 |
| Exception handling | 55 |

F

| | |
|---------------------|-----|
| Flash memory | 110 |
| Framing error | 246 |

G

| | |
|-------------------------|----|
| General registers | 22 |
|-------------------------|----|

H

| | |
|---------------------------|-----|
| Hardware protection | 127 |
|---------------------------|-----|

I

| | |
|-------------------------------|----|
| Immediate | 41 |
| Instruction set | 28 |
| Internal interrupts | 67 |
| Interrupt mask bit (I) | 23 |
| Interrupt response time | 69 |
| IRQ interrupts | 66 |

L

| | |
|-------------------------------------|----|
| Large current ports | 4 |
| Logic operations instructions | 32 |

M

| | |
|-------------------------------|-----|
| Mark state | 261 |
| Memory indirect | 41 |
| Memory map | 15 |
| Memory read mode..... | 131 |
| Module standby function | 106 |

O

| | |
|---------------------------------|-----|
| On-board programming modes..... | 117 |
| Operation field..... | 38 |
| Overrun error | 246 |

P

| | |
|--------------------------------|-----|
| Parity error..... | 246 |
| Pin assignment..... | 8 |
| Power-down modes | 87 |
| Power-down state | 141 |
| Prescaler S | 80 |
| Prescaler W..... | 80 |
| Program counter (PC)..... | 23 |
| Program/program-verify..... | 122 |
| Program-counter relative | 41 |
| Programmer mode | 128 |
| Programming units | 112 |

R

Register

| | |
|---------------|--------------------|
| ADRR..... | 275, 287, 290, 293 |
| ADSR | 277, 287, 290, 293 |
| AEGSR..... | 203, 286, 289, 292 |
| AMR..... | 276, 287, 290, 293 |
| BRR | 231, 286, 289, 292 |
| CKSTPR1 | 91, 288, 291, 294 |
| CKSTPR2 | 91, 288, 291, 294 |
| EBR | 115, 286, 289, 292 |
| ECCR..... | 204, 286, 289, 292 |
| ECCSR | 205, 286, 289, 292 |

| | |
|--------------|--------------------|
| ECPWCR..... | 201, 286, 289, 292 |
| ECPWDR..... | 202, 286, 289, 292 |
| FENR | 116, 286, 289, 292 |
| FLMCR1 | 114, 286, 289, 292 |
| FLMCR2..... | 115, 286, 289, 292 |
| FLPWCR | 116, 286, 289, 292 |
| IEGR..... | 59, 288, 291, 294 |
| IENR..... | 60, 288, 291, 294 |
| IRR..... | 62, 288, 291, 294 |
| IWPR | 64, 288, 291, 294 |
| OCR..... | 185, 287, 290, 293 |
| PCR3..... | 148, 288, 290, 293 |
| PCR4..... | 155, 288, 290, 293 |
| PCR5..... | 159, 288, 291, 294 |
| PCR6..... | 163, 288, 291, 294 |
| PCR7..... | 166, 288, 291, 294 |
| PCR8..... | 168, 288, 291, 294 |
| PCRA | 172, 288, 291, 294 |
| PDR3..... | 148, 287, 290, 293 |
| PDR4..... | 154, 287, 290, 293 |
| PDR5..... | 159, 287, 290, 293 |
| PDR6..... | 163, 287, 290, 293 |
| PDR7..... | 166, 287, 290, 293 |
| PDR8..... | 168, 287, 290, 293 |
| PDR9..... | 169, 287, 290, 293 |
| PDRA..... | 171, 287, 290, 293 |
| PDRB..... | 174, 288, 290, 293 |
| PMR2..... | 151, 287, 290, 293 |
| PMR3..... | 150, 287, 290, 293 |
| PMR5..... | 160, 287, 290, 293 |
| PMR9..... | 170, 288, 291, 294 |
| PMRB | 174, 288, 291, 294 |
| PUCR3..... | 149, 288, 290, 293 |
| PUCR5..... | 160, 288, 290, 293 |
| PUCR6..... | 164, 288, 290, 293 |
| PWCR..... | 269, 287, 290, 293 |
| PWDR..... | 270, 287, 290, 293 |
| RDR | 222, 286, 289, 292 |
| RSR..... | 221 |
| SCR3..... | 226, 286, 289, 292 |

| | | | |
|--|--------------------|----------------------------------|-----|
| SMR..... | 223, 286, 289, 292 | Socket adapter..... | 128 |
| SPCR..... | 155, 286, 289, 292 | Software protection..... | 127 |
| SSR..... | 228, 286, 289, 292 | Stack pointer (SP)..... | 22 |
| SYSCR1..... | 88, 288, 291, 294 | Stack status..... | 69 |
| SYSCR2..... | 90, 288, 291, 294 | Standby mode..... | 99 |
| TCA..... | 181, 287, 289, 292 | Status polling..... | 139 |
| TCR..... | 186, 287, 290, 293 | Status read mode..... | 137 |
| TCSR..... | 187, 287, 290, 293 | Subactive mode..... | 100 |
| TCSRW..... | 215, 287, 289, 292 | Subclock generator..... | 78 |
| TCW..... | 216, 287, 289, 292 | Subsleep mode..... | 100 |
| TDR..... | 222, 286, 289, 292 | System clock generator..... | 76 |
| TMA..... | 180, 287, 289, 292 | System control instructions..... | 36 |
| TSR..... | 222 | | |
| WEGR..... | 65, 286, 289, 292 | | |
| Register direct..... | 39 | T | |
| Register field..... | 38 | Timer A..... | 178 |
| Register indirect..... | 40 | Timer F..... | 182 |
| Register indirect with displacement..... | 40 | | |
| Register indirect with post-increment..... | 40 | V | |
| Register indirect with pre-decrement..... | 40 | Vector address..... | 58 |
| Reset exception handling..... | 65 | | |
| | | W | |
| S | | Watchdog timer..... | 214 |
| Serial communication interface 3 | | WKP interrupts..... | 66 |
| (SCI3)..... | 219 | | |
| Shift instructions..... | 32 | | |
| Sleep mode..... | 98 | | |

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